

Audio Hub CODEC with Voice Processor DSP

DESCRIPTION

The WM5102^[1] is a highly-integrated low-power audio system for smartphones, tablets and other portable audio devices. It combines wideband telephony voice processing with a flexible, high-performance audio hub CODEC.

The WM5102 digital core provides a powerful combination of fixed-function signal processing blocks with a programmable DSP. These are supported by a fully-flexible, all-digital audio mixing and routing engine with sample rate converters, for wide use-case flexibility. The programmable DSP is optimised for Wolfson's wideband voice processing which includes multi-mic noise reduction and echo cancellation. Many other audio algorithms can also be implemented. Fixed-function signal processing blocks include filters, EQ, dynamics processors and sample rate converters.

A SLIMbus interface supports multi-channel audio paths and host control register access. Multiple sample rates are supported concurrently via the SLIMbus interface. Three further digital audio interfaces are provided, each supporting a wide range of standard audio sample rates and serial interface formats. Automatic sample rate detection enables seamless wideband/narrowband voice call handover.

Two stereo headphone drivers each provide stereo ground-referenced or mono BTL outputs, with noise levels as low as $2.3\mu V_{\text{RMS}}$ for hi-fi quality line or headphone output. The CODEC also features stereo 2W Class-D speaker outputs, a dedicated BTL earpiece output and PDM for external speaker amplifiers. A signal generator for controlling haptics devices is included; vibe actuators can connect directly to the Class-D speaker output, or via an external driver on the PDM output interface. All inputs, outputs and system interfaces can function concurrently.

The WM5102 supports up to six microphone inputs, each either analogue or PDM digital. Microphone activity detection with interrupt is available. A smart accessory interface supports most standard 3.5mm accessories. Impedance sensing and measurement is provided for external accessory and push-button detection.

The WM5102 power, clocking and output driver architectures are all designed to maximise battery life in voice, music and standby modes. Low-power 'Sleep' is supported, with configurable wake-up events. The WM5102 is powered from a 1.8V external supply. A separate supply is required for the Class D speaker drivers (typically direct connection to 4.2V battery).

Two integrated FLLs provide support for a wide range of system clock frequencies. The WM5102 is configured using the I2C, SPI or SLIMbus interfaces. The fully-differential internal analogue architecture, minimal analogue signal paths and on-chip RF noise filters ensure a very high degree of noise immunity.

FEATURES

- Audio hub CODEC with integrated voice processor DSP
- · Programmable audio effects and voice processing functions
 - Transmit-path noise reduction and echo cancellation
 - Receive-path enhancement and noise reduction
 - Wind noise, sidetone and other programmable filters
 - Dynamic Range Control, Fully parametric EQs
- Multi-channel asynchronous sample rate conversion
- Integrated 6/7 channel 24-bit hi-fi audio hub CODEC
 - 6 ADCs, 96dB SNR microphone input (48kHz)
 - 7 DACs, 113dB SNR headphone playback (48kHz)
- Audio inputs
 - Up to 6 analogue or digital microphone inputs
 - Single-ended or differential mic/line inputs
- Multi-purpose headphone / earpiece / line output drivers
 - 2 stereo output paths
 - 29mW into 32Ω load at 0.1% THD+N
 - 100mW into 32Ω BTL load at 5% THD+N
 - 6.5mW typical headphone playback power consumption
 - Pop suppression functions
 - 2.3μV_{RMS} noise floor (A-weighted)
- · Mono BTL earpiece output driver
- 2 x 2W stereo Class D speaker output drivers
 - Direct drive of external haptics vibe actuators
- Two-channel digital speaker (PDM) interface
- SLIMbus® audio and control interface
- 3 full digital audio interfaces
 - Standard sample rates from 4kHz up to 192kHz
 - Ultrasonic accessory function support
 - TDM support on all AIFs
 - 8 channel input and output on AIF1
- Flexible clocking, derived from MCLKn, BCLKn or SLIMbus
- 2 low-power FLLs support reference clocks down to 32kHz
- Advanced accessory detection functions
 - Low-power standby mode and configurable wake-up
- Configurable functions on 5 GPIO pins
- · Integrated LDO regulators and charge pumps
- · Support for single 1.8V supply operation
- Small W-CSP package, 0.4mm pitch

APPLICATIONS

- Smartphones and Multimedia handsets
- Tablets and Mobile Internet Devices (MID)
- General-purpose low-power audio CODEC hub

BLOCK DIAGRAM

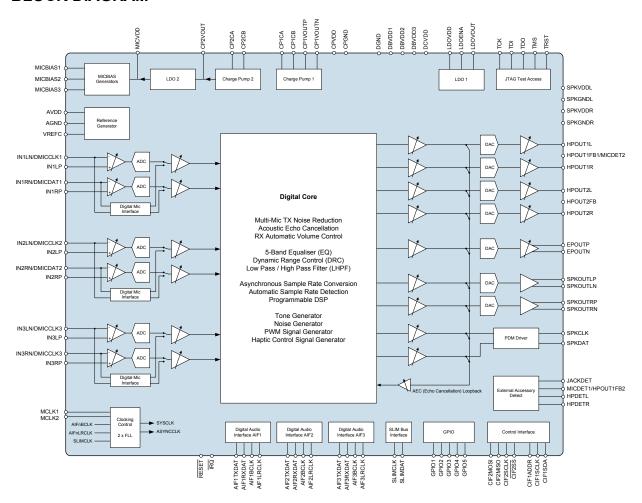


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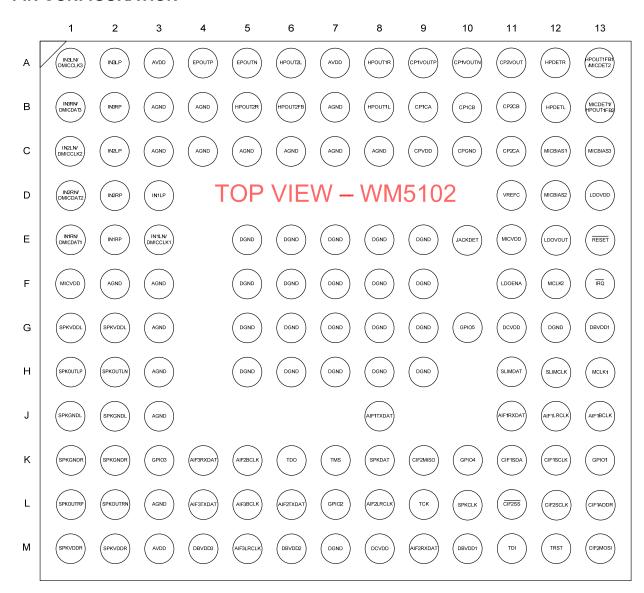
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PIN CONFIGURATION



ORDERING INFORMATION

ORDER CODE	TEMPERATURE RANGE	PACKAGE	MOISTURE SENSITIVITY LEVEL	PEAK SOLDERING TEMPERATURE
WM5102ECS/R	-40°C to +85°C	W-CSP (Pb-free, Tape and reel)	MSL1	260°C

Note:

Reel quantity = 5000

PIN DESCRIPTION

A description of each pin on the WM5102 is provided below.

Note that a table detailing the associated power domain for every input and output pin is provided on the following page.

Note that, where multiple pins share a common name, these pins should be tied together on the PCB.

All Digital Output pins are CMOS outputs, unless otherwise stated.

PIN NO	NAME	TYPE	DESCRIPTION	
B3, B4, B7, C3, C4, C5, C6, C7, C8, F2, F3, G3,	AGND	Supply	Analogue ground (Return path for AVDD)	
H3, J3, L3				
J13	AIF1BCLK	Digital Input / Output	Audio interface 1 bit clock	
J11	AIF1RXDAT	Digital Input	Audio interface 1 RX digital audio data	
J12	AIF1LRCLK	Digital Input / Output	Audio interface 1 left / right clock	
J8	AIF1TXDAT	Digital Output	Audio interface 1 TX digital audio data	
K5	AIF2BCLK	Digital Input / Output	Audio interface 2 bit clock	
M9	AIF2RXDAT	Digital Input	Audio interface 2 RX digital audio data	
L8	AIF2LRCLK	Digital Input / Output	Audio interface 2 left / right clock	
L6	AIF2TXDAT	Digital Output	Audio interface 2 TX digital audio data	
L5	AIF3BCLK	Digital Input / Output	Audio interface 3 bit clock	
K4	AIF3RXDAT	Digital Input	Audio interface 3 RXdigital audio data	
M5	AIF3LRCLK	Digital Input / Output	Audio interface 3 left / right clock	
L4	AIF3TXDAT	Digital Output	Audio interface 3 TX digital audio data	
A3, A7, M3	AVDD	Supply	Analogue supply	
L13	CIF1ADDR	Digital Input	Control interface 1 (I2C) address select	
K12	CIF1SCLK	Digital Input	Control interface 1 clock input	
K11	CIF1SDA	Digital Input / Output	Control interface 1 data input and output / acknowledge output. The output function is implemented as an Open Drain circuit.	
M13	CIF2MOSI	Digital Input	Control interface 2 Master Out / Slave In data	
K9	CIF2MISO	Digital Output	Control interface 2 Master In / Slave Out data	
L12	CIF2SCLK	Digital Input	Control interface 2 clock input	
L11	CIF2SS	Digital Input	Control interface 2 Slave Select (SS)	
B9	CP1CA	Analogue Output	Charge pump 1 fly-back capacitor pin	
B10	CP1CB	Analogue Output	Charge pump 1 fly-back capacitor pin	
A10	CP1VOUTN	Analogue Output	Charge pump 1 negative output decoupling pin	
A9	CP1VOUTP	Analogue Output	Charge pump 1 positive output decoupling pin	
C11	CP2CA	Analogue Output	Charge pump 2 fly-back capacitor pin	
B11	CP2CB	Analogue Output	Charge pump 2 fly-back capacitor pin	
A11	CP2VOUT	Analogue Output	Charge pump 2 output decoupling pin / Supply for LDO2	
C10	CPGND	Supply	Charge pump 1 & 2 ground (Return path for CPVDD)	
C9	CPVDD	Supply	Supply for Charge Pump 1 & 2	
G13, M10	DBVDD1	Supply	Digital buffer (I/O) supply (core functions and Audio Interface 1)	
M6	DBVDD2	Supply	Digital buffer (I/O) supply (for Audio Interface 2)	
M4	DBVDD3	Supply	Digital buffer (I/O) supply (for Audio Interface 3)	
G11, M8	DCVDD	Supply	Digital core supply	
E5, E6, E7, E8, E9, F5, F6, F7, F8, F9, G5, G6, G7, G8, G9, G12, H5, H6, H7, H8, H9,	DGND	Supply	Digital ground (Return path for DCVDD, DBVDD1, DBVDD2 and DBVDD3)	
A4	EPOUTP	Analogue Output	Earpiece positive output	



PIN NO	NAME	TYPE	DESCRIPTION		
A5	EPOUTN	Analogue Output	Earpiece negative output		
K13	GPIO1	Digital Input / Output	General Purpose pin GPIO1.		
			The output configuration is selectable CMOS or Open Drain.		
L7	GPIO2	Digital Input / Output	General Purpose pin GPIO2.		
			The output configuration is selectable CMOS or Open Drain.		
K3	GPIO3	Digital Input / Output	General Purpose pin GPIO3.		
			The output configuration is selectable CMOS or Open Drain.		
K10	GPIO4	Digital Input / Output	General Purpose pin GPIO4.		
			The output configuration is selectable CMOS or Open Drain.		
G10	GPIO5	Digital Input / Output	General Purpose pin GPIO5.		
			The output configuration is selectable CMOS or Open Drain.		
B12	HPDETL	Analogue Input	Headphone left (HPOUT1L) sense input		
A12	HPDETR	Analogue Input	Headphone right (HPOUT1R) sense input		
A13	HPOUT1FB1/	Analogue Input	HPOUT1L and HPOUT1R ground feedback pin 1/		
	MICDET2		Microphone & accessory sense input 2		
B8	HPOUT1L	Analogue Output	Left headphone 1 output		
A8	HPOUT1R	Analogue Output	Right headphone 1 output		
B6	HPOUT2FB	Analogue Input	HPOUT2L and HPOUT2R ground loop noise rejection feedback		
A6	HPOUT2L	Analogue Output	Left headphone 2 output		
B5	HPOUT2R	Analogue Output	Right headphone 2 output		
E3	IN1LN/	Analogue Input /	Left channel negative differential MIC input /		
	DMICCLK1	Digital Output	Digital MIC clock output 1		
D3	IN1LP	Analogue Input	Left channel single-ended MIC input /		
			Left channel line input /		
			Left channel positive differential MIC input		
E1	IN1RN/	Analogue input / Digital Input	Right channel negative differential MIC input /		
F0	DMICDAT1	<u> </u>	Digital MIC data input 1		
E2	IN1RP	Analogue Input	Right channel single-ended MIC input /		
			Right channel line input / Right channel positive differential MIC input		
C1	IN2LN/	Analogue Input /	Left channel negative differential MIC input /		
C1	DMICCLK2	Digital Output	Digital MIC clock output 2		
C2	IN2LP	Analogue Input	Left channel single-ended MIC input /		
O2	IIVZLI	Analogue input	Left channel line input /		
			Left channel positive differential MIC input		
D1	IN2RN/	Analogue input /	Right channel negative differential MIC input /		
	DMICDAT2	Digital Input	Digital MIC data input 2		
D2	IN2RP	Analogue Input	Right channel single-ended MIC input /		
			Right channel line input /		
			Right channel positive differential MIC input		
A1	IN3LN/	Analogue Input /	Left channel negative differential MIC input /		
	DMICCLK3	Digital Output	Digital MIC clock output 3		
A2	IN3LP	Analogue Input	Left channel single-ended MIC input /		
			Left channel line input /		
			Left channel positive differential MIC input		
B1	IN3RN/	Analogue input /	Right channel negative differential MIC input /		
	DMICDAT3	Digital Input	Digital MIC data input 3		
B2	IN3RP	Analogue Input	ut Right channel single-ended MIC input /		
			Right channel line input /		
			Right channel positive differential MIC input		
F13	ĪRQ	Digital Output	Interrupt Request (IRQ) output (default is active low).		
			The pin configuration is selectable CMOS or Open Drain.		
E10	JACKDET	Analogue Input	Jack detect input		



PIN NO	NAME	TYPE	DESCRIPTION	
F11	LDOENA	Digital Input	Enable pin for LDO1	
D13	LDOVDD	Supply	Supply for LDO1	
E12	LDOVOUT	Analogue Output	LDO1 output	
H13	MCLK1	Digital Input	Master clock 1	
F12	MCLK2	Digital Input	Master clock 2	
C12	MICBIAS1	Analogue Output	Microphone bias 1	
D12	MICBIAS2	Analogue Output	Microphone bias 2	
C13	MICBIAS3	Analogue Output	Microphone bias 3	
B13	MICDET1/	Analogue Input	Microphone & accessory sense input 1/	
	HPOUT1FB2		HPOUT1L and HPOUT1R ground feedback pin 2	
E11, F1	MICVDD	Analogue Output	LDO2 output decoupling pin (generated internally by WM5102).	
			(Can also be used as reference/supply for external	
			microphones.)	
E13	RESET	Digital Input	Digital Reset input (active low)	
H12	SLIMCLK	Digital Input / Output	SLIMbus Clock input / output	
H11	SLIMDAT	Digital Input / Output	SLIMbus Data input / output	
L10	SPKCLK	Digital Output	Digital speaker (PDM) clock output	
K8	SPKDAT	Digital Output	Digital speaker (PDM) data output	
J1, J2	SPKGNDL	Supply	Left speaker driver ground (Return path for SPKVDDL)	
K1, K2	SPKGNDR	Supply	Right speaker driver ground (Return path for SPKVDDR)	
H2	SPKOUTLN	Analogue Output	Left speaker negative output	
H1	SPKOUTLP	Analogue Output	Left speaker positive output	
L2	SPKOUTRN	Analogue Output	Right speaker negative output	
L1	SPKOUTRP	Analogue Output	Right speaker positive output	
G1, G2	SPKVDDL	Supply	Left speaker driver supply	
M1, M2	SPKVDDR	Supply	Right speaker driver supply	
L9	TCK	Digital Input	JTAG clock input	
M11	TDI	Digital Input	JTAG data input	
K6	TDO	Digital Output	JTAG data output	
K7	TMS	Digital Input	JTAG mode select input	
M12	TRST	Digital Input	JTAG Test Access Port reset (active low, internal pull-down).	
			This input should be logic 0 for normal WM5102 operation.	
D11	VREFC	Analogue Output	Bandgap reference decoupling capacitor connection	



The following table identifies the power domain and ground reference associated with each of the input / output pins.

PIN NO	NAME	POWER DOMAIN	GROUND DOMAIN
J13	AIF1BCLK	DBVDD1	DGND
J11	AIF1RXDAT	DBVDD1	DGND
J12	AIF1LRCLK	DBVDD1	DGND
J8	AIF1TXDAT	DBVDD1	DGND
K5	AIF2BCLK	DBVDD2	DGND
M9	AIF2RXDAT	DBVDD2	DGND
L8	AIF2LRCLK	DBVDD2	DGND
L6	AIF2TXDAT	DBVDD2	DGND
L5	AIF3BCLK	DBVDD3	DGND
K4	AIF3RXDAT	DBVDD3	DGND
M5	AIF3LRCLK	DBVDD3	DGND
L4	AIF3TXDAT	DBVDD3	DGND
L13	CIF1ADDR	DBVDD1	DGND
K12	CIF1SCLK	DBVDD1	DGND
K11	CIF1SDA	DBVDD1	DGND
M13	CIF2MOSI	DBVDD1	DGND
K9	CIF2MISO	DBVDD1	DGND
L12	CIF2SCLK	DBVDD1	DGND
L11	CIF2SS	DBVDD1	DGND
A4	EPOUTP	CPVDD	AGND
A5	EPOUTN	CPVDD	AGND
K13	GPIO1	DBVDD1	DGND
L7	GPIO2	DBVDD2	DGND
K3	GPIO3	DBVDD3	DGND
K10	GPIO4	DBVDD1	DGND
G10	GPIO5	DBVDD1	DGND
B12	HPDETL	AVDD	AGND
A12	HPDETR	AVDD	AGND
A13	HPOUT1FB1/	CPVDD (Ground noise rejection) /	AGND
	MICDET2	MICVDD (Microphone / Accessory detection)	
B8	HPOUT1L	CPVDD	AGND
A8	HPOUT1R	CPVDD	AGND
B6	HPOUT2FB	CPVDD	AGND
A6	HPOUT2L	CPVDD	AGND
B5	HPOUT2R	CPVDD	AGND
E3	IN1LN/	MICVDD (analogue) /	AGND
	DMICCLK1	MICVDD, MICBIAS1, MICBIAS2, MICBIAS3 (digital)	
		The DMICCLK1 power domain is selectable using IN1_DMIC_SUP	
D3	IN1LP	AVDD	AGND
E1	IN1RN/	MICVDD (analogue) /	AGND
	DMICDAT1	MICVDD, MICBIAS1, MICBIAS2, MICBIAS3 (digital)	
		The DMICDAT1 power domain is selectable using IN1_DMIC_SUP	
E2	IN1RP	AVDD	AGND
C1	IN2LN/	MICVDD (analogue) /	AGND
	DMICCLK2	MICVDD, MICBIAS1, MICBIAS2, MICBIAS3 (digital)	
		The DMICCLK2 power domain is selectable using IN2_DMIC_SUP	
C2	IN2LP	AVDD	AGND
D1	IN2RN/	MICVDD (analogue) /	AGND
	DMICDAT2	MICVDD, MICBIAS1, MICBIAS2, MICBIAS3 (digital)	
		The DMICDAT2 power domain is selectable using IN2_DMIC_SUP	
D2	IN2RP	AVDD	AGND



PIN NO	NAME	POWER DOMAIN	GROUND DOMAIN
A1	IN3LN/	MICVDD (analogue) /	AGND
	DMICCLK3	MICVDD, MICBIAS1, MICBIAS2, MICBIAS3 (digital)	
		The DMICCLK3 power domain is selectable using IN3_DMIC_SUP	
A2	IN3LP	AVDD	AGND
B1	IN3RN/	MICVDD (analogue) /	AGND
	DMICDAT3	MICVDD, MICBIAS1, MICBIAS2, MICBIAS3 (digital)	
		The DMICDAT3 power domain is selectable using IN3_DMIC_SUP	
B2	IN3RP	AVDD	AGND
F13	ĪRQ	DBVDD1	DGND
E10	JACKDET	AVDD	AGND
F11	LDOENA	DBVDD1	DGND
H13	MCLK1	DBVDD1	DGND
F12	MCLK2	DBVDD1	DGND
C12	MICBIAS1	MICVDD	AGND
D12	MICBIAS2	MICVDD	AGND
C13	MICBIAS3	MICVDD	AGND
B13	MICDET1/	MICVDD (Microphone / Accessory detection) /	AGND
	HPOUT1FB2	CPVDD (Ground noise rejection)	
E13	RESET	DBVDD1	DGND
H12	SLIMCLK	DBVDD1	DGND
H11	SLIMDAT	DBVDD1	DGND
L10	SPKCLK	DBVDD1	DGND
K8	SPKDAT	DBVDD1	DGND
H2	SPKOUTLN	SPKVDDL	SPKGNDL
H1	SPKOUTLP	SPKVDDL	SPKGNDL
L2	SPKOUTRN	SPKVDDR	SPKGNDR
L1	SPKOUTRP	SPKVDDR	SPKGNDR
L9	TCK	DBVDD1	DGND
M11	TDI	DBVDD1	DGND
K6	TDO	DBVDD1	DGND
K7	TMS	DBVDD1	DGND
M12	TRST	DBVDD1	DGND
D11	VREFC	AVDD	AGND



ABSOLUTE MAXIMUM RATINGS

Absolute Maximum Ratings are stress ratings only. Permanent damage to the device may be caused by continuously operating at or beyond these limits. Device functional operating limits and guaranteed performance specifications are given under Electrical Characteristics at the test conditions specified.



ESD Sensitive Device. This device is manufactured on a CMOS process. It is therefore generically susceptible to damage from excessive static voltages. Proper ESD precautions must be taken during handling and storage of this device.

Wolfson tests its package types according to IPC/JEDEC J-STD-020 for Moisture Sensitivity to determine acceptable storage conditions prior to surface mount assembly. These levels are:

MSL1 = unlimited floor life at <30°C / 85% Relative Humidity. Not normally stored in moisture barrier bag.

MSL2 = out of bag storage for 1 year at <30°C / 60% Relative Humidity. Supplied in moisture barrier bag.

MSL3 = out of bag storage for 168 hours at <30°C / 60% Relative Humidity. Supplied in moisture barrier bag.

The Moisture Sensitivity Level for each package type is specified in Ordering Information.

CONDITION	MIN	MAX
Supply voltages (DBVDD1, LDOVDD, AVDD, DCVDD, CPVDD)	-0.3V	+2.0V
Supply voltages (DBVDD2, DBVDD3, MICVDD)	-0.3V	+4.0V
Supply voltages (SPKVDDL, SPKVDDR)	-0.3V	+6.0V
Voltage range digital inputs (DBVDD1 domain)	AGND - 0.3V	DBVDD1 + 0.3V
Voltage range digital inputs (DBVDD2 domain)	AGND - 0.3V	DBVDD2 + 0.3V
Voltage range digital inputs (DBVDD3 domain)	AGND - 0.3V	DBVDD3 + 0.3V
Voltage range digital inputs (DMICDATn)	AGND - 3.3V	MICVDD + 0.3V
Voltage range analogue inputs (INnLN)	AGND - 0.3V	MICVDD + 0.3V
Voltage range analogue inputs (INnLP, INnRN, INnRP)	AGND - 3.3V	MICVDD + 0.3V
Ground (DGND, CPGND, SPKGNDL, SPKGNDR)	AGND - 0.3V	AGND + 0.3V
Operating temperature range, T _A	-40°C	+85°C
Operating junction temperature, T _J	-40°C	+125°C
Storage temperature after soldering	-65°C	+150°C



RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Digital supply range (Core) See notes 3, 5, 6	DCVDD (≤24.576MHz clocking)	1.14	1.2	1.9	V
	DCVDD (>24.576MHz clocking)	1.71	1.8	1.9	1
Digital supply range (I/O)	DBVDD1	1.7		1.9	V
Digital supply range (I/O)	DBVDD2, DBVDD3	1.7		3.47	V
LDO supply range	LDOVDD	1.7	1.8	1.9	V
Charge Pump supply range	CPVDD	1.7	1.8	1.9	V
Speaker supply range	SPKVDDL, SPKVDDR	2.4		5.5	V
Analogue supply range	AVDD	1.7	1.8	1.9	V
Microphone Bias supply	MICVDD	2.375	2.5	3.6	V
See note 7					
Ground	DGND, AGND, CPGND, SPKGNDL, SPKGNDR		0		V
Power supply rise time	All supplies	1			μs
See notes 8, 9, 10					
Operating temperature range	T _A	-40		85	°C

Notes:

- 1. The grounds must always be within 0.3V of AGND.
- 2. AVDD must be supplied before or simultaneously to DCVDD. DCVDD must not be powered if AVDD is not present. There are no other power sequencing requirements.
- An internal LDO (powered by LDOVDD) can be used to provide the DCVDD supply.
- 4. The RESET input must be asserted (logic 0) during power-up, and held asserted until after the AVDD, DBVDD1 and DCVDD supplies are within the recommended operating limits. If DCVDD is powered from the internal LDO, then the RESET pin must be held asserted until at least 1.5ms after the LDO has been enabled.
- 5. 'Sleep' mode is supported when DCVDD is below the limits noted, provided AVDD and DBVDD1 are present.
- 6. Under default conditions, digital core clocking rates above 24.576MHz are inhibited. The register-controlled clocking limit should only be raised when the applicable DCVDD voltage is present.
- 7. An internal Charge Pump and LDO (powered by CPVDD) provide the Microphone Bias supply; the MICVDD pin should not be connected to an external supply.
- 8. DCVDD and MICVDD minimum rise times do not apply when these domains are powered using the internal LDOs.
- 9. The specified minimum power supply rise times assume a minimum decoupling capacitance of 100nF per pin. However, Wolfson strongly advises that the recommended decoupling capacitors are present on the PCB and that appropriate layout guidelines are observed.
- 10. The specified minimum power supply rise times also assume a maximum PCB inductance of 10nH between decoupling capacitor and pin.

ELECTRICAL CHARACTERISTICS

Test Conditions

AVDD = 1.8V

With the exception of the condition(s) noted above, the following electrical characteristics are valid across the full range of recommended operating conditions.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
Analogue Input Signal Level (IN1L, IN1R, IN2L, IN2R, IN3L, IN3R)								
Full-scale input signal level	V _{INFS}	Single-ended PGA input,	0.5			V_{RMS}		
(0dBFS output)		6dB PGA gain	-6			dBV		
		Differential PGA input,	1			V_{RMS}		
		0dB PGA gain	0			dBV		

Notes:

- 1. The full-scale input signal level is also the maximum analogue input level, before clipping occurs.
- 2. The full-scale input signal level changes in proportion with AVDD. For differential input, it is calculated as AVDD / 1.8.
- 3. A 1.0V_{RMS} differential signal equates to 0.5V_{RMS}/-6dBV per input.
- 4. A sinusoidal input signal is assumed.

Test Conditions

 $T_A = +25^{\circ}C$

With the exception of the condition(s) noted above, the following electrical characteristics are valid across the full range of recommended operating conditions.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
Analogue Input Pin Characteristics (IN1L, IN1R, IN2L, IN2R, IN3L, IN3R)								
Input resistance	R _{IN}	Differential input, All PGA gain settings		24		kΩ		
		Single-ended input, 0dB PGA gain		16				
Input capacitance	C _{IN}				5	pF		

Test Conditions

The following electrical characteristics are valid across the full range of recommended operating conditions.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
Input Programmable Gain Amplifiers (PGAs)								
Minimum programmable gain				0		dB		
Maximum programmable gain				31		dB		
Programmable gain step size		Guaranteed monotonic		1		dB		

Test Conditions

The following electrical characteristics are valid across the full range of recommended operating conditions.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
Digital Microphone Input Signal Level (DMICDAT1, DMICDAT2, DMICDAT3)								
Full-scale input signal level		0dB gain		-6		dBFS		
(0dBFS output)								

Notes:

5. The digital microphone input signal level is measured in dBFS, where 0dBFS is a signal level equal to the full-scale range (FSR) of the PDM input. The FSR is defined as the amplitude of a 1kHz sine wave whose positive and negative peaks are represented by the maximum and minimum digital codes respectively - this is the largest 1kHz sine wave that will fit in the digital output range without clipping. Note that, because the definition of FSR is based on a sine wave, the PDM data format can support signals larger than 0dBFS.



Test Conditions

The following electrical characteristics are valid across the full range of recommended operating conditions.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Line / Headphone / Earpiece O	utput Driver (HP	OUTnL, HPOUTnR)	<u>.</u>			
Load resistance		Normal Mode	15			Ω
		Mono Mode (BTL)	30			
		Device survival with load applied indefinitely	0.1			
Load capacitance		Direct connection, Normal Mode			400	pF
		Direct connection, Mono Mode (BTL)			200	
		Connection via 16Ω series resistor			2	nF
DC offset at Load		Single-ended mode		0.1		mV
		Differential (BTL) mode		0.2		
Earpiece Output Driver (EPOU	TP+EPOUTN)		<u>.</u>			
Load resistance		Normal operation	15			Ω
		Device survival with load applied indefinitely	0.1			
Load capacitance		Direct connection (BTL)			200	pF
		Connection via 16Ω series resistor			2	nF
DC offset at Load				0.2		mV
Speaker Output Driver (SPKOL	ITLP+SPKOUTL	N, SPKOUTRP+SPKOUTRN)				
Load resistance			3			Ω
Load capacitance					200	pF
DC offset at Load				5		mV
SPKVDD leakage current				1		μΑ



Test Conditions

DBVDD1 = DBVDD2 = DBVDD3 = LDOVDD = CPVDD = AVDD = 1.8V,

DCVDD = 1.2V (powered from LDO1), MICVDD = 3.0V (powered from LDO2), SPKVDDL = SPKVDDR = 4.2V, $T_A = +25^{\circ}C$, 1kHz sinusoid signal, fs = 48kHz, Input PGA gain = 0dB, 24-bit audio data unless otherwise stated.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Analogue Input Paths (INnL, INn	R) to ADC (Di	fferential Input Mode, INn_MC	DDE = 00)			
Signal to Noise Ratio	SNR	High performance mode	85	95		dB
(A-weighted)		(INn_OSR = 1)				
		Normal mode		93		
		(INn_OSR = 0)				
Total Harmonic Distortion	THD	-1dBV input		-88		dB
Total Harmonic Distortion Plus Noise	THD+N	-1dBV input		-86	-76	dB
Channel separation (Left/Right)				100		dB
Input noise floor		A-weighted,		3.2		μV_{RMS}
		PGA gain = +18dB				
Common mode rejection ratio	CMRR	PGA gain = +30dB		65		dB
		PGA gain = 0dB		70		
PSRR (DBVDDn, LDOVDD,	PSRR	100mV (peak-peak) 217Hz		70		dB
CPVDD, AVDD)		100mV(peak-peak) 10kHz		65		
Analogue Input Paths (INnL, INn	R) to ADC (Si	ngle-Ended Input Mode, INn_	MODE = 01)			
PGA Gain = +6dB unless otherwise	e stated.					
Signal to Noise Ratio	SNR	High performance mode		94		dB
(A-weighted)		(INn_OSR = 1)				
		Normal mode		90		
		(INn_OSR = 0)				
Total Harmonic Distortion	THD	-7dBV input		-81		dB
Total Harmonic Distortion Plus Noise	THD+N	-7dBV input		-80		dB
Channel separation (Left/Right)				100		dB
Input noise floor		A-weighted,		3.2		μV_{RMS}
		PGA gain = +18dB				
PSRR (DBVDDn, LDOVDD,	PSRR	100mV (peak-peak) 217Hz		60		dB
CPVDD, AVDD)		100mV(peak-peak) 10kHz		55		
DAC to Headphone Output (HPO	UT1L, HPOUT	Γ1R; R _L = 32Ω)				
Maximum output power	Po	0.1% THD+N		29		mW
Signal to Noise Ratio	SNR	A-weighted, Output signal = 1Vrms		112		dB
Total Harmonic Distortion	THD	P _O = 20mW		-86		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 20mW		-84		dB
Total Harmonic Distortion	THD	P _O = 5mW		-89		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 5mW		-85		dB
Channel separation (Left/Right)		P _O = 20mW		75		dB
Output noise floor		A-weighted		2.5		μV_{RMS}
PSRR (DBVDDn, LDOVDD,	PSRR	100mV (peak-peak) 217Hz		57		dB
CPVDD, AVDD)		100mV (peak-peak) 10kHz		57		



Test Conditions

DBVDD1 = DBVDD2 = DBVDD3 = LDOVDD = CPVDD = AVDD = 1.8V,

 $DCVDD = 1.2V \ (powered \ from \ LDO1), \ MICVDD = 3.0V \ (powered \ from \ LDO2), \ SPKVDDL = SPKVDDR = 4.2V,$

 T_A = +25°C, 1kHz sinusoid signal, fs = 48kHz, Input PGA gain = 0dB, 24-bit audio data unless otherwise stated.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
DAC to Headphone Output (HPO	UT1L, HPOUT	Γ 1R; R _L = 16Ω)				
Maximum output power	Po	0.1% THD+N		34		mW
Signal to Noise Ratio	SNR	A-weighted, Output signal = 1Vrms	102	112		dB
Total Harmonic Distortion	THD	P _O = 20mW		-78		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 20mW		-76		dB
Total Harmonic Distortion	THD	$P_0 = 5mW$		-78		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 5mW		-77	-67	dB
Channel separation (Left/Right)		P _O = 20mW		75		dB
Output noise floor		A-weighted		2.5	8	μV_{RMS}
PSRR (DBVDDn, LDOVDD,	PSRR	100mV (peak-peak) 217Hz		57		dB
CPVDD, AVDD)		100mV (peak-peak) 10kHz		57		
DAC to Line Output (HPOUT1L, H	IPOUT1R; Lo	ad = 10kΩ, 50pF)				
Full-scale output signal level	V _{out}	0dBFS input	1			Vrms
			0			dBV
Signal to Noise Ratio	SNR	A-weighted, Output signal = 1Vrms	101	110		dB
Total Harmonic Distortion	THD	0dBFS input		-83		dB
Total Harmonic Distortion Plus Noise	THD+N	0dBFS input		-81	-71	dB
Channel separation (Left/Right)				100		dB
Output noise floor		A-weighted		2.8	8	μV_{RMS}
PSRR (DBVDDn, LDOVDD,	PSRR	100mV (peak-peak) 217Hz		57		dB
CPVDD, AVDD)		100mV (peak-peak) 10kHz		57		
DAC to Earpiece Output (HPOUT	1L, HPOUT1F	R, Mono Mode, $R_L = 32\Omega$ BTL)				
Maximum output power	Po	0.1% THD+N		89		mW
		5% THD+N		104		
Signal to Noise Ratio	SNR	A-weighted, Output signal = 2Vrms		113		dB
Total Harmonic Distortion	THD	P _O = 50mW		-92		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 50mW		-90		dB
Total Harmonic Distortion	THD	P _o = 5mW		-86		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 5mW		-88		dB
Output noise floor		A-weighted		2.5		μV_{RMS}
PSRR (DBVDDn, LDOVDD,	PSRR	100mV (peak-peak) 217Hz		57		dB
CPVDD, AVDD)		100mV (peak-peak) 10kHz		57		



Test Conditions

DBVDD1 = DBVDD2 = DBVDD3 = LDOVDD = CPVDD = AVDD = 1.8V,

DCVDD = 1.2V (powered from LDO1), MICVDD = 3.0V (powered from LDO2), SPKVDDL = SPKVDDR = 4.2V, $T_A = +25^{\circ}C$, 1kHz sinusoid signal, fs = 48kHz, Input PGA gain = 0dB, 24-bit audio data unless otherwise stated.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
DAC to Headphone Output (HPO	UT2L, HPOUT	2R; R _L = 32Ω)				•
Maximum output power	Po	0.1% THD+N		27		mW
Signal to Noise Ratio	SNR	A-weighted, Output signal = 1Vrms		109		dB
Total Harmonic Distortion	THD	P _o = 20mW		-90		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 20mW		-88		dB
Total Harmonic Distortion	THD	P _O = 5mW		-90		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 5mW		-88		dB
Channel separation (Left/Right)		P _o = 20mW		75		dB
Output noise floor		A-weighted		3		μV_{RMS}
PSRR (DBVDDn, LDOVDD,	PSRR	100mV (peak-peak) 217Hz		57		dB
CPVDD, AVDD)		100mV (peak-peak) 10kHz		57		
DAC to Headphone Output (HPO	UT2L, HPOUT	$^{\prime}$ 2R; R _L = 16 Ω)				•
Maximum output power	Po	0.1% THD+N		32		mW
Signal to Noise Ratio	SNR	A-weighted, Output signal = 1Vrms	101	111		dB
Total Harmonic Distortion	THD	P _O = 20mW		-88		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 20mW		-87		dB
Total Harmonic Distortion	THD	$P_0 = 5mW$		-85		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 5mW		-83	-73	dB
Channel separation (Left/Right)		P _o = 20mW		75		dB
Output noise floor		A-weighted		2.8	10	μV_{RMS}
PSRR (DBVDDn, LDOVDD,	PSRR	100mV (peak-peak) 217Hz		57		dB
CPVDD, AVDD)		100mV (peak-peak) 10kHz		57		
DAC to Line Output (HPOUT2L, H	IPOUT2R; Loa	ad = 10kΩ, 50pF)				
Full-scale output signal level	V _{OUT}	0dBFS input	1			Vrms
			0			dBV
Signal to Noise Ratio	SNR	A-weighted, Output signal = 1Vrms	100	110		dB
Total Harmonic Distortion	THD	0dBFS input		-87		dB
Total Harmonic Distortion Plus Noise	THD+N	0dBFS input		-85	-75	dB
Channel separation (Left/Right)				105		dB
Output noise floor		A-weighted		3.5	10	μV_{RMS}
PSRR (DBVDDn, LDOVDD, CPVDD, AVDD)	PSRR	100mV (peak-peak) 217Hz 100mV (peak-peak) 10kHz		57 57		dB



Test Conditions

DBVDD1 = DBVDD2 = DBVDD3 = LDOVDD = CPVDD = AVDD = 1.8V,

 $DCVDD = 1.2V \ (powered \ from \ LDO1), \ MICVDD = 3.0V \ (powered \ from \ LDO2), \ SPKVDDL = SPKVDDR = 4.2V,$

 T_A = +25°C, 1kHz sinusoid signal, fs = 48kHz, Input PGA gain = 0dB, 24-bit audio data unless otherwise stated.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
DAC to Earpiece Output (HPOUT2	L, HPOUT2R	, Mono Mode, $R_L = 32\Omega$ BTL)				
Maximum output power	Po	0.1% THD+N		85		mW
		5% THD+N		100		
Signal to Noise Ratio	SNR	A-weighted, Output signal = 2Vrms		112		dB
Total Harmonic Distortion	THD	P _o = 50mW		-90		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 50mW		-88		dB
Total Harmonic Distortion	THD	P _O = 5mW		-90		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 5mW		-88		dB
Output noise floor		A-weighted		6		μV_{RMS}
PSRR (DBVDDn, LDOVDD,	PSRR	100mV (peak-peak) 217Hz		57		dB
CPVDD, AVDD)		100mV (peak-peak) 10kHz		57		1
DAC to Earpiece Output (EPOUTF	+EPOUTN, F	R _L = 32Ω BTL)				
Maximum output power	Po	0.1% THD+N		80		mW
		5% THD+N		100		
Signal to Noise Ratio	SNR	A-weighted, Output signal = 2Vrms	99	109		dB
Total Harmonic Distortion	THD	P _o = 50mW		-86		dB
Total Harmonic Distortion Plus Noise	THD+N	P _o = 50mW		-84		dB
Total Harmonic Distortion	THD	P _O = 5mW		-85		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 5mW		-83	-73	dB
Output noise floor		A-weighted		3.5	10.5	μV_{RMS}
PSRR (DBVDDn, LDOVDD,	PSRR	100mV (peak-peak) 217Hz		52		dB
CPVDD, AVDD)		100mV (peak-peak) 10kHz		52		
DAC to Earpiece Output (EPOUTF	+EPOUTN, F	$R_L = 16\Omega BTL$				
Maximum output power	Po	0.1% THD+N		80		mW
		10% THD+N		105		
Signal to Noise Ratio	SNR	A-weighted, Output signal = 2Vrms		111		dB
Total Harmonic Distortion	THD	P _o = 50mW		-92		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 50mW		-90		dB
Total Harmonic Distortion	THD	P _O = 5mW		-84		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 5mW		-82		dB
Output noise floor		A-weighted		3		μV_{RMS}
PSRR (DBVDDn, LDOVDD,	PSRR	100mV (peak-peak) 217Hz		52		dB
CPVDD, AVDD)		100mV (peak-peak) 10kHz		52		



Test Conditions

DBVDD1 = DBVDD2 = DBVDD3 = LDOVDD = CPVDD = AVDD = 1.8V,

 $T_A = +25$ °C, 1kHz sinusoid signal, fs = 48kHz, Input PGA gain = 0dB, 24-bit audio data unless otherwise stated.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
DAC to Speaker Output (SPKOU' High Performance mode (OUT4_O		LN, SPKOUTRP+SPKOUTRN	, Load = 8Ω	, 22µH, BTL)		
Maximum output power	Po	SPKVDD = 5.0V, 1% THD+N		1.4		W
		SPKVDD = 4.2V, 1% THD+N		1.0		
		SPKVDD = 3.6V, 1% THD+N		0.7		
Signal to Noise Ratio	SNR	A-weighted, Output signal = 3.3Vrms	82	97		dB
Total Harmonic Distortion	THD	P ₀ = 0.9W		-70		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 0.9W		-68		dB
Total Harmonic Distortion	THD	P _O = 0.5W		-70		dB
Total Harmonic Distortion Plus Noise	THD+N	P ₀ = 0.5W		-68	-57	dB
Channel separation (Left/Right)		P _O = 0.5W		105		dB
Output noise floor		A-weighted		55	300	μV_{RMS}
PSRR (DBVDDn, LDOVDD,	PSRR	100mV (peak-peak) 217Hz		60		dB
CPVDD, AVDD)		100mV (peak-peak) 10kHz		60		
PSRR (SPKVDDL, SPKVDDR)	PSRR	100mV (peak-peak) 217Hz		70		dB
		100mV (peak-peak) 10kHz		70		1
DAC to Speaker Output (SPKOU' High Performance mode (OUT4_O		LN, SPKOUTRP+SPKOUTRN	, Load = 4Ω	, 15μH, BTL)		
Maximum output power	Po	SPKVDD = 5.0V, 1% THD+N		2.5		W
		SPKVDD = 4.2V, 1% THD+N		1.8		
		SPKVDD = 3.6V, 1% THD+N		1.3		
Signal to Noise Ratio	SNR	A-weighted, Output signal = 3.3Vrms		95		dB
Total Harmonic Distortion	THD	P _O = 1.0W		-64		dB
Total Harmonic Distortion Plus Noise	THD+N	P _O = 1.0W		-62		dB
Total Harmonic Distortion	THD	P _O = 0.5W		-66		dB
Total Harmonic Distortion Plus Noise	THD+N	P _o = 0.5W		-64		dB
Channel separation (Left/Right)		P _O = 0.5W		105		dB
Output noise floor		A-weighted		55		μV_{RMS}
PSRR (DBVDDn, LDOVDD,	PSRR	100mV (peak-peak) 217Hz		60		dB
CPVDD, AVDD)		100mV (peak-peak) 10kHz		60		
PSRR (SPKVDDL, SPKVDDR)	PSRR	100mV (peak-peak) 217Hz		70		dB
		100mV (peak-peak) 10kHz		70		



WM5102

Production Data

Test Conditions

The following electrical characteristics are valid across the full range of recommended operating conditions.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Digital Input / Output (except DN	IICDATn and D	MICCLKn)				
Digital I/O is referenced to DBVI	DD1, DBVDD2 o	or DBVDD3. See "Pin Desc	ription" for the	domain ap	plicable to eac	h pin.
See "Recommended Operating (Conditions" for	r the valid operating voltag	je range of eac	h DBVDDn	domain.	
Input HIGH Level	V _{IH}	V_{DBVDDn} =1.8V ±10%	0.65 ×			V
			V_{DBVDDn}			
		V_{DBVDDn} =3.3V ±10%	0.7 ×			
	.,	1 01/11/00/	V _{DBVDDn}		0.05	
Input LOW Level	V_{IL}	V_{DBVDDn} =1.8V ±10%			$0.35 \times V_{DBVDDn}$	V
		V _{DBVDDn} =3.3V ±10%	+		0.3 ×	
		V DBVDDn -3.3V ±1070			V _{DBVDDn}	
Note that digital input pins should	not be left uncor	nnected or floating.			BBVBBII	
Output HIGH Level	V _{OH}	I _{OH} = 1mA	0.9 ×			V
•	511	011	V_{DBVDDn}			
Output LOW Level	V _{OL}	I _{OL} = -1mA			0.1 ×	V
					V_{DBVDDn}	
Input capacitance				10		pF
Input leakage			-1		1	μΑ
Pull-up / pull-down resistance			28	36	45	kΩ
(where applicable)						
Digital Microphone Input / Output	ut (DMICDATn a	and DMICCLKn)				
DMICDATn and DMICCLKn are e	each referenced	d to a selectable supply, V	_{SUP} , according t	o the INn_	DMIC_SUP reg	isters
DMICDATn input HIGH Level	V _{IH}		$0.65 \times V_{\text{SUP}}$			V
DMICDATn input LOW Level	17				0.05 1/	
	V _{IL}				$0.35 \times V_{SUP}$	V
DMICCLKn output HIGH Level	V _{IL} V _{OH}	I _{OH} = 1mA	$0.8 \times V_{SUP}$		$0.35 \times V_{SUP}$	V
DMICCLKn output HIGH Level DMICCLKn output LOW Level		I _{OH} = 1mA I _{OL} = -1mA	0.8 × V _{SUP}		$0.35 \times V_{SUP}$ $0.2 \times V_{SUP}$	
	V _{OH}		0.8 × V _{SUP}	10		V
DMICCLKn output LOW Level	V _{OH}		0.8 × V _{SUP}	10		V
DMICCLKn output LOW Level Input capacitance	V _{OH} V _{OL}	I _{OL} = -1mA		10	0.2 × V _{SUP}	V V pF
DMICCLKn output LOW Level Input capacitance Input leakage	V _{OH} V _{OL} SLIMCLK and S	I _{OL} = -1mA SLIMDAT)		10	0.2 × V _{SUP}	V V pF
DMICCLKn output LOW Level Input capacitance Input leakage SLIMbus Digital Input / Output (\$	V _{OH} V _{OL} SLIMCLK and S	I _{OL} = -1mA SLIMDAT)		10	0.2 × V _{SUP}	V V pF
DMICCLKn output LOW Level Input capacitance Input leakage SLIMbus Digital Input / Output (\$ 1.8V I/O Signalling (ie. 1.65V ≤ D	V _{OH} V _{OL} SLIMCLK and S BVDD1 ≤1.95V	I _{OL} = -1mA SLIMDAT)	-1	10	0.2 × V _{SUP}	V V pF μA
DMICCLKn output LOW Level Input capacitance Input leakage SLIMbus Digital Input / Output (\$ 1.8V I/O Signalling (ie. 1.65V ≤ D	V _{OH} V _{OL} SLIMCLK and S BVDD1 ≤1.95V	I _{OL} = -1mA SLIMDAT)	-1	10	0.2 × V _{SUP} 1 0.35 ×	V V pF μA
DMICCLKn output LOW Level Input capacitance Input leakage SLIMbus Digital Input / Output (\$ 1.8V I/O Signalling (ie. 1.65V ≤ D Input HIGH Level Input LOW Level	V _{OH} V _{OL} SLIMCLK and S BVDD1 ≤1.95V V _{IH} V _{IL}	I _{OL} = -1mA SLIMDAT)	-1 0.65 × VDBVDD1	10	0.2 × V _{SUP}	V V pF μA V
DMICCLKn output LOW Level Input capacitance Input leakage SLIMbus Digital Input / Output (\$ 1.8V I/O Signalling (ie. 1.65V ≤ D Input HIGH Level	V _{OH} V _{OL} SLIMCLK and S BVDD1 ≤1.95V V _{IH}	I _{OL} = -1mA SLIMDAT)	-1 0.65 × VDBVDD1 0.9 ×	10	0.2 × V _{SUP} 1 0.35 ×	V V pF µA
DMICCLKn output LOW Level Input capacitance Input leakage SLIMbus Digital Input / Output (\$ 1.8V I/O Signalling (ie. 1.65V ≤ D Input HIGH Level Output HIGH Level	V _{OH} V _{OL} SLIMCLK and S BVDD1 ≤1.95V V _{IH} V _{IL} V _{OH}	I _{OL} = -1mA SLIMDAT)) I _{OH} = 1mA	-1 0.65 × VDBVDD1	10	0.2 × V _{SUP} 1 0.35 × V _{DBVDD1}	V V pF μA V V
DMICCLKn output LOW Level Input capacitance Input leakage SLIMbus Digital Input / Output (\$ 1.8V I/O Signalling (ie. 1.65V ≤ D Input HIGH Level Input LOW Level	V _{OH} V _{OL} SLIMCLK and S BVDD1 ≤1.95V V _{IH} V _{IL}	I _{OL} = -1mA SLIMDAT)	-1 0.65 × VDBVDD1 0.9 ×	10	0.2 × V _{SUP} 1 0.35 × V _{DBVDD1} 0.1 ×	V V pF μA V
DMICCLKn output LOW Level Input capacitance Input leakage SLIMbus Digital Input / Output (\$ 1.8V I/O Signalling (ie. 1.65V ≤ D Input HIGH Level Input LOW Level Output HIGH Level Output LOW Level	V _{OH} V _{OL} SLIMCLK and S BVDD1 ≤1.95V V _{IH} V _{IL} V _{OH}	I _{OL} = -1mA SLIMDAT)) I _{OH} = 1mA	-1 0.65 × VDBVDD1 0.9 ×	10	0.2 × V _{SUP} 1 0.35 × V _{DBVDD1} 0.1 × V _{DBVDD1}	V V pF μA V V
DMICCLKn output LOW Level Input capacitance Input leakage SLIMbus Digital Input / Output (\$ 1.8V I/O Signalling (ie. 1.65V ≤ D Input HIGH Level Input LOW Level Output HIGH Level Output LOW Level Pin capacitance	V _{OH} V _{OL} SLIMCLK and S BVDD1 ≤1.95V V _{IH} V _{IL} V _{OH} V _{OL}	I _{OL} = -1mA SLIMDAT)) I _{OH} = 1mA	-1 0.65 × VDBVDD1 0.9 ×	10	0.2 × V _{SUP} 1 0.35 × V _{DBVDD1} 0.1 ×	V V pF μA V V
DMICCLKn output LOW Level Input capacitance Input leakage SLIMbus Digital Input / Output (\$ 1.8V I/O Signalling (ie. 1.65V ≤ D Input HIGH Level Input LOW Level Output HIGH Level Output LOW Level	V _{OH} V _{OL} SLIMCLK and S BVDD1 ≤1.95V V _{IH} V _{IL} V _{OH} V _{OL}	I _{OL} = -1mA SLIMDAT)) I _{OH} = 1mA	-1 0.65 × VDBVDD1 0.9 ×	10	0.2 × V _{SUP} 1 0.35 × V _{DBVDD1} 0.1 × V _{DBVDD1}	V V pF μA V V

Test Conditions

fs ≤ 48kHz

With the exception of the condition(s) noted above, the following electrical characteristics are valid across the full range of recommended operating conditions.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
ADC Decimation Filters						
Passband		+/- 0.05dB	0		0.454 fs	
		-6dB		0.5 fs		
Passband ripple					+/- 0.05	dB
Stopband			0.546 fs			
Stopband attenuation		f > 0.546 fs	85			dB
Signal path delay		Analogue input to Digital AIF output			2	ms
DAC Interpolation Filters						
Passband		+/- 0.05dB	0		0.454 fs	
		-6dB		0.5 fs		
Passband ripple					+/- 0.05	dB
Stopband			0.546 fs			
Stopband attenuation		f > 0.546 fs	85			dB
Signal path delay		Digital AIF input to Analogue output			1.5	ms



Test Conditions

DBVDD1 = DBVDD2 = DBVDD3 = LDOVDD = CPVDD = AVDD = 1.8V,

 $DCVDD = 1.2V \ (powered \ from \ LDO1), \ MICVDD = 3.0V \ (powered \ from \ LDO2), \ SPKVDDL = SPKVDDR = 4.2V,$

 T_A = +25°C, 1kHz sinusoid signal, fs = 48kHz, Input PGA gain = 0dB, 24-bit audio data unless otherwise stated.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Microphone Bias (MICBIAS1, MIC	BIAS2, MICB	IAS3)				
Note - No capacitor on MICBIASn						
Note - In regulator mode, it is require	ed that V _{MICVD}	D - V _{MICBIASn} > 200mV				
Minimum Bias Voltage	V _{MICBIAS}	Regulator mode		1.5		V
Maximum Bias Voltage		(MICBn_BYPASS=0)		2.8		V
Bias Voltage output step size		Load current ≤ 1.0mA		0.1		V
Bias Voltage accuracy			-5%		+5%	V
Bias Current		Regulator mode (MICBn_BYPASS=0),			2.4	mA
		V _{MICVDD} - V _{MICBIAS} >200mV				
		Bypass mode (MICBn_BYPASS=1)			5.0	
Output Noise Density		Regulator mode (MICBn_BYPASS=0), MICBn_LVL = 4h, Load current = 1mA, Measured at 1kHz		50		nV/√Hz
Integrated noise voltage		Regulator mode (MICBn_BYPASS=0), MICBn_LVL = 4h, Load current = 1mA, 100Hz to 7kHz, A-weighted		4		μVrms
Power Supply Rejection Ratio	PSRR	100mV (peak-peak) 217Hz		95		dB
(DBVDDn, LDOVDD, CPVDD, AVDD)		100mV (peak-peak) 10kHz		65		
Load capacitance		Regulator mode (MICBn_BYPASS=0), MICBn_EXT_CAP=0			50	pF
		Regulator mode (MICBn_BYPASS=0), MICBn_EXT_CAP=1	1.8	4.7		μF
Output discharge resistance		MICBn_ENA=0, MICBn_DISCH=1		5		kΩ
External Accessory Detect	I	_		l		
Load impedance detection range (HPDETL or HPDETR)		HP_IMPEDANCE_ RANGE=00	4		80	Ω
(HP_IMPEDANCE_ RANGE=01	70		1000	1
		HP_IMPEDANCE_ RANGE=10	1000		10000	
Load impedance detection accuracy (HPDETL or HPDETR)			-30		+30	%
Load impedance detection range		for MICD_LVL[0] = 1	0		3	Ω
(MICDET1 or MICDET2)		for MICD_LVL[1] = 1	17		21	
$2.2k\Omega$ (2%) MICBIAS resistor.		for MICD_LVL[2] = 1	36		44	1
Note these characteristics assume		for MICD_LVL[3] = 1	62		88	
no other component is connected		for MICD_LVL[4] = 1	115		160	
to MICDETn. See "Applications Information" for recommended		for MICD_LVL[5] = 1	207		381	
external components when a typical microphone is present.		for MICD_LVL[8] = 1	475		30000	
Jack Detection input threshold	V _{JACKDET}	Jack insertion		0.5 x AVDD		V
voltage (JACKDET)		Jack removal		0.85 x AVDD		

Test Conditions

DBVDD1 = DBVDD2 = DBVDD3 = LDOVDD = CPVDD = AVDD = 1.8V,

DCVDD = 1.2V (powered from LDO1), MICVDD = 3.0V (powered from LDO2), SPKVDDL = SPKVDDR = 4.2V,

T_A = +25°C, 1kHz sinusoid signal, fs = 48kHz, Input PGA gain = 0dB, 24-bit audio data unless otherwise stated.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
MICVDD Charge Pump and Regul	ator (CP2 and	I LDO2)				
Output voltage	V_{MICVDD}		1.7	2.7	3.3	V
Programmable output voltage step size				50		mV
Maximum output current				8		mA
Start-up time		4.7 μ F on MICVDD, I _{MICBIASn} = 1mA		4.5		ms
Frequency Locked Loop (FLL1, Fl	LL2)					
Output frequency		Normal operation, input reference supplied	13		52	MHz
		Free-running mode, no reference supplied		30		
Lock Time		$F_{REF} = 32kHz$, $F_{OUT} = 24.576MHz$		10		ms
		$F_{REF} = 12MHz$, $F_{OUT} = 24.576MHz$		1		
RESET pin Input						
RESET input pulse width			1			μs
(To trigger a Hardware Reset, the RESET input must be asserted for longer than this duration)						

Test Conditions

The following electrical characteristics are valid across the full range of recommended operating conditions.

Device Reset Thresholds				
AVDD Reset Threshold	V_{AVDD}	0.50	1.51	V
DCVDD Reset Threshold	V _{DCVDD}	0.59	0.81	V
DBVDD1 Reset Threshold	V_{DBVDD1}	0.50	1.51	V

Note that the reset thresholds are derived from simulations only, across all operational and process corners.

Device performance is not assured outside the voltage ranges defined in the "Recommended Operating Conditions" section. Refer to this section for the WM5102 power-up sequencing requirements.



TERMINOLOGY

1. Signal-to-Noise Ratio (dB) – SNR is a measure of the difference in level between the maximum full scale output signal and the output with no input signal applied. (Note that this is measured without any mute function enabled.)

- 2. Total Harmonic Distortion (dB) THD is the ratio of the RMS sum of the harmonic distortion products in the specified bandwidth (see note below) relative to the RMS amplitude of the fundamental (ie. test frequency) output.
- 3. Total Harmonic Distortion plus Noise (dB) THD+N is the ratio of the RMS sum of the harmonic distortion products plus noise in the specified bandwidth (see note below) relative to the RMS amplitude of the fundamental (ie. test frequency) output.
- 4. Power Supply Rejection Ratio (dB) PSRR is the ratio of a specified power supply variation relative to the output signal that results from it. PSRR is measured under quiescent signal path conditions.
- 5. Common Mode Rejection Ratio (dB) CMRR is the ratio of a specified input signal (applied to both sides of a differential input), relative to the output signal that results from it.
- 6. Channel Separation (L/R) (dB) left-to-right and right-to-left channel separation is the difference in level between the active channel (driven to maximum full scale output) and the measured signal level in the idle channel at the test signal frequency. The active channel is configured and supplied with an appropriate input signal to drive a full scale output, with signal measured at the output of the associated idle channel.
- 7. Multi-Path Crosstalk (dB) is the difference in level between the output of the active path and the measured signal level in the idle path at the test signal frequency. The active path is configured and supplied with an appropriate input signal to drive a full scale output, with signal measured at the output of the specified idle path.
- 8. Mute Attenuation This is a measure of the difference in level between the full scale output signal and the output with mute applied.
- 9. All performance measurements are specified with a 20kHz low pass 'brick-wall' filter and, where noted, an A-weighted filter. Failure to use these filters will result in higher THD and lower SNR readings than are found in the Electrical Characteristics. The low pass filter removes out of band noise.



THERMAL CHARACTERISTICS

Thermal analysis should be performed in the intended application to ensure the WM5102 does not exceed its thermal limits. Several contributing factors affect thermal performance, including the physical properties of the mechanical enclosure, location of the device on the PCB in relation to surrounding components and the number of PCB layers. Connecting the GND balls through thermal vias and into a large ground plane will aid heat extraction.

Three main heat transfer paths exist to surrounding air as illustrated below in Figure 1:

- Package top to air (radiation).
- Package bottom to PCB (radiation).
- Package balls to PCB (conduction).

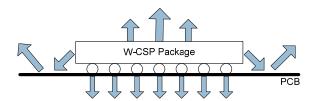


Figure 1 Heat Transfer Paths

The temperature rise T_R is given by $T_R = P_D * \Theta_{JA}$

- P_D is the power dissipated in the device.
- Θ_{JA} is the thermal resistance from the junction of the die to the ambient temperature and is therefore a measure of heat transfer from the die to surrounding air. Θ_{JA} is determined with reference to JEDEC standard JESD51-9.

The junction temperature T_J is given by $T_J = T_A + T_R$, where T_A is the ambient temperature.

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Operating temperature range	T _A	-40		85	°C
Operating junction temperature	T_J	-40		125	°C
Thermal Resistance	Θ_{JA}		25		°C/W

Note: Junction temperature is a function of ambient temperature and of the device operating conditions. The ambient temperature limits and junction temperature limits must both be observed.

TYPICAL PERFORMANCE

TYPICAL POWER CONSUMPTION

Typical power consumption data is provided below for a number of different operating conditions.

Test Conditions:

DBVDD1 = DBVDD2 = DBVDD3 = LDOVDD = CPVDD = AVDD = 1.8V,

SPKVDDL = SPKVDDR = 4.2V,

DCVDD = 1.2V (powered from LDO1), MICVDD = 3.0V (powered from LDO2), T_A = +25°C

OPERATING MODE	TEST CONDITIONS	SUPPLY CURRENT (1.8V)	SUPPLY CURRENT (4.2V)	TOTAL POWER
Music Playback to Headphone				
AIF1 to DAC to HPOUT1 (stereo)	Quiescent	4.8mA	0.0mA	8.6mW
fs=48kHz, 24-bit I2S, Slave mode	1kHz sine wave, Po=10mW	37.7mA	0.0mA	67.9mW
Load = 32Ω				
Music Playback to Line Output				
AIF1 to DAC to HPOUT2 (stereo)	Quiescent	4.4mA	0.0mA	7.9mW
fs=48kHz, 24-bit I2S, Slave mode				
Load = 10kΩ, 50pF				
Music Playback to Earpiece				
AIF1 to DAC to EPOUT (mono)	Quiescent	5.3mA	0.0mA	9.5mW
fs=48kHz, 24-bit I2S, Slave mode	1kHz sine wave, P ₀ =30mW	59.7mA	0.0mA	107.5mW
Load = 32Ω, 22μH, BTL				
Music Playback to Speaker				
AIF1 to DAC to SPKOUT (stereo)	Quiescent	5.5mA	5.8mA	34.3mW
fs=48kHz, 24-bit I2S, Slave mode	1kHz sine wave, Po=700mW	5.6mA	380mA	1606mW
Load = 8Ω, 22μH, BTL				
Full Duplex Voice Call				
Analogue Mic to ADC to AIF1 (out)	Quiescent	6.7mA	0.0mA	12mW
AIF (in) to DAC to EPOUT (mono)				
fs=8kHz, 16-bit I2S, Slave mode				
Low Power mode (INn_OSR=00)				
Load = 32Ω, 22μH, BTL				
Stereo Line Record				
Analogue Line to ADC to AIF1	1kHz sine wave, -1dBFS out	4.2mA	0.0mA	7.6mW
fs=48kHz, 24-bit I2S, Slave mode				
Low Power mode (INn_OSR=00)				
Sleep Mode				
Accessory detect enabled (JD1_ENA=1)		0.015mA	0.0mA	0.03mW



TYPICAL SIGNAL LATENCY

OPERATING MODE		TEST CONDITIONS	S	LATENCY
	INPUT	OUTPUT	DIGITAL CORE	
AIF to DAC Stereo Path				
Digital input (AIFn) to analogue	fs = 48kHz	fs = 48kHz	Synchronous	352µs
output (EPOUT).	fs = 44.1kHz	fs = 44.1kHz	Synchronous	362µs
Signal is routed via the digital	fs = 16kHz	fs = 16kHz	Synchronous	711µs
core ASRC function in the asynchronous test cases only.	fs = 8kHz	fs = 8kHz	Synchronous	3580µs
asynomical test dases only.	fs = 8kHz	fs = 44.1kHz	Asynchronous	3750µs
	fs = 16kHz	fs = 44.1kHz	Asynchronous	848µs
ADC to AIF Stereo Path				
Analogue input (INn) to digital	fs = 48kHz	fs = 48kHz	Synchronous	268µs
output (AIFn).	fs = 44.1kHz	fs = 44.1kHz	Synchronous	292µs
Digital core High Pass filter	fs = 16kHz	fs = 16kHz	Synchronous	894µs
included in signal path.	fs = 8kHz	fs = 8kHz	Synchronous	1730µs
Signal is routed via the digital core ASRC function in the	fs = 44.1kHz	fs = 8kHz	Asynchronous	880µs
asynchronous test cases only.	fs = 44.1kHz	fs = 16kHz	Asynchronous	530µs



SIGNAL TIMING REQUIREMENTS

SYSTEM CLOCK & FREQUENCY LOCKED LOOP (FLL)

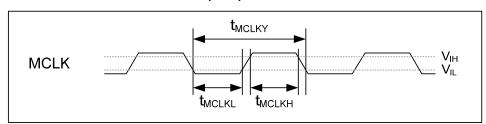


Figure 2 Master Clock Timing

Test Conditions

The following timing information is valid across the full range of recommended operating conditions.

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Master Clock Timing (MCL	K1, MCLK2)				
	MCLK as input to FLL, FLLn_REFCLK_DIV=00	74			ns
MCLK avalatima	MCLK as input to FLL, FLLn_REFCLK_DIV=01	37			
MCLK cycle time	MCLK as input to FLL, FLLn_REFCLK_DIV=10 or 11	25			
	MCLK as direct SYSCLK or ASYNCCLK source	40			
MCLK duty cycle	MCLK as input to FLL	80:20		20:80	%
	MCLK as direct SYSCLK or ASYNCCLK source	60:40		40:60	
MCLK2 frequency	Sleep Mode			32.768	kHz
Frequency Locked Loops (FLL1, FLL2)				
FLL input frequency	FLLn_REFCLK_DIV=00	0.032		13.5	MHz
	FLLn_REFCLK_DIV=01	0.064		27	
	FLLn_REFCLK_DIV=10	0.128		40	
	FLLn_REFCLK_DIV=11	0.256		40	
FLL synchroniser input	FLLn_SYNCCLK_DIV=00	0.032		13.5	MHz
frequency	FLLn_SYNCCLK_DIV=01	0.064		27	
	FLLn_SYNCCLK_DIV=10	0.128		40	
	FLLn_SYNCCLK_DIV=11	0.256		40	



Test Conditions

The following timing information is valid across the full range of recommended operating conditions.

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Internal Clocking	•				
SYSCLK frequency	SYSCLK_FREQ=000, SYSCLK_FRAC=0	-1%	6.144	+1%	MHz
	SYSCLK_FREQ=000, SYSCLK_FRAC=1	-1%	5.6448	+1%	
	SYSCLK_FREQ=001, SYSCLK_FRAC=0	-1%	12.288	+1%	
	SYSCLK_FREQ=001, SYSCLK_FRAC=1	-1%	11.2896	+1%	
	SYSCLK_FREQ=010, SYSCLK_FRAC=0	-1%	24.576	+1%	
	SYSCLK_FREQ=010, SYSCLK_FRAC=1	-1%	22.5792	+1%	
	SYSCLK_FREQ=011, SYSCLK_FRAC=0	-1%	49.152	+1%	
	SYSCLK_FREQ=011, SYSCLK_FRAC=1	-1%	45.1584	+1%	
ASYNCCLK frequency	ASYNC_CLK_FREQ=000	-1%	6.144	+1%	MHz
		-1%	5.6448	+1%	
	ASYNC_CLK_FREQ=001	-1%	12.288	+1%	
		-1%	11.2896	+1%	
	ASYNC_CLK_FREQ=010	-1%	24.576	+1%	
		-1%	22.5792	+1%	
	ASYNC_CLK_FREQ=011	-1%	49.152	+1%	
		-1%	45.1584	+1%	

Note:

When MCLK1 or MCLK2 is selected as a source for SYSCLK or ASYNCCLK (either directly or via one of the FLLs), the frequency must be within 1% of the applicable SYSCLK_FREQ or ASYNCCLK_FREQ register setting.



AUDIO INTERFACE TIMING

DIGITAL MICROPHONE (DMIC) INTERFACE TIMING

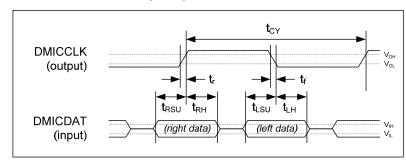


Figure 3 Digital Microphone Interface Timing

Test Conditions

The following timing information is valid across the full range of recommended operating conditions.

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Digital Microphone Interface Timing					
DMICCLKn cycle time	t _{CY}	320	326	716	ns
DMICCLKn duty cycle		45		55	%
DMICCLKn rise/fall time (25pF load, 1.8V supply - see note)	t _r , t _f	5		30	ns
DMICDATn (Left) setup time to falling DMICCLK edge	t _{LSU}	15			ns
DMICDATn (Left) hold time from falling DMICCLK edge	t _{LH}	0			ns
DMICDATn (Right) setup time to rising DMICCLK edge	t _{RSU}	15			ns
DMICDATn (Right) hold time from rising DMICCLK edge	t _{RH}	0			ns

Notes:

DMICDATn and DMICCLKn are each referenced to a selectable supply, V_{SUP} .

The applicable supply is selected using the INn_DMIC_SUP registers.



DIGITAL SPEAKER (PDM) INTERFACE TIMING

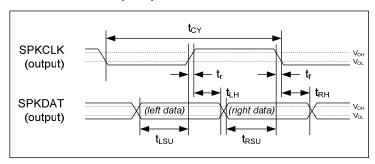


Figure 4 Digital Speaker (PDM) Interface Timing - Mode A

Test Conditions

The following timing information is valid across the full range of recommended operating conditions.

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
PDM Audio Interface Timing					
SPKCLK cycle time	t _{CY}	160	163	358	ns
SPKCLK duty cycle		45		55	%
SPKCLK rise/fall time (DBVDD=1.8V, 25pF load)	t _r , t _f	5		30	ns
SPKDAT set-up time to SPKCLKn rising edge (Left channel)	t _{LSU}	30			ns
SPKDAT hold time from SPKCLKn rising edge (Left channel)	t _{LH}	30			ns
SPKDAT set-up time to SPKCLKn falling edge (Right channel)	t _{RSU}	30			ns
SPKDAT hold time from SPKCLKn falling edge (Right channel)	t _{RH}	30			ns

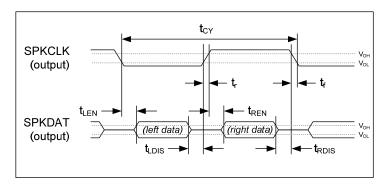


Figure 5 Digital Speaker (PDM) Interface Timing - Mode B

Test Conditions

The following timing information is valid across the full range of recommended operating conditions.

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
PDM Audio Interface Timing					
SPKCLK cycle time	t _{CY}	160	163	358	ns
SPKCLK duty cycle		45		55	%
SPKCLK rise/fall time (DBVDD=1.8V, 25pF load)	t _r , t _f	5		30	ns
SPKDAT enable from SPKCLK rising edge (Right channel)	t _{REN}			15	ns
SPKDAT disable to SPKCLK falling edge (Right channel)	t _{RDIS}			5	ns
SPKDAT enable from SPKCLK falling edge (Left channel)	t _{LEN}			15	ns
SPKDAT disable to SPKCLK rising edge (Left channel)	t _{LDIS}			5	ns



DIGITAL AUDIO INTERFACE - MASTER MODE

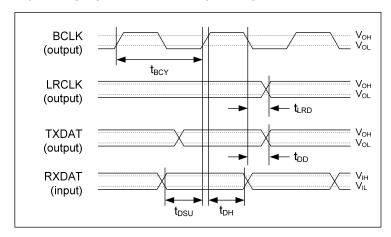


Figure 6 Audio Interface Timing - Master Mode

Note that BCLK and LRCLK outputs can be inverted if required; Figure 6 shows the default, non-inverted polarity.

Test Conditions

The following timing information is valid across the full range of recommended operating conditions.

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Audio Interface Timing - Master Mode					
AIFnBCLK cycle time	t _{BCY}	80			ns
AIFn[TX/RX]LRCLK propagation delay from BCLK falling edge	t_{LRD}	0		12	ns
AIFnTXDAT propagation delay from BCLK falling edge	t _{DD}	0		12	ns
AIFnRXDAT setup time to BCLK rising edge	t _{DSU}	7			ns
AIFnRXDAT hold time from BCLK rising edge	t _{DH}	5			ns

Note:

The descriptions above assume non-inverted polarity of AIFnBCLK and AIFn[TX/RX]LRCLK.

DIGITAL AUDIO INTERFACE - SLAVE MODE

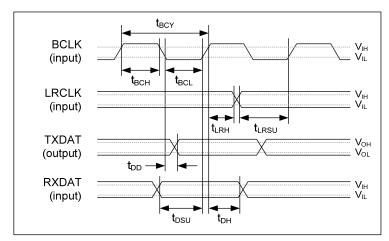


Figure 7 Audio Interface Timing - Slave Mode

Note that BCLK and LRCLK inputs can be inverted if required; Figure 7 shows the default, non-inverted polarity.

Test Conditions

The following timing information is valid across the full range of recommended operating conditions.

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Audio Interface Timing - Slave Mode					
AIFnBCLK cycle time	t _{BCY}	80			ns
AIFnBCLK pulse width high	t _{BCH}	12			ns
AIFnBCLK pulse width low	t _{BCL}	12			ns
AIFn[TX/RX]LRCLK set-up time to BCLK rising edge	t _{LRSU}	7			ns
AIFn[TX/RX]LRCLK hold time from BCLK rising edge	t_{LRH}	5			ns
AIFnRXDAT hold time from BCLK rising edge	t _{DH}	5			ns
AIFnTXDAT propagation delay from BCLK falling edge	t _{DD}	0		12	ns
AIFnRXDAT set-up time to BCLK rising edge	t _{DSU}	7			ns

Notes:

The descriptions above assume non-inverted polarity of AIFnBCLK.

When AIFnBCLK is selected as a source for SYSCLK or ASYNCCLK (either directly or via one of the FLLs), the frequency must be within 1% of the applicable SYSCLK_FREQ or ASYNCCLK_FREQ register setting.

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DIGITAL AUDIO INTERFACE - TDM MODE

When TDM operation is used on the AIFnTXDAT pins, it is important that two devices do not attempt to drive the AIFnTXDAT pin simultaneously. To support this requirement, the AIFnTXDAT pins can be configured to be tri-stated when not outputting data.

The timing of the AIFnTXDAT tri-stating at the start and end of the data transmission is described in Figure 8 below.

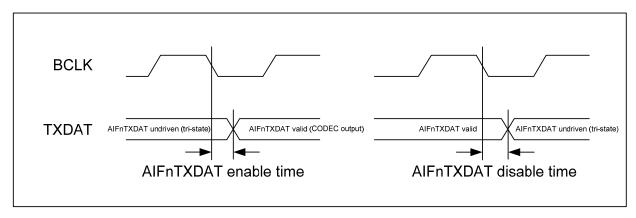


Figure 8 Audio Interface Timing - TDM Mode

Test Conditions

The following timing information is valid across the full range of recommended operating conditions.

PARAMETER	MIN	TYP	MAX	UNIT
TDM Timing - Master Mode				
AIFnTXDAT enable time from BCLK falling edge	0			ns
AIFnTXDAT disable time from BCLK falling edge			15	ns
TDM Timing - Slave Mode				
AIFnTXDAT enable time from BCLK falling edge	5			ns
AIFnTXDAT disable time from BCLK falling edge			32	ns

CONTROL INTERFACE TIMING

2-WIRE (I2C) CONTROL MODE

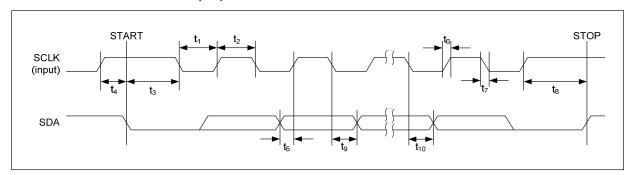


Figure 9 Control Interface Timing - 2-wire (I2C) Control Mode

Test Conditions

The following timing information is valid across the full range of recommended operating conditions.

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
SCLK Frequency				1000	kHz
SCLK Low Pulse-Width	t ₁	500			ns
SCLK High Pulse-Width	t_2	260			ns
Hold Time (Start Condition)	t ₃	260			ns
Setup Time (Start Condition)	t_4	260			ns
SDA, SCLK Rise Time	t ₆			120	ns
SDA, SCLK Fall Time	t ₇			120	ns
Setup Time (Stop Condition)	t ₈	260			ns
SDA Setup Time (data input)	t ₅	50			ns
SDA Hold Time (data input)	t ₉	0			ns
SDA Valid Time (data/ACK output)	t ₁₀			450	ns
Pulse width of spikes that will be suppressed	t _{ps}	0		50	ns

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4-WIRE (SPI) CONTROL MODE

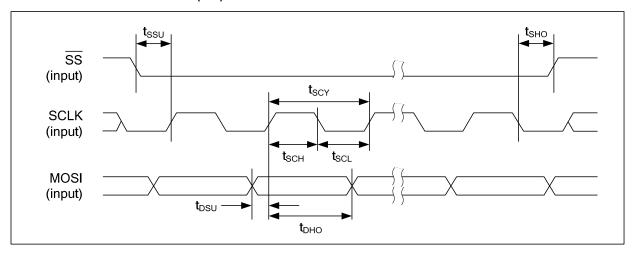


Figure 10 Control Interface Timing - 4-wire (SPI) Control Mode (Write Cycle)

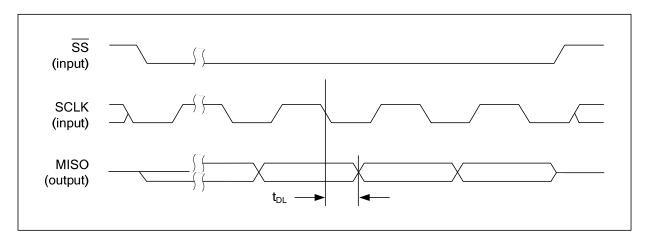


Figure 11 Control Interface Timing - 4-wire (SPI) Control Mode (Read Cycle)

Test Conditions

The following timing information is valid across the full range of recommended operating conditions.

PAF	SYMBOL	MIN	TYP	MAX	UNIT	
SS falling edge to SCLK risin	g edge	t _{ssu}	2.6			ns
SCLK falling edge to SS risin	CLK falling edge to SS rising edge					ns
SCLK pulse cycle time	SYSCLK disabled (SYSCLK_ENA=0)	t _{scy}	38.4			ns
	SYSCLK_ENA=1 and SYSCLK_FREQ = 000		76.8			
	SYSCLK_ENA=1 and SYSCLK_FREQ > 000		38.4			
SCLK pulse width low		t _{scl}	15.3			ns
SCLK pulse width high		t _{SCH}	15.3			ns
MOSI to SCLK set-up time		t _{DSU}	1.3			ns
MOSI to SCLK hold time		t _{DHO}	1.7			ns
SCLK falling edge to MISO transition		t _{DL}	0		7.8	ns

SLIMBUS INTERFACE TIMING

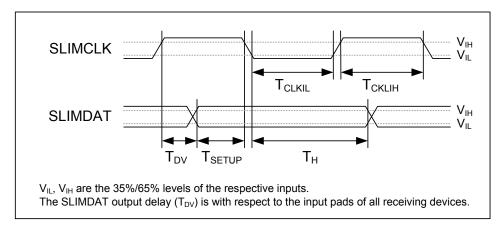


Figure 12 SLIMbus Interface Timing

The signal timing information shown in Figure 12 describe the timing requirements of the SLIMbus interface as a whole, not just the WM5102 device. Accordingly, the following should be noted:

- T_{DV} is the propagation delay from the rising SLIMCLK edge (at WM5102 input) to the SLIMDAT output being achieved at the input to all devices across the bus.
- T_{SETUP} is the set-up time for SLIMDAT input (at WM5102), relative to the falling SLIMCLK edge (at WM5102).
- T_H is the hold time for SLIMDAT input (at WM5102) relative to the falling SLIMCLK edge (at WM5102).

For more details of the interface timing, refer to the MIPI Alliance Specification for Serial Low-power Inter-chip Media Bus (SLIMbus).

Test Conditions

The following timing information is valid across the full range of recommended operating conditions, unless otherwise noted.

F	SYMBOL	MIN	TYP	MAX	UNIT	
SLIMCLK Input						
SLIMCLK cycle time			35			ns
SLIMCLK pulse width high	l	T _{CLKIH}	13			ns
SLIMCLK pulse width low		T _{CLKIL}	13			ns
SLIMCLK Output						
SLIMCLK cycle time			40			ns
SLIMCLK slew rate (20% to 80%)	C _{LOAD} = 15pF	SR _{CLK}	0.09 x V _{DBVDD1}		0.23 x V _{DBVDD1}	V/ns
,	C _{LOAD} = 35pF		0.05 x V _{DBVDD1}		0.13 x V _{DBVDD1}	
SLIMDAT Input						
SLIMDAT setup time to SI	IMCLK falling edge	T _{SETUP}	3.5			ns
SLIMDAT hold time from S	SLIMDAT hold time from SLIMCLK falling edge		2			ns

Test Conditions

The following timing information is valid across the full range of recommended operating conditions, unless otherwise noted.

PARA	SYMBOL	MIN	TYP	MAX	UNIT		
SLIMDAT Output							
SLIMDAT time for data output valid (wrt SLIMCLK	C _{LOAD} = 15pF, V _{DBVDD1} = 1.62V	T _{DV}		6.7	8.6	ns	
rising edge)	C_{LOAD} = 35pF, V_{DBVDD1} = 1.62V			9.8	12.5		
SLIMDAT slew rate (20% to 80%)	C _{LOAD} = 15pF	SR _{DATA}			0.54 x V _{DBVDD1}	V/ns	
	C _{LOAD} = 35pF				0.34 x V _{DBVDD1}		
Other Parameters							
Driver disable time		T_DD			6	ns	
Bus holder output impedance	0.1 x V _{DBVDD1} < V < 0.9 x V _{DBVDD1}	R _{DATAS}	18		50	kΩ	



Production Data

DEVICE DESCRIPTION

INTRODUCTION

The WM5102 is a highly integrated low-power audio hub CODEC for mobile telephony and portable devices. It provides flexible, high-performance audio interfacing for handheld devices in a small and cost-effective package. It provides wideband voice processing for mobile telephony, ideally suited for multimedia phones and smartphones.

The WM5102 digital core provides an extensive capability for signal processing algorithms, including echo cancellation, wind noise, side-tone and other programmable filters. Parametric equalisation (EQ) and dynamic range control (DRC) are also supported. Highly flexible digital mixing, including stereo full-duplex asynchronous sample rate conversion, provides use-case flexibility across a broad range of system architectures. A signal generator for controlling haptics vibe actuators is included.

The WM5102 provides multiple digital audio interfaces, including SLIMbus, in order to provide independent and fully asynchronous connections to different processors (eg. application processor, baseband processor and wireless transceiver).

A flexible clocking arrangement supports a wide variety of external clock references, including clocking derived from the digital audio interface. Two integrated Frequency Locked Loop (FLL) circuits provide additional flexibility.

Unused circuitry can be disabled under software control, in order to save power; low leakage currents enable extended standby/off time in portable battery-powered applications. Configurable 'Wake-Up' actions can be associated with the low-power standby (Sleep) mode.

Versatile GPIO functionality is provided, and support for external accessory / push-button detection inputs. Comprehensive Interrupt (IRQ) logic and status readback are also provided.

HI-FI AUDIO CODEC

The WM5102 is a high-performance low-power audio CODEC which uses a simple analogue architecture. 6 ADCs and 7 DACs are incorporated, providing a dedicated ADC for each input and a dedicated DAC for each output channel.

The analogue outputs comprise two 29mW (113dB SNR) stereo headphone amplifiers with ground-referenced output, a 100mW differential (BTL) earpiece driver, and a Class D stereo speaker driver capable of delivering 2W per channel into a 4Ω load. Six analogue inputs are provided, each supporting single-ended or differential input modes. In differential mode, the input path SNR is 96dB. The ADC input paths can be bypassed, supporting up to 6 channels of digital microphone input.

The audio CODEC is controlled directly via register access. The simple analogue architecture, combined with the integrated tone generator, enables simple device configuration and testing, minimising debug time and reducing software effort.

The WM5102 output drivers are designed to support as many different system architectures as possible. Each output has a dedicated DAC which allows mixing, equalisation, filtering, gain and other audio processing to be configured independently for each channel. This allows each signal path to be individually tailored for the load characteristics. All outputs have integrated pop and click suppression features.

The headphone output drivers are ground-referenced, powered from an integrated charge pump, enabling high quality, power efficient headphone playback without any requirement for DC blocking capacitors. Ground loop feedback is incorporated, providing rejection of noise on the ground connections. A mono mode is available on the headphone outputs; this configures the drivers as differential (BTL) outputs, suitable for an earpiece or hearing aid coil.

The Class D speaker drivers deliver excellent power efficiency. High PSRR, low leakage and optimised supply voltage ranges enable powering from switching regulators or directly from the battery. Battery current consumption is minimised across a wide variety of voice communication and multimedia playback use cases.



The WM5102 is cost-optimised for a wide range of mobile phone applications, and features two channels of Class D power amplification. For applications requiring more than two channels of power amplification (or when using the integrated Class D path to drive a haptics actuator), the PDM output channels can be used to drive two external PDM-input speaker drivers. In applications where stereo loudspeakers are physically widely separated, the PDM outputs can ease layout and EMC by avoiding the need to run the Class-D speaker outputs over long distances and interconnects.

DIGITAL AUDIO CORE

The WM5102 uses a core architecture based on all-digital signal routing, making digital audio effects available on all signal paths, regardless of whether the source data input is analogue or digital. The digital mixing desk allows different audio effects to be applied simultaneously on many independent paths, whilst also supporting a variety of sample rates concurrently. This helps support many new audio use-cases. Soft mute and un-mute control allows smooth transitions between use-cases without interrupting existing audio streams elsewhere.

The WM5102 digital core provides an extensive capability for programmable signal processing algorithms. The DSP can support functions such as echo cancellation, wind noise, side-tone and other programmable filters. The DSP is optimised for advanced voice processing, but a wide range of application-specific filters and audio enhancements can also be implemented.

Highly flexible digital mixing, including mixing between audio interfaces, is possible. The WM5102 performs stereo full-duplex asynchronous sample rate conversion, providing use-case flexibility across a broad range of system architectures. Automatic sample rate detection is provided, enabling seamless wideband/narrowband voice call handover.

Dynamic Range Controller (DRC) functions are available for optimising audio signal levels. In playback modes, the DRC can be used to maximise loudness, while limiting the signal level to avoid distortion, clipping or battery droop, in particular for high-power output drivers such as speaker amplifiers. In record modes, the DRC assists in applications where the signal level is unpredictable.

The 5-band parametric equaliser (EQ) functions can be used to compensate for the frequency characteristics of the output transducers. EQ functions can be cascaded to provide additional frequency control. Programmable high-pass and low-pass filters are also available for general filtering applications such as removal of wind and other low-frequency noise.

DIGITAL INTERFACES

Three serial digital audio interfaces (AIFs) each support PCM, TDM and I2S data formats for compatibility with most industry-standard chipsets. AIF1 supports eight input/output channels; AIF2 and AIF3 each support two input/output channels. Bidirectional operation at sample rates up to 192kHz is supported.

Six digital PDM input channels are available (three stereo interfaces); these are typically used for digital microphones, powered from the integrated MICBIAS power supply regulators. Two PDM output channels are also available (one stereo interface); these are typically used for external power amplifiers. Embedded mute codes provide a control mechanism for external PDM-input devices.

The WM5102 features a MIPI-compliant SLIMbus interface, providing eight channels of audio input/output. Mixed audio sample rates are supported on the SLIMbus interface. The SLIMbus interface also supports read/write access to the WM5102 control registers.

The WM5102 is equipped with an I2C slave port (at up to 1MHz), and an SPI port (at up to 26MHz). Full access to the register map is also provided via the SLIMbus port.



OTHER FEATURES

The WM5102 incorporates two 1kHz tone generators which can be used for 'beep' functions through any of the audio signal paths. The phase relationship between the two generators is configurable, providing flexibility in creating differential signals, or for test scenarios.

A white noise generator is provided, which can be routed within the digital core. The noise generator can provide 'comfort noise' in cases where silence (digital mute) is not desirable.

Two Pulse Width Modulation (PWM) signal generators are incorporated. The duty cycle of each PWM signal can be modulated by an audio source, or can be set to a fixed value using a control register setting. The PWM signal generators can be output directly on a GPIO pin.

The WM5102 provides 5 GPIO pins, supporting selectable input/output functions for interfacing, detection of external hardware, and to provide logic outputs to other devices. Comprehensive Interrupt (IRQ) functionality is also provided for monitoring internal and external event conditions.

A signal generator for controlling haptics devices is included, compatible with both Eccentric Rotating Mass (ERM) and Linear Resonant Actuator (LRA) haptic devices. The haptics signal generator is highly configurable, and can execute programmable drive event profiles, including reverse drive control. An external vibe actuator can be driven directly by the Class D speaker output.

The WM5102 can be powered from a 1.8V external supply. A separate supply (4.2V) is typically required for the Class D speaker driver. Integrated Charge Pump and LDO Regulators circuits are used to generate supply rails for internal functions and to support powering or biasing of external microphones.

A smart accessory interface is included, supporting most standard 3.5mm accessories. Jack detection, accessory sensing and impedance measurement is provided, for external accessory and push-button detection. Accessory detection can be used as a 'Wake-Up' trigger from low-power standby. Microphone activity detection with interrupt is also available.

System clocking can be derived from the MCLK1 or MCLK2 input pins. Alternatively, the SLIMbus interface, or the audio interfaces (configured in Slave mode), can be used to provide a clock reference. Two integrated Frequency Locked Loop (FLL) circuits provide support for a wide range of clocking configurations, including the use of a 32kHz input clock reference.



WM5102 Production Data

INPUT SIGNAL PATH

The WM5102 has six highly flexible input channels, configurable in a large number of combinations. Each of the six input channels supports analogue (mic or line) and digital input configurations.

The analogue input paths support single-ended and differential modes, programmable gain control and are digitised using a high performance 24-bit sigma-delta ADC.

The digital input paths interface directly with external digital microphones; a separate microphone interface clock is provided for 3 separate stereo pairs of digital microphones. Digital delay can be applied to any of the digital input paths; this can be used for phase adjustment of any digital input, including directional control of multiple microphones.

Three microphone bias (MICBIAS) generators are available, which provide a low noise reference for biasing electret condenser microphones (ECMs) or for use as a low noise supply for MEMS microphones and digital microphones.

Digital volume control is available on all inputs (analogue and digital), with programmable ramp control for smooth, glitch-free operation.

The IN1L and IN1R input signal paths and control registers are illustrated in Figure 13. The IN2 and IN3 signal paths are equivalent to the IN1 signal path.

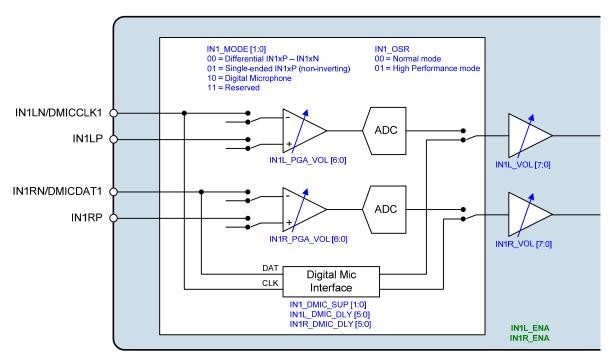


Figure 13 Input Signal Paths

ANALOGUE MICROPHONE INPUT

Up to six analogue microphones can be connected to the WM5102, either in single-ended or differential mode. The applicable mode is selected using the INn_MODE registers, as described later. Note that the mode is configurable for each stereo pair of inputs; the Left and Right channels of any pair of inputs are always in the same mode.

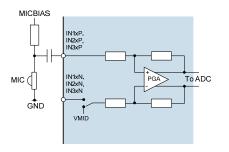
The WM5102 includes external accessory detection circuits, which can detect the presence of a microphone, and the status of a hookswitch or other push-buttons. When using this function, it is recommended to use one of the Right channel analogue microphone input paths, to ensure best immunity to electrical transients arising from the push-buttons.

For single-ended input, the microphone signal is connected to the non-inverting input of the PGAs (INnLP or INnRP). The inverting inputs of the PGAs are connected to an internal reference in this configuration.

For differential input, the non-inverted microphone signal is connected to the non-inverting input of the PGAs (INnLP or INnRP), whilst the inverted (or 'noisy ground') signal is connected to the inverting input pins (INnLN or INnRN).

The gain of the input PGAs is controlled via register settings, as defined in Table 4. Note that the input impedance of the analogue input paths is fixed across all PGA gain settings.

The Electret Condenser Microphone (ECM) analogue input configurations are illustrated in Figure 14 and Figure 15. The integrated MICBIAS generators provide a low noise reference for biasing the ECMs.



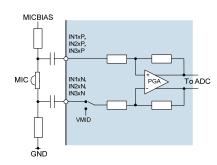


Figure 14 Single-Ended ECM Input

Figure 15 Differential ECM Input

Analogue MEMS microphones can be connected to the WM5102 in a similar manner to the ECM configurations described above; typical configurations are illustrated in Figure 16 and Figure 17. In this configuration, the integrated MICBIAS generators provide a low-noise power supply for the microphones.

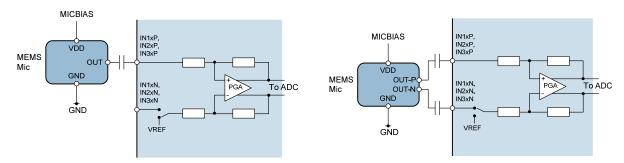


Figure 16 Single-Ended MEMS Input

Figure 17 Differential MEMS Input

Note that the MICVDD pin can also be used (instead of MICBIASn) as a reference or power supply for external microphones. The MICBIAS outputs are recommended, as these offer better noise performance and independent enable/disable control.



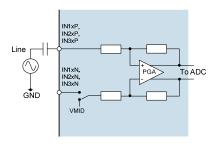
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ANALOGUE LINE INPUT

Line inputs can be connected to the WM5102 in a similar manner to the microphone inputs described above. Single-ended and differential modes are supported on each of the six input paths.

The applicable mode (single-ended or differential) is selected using the INn_MODE registers, as described later. Note that the mode is configurable for each stereo pair of inputs; the Left and Right channels of any pair of inputs are always in the same mode.

The analogue line input configurations are illustrated in Figure 18 and Figure 19. Note that the microphone bias (MICBIAS) is not used for line input connections.



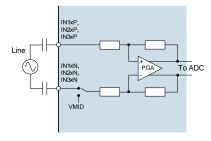


Figure 18 Single-Ended Line Input

Figure 19 Differential Line Input

DIGITAL MICROPHONE INPUT

Up to six digital microphones can be connected to the WM5102. The digital microphone mode is selected using the INn_MODE registers, as described later. Note that the mode is configurable for each stereo pair of inputs; the Left and Right channels of any pair of inputs are always in the same mode.

In digital microphone mode, two channels of audio data are multiplexed on the DMICDAT1, DMICDAT2 or DMICDAT3 pins. Each of these stereo interfaces is clocked using the respective DMICCLK1, DMICCLK2 or DMICCLK3 pin.

When digital microphone input is enabled, the WM5102 outputs a clock signal on the applicable DMICCLKn pin(s). The DMICCLKn frequency is controlled by the respective INn_OSR register, as described in Table 1. See Table 3 for details of the INn_OSR registers.

Note that the DMICCLKn frequencies noted in Table 1 assume that the SYSCLK frequency is a multiple of 6.144MHz (SYSCLK_FRAC=0). If the SYSCLK frequency is a multiple of 5.6448MHz (SYSCLK_FRAC=1), then the DMICCLKn frequencies will be scaled accordingly.

CONDITION	DMICCLKn FREQUENCY
IN <i>n</i> _OSR = 00	1.536MHz
IN <i>n</i> _OSR = 01	3.072MHz

Table 1 DMICCLK Frequency

The voltage reference for each digital microphone interface is selectable, using the INn_DMIC_SUP registers. Each interface may be referenced to MICVDD, or to the MICBIAS1, MICBIAS2 or MICBIAS3 levels.

A pair of digital microphones is connected as illustrated in Figure 20. The microphones must be configured to ensure that the Left mic transmits a data bit when DMICCLK is high, and the Right mic transmits a data bit when DMICCLK is low. The WM5102 samples the digital microphone data at the end of each DMICCLK phase. Each microphone must tri-state its data output when the other microphone is transmitting.

Note that the WM5102 provides integrated pull-down resistors on the DMICDAT1, DMICDAT2 and DMICDAT3 pins. This provides a flexible capability for interfacing with other devices.



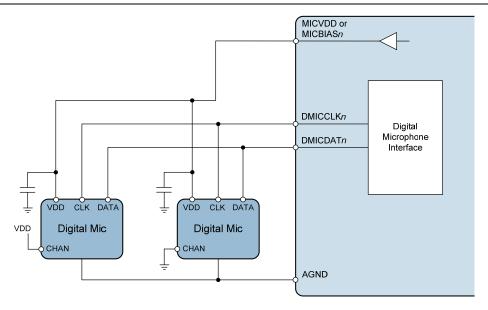


Figure 20 Digital Microphone Input

Two digital microphone channels are interleaved on DMICDAT*n*. The digital microphone interface timing is illustrated in Figure 21. Each microphone must tri-state its data output when the other microphone is transmitting.

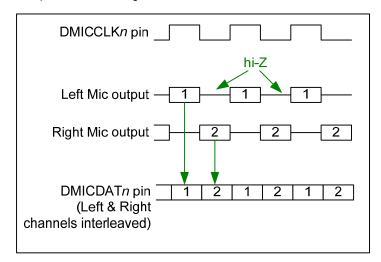


Figure 21 Digital Microphone Interface Timing

When digital microphone input is enabled, the WM5102 outputs a clock signal on the applicable DMICCLK pin(s). The DMICCLK frequency is selectable, as described in Table 1.

Note that SYSCLK must be present and enabled when using the Digital Microphone inputs; see "Clocking and Sample Rates" for details of SYSCLK and the associated register control fields.

INPUT SIGNAL PATH ENABLE

The input signal paths are enabled using the register bits described in Table 2. The respective bit(s) must be enabled for analogue or digital input on the respective input path(s).

The input signal paths are muted by default. It is recommended that de-selecting the mute should be the final step of the path enable control sequence. Similarly, the mute should be selected as the first step of the path disable control sequence. The input signal path mute functions are controlled using the register bits described in Table 4.

The MICVDD power domain must be enabled when using the analogue input signal path(s). This power domain is provided using an internal Charge Pump (CP2) and LDO Regulator (LDO2). See "Charge Pumps, Regulators and Voltage Reference" for details of these circuits.

The system clock, SYSCLK, must be configured and enabled before any audio path is enabled. The ASYNCCLK and 32kHz clock may also be required, depending on the path configuration. See "Clocking and Sample Rates" for details of the system clocks.

The WM5102 performs automatic checks to confirm that the SYSCLK frequency is high enough to support the input signal paths and associated ADCs. If an attempt is made to enable an input signal path, and there are insufficient SYSCLK cycles to support it, then the attempt will be unsuccessful. (Note that any signal paths that are already active will not be affected under these circumstances.)

The Underclocked Error condition can be monitored using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.

The status bits in Register R769 indicate the status of each of the input signal paths. If an Underclocked Error condition occurs, then these bits provide readback of which input signal path(s) have been successfully enabled.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R768	5	IN3L_ENA	0	Input Path 3 (Left) Enable
(0300h)				0 = Disabled
Input				1 = Enabled
Enables	4	IN3R_ENA	0	Input Path 3 (Right) Enable
				0 = Disabled
				1 = Enabled
	3	IN2L_ENA	0	Input Path 2 (Left) Enable
				0 = Disabled
				1 = Enabled
	2	IN2R_ENA	0	Input Path 2 (Right) Enable
				0 = Disabled
				1 = Enabled
	1	IN1L_ENA	0	Input Path 1 (Left) Enable
				0 = Disabled
				1 = Enabled
	0	IN1R_ENA	0	Input Path 1 (Right) Enable
				0 = Disabled
				1 = Enabled
R769	5	IN3L_ENA_STS	0	Input Path 3 (Left) Enable Status
(0301h)				0 = Disabled
Input Enables				1 = Enabled
Status	4	IN3R_ENA_STS	0	Input Path 3 (Right) Enable Status
Ciaido				0 = Disabled
				1 = Enabled
	3	IN2L_ENA_STS	0	Input Path 2 (Left) Enable Status
				0 = Disabled
				1 = Enabled



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	2	IN2R_ENA_STS	0	Input Path 2 (Right) Enable Status
				0 = Disabled
				1 = Enabled
	1	IN1L_ENA_STS	0	Input Path 1 (Left) Enable Status
				0 = Disabled
				1 = Enabled
	0	IN1R_ENA_STS	0	Input Path 1 (Right) Enable Status
				0 = Disabled
				1 = Enabled

Table 2 Input Signal Path Enable

INPUT SIGNAL PATH SAMPLE RATE CONTROL

The input signal paths may be selected as input to the digital mixers or signal processing functions within the WM5102 digital core. The sample rate for the input signal paths is configured using the IN RATE register - see Table 21 within the "Digital Core" section.

Note that sample rate conversion is required when routing the input signal paths to any signal chain that is asynchronous and/or configured for a different sample rate.

INPUT SIGNAL PATH CONFIGURATION

The WM5102 supports six input signal paths. Each pair of inputs can be configured as single-ended, differential, or digital microphone configuration. Note that the mode is configurable for each stereo pair of inputs; the Left and Right channels of any pair of inputs are always in the same mode.

The input signal path configuration is selected using the INn_MODE registers (where 'n' identifies the associated input). The external circuit configurations are illustrated on the previous pages.

The analogue input signal paths (single-ended or differential) each incorporate a PGA to provide gain in the range 0dB to +31dB in 1dB steps. Note that these PGAs do not provide pop suppression functions; it is recommended that the gain should not be adjusted whilst the respective signal path is enabled.

The analogue input PGA gain is controlled using the IN*n*L_PGA_VOL and IN*n*R_PGA_VOL registers. Note that separate volume control is provided for the Left and Right channels of each stereo pair.

When the input signal path is configured for digital microphone input, the voltage reference for the associated input/output pins is selectable using the INn_DMIC_SUP registers - each interface may be referenced to MICVDD, or to the MICBIAS1, MICBIAS2 or MICBIAS3 levels.

A digital delay may be applied to any of the digital microphone input channels. This feature can be used for phase adjustment of any digital input, including directional control of multiple microphones. The delay is controlled using the INnL_DMIC_DLY and INnR_DMIC_DLY registers.

The MICVDD voltage is generated by an internal Charge Pump and LDO Regulator. The MICBIAS1, MICBIAS2 and MICBIAS3 outputs are derived from MICVDD - see "Charge Pumps, Regulators and Voltage Reference".

Under default register conditions, the input signal paths are configured for highest performance. This can be adjusted using the INn_OSR registers, which provide control of the DMICCLKn frequency and the ADC oversample rate.

The input signal paths are configured using the register bits described in Table 3.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R784 (0310h) IN1L Control	14:13	IN1_OSR [1:0]	01	Input Path 1 Oversample Rate When analogue input is selected (IN1_MODE=0X), this bit controls the performance mode 00 = Low Power mode 01 = High Performance mode 1X = Reserved
				When digital microphone input is selected (IN1_MODE=10), this bit controls the sample rate as below: 00 = 1.536MHz 01 = 3.072MHz 1X = Reserved
	12:11	IN1_DMIC_SUP [1:0]	00	Input Path 1 DMIC Reference Select (Sets the DMICDAT1 and DMICCLK1 logic levels) 00 = MICVDD 01 = MICBIAS1 10 = MICBIAS2 11 = MICBIAS3
	10:9	IN1_MODE [1:0]	00	Input Path 1 Mode 00 = Differential (IN1xP - IN1xN) 01 = Single-ended (IN1xP) 10 = Digital Microphone 11 = Reserved
	7:1	IN1L_PGA_VOL [6:0]	40h	Input Path 1 (Left) PGA Volume (Applicable to analogue inputs only) 00h to 3Fh = Reserved 40h = 0dB 41h = 1dB 42h = 2dB (1dB steps) 5F = 31dB 60h to 7Fh = Reserved
R786 (0312h) DMIC1L Control	5:0	IN1L_DMIC_DLY [5:0]	00h	Input Path 1 (Left) Digital Delay (Applicable to digital input only) LSB = 1 sample, Range is 0 to 63. (Sample rate is controlled by IN1_OSR.)
R788 (0314h) IN1R Control	7:1	IN1R_PGA_VOL [6:0]	40h	Input Path 1 (Right) PGA Volume (Applicable to analogue inputs only) 00h to 3Fh = Reserved 40h = 0dB 41h = 1dB 42h = 2dB (1dB steps) 5F = 31dB 60h to 7Fh = Reserved
R790 (0316h) DMIC1R Control	5:0	IN1R_DMIC_DLY [5:0]	00h	Input Path 1 (Right) Digital Delay (Applicable to digital input only) LSB = 1 sample, Range is 0 to 63. (Sample rate is controlled by IN1_OSR.)



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R792 (0318h) IN2L Control	14:13	IN2_OSR [1:0]	01	Input Path 2 Oversample Rate When analogue input is selected (IN2_MODE=0X), this bit controls the performance mode 00 = Low Power mode 01 = High Performance mode 1X = Reserved
				When digital microphone input is selected (IN2_MODE=10), this bit controls the sample rate as below: 00 = 1.536MHz 01 = 3.072MHz 1X = Reserved
	12:11	IN2_DMIC_SUP [1:0]	00	Input Path 2 DMIC Reference Select (Sets the DMICDAT2 and DMICCLK2 logic levels) 00 = MICVDD 01 = MICBIAS1 10 = MICBIAS2 11 = MICBIAS3
	10:9	IN2_MODE [1:0]	00	Input Path 2 Mode 00 = Differential (IN2xP - IN2xN) 01 = Single-ended (IN2xP) 10 = Digital Microphone 11 = Reserved
	7:1	IN2L_PGA_VOL [6:0]	40h	Input Path 2 (Left) PGA Volume (Applicable to analogue inputs only) 00h to 3Fh = Reserved 40h = 0dB 41h = 1dB 42h = 2dB (1dB steps) 5F = 31dB 60h to 7Fh = Reserved
R794 (031Ah) DMIC2L Control	5:0	IN2L_DMIC_DLY [5:0]	00h	Input Path 1 (Left) Digital Delay (Applicable to digital input only) LSB = 1 sample, Range is 0 to 63. (Sample rate is controlled by IN2_OSR.)
R796 (031Ch) IN2R Control	7:1	IN2R_PGA_VOL [6:0]	40h	Input Path 2 (Right) PGA Volume (Applicable to analogue inputs only) 00h to 3Fh = Reserved 40h = 0dB 41h = 1dB 42h = 2dB (1dB steps) 5F = 31dB 60h to 7Fh = Reserved
R798 (031Eh) DMIC2R Control	5:0	IN2R_DMIC_DLY [5:0]	00h	Input Path 1 (Right) Digital Delay (Applicable to digital input only) LSB = 1 sample, Range is 0 to 63. (Sample rate is controlled by IN2_OSR.)



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION
R800	14:13	IN3_OSR [1:0]	01	Input Path 3 Oversample Rate
(0320h)	14.15	1140_001([1.0]	01	When analogue input is selected
IN3L				(IN3_MODE=0X), this bit controls the
Control				performance mode
				00 = Low Power mode
				01 = High Performance mode
				1X = Reserved
				When digital microphone input is selected
				(IN3_MODE=10), this bit controls the
				sample rate as below:
				00 = 1.536MHz
				01 = 3.072MHz
				1X = Reserved
	12:11	IN3_DMIC_SUP	00	Input Path 3 DMIC Reference Select
		[1:0]		(Sets the DMICDAT3 and DMICCLK3
				logic levels)
				00 = MICVDD 01 = MICBIAS1
				10 = MICBIAS2
				11 = MICBIAS3
	10:9	IN3 MODE [1:0]	00	Input Path 3 Mode
	10.9	INO_WODE [1.0]	00	00 = Differential (IN3xP - IN3xN)
				01 = Single-ended (IN3xP)
				10 = Digital Microphone
				11 = Reserved
	7:1	IN3L_PGA_VOL	40h	Input Path 3 (Left) PGA Volume
	'	[6:0]	1011	(Applicable to analogue inputs only)
				00h to 3Fh = Reserved
				40h = 0dB
				41h = 1dB
				42h = 2dB
				(1dB steps)
				5F = 31dB
				60h to 7Fh = Reserved
R802	5:0	IN3L_DMIC_DLY	00h	Input Path 1 (Left) Digital Delay
(0322h)		[5:0]		(Applicable to digital input only)
DMIC3L				LSB = 1 sample, Range is 0 to 63.
Control				(Sample rate is controlled by IN3_OSR.)
R804	7:1	IN3R_PGA_VOL	40h	Input Path 3 (Right) PGA Volume
(0324h)		[6:0]		(Applicable to analogue inputs only)
IN3R Control				00h to 3Fh = Reserved
Control				40h = 0dB
				41h = 1dB
				42h = 2dB
				(1dB steps)
				5F = 31dB
				60h to 7Fh = Reserved
R806	5:0	IN3R_DMIC_DLY	00h	Input Path 1 (Right) Digital Delay
(0326h) DMIC3R		[5:0]		(Applicable to digital input only)
Control				LSB = 1 sample, Range is 0 to 63.
				(Sample rate is controlled by IN3_OSR.)

Table 3 Input Signal Path Configuration



INPUT SIGNAL PATH DIGITAL VOLUME CONTROL

A digital volume control is provided on each of the input signal paths, providing -64dB to +31.5dB gain control in 0.5dB steps. An independent mute control is also provided for each input signal path.

Whenever the gain or mute setting is changed, the signal path gain is ramped up or down to the new settings at a programmable rate. For increasing gain (or un-mute), the rate is controlled by the IN_VI_RAMP register. For decreasing gain (or mute), the rate is controlled by the IN_VD_RAMP register. Note that the IN_VI_RAMP and IN_VD_RAMP registers should not be changed while a volume ramp is in progress.

The IN_VU bits control the loading of the input signal path digital volume and mute controls. When IN_VU is set to 0, the digital volume and mute settings will be loaded into the respective control register, but will not actually change the signal path gain. The digital volume and mute settings on all of the input signal paths are updated when a 1 is written to IN_VU. This makes it possible to update the gain of multiple signal paths simultaneously.

For correct gain ramp behaviour, the IN_VU bits should not be written during the 0.75ms after any of the input path enable bits (see Table 2) have been asserted. It is recommended that the input path mute bit be set when the respective input path is enabled; the signal path can then be un-muted after the 0.75ms has elapsed.

Note that, although the digital volume control registers provide 0.5dB steps, the internal circuits provide signal gain adjustment in 0.125dB steps. This allows a very high degree of gain control, and smooth volume ramping under all operating conditions.

The digital volume control register fields are described in Table 4 and Table 5.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R777 (0309h) Input Volume Ramp	6:4	IN_VD_RAMP [2:0]	010	Input Volume Decreasing Ramp Rate (seconds/6dB) 000 = 0ms 001 = 0.5ms 010 = 1ms 011 = 2ms 100 = 4ms 101 = 8ms 110 = 15ms 111 = 30ms This register should not be changed while
	2:0	IN_VI_RAMP [2:0]	010	a volume ramp is in progress. Input Volume Increasing Ramp Rate (seconds/6dB) 000 = 0ms 001 = 0.5ms 010 = 1ms 011 = 2ms 100 = 4ms 101 = 8ms 110 = 15ms 111 = 30ms This register should not be changed while a volume ramp is in progress.
R785 (0311h) ADC Digital Volume 1L	9	IN_VU		Input Signal Paths Volume and Mute Update Writing a 1 to this bit will cause the Input Signal Paths Volume and Mute settings to be updated simultaneously
	8	IN1L_MUTE	1	Input Path 1 (Left) Digital Mute 0 = Un-mute 1 = Mute



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION
ADDRESS	7.0	INAL VOL 17:01	001-	Largest Dotte 4 (Loff) Digital Values
	7:0	IN1L_VOL [7:0]	80h	Input Path 1 (Left) Digital Volume
				-64dB to +31.5dB in 0.5dB steps 00h = -64dB
				01h = -63.5dB
				(0.5dB steps) 80h = 0dB
				(0.5dB steps)
				BFh = +31.5dB
				Coh to FFh = Reserved
D700		INT NAT		(See Table 5 for volume range)
R789 (0315h)	9	IN_VU		Input Signal Paths Volume and Mute Update
ADC				Writing a 1 to this bit will cause the Input
Digital				Signal Paths Volume and Mute settings to
Volume				be updated simultaneously
1R	8	IN1R_MUTE	1	Input Path 1 (Right) Digital Mute
				0 = Un-mute
				1 = Mute
	7:0	IN1R_VOL [7:0]	80h	Input Path 1 (Right) Digital Volume
				-64dB to +31.5dB in 0.5dB steps
				00h = -64dB
				01h = -63.5dB
				(0.5dB steps)
				80h = 0dB
				(0.5dB steps)
				BFh = +31.5dB
				C0h to FFh = Reserved
				(See Table 5 for volume range)
R793	9	IN_VU		Input Signal Paths Volume and Mute
(0319h)				Update
ADC				Writing a 1 to this bit will cause the Input
Digital Volume 2L				Signal Paths Volume and Mute settings to
Volume 2L		INIOL MULTE	4	be updated simultaneously
	8	IN2L_MUTE	1	Input Path 2 (Left) Digital Mute
				0 = Un-mute
	7.0	INIOL 1/OL [7:0]	001-	1 = Mute
	7:0	IN2L_VOL [7:0]	80h	Input Path 2 (Left) Digital Volume
				-64dB to +31.5dB in 0.5dB steps
				00h = -64dB
				01h = -63.5dB
				(0.5dB steps) 80h = 0dB
				(0.5dB steps)
				BFh = +31.5dB C0h to FFh = Reserved
R797	9	IN_VU		(See Table 5 for volume range)
	Э	"14_VO		Input Signal Paths Volume and Mute Update
1 (0.511)(1)				
(031Dh) ADC				Writing a 1 to this bit will cause the Input
ADC Digital				Writing a 1 to this bit will cause the Input Signal Paths Volume and Mute settings to
ADC Digital Volume				
ADC Digital	8	IN2R_MUTE	1	Signal Paths Volume and Mute settings to
ADC Digital Volume	8	IN2R_MUTE	1	Signal Paths Volume and Mute settings to be updated simultaneously



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	7:0	IN2R_VOL [7:0]	80h	Input Path 2 (Right) Digital Volume -64dB to +31.5dB in 0.5dB steps 00h = -64dB 01h = -63.5dB (0.5dB steps) 80h = 0dB (0.5dB steps) BFh = +31.5dB C0h to FFh = Reserved (See Table 5 for volume range)
R801 (0321h) ADC Digital Volume 3L	9	IN_VU		Input Signal Paths Volume and Mute Update Writing a 1 to this bit will cause the Input Signal Paths Volume and Mute settings to be updated simultaneously
	8	IN3L_MUTE	1	Input Path 3 (Left) Digital Mute 0 = Un-mute 1 = Mute
	7:0	IN3L_VOL [7:0]	80h	Input Path 3 (Left) Digital Volume -64dB to +31.5dB in 0.5dB steps 00h = -64dB 01h = -63.5dB (0.5dB steps) 80h = 0dB (0.5dB steps) BFh = +31.5dB C0h to FFh = Reserved (See Table 5 for volume range)
R805 (0325h) ADC Digital Volume	9	IN_VU		Input Signal Paths Volume and Mute Update Writing a 1 to this bit will cause the Input Signal Paths Volume and Mute settings to be updated simultaneously
3R	8	IN3R_MUTE	1	Input Path 3 (Right) Digital Mute 0 = Un-mute 1 = Mute
	7:0	IN3R_VOL [7:0]	80h	Input Path 3 (Right) Digital Volume -64dB to +31.5dB in 0.5dB steps 00h = -64dB 01h = -63.5dB (0.5dB steps) 80h = 0dB (0.5dB steps) BFh = +31.5dB C0h to FFh = Reserved (See Table 5 for volume range)

Table 4 Input Signal Path Digital Volume Control



Input Volume Register	Volume (dB)						
00h	-64.0	40h	-32.0	80h	0.0	C0h	Reserved
01h	-63.5	41h	-31.5	81h	0.5	C1h	Reserved
02h	-63.0	42h	-31.0	82h	1.0	C2h	Reserved
03h	-62.5	43h	-30.5	83h	1.5	C3h	Reserved
04h	-62.0	44h	-30.0	84h	2.0	C4h	Reserved
05h	-61.5	45h	-29.5	85h	2.5	C5h	Reserved
06h	-61.0	46h	-29.0	86h	3.0	C6h	Reserved
07h	-60.5	47h	-28.5	87h	3.5	C7h	Reserved
08h	-60.0	48h	-28.0	88h	4.0	C8h	Reserved
09h	-59.5	49h	-27.5	89h	4.5	C9h	Reserved
0Ah	-59.0	4Ah	-27.0	8Ah	5.0	CAh	Reserved
0Bh	-58.5	4Bh	-26.5	8Bh	5.5	CBh	Reserved
0Ch	-58.0	4Ch	-26.0	8Ch	6.0	CCh	Reserved
0Dh	-57.5	4Dh	-25.5	8Dh	6.5	CDh	Reserved
0Eh	-57.0	4Eh	-25.0	8Eh	7.0	CEh	Reserved
0Fh	-56.5	4Fh	-24.5	8Fh	7.5	CFh	Reserved
10h	-56.0	50h	-24.0	90h	8.0	D0h	Reserved
11h	-55.5	51h	-23.5	91h	8.5	D1h	Reserved
12h	-55.0	52h	-23.0	92h	9.0	D2h	Reserved
13h	-54.5	53h	-22.5	93h	9.5	D3h	Reserved
14h	-54.0	54h	-22.0	94h	10.0	D4h	Reserved
15h	-53.5	55h	-21.5	95h	10.5	D5h	Reserved
16h	-53.0	56h	-21.0	96h	11.0	D6h	Reserved
17h	-52.5	57h	-20.5	97h	11.5	D7h	Reserved
18h	-52.0	58h	-20.0	98h	12.0	D8h	Reserved
19h	-51.5	59h	-19.5	99h	12.5	D9h	Reserved
1Ah	-51.0	5Ah	-19.0	9Ah	13.0	DAh	Reserved
1Bh	-50.5	5Bh	-18.5	9Bh	13.5	DBh	Reserved
1Ch	-50.0	5Ch	-18.0	9Ch	14.0	DCh	Reserved
1Dh	-49.5	5Dh	-17.5	9Dh	14.5	DDh	Reserved
1Eh	-49.0	5Eh	-17.0	9Eh	15.0	DEh	Reserved
1Fh	-48.5	5Fh	-16.5	9Fh	15.5	DFh	Reserved
20h	-48.0	60h	-16.0	A0h	16.0	E0h	Reserved
21h	-47.5	61h	-15.5	A1h	16.5	E1h	Reserved
22h	-47.0	62h	-15.0	A2h	17.0	E2h	Reserved
23h	-46.5	63h	-14.5	A3h	17.5	E3h	Reserved
24h	-46.0	64h	-14.0	A4h	18.0	E4h	Reserved
25h	-45.5	65h	-13.5	A5h	18.5	E5h	Reserved
26h	-45.0	66h	-13.0	A6h	19.0	E6h	Reserved
27h	-44.5	67h	-12.5	A7h	19.5	E7h	Reserved
28h	-44.0	68h	-12.0	A8h	20.0	E8h	Reserved
29h	-43.5	69h	-11.5	A9h	20.5	E9h	Reserved
2Ah	-43.0	6Ah	-11.0	AAh	21.0	EAh	Reserved
2Bh	-43.0 -42.5	6Bh	-10.5	ABh	21.5	EBh	Reserved
2Ch	-42.0	6Ch	-10.0	ACh	22.0	ECh	Reserved
2Dh	-42.0 -41.5	6Dh	-9.5	ADh	22.5	EDh	Reserved
2Eh	-41.0	6Eh	-9.0	AEh	23.0	EEh	Reserved
2Fh	-40.5	6Fh	-8.5	AFh	23.5	EFh	Reserved
30h	-40.5 -40.0	70h	-8.0	B0h	24.0	F0h	Reserved
31h	-39.5	7011 71h	-6.0 -7.5	B1h	24.5	F1h	Reserved
32h	-39.0	7111 72h	-7.5 -7.0	B2h	25.0	F2h	Reserved
32h	-39.0 -38.5	72fi 73h	-7.0 -6.5	B3h	25.0 25.5		
34h	-36.5 -38.0	73fi 74h	-6.0	B4h	26.0	F3h F4h	Reserved Reserved
35h	-36.0 -37.5	7411 75h	-5.5	B5h	26.5	F5h	Reserved
36h	-37.5 -37.0	76h	-5.5 -5.0	B6h	27.0	F6h	Reserved
37h	-37.0 -36.5	76fi 77h	-5.0 -4.5	B7h	27.5	F7h	
38h	-36.5 -36.0	7711 78h	-4.5 -4.0	B8h	28.0	F8h	Reserved Reserved
38h	-36.0 -35.5	78h 79h		B9h		F9h	Reserved
			-3.5 3.0		28.5		
3Ah	-35.0 34.5	7Ah 7Rh	-3.0 2.5	BAh BBh	29.0	FAh	Reserved
3Bh	-34.5 34.0	7Bh	-2.5 2.0	BBh BCh	29.5	FBh ECh	Reserved
3Ch 3Dh	-34.0 -33.5	7Ch 7Dh	-2.0 -1.5	BCh BDh	30.0 30.5	FCh FDh	Reserved Reserved
3Eh	-33.5 -33.0	7Dh 7Eh	-1.5 -1.0	BEh		FEh	Reserved
		7En 7Fh	-1.0 -0.5	BFh	31.0 31.5	FFh	Reserved
00.	-32.5	/ [1]	-0.5	DEII	31.5	L LLII	Reserved

Table 5 Input Signal Path Digital Volume Range

DIGITAL MICROPHONE INTERFACE PULL-DOWN

The WM5102 provides integrated pull-down resistors on the DMICDAT1, DMICDAT2 and DMICDAT3 pins. This provides a flexible capability for interfacing with other devices.

Each of the pull-down resistors can be configured independently using the register bits described in Table 6. Note that, if the DMICDAT1, DMICDAT2 or DMICDAT3 digital microphone input paths are disabled, then the pull-down will be disabled on the respective pin.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3106	2	DMICDAT3_PD	0	DMICDAT3 Pull-Down Control
(0C22h)				0 = Disabled
Misc Pad				1 = Enabled
Ctrl 3	1	DMICDAT2_PD	0	DMICDAT2 Pull-Down Control
				0 = Disabled
				1 = Enabled
İ	0	DMICDAT1_PD	0	DMICDAT1 Pull-Down Control
				0 = Disabled
ı				1 = Enabled

Table 6 Digital Microphone Interface Pull-Down Control



WM5102 Production Data

DIGITAL CORE

The WM5102 digital core provides extensive mixing and processing capabilities for multiple signal paths. The configuration is highly flexible, and virtually every conceivable input/output connection can be supported between the available processing blocks.

The digital core provides parametric equalisation (EQ) functions, dynamic range control (DRC), low-pass / high-pass filters (LHPF), and programmable DSP capability. The DSP can support functions such as wind noise, side-tone or other programmable filters, also dynamic range control and compression, or virtual surround sound and other audio enhancements.

The WM5102 supports multiple signal paths through the digital core. Stereo full-duplex sample rate conversion is provided to allow digital audio to be routed between input (ADC) paths, output (DAC) paths, Digital Audio Interfaces (AIF1, AIF2 and AIF3) and SLIMbus paths operating at different sample rates and/or referenced to asynchronous clock domains.

The DSP functions are highly programmable, using application-specific control sequences. It should be noted that the DSP configuration data is lost whenever the DCVDD power domain is removed; the DSP configuration data must be downloaded to the WM5102 each time the device is powered up.

The procedure for configuring the WM5102 DSP functions is tailored to each customer's application; please contact your local Wolfson representative for more details.

The WM5102 incorporates two 1kHz tone generators which can be used for 'beep' functions through any of the audio signal paths. A white noise generator is incorporated, to provide 'comfort noise' in cases where silence (digital mute) is not desirable.

A haptic signal generator is provided, for use with external haptic devices (eg. mechanical vibration actuators). Two Pulse Width Modulation (PWM) signal generators are also provided; the PWM waveforms can be modulated by an audio source within the digital core, and can be output on a GPIO pin.

An overview of the digital core processing and mixing functions is provided in Figure 22. An overview of the external digital interface paths is provided in Figure 23.

The control registers associated with the digital core signal paths are shown in Figure 24 through to Figure 41. The full list of digital mixer control registers is provided in the "Register Map" section (Register R1600 through to R2920). Generic register definitions are provided in Table 7.



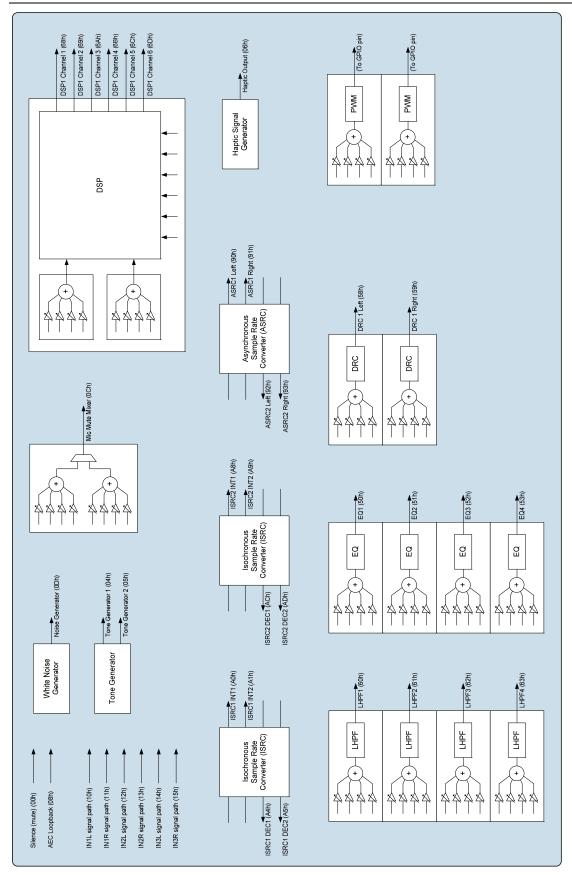


Figure 22 Digital Core - Internal Signal Processing



WM5102 Production Data

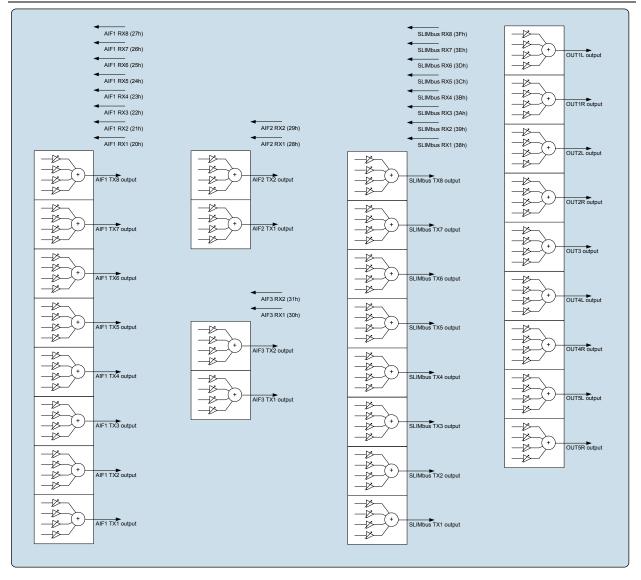


Figure 23 Digital Core - External Digital Interfaces

DIGITAL CORE MIXERS

The WM5102 provides an extensive digital mixing capability. The digital core signal processing blocks and audio interface paths are illustrated in Figure 22 and Figure 23.

A 4-input digital mixer is associated with many of these functions, as illustrated. The digital mixer circuit is identical in each instance, providing up to 4 selectable input sources, with independent volume control on each input.

The control registers associated with the digital core signal paths are shown in Figure 24 through to Figure 41. The full list of digital mixer control registers is provided in the "Register Map" section (Register R1600 through to R2920).

Further description of the associated control registers is provided below. Generic register definitions are provided in Table 7.

The digital mixer input sources are selected using the associated *_SRCn registers; the volume control is implemented via the associated *_VOLn registers.

The ASRC, ISRC, and DSP Aux Input functions support selectable input sources, but do not



incorporate any digital mixing. The respective input source (*_SRCn) registers are identical to those of the digital mixers.

The *_SRCn registers select the input source(s) for the respective mixer or signal processing block. Note that the selected input source(s) must be configured for the same sample rate as the block(s) to which they are connected. Sample rate conversion functions are available to support flexible interconnectivity - see "Asynchronous Sample Rate Converter (ASRC)" and "Isochronous Sample Rate Converter (ISRC)".

A status bit associated with each of the configurable input sources provides readback for the respective signal path. If an Underclocked Error condition occurs, then these bits provide readback of which signal path(s) have been successfully enabled.

The generic register definition for the digital mixers is provided in Table 7.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1600 (0640h) to R2920 (0B68h)	15	*_STSn Valid for every digital core function input (digital mixers, DSP Aux inputs, ASRC & ISRC inputs).	0	[Digital Core function] input <i>n</i> status 0 = Disabled 1 = Enabled
	7:1	*_VOLn Valid for every digital mixer input.	40h	[Digital Code mixer] input <i>n</i> volume -32dB to +16dB in 1dB steps 00h to 20h = -32dB 21h = -31dB 22h = -30dB (1dB steps) 40h = 0dB (1dB steps) 50h = +16dB 51h to 7Fh = +16dB
	8:0	*_SRCn Valid for every digital core function input (digital mixers, DSP Aux inputs, ASRC & ISRC inputs).	00h	[Digital Core function] input <i>n</i> source select 00h = Silence (mute) 04h = Tone generator 1 05h = Tone generator 2 06h = Haptic generator 08h = AEC loopback 0Ch = Mic Mute Mixer 0Dh = Noise generator 10h = IN1L signal path 11h = IN1R signal path 12h = IN2L signal path 13h = IN2R signal path 14h = IN3L signal path 15h = IN3R signal path 15h = IN3R signal path 20h = AIF1 RX1 21h = AIF1 RX2 22h = AIF1 RX3 23h = AIF1 RX4 24h = AIF1 RX5 25h = AIF1 RX7 27h = AIF1 RX8



Ī	REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
					28h = AIF2 RX1
					29h = AIF2 RX2
					30h = AIF3 RX1
					31h = AIF3 RX2
					38h = SLIMbus RX1
					39h = SLIMbus RX2
					3Ah = SLIMbus RX3
					3Bh = SLIMbus RX4
					3Ch = SLIMbus RX5
					3Dh = SLIMbus RX6
					3Eh = SLIMbus RX7
					3Fh = SLIMbus RX8
					50h = EQ1
					51h = EQ2
					52h = EQ3
					53h = EQ4
					58h = DRC1 Left
					59h = DRC1 Right
					60h = LHPF1
					61h = LHPF2
					62h = LHPF3
					63h = LHPF4
					68h = DSP1 channel 1
					69h = DSP1 channel 2
					6Ah = DSP1 channel 3
					6Bh = DSP1 channel 4
					6Ch = DSP1 channel 5
					6Dh = DSP1 channel 6
					90h = ASRC1 Left
					91h = ASRC1 Right
					92h = ASRC2 Left
					93h = ASRC2 Right
					A0h = ISRC1 INT1
					A1h = ISRC1 INT2
					A4h = ISRC1 DEC1
					A5h = ISRC1 DEC2
					A8h = ISRC2 INT1
					A9h = ISRC2 INT2
					ACh = ISRC2 DEC1
					ADh = ISRC2 DEC2

Table 7 Digital Core Mixer Control Registers

DIGITAL CORE INPUTS

The digital core comprises multiple input paths as illustrated in Figure 24. Any of these inputs may be selected as a source to the digital mixers or signal processing functions within the WM5102 digital core.

Note that the outputs from other blocks within the Digital Core may also be selected as input to the digital mixers or signal processing functions within the WM5102 digital core. Those input sources, which are not shown in Figure 24, are described separately in other sections of the "Digital Core" description.

The bracketed numbers in Figure 24, eg. "(10h)" indicate the corresponding *_SRCn register setting for selection of that signal as an input to another digital core function.

The sample rate for the input signal paths is configured using the applicable IN_RATE, AIFn_RATE or SLIMRXn_RATE register - see Table 21. Note that sample rate conversion is required when routing the input signal paths to any signal chain that is asynchronous and/or configured for a different sample rate

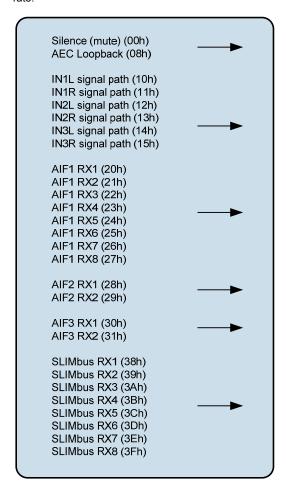


Figure 24 Digital Core Inputs

DIGITAL CORE OUTPUT MIXERS

The digital core comprises multiple output paths. The output paths associated with AIF1, AIF2 and AIF3 are illustrated in Figure 25. The output paths associated with OUT1, OUT2, OUT3, OUT4 and OUT5 are illustrated in Figure 26. The output paths associated with the SLIMbus interface are illustrated in Figure 27.

A 4-input mixer is associated with each output. The 4 input sources are selectable in each case, and independent volume control is provided for each path.

The AIF1, AIF2 and AIF3 output mixer control registers (see Figure 25) are located at register addresses R1792 (700h) through to R1935 (78Fh). The OUT1, OUT2, OUT3, OUT4 and OUT5 output mixer control registers (see Figure 26) are located at addresses R1664 (680h) through to R1743 (06CFh). The SLIMbus output mixer control registers (see Figure 27) are located at addresses R1984 (7C0h) through to R2047 (7FFh).

The full list of digital mixer control registers is provided in the "Register Map" section (Register R1600 through to R2920). Generic register definitions are provided in Table 7.

The *_SRCn registers select the input source(s) for the respective mixers. Note that the selected input source(s) must be configured for the same sample rate as the mixer to which they are connected. Sample rate conversion functions are available to support flexible interconnectivity - see "Asynchronous Sample Rate Converter (ASRC)" and "Isochronous Sample Rate Converter (ISRC)".

The sample rate for the output signal paths is configured using the applicable OUT_RATE, AIFn_RATE or SLIMTXn_RATE register - see Table 21. Note that sample rate conversion is required when routing the output signal paths to any signal chain that is asynchronous and/or configured for a different sample rate.

The WM5102 performs automatic checks to confirm that the SYSCLK frequency is high enough to support the output mixer paths. If an attempt is made to enable an output mixer path, and there are insufficient SYSCLK cycles to support it, then the attempt will be unsuccessful. (Note that any signal paths that are already active will not be affected under these circumstances.)

The Underclocked Error condition can be monitored using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.

The status bits in Registers R1600 to R2920 indicate the status of each of the digital mixers. If an Underclocked Error condition occurs, then these bits provide readback of which mixer(s) have been successfully enabled.



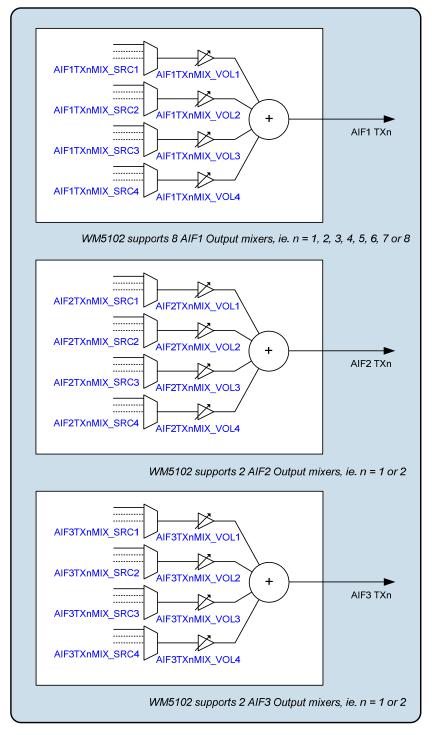


Figure 25 Digital Core AIF Outputs

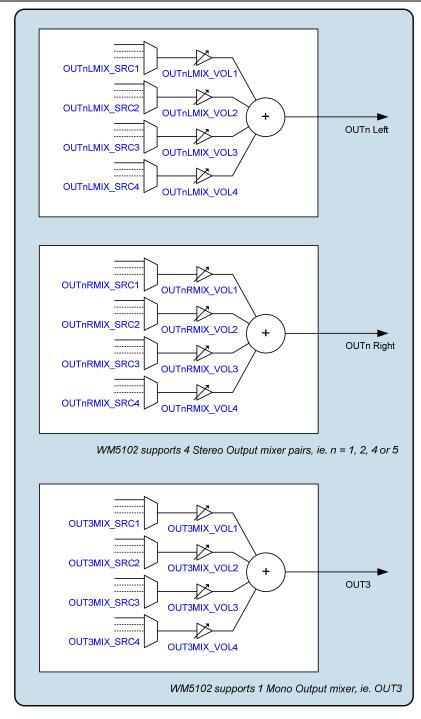


Figure 26 Digital Core OUTn Outputs

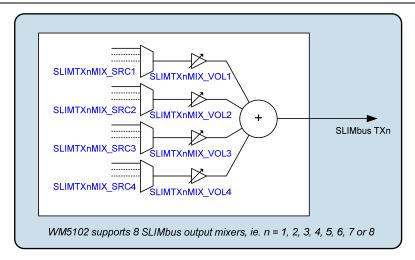


Figure 27 Digital Core SLIMbus Outputs

MIC MUTE MIXER

The Mic Mute mixer function supports applications where two signal paths are multiplexed into a single output. A typical use case is muting a microphone audio path and inserting a 'comfort noise' signal in place of the normal audio path.

The Mic Mute mixer function comprises two digital mixers (MICMIX and NOISEMIX), as illustrated in Figure 28. A multiplexer selects one or other mixer as the Mic Mute output signal. Up to 4 input sources can be selected for each mixer, and independent volume control is provided for each path.

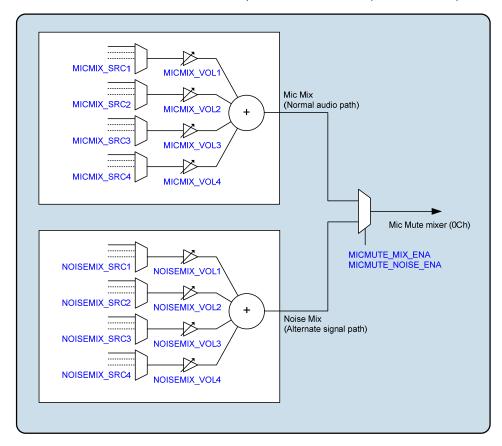


Figure 28 Mic Mute Digital Mixers

The MICMIX and NOISEMIX control registers (see Figure 28) are located at register addresses R1632 (0660h) through to R1647 (066Fh).

The full list of digital mixer control registers is provided in the "Register Map" section (Register R1600 through to R2920). Generic register definitions are provided in Table 7.

The Mic Mute mixer can be selected as input to any of the digital mixers or signal processing functions within the WM5102 digital core. The bracketed number (0Ch) in Figure 28 indicates the corresponding * SRCn register setting for selection of the Mic Mute mixer as an input to another digital core function.

The sample rate for the Mic Mute mixer and multiplexer is configured using the MICMUTE_RATE register - see Table 21. Note that sample rate conversion is required when routing the Mic Mute mixer to any signal chain that is asynchronous and/or configured for a different sample rate.

The control registers associated with the Mic Mute mixer function are described in Table 8.

The output of the Mic Mute mixer and multiplexer is enabled using MICMUTE_MIX_ENA.

The multiplexer is controlled using the MICMUTE_NOISE_ENA register bit, selecting MICMIX or NOISEMIX as the output signal source.

Under recommended operating conditions, the MICMIX output is selected for normal (audio) conditions, and the NOISEMIX output is selected for mute (or 'comfort noise') conditions.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R707	7	MICMUTE_NOIS	0	Mic Mute Mixer Control
(02C3h)		E_ENA		0 = Mic Mix
Mic noise				1 = Noise Mix
mix control	6	MICMUTE_MIX_E	0	Mic Mute Mixer Enable
'		NA		0 = Disabled
				1 = Enabled

Table 8 Mic Mute Mixer Control Registers

The WM5102 performs automatic checks to confirm that the SYSCLK frequency is high enough to support the commanded digital mixing functions. If an attempt is made to enable a MICMIX or NOISEMIX signal path, and there are insufficient SYSCLK cycles to support it, then the attempt will be unsuccessful. (Note that any signal paths that are already active will not be affected under these circumstances.)

The Underclocked Error condition can be monitored using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.

The status bits in Registers R1600 to R2920 indicate the status of each of the digital mixers. If an Underclocked Error condition occurs, then these bits provide readback of which mixer(s) have been successfully enabled, and which mixer(s) could not be enabled.

5-BAND PARAMETRIC EQUALISER (EQ)

The digital core provides four EQ processing blocks as illustrated in Figure 29. A 4-input mixer is associated with each EQ. The 4 input sources are selectable in each case, and independent volume control is provided for each path. Each EQ block supports 1 output.

The EQ provides selective control of 5 frequency bands as described below.

The low frequency band (Band 1) filter can be configured either as a peak filter or a shelving filter. When configured as a shelving filter, is provides adjustable gain below the Band 1 cut-off frequency. As a peak filter, it provides adjustable gain within a defined frequency band that is centred on the Band 1 frequency.

The mid frequency bands (Band 2, Band 3, Band 4) filters are peak filters, which provide adjustable gain around the respective centre frequency.

The high frequency band (Band 5) filter is a shelving filter, which provides adjustable gain above the



Band 5 cut-off frequency.

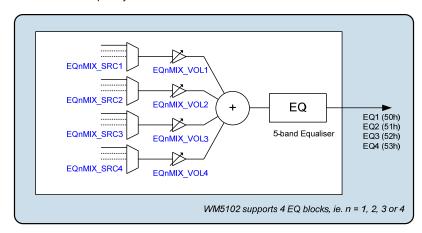


Figure 29 Digital Core EQ Blocks

The EQ1, EQ2, EQ3 and EQ4 mixer control registers (see Figure 29) are located at register addresses R2176 (880h) through to R2207 (89Fh).

The full list of digital mixer control registers is provided in the "Register Map" section (Register R1600 through to R2920). Generic register definitions are provided in Table 7.

The *_SRCn registers select the input source(s) for the respective EQ processing blocks. Note that the selected input source(s) must be configured for the same sample rate as the EQ to which they are connected. Sample rate conversion functions are available to support flexible interconnectivity - see "Asynchronous Sample Rate Converter (ASRC)" and "Isochronous Sample Rate Converter (ISRC)".

The bracketed numbers in Figure 29, eg. "(50h)" indicate the corresponding *_SRCn register setting for selection of that signal as an input to another digital core function.

The sample rate for the EQ function is configured using the FX_RATE register - see Table 21. Note that the EQ, DRC and LHPF functions must all be configured for the same sample rate.

The EQ function supports audio sample rates in the range 8kHz to 192kHz. When the DRC is enabled, the maximum sample rate for the EQ, DRC and LHPF functions is 96kHz.

Sample rate conversion is required when routing the EQ signal paths to any signal chain that is asynchronous and/or configured for a different sample rate.

The control registers associated with the EQ functions are described in Table 10.

The cut-off or centre frequencies for the 5-band EQ are set using the coefficients held in the registers identified in Table 9. These coefficients are derived using tools provided in Wolfson's WISCE™ evaluation board control software; please contact your local Wolfson representative for more details.

EQ	REGISTER ADDRESSES
EQ1	R3602 (0E10h) to R3620 (0E24h)
EQ2	R3624 (0E28h) to R3642 (0E3Ah)
EQ3	R3646 (0E3Eh) to R3664 (0E53h)
EQ4	R3668 (0E54h) to R3686 (0E66h)

Table 9 EQ Coefficient Registers

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3585 (0E01h) FX_Ctrl2	15:4	FX_STS [11:0]	000h	LHPF, DRC, EQ Enable Status Indicates the status of each of the respective signal processing functions. [11] = EQ4 [10] = EQ3 [9] = EQ2 [8] = EQ1 [7] = Reserved [6] = Reserved [5] = DRC1 (Right) [4] = DRC1 (Left) [3] = LHPF4 [2] = LHPF3 [1] = LHPF2 [0] = LHPF1 Each bit is coded as:
				0 = Disabled
R3600 (0E10h) EQ1_1	15:11	EQ1_B1_GAIN [4:0]	01100	1 = Enabled EQ1 Band 1 Gain -12dB to +12dB in 1dB steps (see Table 11 for gain range)
	10:6	EQ1_B2_GAIN [4:0]	01100	EQ1 Band 2 Gain -12dB to +12dB in 1dB steps (see Table 11 for gain range)
	5:1	EQ1_B3_GAIN [4:0]	01100	EQ1 Band 3 Gain -12dB to +12dB in 1dB steps (see Table 11 for gain range)
	0	EQ1_ENA	0	EQ1 Enable 0 = Disabled 1 = Enabled
R3601 (0E11h) EQ1_2	15:11	EQ1_B4_GAIN [4:0]	01100	EQ1 Band 4 Gain -12dB to +12dB in 1dB steps (see Table 11 for gain range)
	10:6	EQ1_B5_GAIN [4:0]	01100	EQ1 Band 5 Gain -12dB to +12dB in 1dB steps (see Table 11 for gain range)
	0	EQ1_B1_MODE	0	EQ1 Band 1 Mode 0 = Shelving filter 1 = Peak filter
R3602 (0E12h) to R3620 (E24h)	15:0	EQ1_B1_* EQ1_B2_* EQ1_B3_* EQ1_B4_* EQ1_B5_*		EQ1 Frequency Coefficients Refer to WISCE evaluation board control software for the deriviation of these field values.
R3622 (0E26h) EQ2_1	15:11	EQ2_B1_GAIN [4:0]	01100	EQ2 Band 1 Gain -12dB to +12dB in 1dB steps (see Table 11 for gain range)
	10:6	EQ2_B2_GAIN [4:0]	01100	EQ2 Band 2 Gain -12dB to +12dB in 1dB steps (see Table 11 for gain range)
	5:1	EQ2_B3_GAIN [4:0]	01100	EQ2 Band 3 Gain -12dB to +12dB in 1dB steps (see Table 11 for gain range)



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
ADDITEGO	0	EQ2 ENA	0	EQ2 Enable
		_		0 = Disabled
				1 = Enabled
R3623	15:11	EQ2_B4_GAIN	01100	EQ2 Band 4 Gain
(0E27h)		[4:0]		-12dB to +12dB in 1dB steps
EQ2_2				(see Table 11 for gain range)
	10:6	EQ2_B5_GAIN	01100	EQ2 Band 5 Gain
		[4:0]		-12dB to +12dB in 1dB steps
				(see Table 11 for gain range)
	0	EQ2_B1_MODE	0	EQ2 Band 1 Mode
				0 = Shelving filter
				1 = Peak filter
R3624	15:0	EQ2_B1_*		EQ2 Frequency Coefficients
(0E28h)		EQ2_B2_*		Refer to WISCE evaluation board control
to		EQ2_B3_*		software for the deriviation of these field
R3642		EQ2_B4_*		values.
(E3Ah)		EQ2_B5_*		
R3644	15:11	EQ3_B1_GAIN	01100	EQ3 Band 1 Gain
(0E3Ch)		[4:0]		-12dB to +12dB in 1dB steps
EQ3_1				(see Table 11 for gain range)
	10:6	EQ3_B2_GAIN	01100	EQ3 Band 2 Gain
		[4:0]		-12dB to +12dB in 1dB steps
				(see Table 11 for gain range)
	5:1	EQ3_B3_GAIN	01100	EQ3 Band 3 Gain
		[4:0]		-12dB to +12dB in 1dB steps
				(see Table 11 for gain range)
	0	EQ3_ENA	0	EQ3 Enable
				0 = Disabled
				1 = Enabled
R3645 (0E3Dh)	15:11	EQ3_B4_GAIN	01100	EQ3 Band 4 Gain
EQ3_2		[4:0]		-12dB to +12dB in 1dB steps
LQ3_2	10.0	500 D5 0AIN	04400	(see Table 11 for gain range)
	10:6	EQ3_B5_GAIN [4:0]	01100	EQ3 Band 5 Gain
		[4.0]		-12dB to +12dB in 1dB steps
		FO2 D4 MODE	0	(see Table 11 for gain range)
	0	EQ3_B1_MODE	0	EQ3 Band 1 Mode 0 = Shelving filter
				1 = Peak filter
R3646	15:0	EQ3_B1_*		EQ3 Frequency Coefficients
(0E3Eh)	13.0	EQ3_B1_ EQ3_B2_*		Refer to WISCE evaluation board control
to		EQ3_B3_*		software for the deriviation of these field
R3664		EQ3_B4_*		values.
(E50h)		EQ3_B5_*		
R3666	15:11	EQ4_B1_GAIN	01100	EQ4 Band 1 Gain
(0E52h)		[4:0]		-12dB to +12dB in 1dB steps
EQ4_1				(see Table 11 for gain range)
	10:6	EQ4_B2_GAIN	01100	EQ4 Band 2 Gain
		[4:0]		-12dB to +12dB in 1dB steps
				(see Table 11 for gain range)
	5:1	EQ4_B3_GAIN	01100	EQ4 Band 3 Gain
		[4:0]		-12dB to +12dB in 1dB steps
				(see Table 11 for gain range)



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	0	EQ4_ENA	0	EQ4 Enable
				0 = Disabled
				1 = Enabled
R3667	15:11	EQ4_B4_GAIN	01100	EQ4 Band 4 Gain
(0E53h)		[4:0]		-12dB to +12dB in 1dB steps
EQ4_2				(see Table 11 for gain range)
	10:6	EQ4_B5_GAIN	01100	EQ4 Band 5 Gain
		[4:0]		-12dB to +12dB in 1dB steps
				(see Table 11 for gain range)
	0	EQ4_B1_MODE	0	EQ4 Band 1 Mode
				0 = Shelving filter
				1 = Peak filter
R3668	15:0	EQ4_B1_*		EQ4 Frequency Coefficients
(0E54h)		EQ4_B2_*		Refer to WISCE evaluation board control
to		EQ4_B3_*		software for the deriviation of these field
R3686		EQ4_B4_*		values.
(E66h)		EQ4_B5_*		

Table 10 EQ Enable and Gain Control

EQ GAIN SETTING	GAIN (dB)
00000	-12
00001	-11
00010	-10
00011	-9
00100	-8
00101	-7
00110	-6
00111	-5
01000	-4
01001	-3
01010	-2
01011	-1
01100	0
01101	+1
01110	+2
01111	+3
10000	+4
10001	+5
10010	+6
10011	+7
10100	+8
10101	+9
10110	+10
10111	+11
11000	+12
11001 to 11111	Reserved

Table 11 EQ Gain Control Range

The WM5102 performs automatic checks to confirm that the SYSCLK frequency is high enough to support the commanded EQ and digital mixing functions. If an attempt is made to enable an EQ signal path, and there are insufficient SYSCLK cycles to support it, then the attempt will be unsuccessful. (Note that any signal paths that are already active will not be affected under these circumstances.)

The Underclocked Error can be monitored using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.

The FX_STS field in Register R3585 indicates the status of each of the EQ, DRC and LHPF signal paths. If an Underclocked Error condition occurs, then this register provides readback of which EQ, DRC or LHPF signal path(s) have been successfully enabled.

The status bits in Registers R1600 to R2920 indicate the status of each of the digital mixers. If an Underclocked Error condition occurs, then these bits provide readback of which mixer(s) have been successfully enabled.

DYNAMIC RANGE CONTROL (DRC)

The digital core provides a stereo Dynamic Range Control (DRC) processing block as illustrated in Figure 30. A 4-input mixer is associated with each DRC input channel. The 4 input sources are selectable in each case, and independent volume control is provided for each path.

The function of the DRC is to adjust the signal gain in conditions where the input amplitude is unknown or varies over a wide range, e.g. when recording from microphones built into a handheld system, or to restrict the dynamic range of an output signal path.

The DRC can apply Compression and Automatic Level Control to the signal path. It incorporates 'anticlip' and 'quick release' features for handling transients in order to improve intelligibility in the presence of loud impulsive noises.

The DRC also incorporates a Noise Gate function, which provides additional attenuation of very low-level input signals. This means that the signal path is quiet when no signal is present, giving an improvement in background noise level under these conditions.

A Signal Detect function is provided within the DRC; this can be used to detect the presence of an audio signal, and used to trigger other events. The Signal Detect function can be used as an Interrupt event, or as a GPIO output, or used to trigger the Control Write Sequencer.



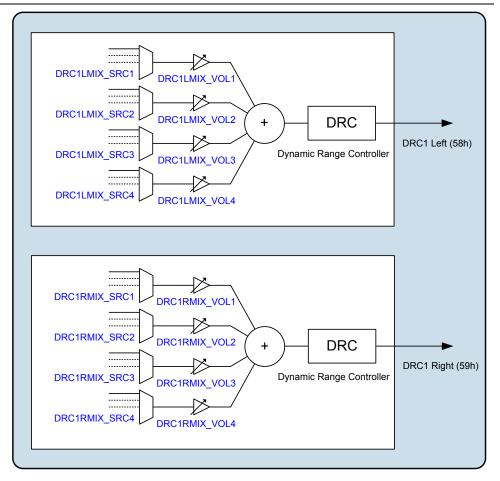


Figure 30 Dynamic Range Control (DRC) Block

The DRC1 mixer control registers (see Figure 30) are located at register addresses R2240 (8C0h) through to R2255 (08CFh).

The full list of digital mixer control registers is provided in the "Register Map" section (Register R1600 through to R2920). Generic register definitions are provided in Table 7.

The *_SRCn registers select the input source(s) for the respective DRC processing blocks. Note that the selected input source(s) must be configured for the same sample rate as the DRC to which they are connected. Sample rate conversion functions are available to support flexible interconnectivity see "Asynchronous Sample Rate Converter (ASRC)" and "Isochronous Sample Rate Converter (ISRC)".

The bracketed numbers in Figure 30, eg. "(58h)" indicate the corresponding *_SRCn register setting for selection of that signal as an input to another digital core function.

The sample rate for the DRC function is configured using the FX_RATE register - see Table 21. Note that the EQ, DRC and LHPF functions must all be configured for the same sample rate.

The DRC function supports audio sample rates in the range 8kHz to 96kHz. Higher sample rates (up to 192kHz) may be selected using FX_RATE, provided that the DRC function is disabled.

Sample rate conversion is required when routing the DRC signal paths to any signal chain that is asynchronous and/or configured for a different sample rate.

The DRC functions are enabled using the control registers described in Table 12.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3712	1	DRC1L_ENA	0	DRC1 (Left) Enable
(0E80h)				0 = Disabled
DRC1 ctrl1				1 = Enabled
	0	DRC1R_ENA	0	DRC1 (Right) Enable
				0 = Disabled
				1 = Enabled

Table 12 DRC Enable

DRC Compression / Expansion / Limiting

The DRC supports two different compression regions, separated by a "Knee" at a specific input amplitude. In the region above the knee, the compression slope DRC1_HI_COMP applies; in the region below the knee, the compression slope DRC1_LO_COMP applies.

The DRC also supports a noise gate region, where low-level input signals are heavily attenuated. This function can be enabled or disabled according to the application requirements. The DRC response in this region is defined by the expansion slope DRC1_NG_EXP.

For additional attenuation of signals in the noise gate region, an additional "knee" can be defined (shown as "Knee2" in Figure 31). When this knee is enabled, this introduces an infinitely steep dropoff in the DRC response pattern between the DRC1_LO_COMP and DRC1_NG_EXP regions.

The overall DRC compression characteristic in "steady state" (i.e. where the input amplitude is near-constant) is illustrated in Figure 31.

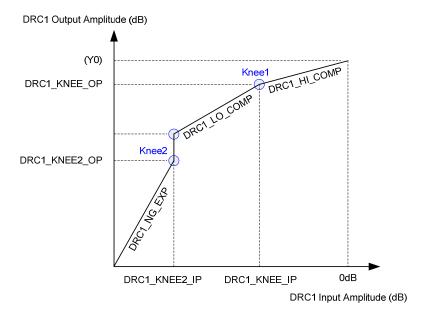


Figure 31 DRC Response Characteristic

The slope of the DRC response is determined by register fields DRC1_HI_COMP and DRC1_LO_COMP. A slope of 1 indicates constant gain in this region. A slope less than 1 represents compression (i.e. a change in input amplitude produces only a smaller change in output amplitude). A slope of 0 indicates that the target output amplitude is the same across a range of input amplitudes; this is infinite compression.

When the noise gate is enabled, the DRC response in this region is determined by the DRC1_NG_EXP register. A slope of 1 indicates constant gain in this region. A slope greater than 1 represents expansion (ie. a change in input amplitude produces a larger change in output amplitude).

When the DRC1_KNEE2_OP knee is enabled ("Knee2" in Figure 31), this introduces the vertical line



in the response pattern illustrated, resulting in infinitely steep attenuation at this point in the response.

The DRC parameters are listed in Table 13.

REF	PARAMETER	DESCRIPTION
1	DRC1_KNEE_IP	Input level at Knee1 (dB)
2	DRC1_KNEE_OP	Output level at Knee2 (dB)
3	DRC1_HI_COMP	Compression ratio above Knee1
4	DRC1_LO_COMP	Compression ratio below Knee1
5	DRC1_KNEE2_IP	Input level at Knee2 (dB)
6	DRC1_NG_EXP	Expansion ratio below Knee2
7	DRC1_KNEE2_OP	Output level at Knee2 (dB)

Table 13 DRC Response Parameters

The noise gate is enabled when the DRC1_NG_ENA register is set. When the noise gate is not enabled, parameters 5, 6, 7 above are ignored, and the DRC1_LO_COMP slope applies to all input signal levels below Knee1.

The DRC1_KNEE2_OP knee is enabled when the DRC1_KNEE2_OP_ENA register is set. When this bit is not set, then parameter 7 above is ignored, and the Knee2 position always coincides with the low end of the DRC1_LO_COMP region.

The "Knee1" point in Figure 31 is determined by register fields DRC1_KNEE_IP and DRC1_KNEE_OP.

Parameter Y0, the output level for a 0dB input, is not specified directly, but can be calculated from the other parameters, using the equation:

Y0 = DRC1_KNEE_OP - (DRC1_KNEE_IP x DRC1_HI_COMP)

Gain Limits

The minimum and maximum gain applied by the DRC is set by register fields DRC1_MINGAIN, DRC1_MAXGAIN and DRC1_NG_MINGAIN. These limits can be used to alter the DRC response from that illustrated in Figure 31. If the range between maximum and minimum gain is reduced, then the extent of the dynamic range control is reduced.

The minimum gain in the Compression regions of the DRC response is set by DRC1_MINGAIN. The minimum gain in the Noise Gate region is set by DRC1_NG_MINGAIN. The minimum gain limit prevents excessive attenuation of the signal path.

The maximum gain limit set by DRC1_MAXGAIN prevents quiet signals (or silence) from being excessively amplified.

Dynamic Characteristics

The dynamic behaviour determines how quickly the DRC responds to changing signal levels. Note that the DRC responds to the average (RMS) signal amplitude over a period of time.

The DRC1_ATK determines how quickly the DRC gain decreases when the signal amplitude is high. The DRC1_DCY determines how quickly the DRC gain increases when the signal amplitude is low.

These register fields are described in Table 14. Note that the register defaults are suitable for general purpose microphone use.



Anti-Clip Control

The DRC includes an Anti-Clip feature to avoid signal clipping when the input amplitude rises very quickly. This feature uses a feed-forward technique for early detection of a rising signal level. Signal clipping is avoided by dynamically increasing the gain attack rate when required. The Anti-Clip feature is enabled using the DRC1_ANTICLIP bit.

Note that the feed-forward processing increases the latency in the input signal path.

Note that the Anti-Clip feature operates entirely in the digital domain. It cannot be used to prevent signal clipping in the analogue domain nor in the source signal. Analogue clipping can only be prevented by reducing the analogue signal gain or by adjusting the source signal.

Quick Release Control

The DRC includes a Quick-Release feature to handle short transient peaks that are not related to the intended source signal. For example, in handheld microphone recording, transient signal peaks sometimes occur due to user handling, key presses or accidental tapping against the microphone. The Quick Release feature ensures that these transients do not cause the intended signal to be masked by the longer time constant of DRC1_DCY.

The Quick-Release feature is enabled by setting the DRC1_QR bit. When this bit is enabled, the DRC measures the crest factor (peak to RMS ratio) of the input signal. A high crest factor is indicative of a transient peak that may not be related to the intended source signal. If the crest factor exceeds the level set by DRC1_QR_THR, then the normal decay rate (DRC1_DCY) is ignored and a faster decay rate (DRC1_QR_DCY) is used instead.

Signal Activity Detect

The DRC incorporates a configurable signal detect function, allowing the signal level at the DRC input to be monitored and to be used to trigger other events. This can be used to detect the presence of a microphone signal on an ADC or digital mic channel, or can be used to detect an audio signal received over the digital audio interface.

The DRC Signal Detect function is enabled by setting DRC1_SIG_DET register bit. (Note that DRC1 must also be enabled.) The detection threshold is either a Peak level (Crest Factor) or an RMS level, depending on the DRC1_SIG_DET_MODE register bit. When Peak level is selected, the threshold is determined by DRC1_SIG_DET_PK, which defines the applicable Crest Factor (Peak to RMS ratio) threshold. If RMS level is selected, then the threshold is set using DRC1_SIG_DET_RMS.

The DRC Signal Detect function is an input to the Interrupt control circuit and can be used to trigger an Interrupt event - see "Interrupts".

The DRC Signal Detect signal can be output directly on a GPIO pin as an external indication of the Signal Detection. See "General Purpose Input / Output" to configure a GPIO pin for this function.

The Control Write Sequencer can be triggered by the DRC Signal Detect function. This is enabled using the DRC1_WSEQ_SIG_DET_ENA register bit. See "Control Write Sequencer" for further details.



GPIO Outputs from DRC

The Dynamic Range Control (DRC) circuit provides a number of status outputs, which can be output directly on a GPIO pin as an external indication of the DRC Status. See "General Purpose Input / Output" to configure a GPIO pin for these functions.

Each of the DRC status outputs is described below.

The DRC Signal Detect flag indicates that a signal is present on the respective signal path. The threshold level for signal detection is configurable using the register fields are described in Table 14.

The DRC Anti-Clip flag indicates that the DRC Anti-Clip function has been triggered. In this event, the DRC gain is decreasing in response to a rising signal level. The flag is asserted until the DRC gain stablises.

The DRC Decay flag indicates that the DRC gain is increasing in response to a low level signal input. The flag is asserted until the DRC gain stabilises.

The DRC Noise Gate flag indicates that the DRC Noise Gate function has been triggered, indicating that an idle condition has been detected in the signal path.

The DRC Quick Release flag indicates that the DRC Quick Release function has been triggered. In this event, the DRC gain is increasing rapidly following detection of a short transient peak. The flag is asserted until the DRC gain stabilises.

DRC Register Controls

The DRC control registers are described in Table 14.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3585 (0E01h) FX_Ctrl2	15:4	FX_STS [11:0]	000h	LHPF, DRC, EQ Enable Status Indicates the status of each of the respective signal processing functions. [11] = EQ4 [10] = EQ3 [9] = EQ2 [8] = EQ1 [7] = Reserved [6] = Reserved [5] = DRC1 (Right) [4] = DRC1 (Left) [3] = LHPF4 [2] = LHPF3 [1] = LHPF2 [0] = LHPF1 Each bit is coded as: 0 = Disabled
R3712 (0E80h) DRC1 ctrl1	15:11	DRC1_SIG_DET _RMS [4:0]	00h	1 = Enabled DRC1 Signal Detect RMS Threshold. This is the RMS signal level for signal detect to be indicated when DRC1_SIG_DET_MODE=1. 00h = -30dB 01h = -31.5dB (1.5dB steps) 1Eh = -75dB 1Fh = -76.5dB



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	10:9	DRC1_SIG_DET _PK [1:0]	00	DRC1 Signal Detect Peak Threshold. This is the Peak/RMS ratio, or Crest Factor, level for signal detect to be indicated when DRC1_SIG_DET_MODE=0. 00 = 12dB 01 = 18dB 10 = 24dB 11 = 30dB
	8	DRC1_NG_ENA	0	DRC1 Noise Gate Enable 0 = Disabled 1 = Enabled
	7	DRC1_SIG_DET _MODE	0	DRC1 Signal Detect Mode 0 = Peak threshold mode 1 = RMS threshold mode
	6	DRC1_SIG_DET	0	DRC1 Signal Detect Enable 0 = Disabled 1 = Enabled
	5	DRC1_KNEE2_ OP_ENA	0	DRC1 KNEE2_OP Enable 0 = Disabled 1 = Enabled
	4	DRC1_QR	1	DRC1 Quick-release Enable 0 = Disabled 1 = Enabled
	3	DRC1_ANTICLI P	1	DRC1 Anti-clip Enable 0 = Disabled 1 = Enabled
	2	DRC1_WSEQ_S IG_DET_ENA	0	DRC1 Signal Detect Write Sequencer Select 0 = Disabled 1 = Enabled
R3713 (0E81h) DRC1 ctrl2	12:9	DRC1_ATK [3:0]	0100	DRC1 Gain attack rate (seconds/6dB) 0000 = Reserved 0001 = 181us 0010 = 363us 0011 = 726us 0100 = 1.45ms 0101 = 2.9ms 0110 = 5.8ms 0111 = 11.6ms 1000 = 23.2ms 1001 = 46.4ms 1010 = 92.8ms 1011 = 185.6ms 1100 to 1111 = Reserved



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	8:5	DRC1_DCY [3:0]	1001	DRC1 Gain decay rate (seconds/6dB) 0000 = 1.45ms 0001 = 2.9ms 0010 = 5.8ms 0011 = 11.6ms
				0100 = 23.25ms 0101 = 46.5ms 0110 = 93ms 0111 = 186ms 1000 = 372ms 1001 = 743ms 1010 = 1.49s 1011 = 2.97s 1100 to1111 = Reserved
	4:2	DRC1_MINGAIN [2:0]	100	DRC1 Minimum gain to attenuate audio signals 000 = 0dB 001 = -12dB 010 = -18dB 011 = -24dB 100 = -36dB 101 = Reserved 11X = Reserved
	1:0	DRC1_MAXGAI N [1:0]	11	DRC1 Maximum gain to boost audio signals (dB) 00 = 12dB 01 = 18dB 10 = 24dB 11 = 36dB
R3714 (0E82h) DRC1 ctrl3	15:12	DRC1_NG_MIN GAIN [3:0]	0000	DRC1 Minimum gain to attenuate audio signals when the noise gate is active. 0000 = -36dB 0001 = -30dB 0010 = -24dB 0011 = -18dB 0100 = -12dB 0101 = -6dB 0110 = 0dB 0111 = 6dB 1000 = 12dB 1001 = 18dB 1001 = 18dB 1010 = 24dB 1011 = 30dB 1111 = 30dB 1100 = 36dB 1101 to 1111 = Reserved
	11:10	DRC1_NG_EXP [1:0]	00	DRC1 Noise Gate slope 00 = 1 (no expansion) 01 = 2 10 = 4 11 = 8



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	9:8	DRC1_QR_THR [1:0]	00	DRC1 Quick-release threshold (crest factor in dB) 00 = 12dB 01 = 18dB 10 = 24dB 11 = 30dB
	7:6	DRC1_QR_DCY [1:0]	00	DRC1 Quick-release decay rate (seconds/6dB) $00 = 0.725 ms$ $01 = 1.45 ms$ $10 = 5.8 ms$ $11 = Reserved$
	5:3	DRC1_HI_COM P [2:0]	011	DRC1 Compressor slope (upper region) 000 = 1 (no compression) 001 = 1/2 010 = 1/4 011 = 1/8 100 = 1/16 101 = 0 110 = Reserved 111 = Reserved
	2:0	DRC1_LO_COM P [2:0]	000	DRC1 Compressor slope (lower region) 000 = 1 (no compression) 001 = 1/2 010 = 1/4 011 = 1/8 100 = 0 101 = Reserved 11X = Reserved
R3715 (0E83h) DRC1 ctrl4	10:5	DRC1_KNEE_IP [5:0]	000000	DRC1 Input signal level at the Compressor 'Knee'. 000000 = 0dB 000001 = -0.75dB 000010 = -1.5dB (-0.75dB steps) 111100 = -45dB 111101 = Reserved 11111X = Reserved
	4:0	DRC1_KNEE_O P [4:0]	00000	DRC1 Output signal at the Compressor 'Knee'. 00000 = 0dB 00001 = -0.75dB 00010 = -1.5dB (-0.75dB steps) 11110 = -22.5dB 11111 = Reserved



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3716 (0E84h)	9:5	DRC1_KNEE2_I P [4:0]	00000	DRC1 Input signal level at the Noise Gate threshold 'Knee2'.
DRC1 ctrl5				00000 = -36dB
				00001 = -37.5dB
				00010 = -39dB
				(-1.5dB steps)
				11110 = -81dB
				11111 = -82.5dB
				Only applicable when DRC1_NG_ENA = 1.
	4:0	DRC1_KNEE2_ OP [4:0]	00000	DRC1 Output signal at the Noise Gate threshold 'Knee2'.
				00000 = -30dB
				00001 = -31.5dB
				00010 = -33dB
				(-1.5dB steps)
				11110 = -75dB
				11111 = -76.5dB
				Only applicable when DRC1_KNEE2_OP_ENA = 1.

Table 14 DRC1 Control Registers

The WM5102 performs automatic checks to confirm that the SYSCLK frequency is high enough to support the commanded DRC and digital mixing functions. If an attempt is made to enable a DRC signal path, and there are insufficient SYSCLK cycles to support it, then the attempt will be unsuccessful. (Note that any signal paths that are already active will not be affected under these circumstances.)

The Underclocked Error can be monitored using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.

The FX_STS field in Register R3585 indicates the status of each of the EQ, DRC and LHPF signal paths. If an Underclocked Error condition occurs, then this register provides readback of which EQ, DRC or LHPF signal path(s) have been successfully enabled.

The status bits in Registers R1600 to R2920 indicate the status of each of the digital mixers. If an Underclocked Error condition occurs, then these bits provide readback of which mixer(s) have been successfully enabled.

LOW PASS / HIGH PASS DIGITAL FILTER (LHPF)

The digital core provides four Low Pass Filter (LPF) / High Pass Filter (HPF) processing blocks as illustrated in Figure 32. A 4-input mixer is associated with each filter. The 4 input sources are selectable in each case, and independent volume control is provided for each path. Each Low/High Pass Filter (LHPF) block supports 1 output.

The Low Pass Filter / High Pass Filter can be used to remove unwanted 'out of band' noise from a signal path. Each filter can be configured either as a Low Pass filter or High Pass filter.

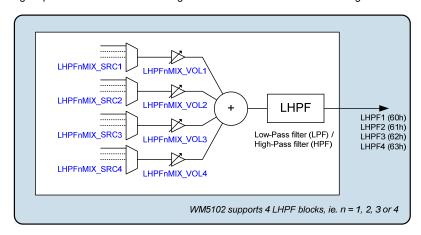


Figure 32 Digital Core LPF/HPF Blocks

The LHPF1, LHPF2, LHPF3 and LHPF4 mixer control registers (see Figure 32) are located at register addresses R2304 (900h) through to R2335 (91Fh).

The full list of digital mixer control registers is provided in the "Register Map" section (Register R1600 through to R2920). Generic register definitions are provided in Table 7.

The *_SRCn registers select the input source(s) for the respective LHPF processing blocks. Note that the selected input source(s) must be configured for the same sample rate as the LHPF to which they are connected. Sample rate conversion functions are available to support flexible interconnectivity - see "Asynchronous Sample Rate Converter (ASRC)" and "Isochronous Sample Rate Converter (ISRC)".

The bracketed numbers in Figure 32, eg. "(60h)" indicate the corresponding *_SRCn register setting for selection of that signal as an input to another digital core function.

The sample rate for the LHPF function is configured using the FX_RATE register - see Table 21. Note that the EQ, DRC and LHPF functions must all be configured for the same sample rate.

The LHPF function supports audio sample rates in the range 8kHz to 192kHz. When the DRC is enabled, the maximum sample rate for the EQ, DRC and LHPF functions is 96kHz.

Sample rate conversion is required when routing the LHPF signal paths to any signal chain that is asynchronous and/or configured for a different sample rate.

The control registers associated with the LHPF functions are described in Table 15.

The cut-off frequencies for the LHPF blocks are set using the coefficients held in registers R3777, R3781, R3785 and R3789 for LHPF1, LHPF2, LHPF3 and LHPF4 respectively. These coefficients are derived using tools provided in Wolfson's WISCE™ evaluation board control software; please contact your local Wolfson representative for more details.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3585 (0E01h) FX_Ctrl2	15:4	FX_STS [11:0]	000h	LHPF, DRC, EQ Enable Status Indicates the status of each of the respective signal processing functions. [11] = EQ4 [10] = EQ3 [9] = EQ2 [8] = EQ1 [7] = Reserved [6] = Reserved [5] = DRC1 (Right) [4] = DRC1 (Left) [3] = LHPF4 [2] = LHPF3 [1] = LHPF2 [0] = LHPF1 Each bit is coded as: 0 = Disabled
R3776 (0EC0h) HPLPF1_	1	LHPF1_MODE	0	1 = Enabled Low/High Pass Filter 1 Mode 0 = Low-Pass 1 = High-Pass
1	0	LHPF1_ENA	0	Low/High Pass Filter 1 Enable 0 = Disabled 1 = Enabled
R3777 (0EC1h) HPLPF1_ 2	15:0	LHPF1_COEFF [15:0]	0000h	Low/High Pass Filter 1 Frequency Coefficient Refer to WISCE evaluation board control software for the derivation of this field value.
R3780 (0EC4h) HPLPF2_	1	LHPF2_MODE	0	Low/High Pass Filter 2 Mode 0 = Low-Pass 1 = High-Pass
1	0	LHPF2_ENA	0	Low/High Pass Filter 2 Enable 0 = Disabled 1 = Enabled
R3781 (0EC5h) HPLPF2_ 2	15:0	LHPF2_COEFF [15:0]	0000h	Low/High Pass Filter 2 Frequency Coefficient Refer to WISCE evaluation board control software for the derivation of this field value.
R3784 (0EC8h) HPLPF3_	1	LHPF3_MODE	0	Low/High Pass Filter 3 Mode 0 = Low-Pass 1 = High-Pass
1	0	LHPF3_ENA	0	Low/High Pass Filter 3 Enable 0 = Disabled 1 = Enabled
R3785 (0EC9h) HPLPF3_ 2	15:0	LHPF3_COEFF [15:0]	0000h	Low/High Pass Filter 3 Frequency Coefficient Refer to WISCE evaluation board control software for the derivation of this field value.
R3788 (0ECCh) HPLPF4_	1	LHPF4_MODE	0	Low/High Pass Filter 4 Mode 0 = Low-Pass 1 = High-Pass



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
1	0	LHPF4_ENA	0	Low/High Pass Filter 4 Enable
				0 = Disabled
				1 = Enabled
R3789 (0ECDh)	15:0	LHPF4_COEFF [15:0]	0000h	Low/High Pass Filter 4 Frequency Coefficient
HPLPF4_ 2				Refer to WISCE evaluation board control software for the derivation of this field value.

Table 15 Low Pass Filter / High Pass Filter Control

The WM5102 performs automatic checks to confirm that the SYSCLK frequency is high enough to support the commanded LHPF and digital mixing functions. If an attempt is made to enable an LHPF signal path, and there are insufficient SYSCLK cycles to support it, then the attempt will be unsuccessful. (Note that any signal paths that are already active will not be affected under these circumstances.)

The Underclocked Error can be monitored using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.

The FX_STS field in Register R3585 indicates the status of each of the EQ, DRC and LHPF signal paths. If an Underclocked Error condition occurs, then this register provides readback of which EQ, DRC or LHPF signal path(s) have been successfully enabled.

The status bits in Registers R1600 to R2920 indicate the status of each of the digital mixers. If an Underclocked Error condition occurs, then these bits provide readback of which mixer(s) have been successfully enabled.

WM5102

DIGITAL CORE DSP

The digital core incorporates a programmable DSP block, as illustrated in Figure 33. The DSP supports 8 inputs (Left, Right, Aux1, Aux2, ... Aux6). A 4-input mixer is associated with the Left and Right inputs, providing further expansion of the number of input paths. Each of the input sources is selectable, and independent volume control is provided for Left and Right input mixer channels. The DSP block supports 6 outputs.

The functionality of the DSP is not fixed, and a wide range of audio enhancements algorithms may be performed. The procedure for configuring the WM5102 DSP functions is tailored to each customer's application; please contact your local Wolfson representative for more details.

For details of the DSP Firmware requirements relating to clocking, register access, and code execution, refer to the "DSP Firmware Control" section.

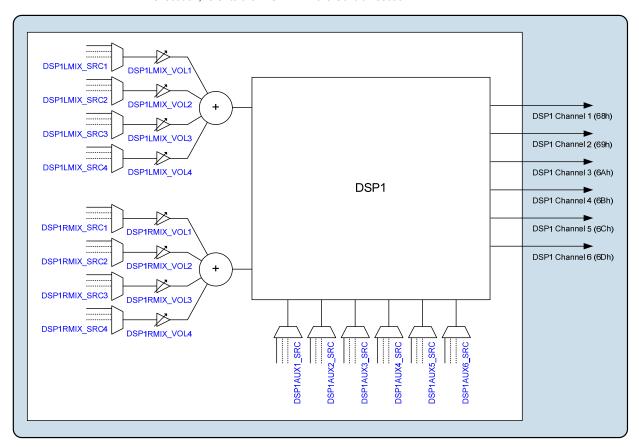


Figure 33 Digital Core DSP Block

The DSP1 mixer / input control registers (see Figure 33) are located at register addresses R2368 (940h) through to R2383 (094Fh).

The full list of digital mixer control registers is provided in the "Register Map" section (Register R1600 through to R2920). Generic register definitions are provided in Table 7.

The *_SRCn registers select the input source(s) for the DSP1 block. Note that the selected input source(s) must be configured for the same sample rate as the DSP to which they are connected. Sample rate conversion functions are available to support flexible interconnectivity - see "Asynchronous Sample Rate Converter (ASRC)" and "Isochronous Sample Rate Converter (ISRC)".

The bracketed numbers in Figure 33, eg. "(68h)" indicate the corresponding *_SRCn register setting for selection of that signal as an input to another digital core function.

The sample rate of the DSP input/output is configured using the DSP1_RATE register - see Table 21. Sample rate conversion is required when routing the DSP1 signal paths to any signal chain that is asynchronous and/or configured for a different sample rate.



The WM5102 performs automatic checks to confirm that the SYSCLK frequency is high enough to support the commanded DSP mixing functions. If an attempt is made to enable a DSP mixer path, and there are insufficient SYSCLK cycles to support it, then the attempt will be unsuccessful. (Note that any signal paths that are already active will not be affected under these circumstances.)

The Underclocked Error condition can be monitored using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.

The status bits in Registers R1600 to R2920 indicate the status of each of the digital mixers. If an Underclocked Error condition occurs, then these bits provide readback of which mixer(s) have been successfully enabled.

The WM5102 supports two DSP Status flags as outputs from the DSP. These are configurable within the DSP to provide external indication of the required function(s). The DSP Status flags can be read using the DSP_IRQn_STS registers described in Table 96 (see "Interrupts").

The DSP Status flags are inputs to the Interrupt control circuit and can be used to trigger an interrupt event - see "Interrupts".

The DSP Status flags can be output directly on a GPIO pin as an external indication of the DSP Status. See "General Purpose Input / Output" to configure a GPIO pin for this function.

The DSP_IRQn_STS fields are read-only bits. These bits can be set (or reset) by writing to the DSP_IRQn fields, as described in Table 16. This facility can be used to allow the DSP core to generate an interrupt to the host processor. The DSP interrupt registers are asserted on the rising and falling edges of the respective DSP_IRQn fields.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3393 (0D41h)	1	DSP_IRQ2	0	DSP IRQ2 0 = Not asserted
ADSP2				1 = Asserted
IRQ0				This bit can be set/reset by a DSP core in order to generate a DSP_IRQ2_EINTn interrupt to the host processor.
	0	DSP_IRQ1	0	DSP IRQ1
				0 = Not asserted
				1 = Asserted
				This bit can be set/reset by a DSP core in order to generate a DSP_IRQ1_EINTn interrupt to the host processor.

Table 16 DSP Interrupts



TONE GENERATOR

The WM5102 incorporates two 1kHz tone generators which can be used for 'beep' functions through any of the audio signal paths. The phase relationship between the two generators is configurable, providing flexibility in creating differential signals, or for test scenarios.

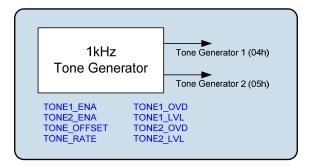


Figure 34 Digital Core Tone Generator

The tone generators can be selected as input to any of the digital mixers or signal processing functions within the WM5102 digital core. The bracketed numbers in Figure 34, eg. "(04h)" indicate the corresponding *_SRCn register setting for selection of that signal as an input to another digital core function.

The sample rate for the tone generators is configured using the TONE_RATE register - see Table 21. Note that sample rate conversion is required when routing the tone generator output(s) to any signal chain that is asynchronous and/or configured for a different sample rate.

The tone generators are enabled using the TONE1_ENA and TONE2_ENA register bits as described in Table 17. The phase relationship is configured using TONE_OFFSET.

The tone generators can also provide a configurable DC signal level, for use as a test signal. The DC output is selected using the TONEn_OVD register bits, and the DC signal amplitude is configured using the TONEn_LVL registers, as described in Table 17.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R32 (0020h) Tone Generator 1	9:8	TONE_OFFSET [1:0]	00	Tone Generator Phase Offset Sets the phase of Tone Generator 2 relative to Tone Generator 1 00 = 0 degrees (in phase) 01 = 90 degrees ahead 10 = 180 degrees ahead 11 = 270 degrees ahead
	5	TONE2_OVD	0	Tone Generator 2 Override 0 = Disabled (1kHz tone output) 1 = Enabled (DC signal output) The DC signal level, when selected, is configured using TONE2_LVL[23:0]
	4	TONE1_OVD	0	Tone Generator 1 Override 0 = Disabled (1kHz tone output) 1 = Enabled (DC signal output) The DC signal level, when selected, is configured using TONE1_LVL[23:0]
	1	TONE2_ENA	0	Tone Generator 2 Enable 0 = Disabled 1 = Enabled
	0	TONE1_ENA	0	Tone Generator 1 Enable 0 = Disabled 1 = Enabled
R33 (0021h) Tone Generator 2	15:0	TONE1_LVL [23:8]	1000h	Tone Generator 1 DC output level TONE1_LVL [23:8] is coded as 2's complement. Bits [23:20] contain the integer portion; bits [19:0] contain the fractional portion. The digital core 0dBFS level corresponds
R34 (0022h) Tone Generator 3	7:0	TONE1_LVL [7:0]	00h	to 1000_00h (+1) or F000_00h (-1). Tone Generator 1 DC output level TONE1_LVL [23:8] is coded as 2's complement. Bits [23:20] contain the integer portion; bits [19:0] contain the fractional portion. The digital core 0dBFS level corresponds to 1000_00h (+1) or F000_00h (-1).
R35 (0023h) Tone Generator 4	15:0	TONE2_LVL [23:8]	1000h	Tone Generator 2 DC output level TONE2_LVL [23:8] is coded as 2's complement. Bits [23:20] contain the integer portion; bits [19:0] contain the fractional portion. The digital core 0dBFS level corresponds to 1000_00h (+1) or F000_00h (-1).
R36 (0024h) Tone Generator 5	7:0	TONE2_LVL [7:0]	00h	Tone Generator 2 DC output level TONE2_LVL [23:8] is coded as 2's complement. Bits [23:20] contain the integer portion; bits [19:0] contain the fractional portion. The digital core 0dBFS level corresponds to 1000_00h (+1) or F000_00h (-1).

Table 17 Tone Generator Control



NOISE GENERATOR

The WM5102 incorporates a white noise generator, which can be routed within the digital core. The main purpose of the noise generator is to provide 'comfort noise' in cases where silence (digital mute) is not desirable.

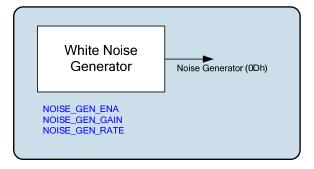


Figure 35 Digital Core Noise Generator

The noise generator can be selected as input to any of the digital mixers or signal processing functions within the WM5102 digital core. The bracketed number (0Dh) in Figure 35 indicates the corresponding *_SRCn register setting for selection of the noise generator as an input to another digital core function.

The sample rate for the noise generator is configured using the NOISE_GEN_RATE register - see Table 21. Note that sample rate conversion is required when routing the noise generator output to any signal chain that is asynchronous and/or configured for a different sample rate.

The noise generator is enabled using the NOISE_GEN_ENA register bit as described in Table 18. The signal level is configured using NOISE_GEN_GAIN.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R112	5	NOISE_GEN_EN	0	Noise Generator Enable
(0070h)		Α		0 = Disabled
Comfort				1 = Enabled
Noise Generator	4:0	NOISE_GEN_GA	00h	Noise Generator Signal Level
Generator		IN [4:0]		00h = -114dBFS
				01h = -108dBFS
				02h = -102dBFS
				(6dB steps)
				11h = -6dBFS
				12h = 0dBFS
				All other codes are Reserved

Table 18 Noise Generator Control

HAPTIC SIGNAL GENERATOR

The WM5102 incorporates a signal generator for use with haptic devices (eg. mechanical vibration actuators). The haptic signal generator is compatible with both Eccentric Rotating Mass (ERM) and Linear Resonant Actuator (LRA) haptic devices.

The haptic signal generator is highly configurable, and includes the capability to execute a programmable event profile comprising three distinct operating phases.

The resonant frequency of the haptic signal output (for LRA devices) is selectable, providing support for many different actuator components.

The haptic signal generator is a digital signal generator which is incorporated within the digital core of the WM5102. The haptic signal may be routed, via one of the digital core output mixers, to a Class D speaker output for connection to the external haptic device, as illustrated in Figure 36. (Note that the digital PDM output paths may also be used for haptic signal output.)

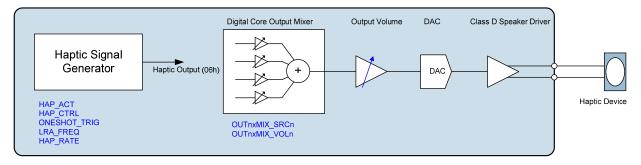


Figure 36 Digital Core Haptic Signal Generator

The bracketed number (06h) in Figure 36 indicates the corresponding *_SRCn register setting for selection of the haptic signal generator as an input to another digital core function.

The haptic signal generator is selected as input to one of the digital core output mixers by setting the *_SRCn register of the applicable output mixer to (06h).

The sample rate for the haptic signal generator is configured using the HAP_RATE register - see Table 21. Note that sample rate conversion is required when routing the haptic signal generator output to any signal chain that is asynchronous and/or configured for a different sample rate.

The haptic signal generator is configured for an ERM or LRA actuator using the HAP_ACT register bit. The required resonant frequency is configured using the LRA_FREQ field. (Note that the resonant frequency is only applicable to LRA actuators.)

The signal generator can be enabled in Continuous mode or configured for One-Shot mode using the HAP_CTRL register, as described in Table 19. In One-Shot mode, the output is triggered by writing to the ONESHOT_TRIG bit.

In One-Shot mode, the signal generator profile comprises the distinct phases (1, 2, 3). The duration and intensity of each output phase is programmable.

In Continuous mode, the signal intensity is controlled using the PHASE2_INTENSITY field only.

In the case of an ERM actuator (HAP_ACT = 0), the haptic output is a DC signal level, which may be positive or negative, as selected by the *_INTENSITY registers.

For an LRA actuator (HAP_ACT = 1), the haptic output is an AC signal; selecting a negative signal level corresponds to a 180 degree phase inversion. In some applications, phase inversion may be desirable during the final phase, to halt the physical motion of the haptic device.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R144 (0090h) Haptics	4	ONESHOT_TRIG	0	Haptic One-Shot Trigger Writing '1' starts the one-shot profile (ie. Phase 1, Phase 2, Phase 3)
Control 1	3:2	HAP_CTRL [1:0]	00	Haptic Signal Generator Control 00 = Disabled 01 = Continuous 10 = One-Shot 11 = Reserved
	1	HAP_ACT	0	Haptic Actuator Select 0 = Eccentric Rotating Mass (ERM) 1 = Linear Resonant Actuator (LRA)
R145 (0091h) Haptics Control 2	14:0	LRA_FREQ [14:0]	7FFFh	Haptic Resonant Frequency Selects the haptic signal frequency (LRA actuator only, HAP_ACT = 1) Haptic Frequency (Hz) = System Clock / (2 x (LRA_FREQ+1)) where System Clock = 6.144MHz or 5.6448MHz, derived by division from SYSCLK or ASYNCCLK. If HAP_RATE<1000, then SYSCLK is the clock source, and the applicable System Clock frequency is determined by SYSCLK. If HAP_RATE>=1000, then ASYNCCLK is the clock source, and the applicable System Clock frequency is determined by ASYNCCLK. Valid for Haptic Frequency in the range 100Hz to 250Hz For 6.144MHz System Clock: 77FFh = 100Hz 4491h = 175Hz 2FFFh = 250Hz For 5.6448MHz System Clock: 6E3Fh = 100Hz
R146 (0092h) Haptics phase 1 intensity	7:0	PHASE1_INTEN SITY [7:0]	00h	3EFFh = 175Hz 2C18h = 250Hz Haptic Output Level (Phase 1) Selects the signal intensity of Phase 1 in one-shot mode. Coded as 2's complement. Range is +/- Full Scale (FS). For ERM actuator, this selects the DC signal level for the haptic output. For LRA actuator, this selects the AC peak amplitude; Negative values correspond to a 180 degree phase shift.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R147 (0093h) Haptics Control phase 1 duration	8:0	PHASE1_DURAT ION [8:0]	000h	Haptic Output Duration (Phase 1) Selects the duration of Phase 1 in one- shot mode. 000h = 0ms 001h = 0.625ms 002h = 1.25ms (0.625ms steps) 1FFh = 319.375ms
R148 (0094h) Haptics phase 2 intensity	7:0	PHASE2_INTEN SITY [7:0]	00h	Haptic Output Level (Phase 2) Selects the signal intensity in Continuous mode or Phase 2 of one-shot mode. Coded as 2's complement. Range is +/- Full Scale (FS). For ERM actuator, this selects the DC signal level for the haptic output. For LRA actuator, this selects the AC peak amplitude; Negative values correspond to a 180 degree phase shift.
R149 (0095h) Haptics phase 2 duration	10:0	PHASE2_DURAT ION [10:0]	000h	Haptic Output Duration (Phase 2) Selects the duration of Phase 2 in one- shot mode. 000h = 0ms 001h = 0.625ms 002h = 1.25ms (0.625ms steps) 7FFh = 1279.375ms
R150 (0096h) Haptics phase 3 intensity	7:0	PHASE3_INTEN SITY [7:0]	00h	Haptic Output Level (Phase 3) Selects the signal intensity of Phase 3 in one-shot mode. Coded as 2's complement. Range is +/- Full Scale (FS). For ERM actuator, this selects the DC signal level for the haptic output. For LRA actuator, this selects the AC peak amplitude; Negative values correspond to a 180 degree phase shift.
R151 (0097h) Haptics phase 3 duration	8:0	PHASE3_DURAT ION [8:0]	000h	Haptic Output Duration (Phase 3) Selects the duration of Phase 3 in one- shot mode. 000h = 0ms 001h = 0.625ms 002h = 1.25ms (0.625ms steps) 1FFh = 319.375ms
R152 (0098h) Haptics Status	0	ONESHOT_STS	0	Haptic One-Shot status 0 = One-Shot event not in progress 1 = One-Shot event in progress

Table 19 Haptic Signal Generator Control



PWM GENERATOR

The WM5102 incorporates two Pulse Width Modulation (PWM) signal generators as illustrated in Figure 37. The duty cycle of each PWM signal can be modulated by an audio source, or can be set to a fixed value using a control register setting.

A 4-input mixer is associated with each PWM generator. The 4 input sources are selectable in each case, and independent volume control is provided for each path.

The PWM signal generators can be output directly on a GPIO pin. See "General Purpose Input / Output" to configure a GPIO pin for this function.

Note that the PWM signal generators cannot be selected as input to the digital mixers or signal processing functions within the WM5102 digital core.

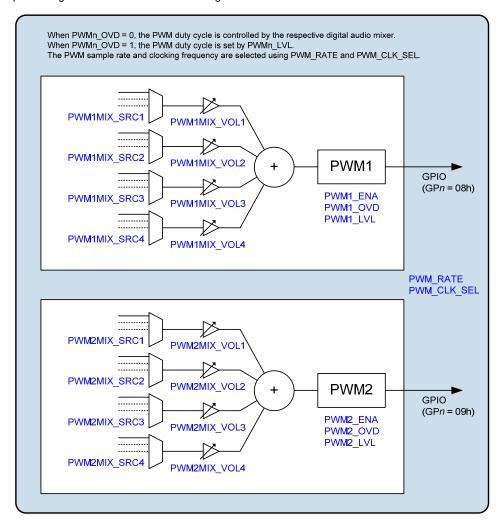


Figure 37 Digital Core Pulse Width Modulation (PWM) Generator

The PWM1 and PWM2 mixer control registers (see Figure 37) are located at register addresses R1600 (640h) through to R1615 (64Fh).

The full list of digital mixer control registers is provided in the "Register Map" section (Register R1600 through to R2920). Generic register definitions are provided in Table 7.

The *_SRCn registers select the input source(s) for the respective mixers. Note that the selected input source(s) must be configured for the same sample rate as the mixer to which they are connected. Sample rate conversion functions are available to support flexible interconnectivity - see "Asynchronous Sample Rate Converter (ASRC)" and "Isochronous Sample Rate Converter (ISRC)".



The PWM sample rate (cycle time) is configured using the PWM_RATE register - see Table 21. Note that sample rate conversion is required when linking the PWM generators to any signal chain that is asynchronous and/or configured for a different sample rate.

The PWM generators are enabled using PWM1_ENA and PWM2_ENA respectively, as described in Table 20.

Under default conditions (PWMn_OVD = 0), the duty cycle of the PWM generators is controlled by an audio signal path; a 4-input mixer is associated with each PWM generator, as illustrated in Figure 37.

When the PWMn_OVD bit is set, the duty cycle of the respective PWM generator is set to a fixed ratio; in this case, the duty cycle ratio is configurable using the PWMn_LVL registers.

The PWM generator clock frequency is selected using PWM_CLK_SEL. For best performance, this register should be set to the highest available setting. Note that the PWM generator clock must not be set to a higher frequency than SYSCLK (if PWM_RATE<1000) or ASYNCCLK (if PWM_RATE≥1000).

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R48 (0030h)	10:8	PWM CLK SEL	000	PWM Clock Select
PWM Drive		[2:0]		000 = 6.144MHz (5.6448MHz)
1				001 = 12.288MHz (11.2896MHz)
				010 = 24.576MHz (22.5792MHz)
				All other codes are Reserved
				The frequencies in brackets apply for 44.1kHz-related sample rates only.
				PWM_CLK_SEL controls the resolution of the PWM generator; higher settings correspond to higher resolution.
				The PWM Clock must be less than or equal to SYSCLK (if PWM_RATE<1000) or less than or equal to ASYNCCLK (if PWM_RATE>=1000).
	5	PWM2_OVD	0	PWM2 Generator Override
				0 = Disabled (PWM duty cycle is
				controlled by audio source)
				1 = Enabled (PWM duty cycle is controlled by PWM2_LVL).
	4	PWM1_OVD	0	PWM1 Generator Override
				0 = Disabled (PWM1 duty cycle is controlled by audio source)
				1 = Enabled (PWM1 duty cycle is controlled by PWM1 LVL).
	1	PWM2_ENA	0	PWM2 Generator Enable
		_		0 = Disabled
				1 = Enabled
	0	PWM1_ENA	0	PWM1 Generator Enable
				0 = Disabled
				1 = Enabled
R49 (0031h)	9:0	PWM1_LVL [9:0]	100h	PWM1 Override Level
PWM Drive 2				Sets the PWM1 duty cycle when PWM1_OVD=1.
				Coded as 2's complement.
				000h = 50% duty cycle
				100h = 0% duty cycle



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R50 (0032h)	9:0	PWM2_LVL [9:0]	100h	PWM2 Override Level
PWM Drive 3				Sets the PWM2 duty cycle when PWM2_OVD=1.
				Coded as 2's complement.
				000h = 50% duty cycle
				100h = 0% duty cycle

Table 20 Pulse Width Modulation (PWM) Generator Control

The WM5102 performs automatic checks to confirm that the SYSCLK frequency is high enough to support the digital mixer paths. If an attempt is made to enable a PWM signal mixer path, and there are insufficient SYSCLK cycles to support it, then the attempt will be unsuccessful. (Note that any signal paths that are already active will not be affected under these circumstances.)

The Underclocked Error condition can be monitored using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.

The status bits in Registers R1600 to R2920 indicate the status of each of the digital mixers. If an Underclocked Error condition occurs, then these bits provide readback of which mixer(s) have been successfully enabled.

SAMPLE RATE CONTROL

The WM5102 supports multiple signal paths through the digital core. Stereo full-duplex sample rate conversion is provided to allow digital audio to be routed between interfaces operating at different sample rates and/or referenced to asynchronous clock domains.

Two independent clock domains are supported, referenced to SYSCLK and ASYNCCLK respectively, as described in "Clocking and Sample Rates". Every digital signal path must be synchronised either to SYSCLK or to ASYNCCLK.

Up to five different sample rates may be in use at any time on the WM5102. Three of these sample rates must be synchronised to SYSCLK; the remaining two, where required, must be synchronised to ASYNCCLK.

Sample rate conversion is required when routing any audio path between digital functions that are asynchronous and/or configured for different sample rates.

The Asynchronous Sample Rate Converter (ASRC) provides two stereo signal paths between the SYSCLK and ASYNCCLK domains. The ASRC is described later, and is illustrated in Figure 40.

There are two Isochronous Sample Rate Converters (ISRCs). These provide two signal paths each between sample rates on the SYSCLK domain, or between sample rates on the ASYNCCLK domain. The ISRCs are described later, and are illustrated in Figure 41.

The sample rate of different blocks within the WM5102 digital core are controlled as illustrated in Figure 38 and Figure 39 - the *_RATE registers select the applicable sample rate for each respective group of digital functions.



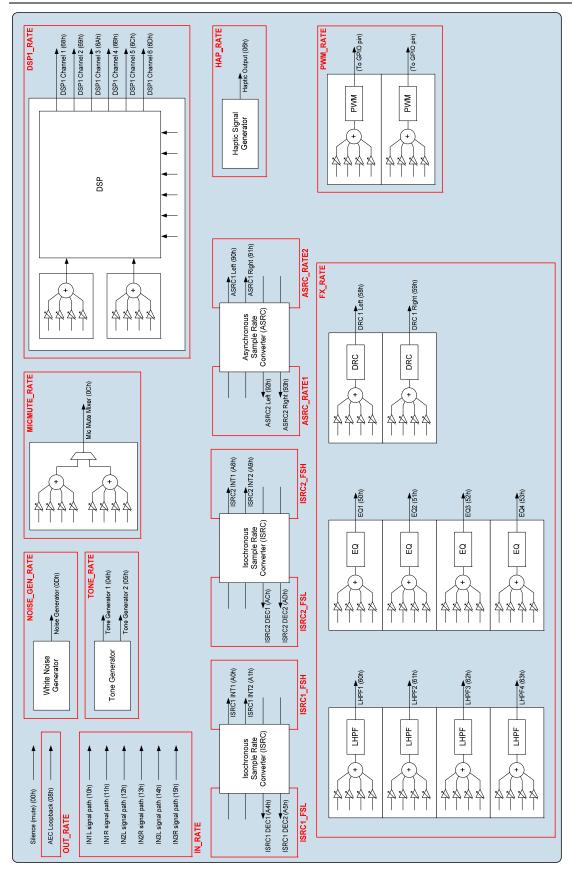


Figure 38 Digital Core Sample Rate Control (Internal Signal Processing)

WM5102 Production Data

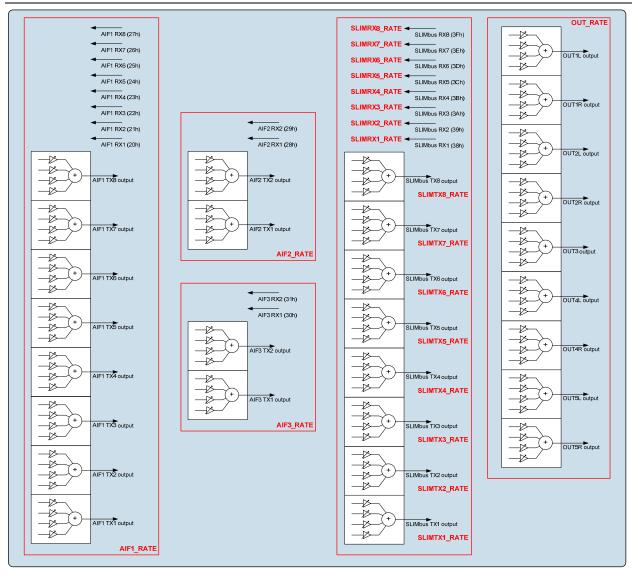


Figure 39 Digital Core Sample Rate Control (External Digital Interfaces)

The input signal paths may be selected as input to the digital mixers or signal processing functions. The sample rate for the input signal paths is configured using the IN RATE register.

The output signal paths are derived from the respective output mixers. The sample rate for the output signal paths is configured using the OUT_RATE register. The sample rate of the AEC Loopback path is also set by the OUT_RATE register.

The AIFn RX inputs may be selected as input to the digital mixers or signal processing functions. The AIFn TX outputs are derived from the respective output mixers. The sample rates for digital audio interfaces (AIF1, AIF2 and AIF3) are configured using the AIF1_RATE, AIF2_RATE and AIF3_RATE registers respectively.

The SLIMbus interface supports up to 8 input channels and 8 output channels. The sample rate of each channel can be configured independently, using the SLIMTXn_RATE and SLIMRXn_RATE registers.

Note that the SLIMbus interface provides simultaneous support for SYSCLK-referenced and ASYNCCLK-referenced sample rates on different channels. For example, 48kHz and 44.1kHz SLIMbus audio paths can be simultaneously supported.



The EQ, LHPF and DRC functions can be enabled in any signal path within the digital core. The sample rate for these functions is configured using the FX_RATE register. Note that the EQ, DRC and LHPF functions must all be configured for the same sample rate.

The DSP functions can be enabled in any signal path within the digital core. The applicable sample rates are configured using the DSP1 RATE register.

The tone generators and noise generator can be selected as input to any of the digital mixers or signal processing functions. The sample rates for these sources are configured using the TONE_RATE and NOISE_GEN_RATE registers respectively.

The haptic signal generator can be used to control an external vibe actuator, which can be driven directly by the Class D speaker output. The sample rate for the haptic signal generator is configured using the HAP_RATE register.

The PWM signal generators can be modulated by an audio source, derived from the associated signal mixers. The sample rate (cycle time) for the PWM signal generators is configured using the PWM_RATE register.

The sample rate control registers are described in Table 21. Refer to the register descriptions for details of the valid selections in each case. Note that the input (ADC) and output (DAC) signal paths must always be associated with the SYSCLK clocking domain and are therefore synchronous to each other.

The control registers associated with the ASRC and ISRCs are described in Table 22 and Table 23 respectively within the following sections.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R32 (0020h) Tone Generator 1	14:11	TONE_RATE [3:0]	0000	Tone Generator Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 8kHz to 192kHz.
R48 (0030h) PWM Drive 1	14:11	PWM_RATE [3:0]	0000	PWM Frequency (sample rate) 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 4kHz to 192kHz.
R112 0070h) Comfort Noise Generator	14:11	NOISE_GEN_RA TE [3:0]	0000	Noise Generator Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 4kHz to 192kHz.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R144 0090h) Haptics Control 1	14:11	HAP_RATE [3:0]	0000	Haptic Signal Generator Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3
				1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved.
				The selected sample rate is valid in the range 8kHz to 192kHz.
R707 (02C3h) Mic noise mix control	14:11	MICMUTE_RATE [3:0]	0000	Mic Mute Mixer Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved.
				The selected sample rate is valid in the range 8kHz to 192kHz.
R776 (0308h) Input Rate	14:11	IN_RATE [3:0]	0000	Input Signal Paths Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 All other codes are Reserved. The selected sample rate is valid in the range 8kHz to 192kHz.
R1032 (0408h) Output Rate 1	14:11	OUT_RATE [3:0]	0000	Output Signal Paths Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 All other codes are Reserved. The selected sample rate is valid in the range 8kHz to 192kHz.
R1283 (0503h) AIF1 Rate Ctrl	3:0	AIF1_RATE [3:0]	0000	AIF1 Audio Interface Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 4kHz to 192kHz.
R1347 (0543h) AIF2 Rate Ctrl	3:0	AIF2_RATE [3:0]	0000	AIF2 Audio Interface Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 4kHz to 192kHz.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1411	3:0	AIF3_RATE [3:0]	0000	AIF3 Audio Interface Sample Rate
(0583h)	0.0	/ o a = [o.o]		0000 = SAMPLE RATE 1
AIF3 Rate				0001 = SAMPLE RATE 2
Ctrl				0010 = SAMPLE RATE 3
				1000 = ASYNC_SAMPLE_RATE_1
				1001 = ASYNC_SAMPLE_RATE_2
				All other codes are Reserved.
				The selected sample rate is valid in the range 4kHz to 192kHz.
R1509	14:11	SLIMRX2_RATE	0000	SLIMbus RX Channel 2 Sample Rate
(05E5h)		[3:0]		0000 = SAMPLE_RATE_1
SLIMbus				0001 = SAMPLE_RATE_2
Rates 1				0010 = SAMPLE_RATE_3
				1000 = ASYNC_SAMPLE_RATE_1
				1001 = ASYNC_SAMPLE_RATE_2
				All other codes are Reserved.
				The selected sample rate is valid in the range 4kHz to 192kHz.
	6:3	SLIMRX1_RATE	0000	SLIMbus RX Channel 1 Sample Rate
		[3:0]		0000 = SAMPLE_RATE_1
				0001 = SAMPLE_RATE_2
				0010 = SAMPLE_RATE_3
				1000 = ASYNC_SAMPLE_RATE_1
				1001 = ASYNC_SAMPLE_RATE_2
				All other codes are Reserved.
				The selected sample rate is valid in the range 4kHz to 192kHz.
R1510	14:11	SLIMRX4_RATE	0000	SLIMbus RX Channel 4 Sample Rate
(05E6h)		[3:0]		0000 = SAMPLE_RATE_1
SLIMbus				0001 = SAMPLE_RATE_2
Rates 2				0010 = SAMPLE_RATE_3
				1000 = ASYNC_SAMPLE_RATE_1
				1001 = ASYNC_SAMPLE_RATE_2
				All other codes are Reserved.
				The selected sample rate is valid in the
		01.11.12.10		range 4kHz to 192kHz.
	6:3	SLIMRX3_RATE [3:0]	0000	SLIMbus RX Channel 3 Sample Rate
		[5.0]		0000 = SAMPLE_RATE_1
				0001 = SAMPLE_RATE_2
				0010 = SAMPLE_RATE_3
				1000 = ASYNC_SAMPLE_RATE_1
				1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved.
				The selected sample rate is valid in the
DATA		OLUMBYO DATE		range 4kHz to 192kHz.
R1511 (05E7h)	14:11	SLIMRX6_RATE [3:0]	0000	SLIMbus RX Channel 6 Sample Rate
SLIMbus		[5.0]		0000 = SAMPLE_RATE_1
Rates 3				0001 = SAMPLE_RATE_2
				0010 = SAMPLE_RATE_3
				1000 = ASYNC_SAMPLE_RATE_1
				1001 = ASYNC_SAMPLE_RATE_2
				All other codes are Reserved.
				The selected sample rate is valid in the range 4kHz to 192kHz.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	6:3	SLIMRX5_RATE [3:0]	0000	SLIMbus RX Channel 5 Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 4kHz to 192kHz.
R1512 (05E8h) SLIMbus Rates 4	14:11	SLIMRX8_RATE [3:0]	0000	SLIMbus RX Channel 8 Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 4kHz to 192kHz.
	6:3	SLIMRX7_RATE [3:0]	0000	SLIMbus RX Channel 7 Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 4kHz to 192kHz.
R1513 (05E9h) SLIMbus Rates 5	14:11	SLIMTX2_RATE [3:0]	0000	SLIMbus TX Channel 2 Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 4kHz to 192kHz.
	6:3	SLIMTX1_RATE [3:0]	0000	SLIMbus TX Channel 1 Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 4kHz to 192kHz.
R1514 (05EAh) SLIMbus Rates 6	14:11	SLIMTX4_RATE [3:0]	0000	SLIMbus TX Channel 4 Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 4kHz to 192kHz.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	6:3	SLIMTX3_RATE [3:0]	0000	SLIMbus TX Channel 3 Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 4kHz to 192kHz.
R1515 (05EBh) SLIMbus Rates 7	14:11	SLIMTX6_RATE [3:0]	0000	SLIMbus TX Channel 6 Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 4kHz to 192kHz.
	6:3	SLIMTX5_RATE [3:0]	0000	SLIMbus TX Channel 5 Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 4kHz to 192kHz.
R1516 (05ECh) SLIMbus Rates 8	14:11	SLIMTX8_RATE [3:0]	0000	SLIMbus TX Channel 8 Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 4kHz to 192kHz.
	6:3	SLIMTX7_RATE [3:0]	0000	SLIMbus TX Channel 7 Sample Rate 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 4kHz to 192kHz.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3584	15:12	FX_RATE [3:0]	0000	FX Sample Rate (EQ, LHPF, DRC)
(0E00h)				0000 = SAMPLE_RATE_1
FX_Ctrl				0001 = SAMPLE_RATE_2
				0010 = SAMPLE_RATE_3
				1000 = ASYNC_SAMPLE_RATE_1
				1001 = ASYNC_SAMPLE_RATE_2
				All other codes are Reserved.
				The selected sample rate is valid in the range 8kHz to 192kHz.
				When the DRC is enabled, the maximum FX_RATE sample rate is 96kHz.
R4352	15:12	DSP1_RATE [3:0]	0000	DSP1 Sample Rate
(1100h)				0000 = SAMPLE_RATE_1
DSP1				0001 = SAMPLE_RATE_2
Control 1				0010 = SAMPLE_RATE_3
				1000 = ASYNC_SAMPLE_RATE_1
				1001 = ASYNC_SAMPLE_RATE_2
				All other codes are Reserved.
				The selected sample rate is valid in the range 4kHz to 192kHz.

Table 21 Digital Core Sample Rate Control

ASYNCHRONOUS SAMPLE RATE CONVERTER (ASRC)

The WM5102 supports multiple signal paths through the digital core. Two independent clock domains are supported, referenced to SYSCLK and ASYNCCLK respectively, as described in "Clocking and Sample Rates". Every digital signal path must be synchronised either to SYSCLK or to ASYNCCLK.

The Asynchronous Sample Rate Converter (ASRC) provides two stereo signal paths between the SYSCLK and ASYNCCLK domains, as illustrated in Figure 40.

The sample rate on the SYSCLK domain is selected using the ASRC_RATE1 register - the rate can be set equal to SAMPLE_RATE_1, SAMPLE_RATE_2 or SAMPLE_RATE_3.

The sample rate on the ASYNCCLK domain is selected using the ASRC_RATE2 register - the rate can be set equal to ASYNC_SAMPLE_RATE_1 or ASYNC_SAMPLE_RATE_2.

See "Clocking and Sample Rates" for details of the sample rate control registers.

The ASRC supports sample rates in the range 8kHz to 48kHz only. The applicable SAMPLE_RATE_n and ASYNC_SAMPLE_RATE_n registers must each select sample rates between 8kHz and 48kHz when any ASRC path is enabled.

The ASRC1 Left and ASRC1 Right paths convert from the SYSCLK domain to the ASYNCCLK domain. These paths are enabled using the ASRC1L_ENA and ASRC1R_ENA register bits respectively.

The ASRC2 Left and ASRC2 Right paths convert from the ASYNCCLK domain to the SYSCLK domain. These paths are enabled using the ASRC2L_ENA and ASRC2R_ENA register bits respectively.

Synchronisation (lock) between different clock domains is not instantaneous when the clocking or sample rate configurations are updated. The lock status of each ASRC path is an input to the Interrupt control circuit and can be used to trigger an Interrupt event - see "Interrupts".

The ASRC Lock status of each ASRC path can be output directly on a GPIO pin as an external indication of ASRC Lock. See "General Purpose Input / Output" to configure a GPIO pin for this function.



The WM5102 performs automatic checks to confirm that the SYSCLK or ASYNCCLK frequency is high enough to support the commanded ASRC and digital mixing functions. If an attempt is made to enable an ASRC signal path, and there are insufficient SYSCLK or ASYNCCLK cycles to support it, then the attempt will be unsuccessful. (Note that any signal paths that are already active will not be affected under these circumstances.)

The Underclocked Error can be monitored using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.

The status bits in Register R3809 indicate the status of each of the ASRC signal paths. If an Underclocked Error condition occurs, then these bits provide readback of which ASRC signal path(s) have been successfully enabled.

The status bits in Registers R1600 to R2920 indicate the status of each of the digital mixers. If an Underclocked Error condition occurs, then these bits provide readback of which mixer(s) have been successfully enabled.

The Asynchronous Sample Rate Converter (ASRC) signal paths and control registers are illustrated in Figure 40.

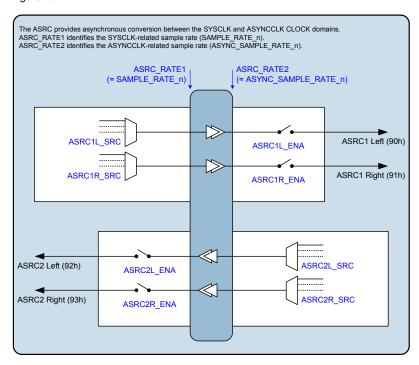


Figure 40 Asynchronous Sample Rate Converters (ASRCs)

The ASRC1 and ASRC2 input control registers (see Figure 40) are located at register addresses R2688 (A80h) through to R2712 (A98h).

The full list of digital mixer control registers is provided in the "Register Map" section (Register R1600 through to R2920). Generic register definitions are provided in Table 7.

The *_SRCn registers select the input source(s) for the respective ASRC processing blocks. Note that the selected input source(s) must be configured for the same sample rate as the ASRC to which they are connected.

The bracketed numbers in Figure 40, eg. "(90h)" indicate the corresponding *_SRCn register setting for selection of that signal as an input to another digital core function.

The register bits associated with the ASRCs are described in Table 22.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3808 (0EE0h) ASRC_EN ABLE	3	ASRC2L_ENA	0	ASRC2 Left Enable (Left ASRC channel from ASYNCCLK domain to SYSCLK domain) 0 = Disabled 1 = Enabled
	2	ASRC2R_ENA	0	ASRC2 Right Enable (Right ASRC channel from ASYNCCLK domain to SYSCLK domain) 0 = Disabled 1 = Enabled
	1	ASRC1L_ENA	0	ASRC1 Left Enable (Left ASRC channel from ASYNCCLK domain to SYSCLK domain) 0 = Disabled 1 = Enabled
	0	ASRC1R_ENA	0	ASRC1 Right Enable (Right ASRC channel from ASYNCCLK domain to SYSCLK domain) 0 = Disabled 1 = Enabled
R3809 (0EE1h) ASRC_ST ATUS	3	ASRC2L_ENA_S TS	0	ASRC2 Left Enable Status (Left ASRC channel from ASYNCCLK domain to SYSCLK domain) 0 = Disabled 1 = Enabled
	2	ASRC2R_ENA_S TS	0	ASRC2 Right Enable Status (Right ASRC channel from ASYNCCLK domain to SYSCLK domain) 0 = Disabled 1 = Enabled
	1	ASRC1L_ENA_S TS	0	ASRC1 Left Enable Status (Left ASRC channel from ASYNCCLK domain to SYSCLK domain) 0 = Disabled 1 = Enabled
	0	ASRC1R_ENA_S TS	0	ASRC1 Right Enable Status (Right ASRC channel from ASYNCCLK domain to SYSCLK domain) 0 = Disabled 1 = Enabled
R3810 (0EE2h) ASRC_RA TE1	14:11	ASRC_RATE1 [3:0]	0000	ASRC Sample Rate select for SYSCLK domain 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 All other codes are Reserved. The selected sample rate is valid in the range 8kHz to 48kHz.
R3811 (0EE3h) ASRC_RA TE2	14:11	ASRC_RATE2 [3:0]	1000	ASRC Sample Rate select for ASYNCCLK domain 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 8kHz to 48kHz.

Table 22 Digital Core ASRC Control



ISOCHRONOUS SAMPLE RATE CONVERTER (ISRC)

The WM5102 supports multiple signal paths through the digital core. The Isochronous Sample Rate Converters (ISRCs) provide sample rate conversion between synchronised sample rates on the SYSCLK clock domain, or between synchronised sample rates on the ASYNCCLK clock domain.

There are two Isochronous Sample Rate Converters (ISRCs). Each of these provides two signal paths between two different sample rates, as illustrated in Figure 41.

The sample rates associated with each ISRC can be set independently. Note that the two sample rates associated with any single ISRC must both be referenced to the same clock domain (SYSCLK or ASYNCCLK).

When an ISRC is used on the SYSCLK domain, then the associated sample rates may be selected from SAMPLE_RATE_1, SAMPLE_RATE_2 or SAMPLE_RATE_3.

When an ISRC is used on the ASYNCCLK domain, then the associated sample rates are ASYNC_SAMPLE_RATE_1 and ASYNC_SAMPLE_RATE_2.

See "Clocking and Sample Rates" for details of the sample rate control registers.

Each ISRC supports sample rates in the range 8kHz to 192kHz. The higher of the sample rates associated with each ISRC must be an integer multiple of the lower sample rate; integer ratios in the range 1 to 6 are supported.

Each ISRC converts between a sample rate selected by ISRCn_FSL and a sample rate selected by ISRCn_FSH, (where 'n' identifies the applicable ISRC 1 or 2). Note that, in each case, the higher of the two sample rates must be selected by ISRCn_FSH.

The ISRCn 'interpolation' paths (increasing sample rate) are enabled using the ISRCn_INT1_ENA and ISRCn_INT2_ENA register bits.

The ISRCn 'decimation' paths (decreasing sample rate) are enabled using the ISRCn_DEC1_ENA and ISRCn_DEC2_ENA register bits.

A notch filter is provided in each of the ISRC paths; these are enabled using the ISRCn_NOTCH_ENA bits. The filter is configured automatically according to the applicable sample rate(s). It is recommended to enable the filter for typical applications. Disabling the filter will provide maximum 'pass' bandwidth, at the expense of degraded stopband attenuation.

The WM5102 performs automatic checks to confirm that the SYSCLK frequency is high enough to support the commanded ISRC and digital mixing functions. If an attempt is made to enable an ISRC signal path, and there are insufficient SYSCLK cycles to support it, then the attempt will be unsuccessful. (Note that any signal paths that are already active will not be affected under these circumstances.)

The Underclocked Error condition can be monitored using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.

The status bits in Registers R1600 to R2920 indicate the status of each of the digital mixers. If an Underclocked Error condition occurs, then these bits provide readback of which mixer(s) have been successfully enabled.

The Isochronous Sample Rate Converter (ISRC) signal paths and control registers are illustrated in Figure 41.



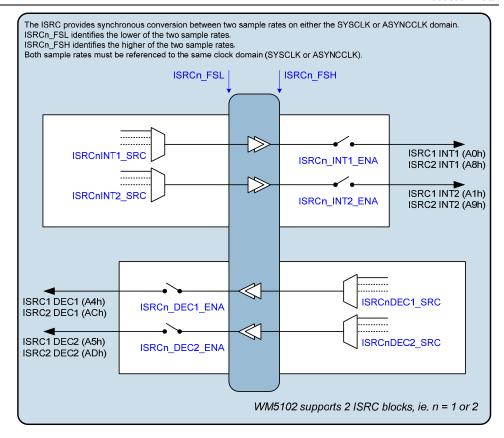


Figure 41 Isochronous Sample Rate Converters (ISRCs)

The ISRC input control registers (see Figure 41) are located at register addresses R2816 (B00h) through to R2920 (0B68h).

The full list of digital mixer control registers is provided in the "Register Map" section (Register R1600 through to R2920). Generic register definitions are provided in Table 7.

The *_SRC registers select the input source(s) for the respective ISRC processing blocks. Note that the selected input source(s) must be configured for the same sample rate as the ISRC to which they are connected.

The bracketed numbers in Figure 41, eg. "(A4h)" indicate the corresponding *_SRC register setting for selection of that signal as an input to another digital core function.

The register bits associated with the ISRCs are described in Table 23.

ſ	REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	R3824 (0EF0h) ISRC 1 CTRL 1	14:11	ISRC1_FSH [3:0]	0000	ISRC1 High Sample Rate (Sets the higher of the ISRC1 sample rates) 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 8kHz to 192kHz. The ISRC1_FSH and ISRC1_FSL fields must both select sample rates referenced to the same clock domain (SYSCLK or ASYNCCLK).
	R3825 (0EF1h) ISRC 1 CTRL 2	14:11	ISRC1_FSL [3:0]	0000	ISRC1 Low Sample Rate (Sets the lower of the ISRC1 sample rates) 0000 = SAMPLE_RATE_1 0001 = SAMPLE_RATE_2 0010 = SAMPLE_RATE_3 1000 = ASYNC_SAMPLE_RATE_1 1001 = ASYNC_SAMPLE_RATE_2 All other codes are Reserved. The selected sample rate is valid in the range 8kHz to 192kHz. The ISRC1_FSH and ISRC1_FSL fields must both select sample rates referenced to the same clock domain (SYSCLK or ASYNCCLK).
	R3826 (0EF2h) ISRC 1 CTRL 3	15	ISRC1_INT1_EN A	0	ISRC1 INT1 Enable (Interpolation Channel 1 path from ISRC1_FSL rate to ISRC1_FSH rate) 0 = Disabled 1 = Enabled
		14	ISRC1_INT2_EN A	0	ISRC1 INT2 Enable (Interpolation Channel 2 path from ISRC1_FSL rate to ISRC1_FSH rate) 0 = Disabled 1 = Enabled
		9	ISRC1_DEC1_EN A	0	ISRC1 DEC1 Enable (Decimation Channel 1 path from ISRC1_FSH rate to ISRC1_FSL rate) 0 = Disabled 1 = Enabled
		8	ISRC1_DEC2_EN A	0	ISRC1 DEC2 Enable (Decimation Channel 2 path from ISRC1_FSH rate to ISRC1_FSL rate) 0 = Disabled 1 = Enabled
		0	ISRC1_NOTCH_ ENA	0	ISRC1 Notch Filter Enable 0 = Disabled 1 = Enabled It is recommended to enable the notch filter for typical applications.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3827 (0EF3h)	14:11	ISRC2_FSH [3:0]	0000	ISRC2 High Sample Rate (Sets the higher of the ISRC2 sample
ISRC 2 CTRL 1				rates) 0000 = SAMPLE_RATE_1
				0001 = SAMPLE_RATE_2
				0010 = SAMPLE_RATE_3
				1000 = ASYNC_SAMPLE_RATE_1
				1001 = ASYNC_SAMPLE_RATE_2
				All other codes are Reserved.
				The selected sample rate is valid in the range 8kHz to 192kHz.
				The ISRC2_FSH and ISRC2_FSL fields must both select sample rates referenced to the same clock domain (SYSCLK or ASYNCCLK).
R3828	14:11	ISRC2_FSL [3:0]	0000	ISRC2 Low Sample Rate
(0EF4h) ISRC 2				(Sets the lower of the ISRC2 sample rates)
CTRL 2				0000 = SAMPLE_RATE_1
				0001 = SAMPLE_RATE_2
				0010 = SAMPLE_RATE_3
				1000 = ASYNC_SAMPLE_RATE_1
				1001 = ASYNC_SAMPLE_RATE_2
				All other codes are Reserved.
				The selected sample rate is valid in the range 8kHz to 192kHz.
				The ISRC2_FSH and ISRC2_FSL fields
				must both select sample rates referenced to the same clock domain (SYSCLK or ASYNCCLK).
R3829	15	ISRC2_INT1_EN	0	ISRC2 INT1 Enable
(0EF5h) ISRC 2		A		(Interpolation Channel 1 path from ISRC2_FSL rate to ISRC2_FSH rate)
CTRL 3				0 = Disabled
				1 = Enabled
	14	ISRC2_INT2_EN	0	ISRC2 INT2 Enable
		Α		(Interpolation Channel 2 path from ISRC2_FSL rate to ISRC2_FSH rate)
				0 = Disabled
				1 = Enabled
	9	ISRC2_DEC1_EN	0	ISRC2 DEC1 Enable
		Α		(Decimation Channel 1 path from ISRC2_FSH rate to ISRC2_FSL rate)
				0 = Disabled
				1 = Enabled
	8	ISRC2_DEC2_EN	0	ISRC2 DEC2 Enable
		Α		(Decimation Channel 2 path from ISRC2_FSH rate to ISRC2_FSL rate)
				0 = Disabled
				1 = Enabled
	0	ISRC2_NOTCH_	0	ISRC2 Notch Filter Enable
		ENA		0 = Disabled
				1 = Enabled
	ital Core			It is recommended to enable the notch filter for typical applications.

Table 23 Digital Core ISRC Control



DSP FIRMWARE CONTROL

The WM5102 digital core incorporates a programmable DSP block, capable of running a wide range of audio enhancement functions. Different firmware configurations can be loaded onto the DSP, enabling the WM5102 to be highly customised for specific application requirements.

Examples of the DSP functions include Virtual Surround Sound (VSS), Multiband Compressor (MBC), and signal enhancements such as Ez2 HearTM. Note that it is possible to implement more than one type of audio enhancement function on the DSP; the precise combination(s) of functions will vary from one firmware configuration to another.

DSP firmware can be configured using Wolfson-supplied software packages. A software programming guide can also be provided to assist users in developing their own software algorithms - please contact your local Wolfson representative for further information.

In order to use the DSP, the required firmware configuration must first be loaded onto the device by writing the appropriate files to the WM5102 register map. The firmware configuration will comprise Program, Coefficient and Data content. In some cases, the Coefficient content must be derived using tools provided in Wolfson's WISCE™ evaluation board control software.

Details of how to load the firmware configuration onto the WM5102 are described below. Note that the WISCE™ evaluation board control software provides support for easy loading of Program, Coefficient and Data content onto the WM5102. Please contact your local Wolfson representative for more details of the WISCE™ evaluation board control software.

After loading the DSP firmware, the DSP functions must be enabled using the associated register control fields.

The audio signal paths connecting to/from the DSP are configured as described in the "Digital Core" section. Note that the DSP firmware must be loaded and enabled before audio signal paths can be enabled.

DSP FIRMWARE MEMORY CONTROL

The DSP firmware memory is programmed by writing to the registers referenced in Table 24. Note that the DSP clock must be configured and enabled to support read/write access to these registers.

The WM5102 Program, Coefficient and Data memory space is described in Table 24. See "Register Map" for a definition of these register addresses.

The Program firmware parameters are formatted as 40-bit words. For this reason, 3 x 16-bit register addresses are required for each 40-bit word.

The Coefficient and Data firmware parameters are formatted as 24-bit words. For this reason, 2 x 16-bit register addresses are required for each 24-bit word.

	DESCRIPTION	REGISTER AD	DSP MEMORY SIZE	
DSP1	Program memory	10_0000h to 10_5FFFh	(24576 registers)	8192 x 40-bit words
	Coefficient memory	18_0000h to 18_07FFh	(2048 registers)	1024 x 24-bit words
	X Data memory 19_0000h to 19_4		(18432 registers)	9216 x 24-bit words
	Y Data memory	1A_8000h to 1A_97FFh	(6144 registers)	3072 x 24-bit words

Table 24 DSP Program, Coefficient and Data Registers

Clocking is required for any functionality of the DSP, including any register read/write operations associated with DSP firmware loading.

The clock source for the DSP is derived from SYSCLK, which must also be enabled. See "Clocking and Sample Rates" for details of how to configure SYSCLK.

The DSP clock frequency is selected using the DSP1_CLK_SEL register. The DSP clock frequency must be less than or equal to the SYSCLK frequency.

If the SUBSYS_MAX_FREQ bit is set to '0', then the DSP clock frequency is restricted to a maximum of 24.576MHz (or 22.5792MHz), even if a higher rate is selected. The SUBSYS_MAX_FREQ should only be set to '1' when the applicable DCVDD condition is satisfied, as described in Table 97.



The clock source for the DSP block is enabled using DSP1_SYS_ENA. The clock must be enabled before (or simultaneous to) enabling the DSP Core or DMA channels. The clock must be disabled after (or simultaneous to) disabling the DSP Core and DMA channels.

The DSP Memory must be enabled for any functionality of the DSP, including any register read/write operations associated with DSP firmware loading. The DSP Memory is controlled using DSP1_MEM_ENA; this bit is enabled by default.

The DSP1_RAM_RDY status bits indicate when the DSP firmware memory registers are ready for read/write access. The DSP memory should not be accessed until this bit has been set.

The DSP RAM Ready flags are inputs to the Interrupt control circuit and can be used to trigger an interrupt event - see "Interrupts".

The DSP RAM Ready flags can be output directly on a GPIO pin as an external indication of the DSP RAM Status. See "General Purpose Input / Output" to configure a GPIO pin for this function.

The DSP memory contents are retained during Hardware Reset and Software Reset, provided DCVDD is held above its reset threshold. The DSP memory contents are cleared in Sleep mode, or if DCVDD falls below its Reset threshold. See the "Applications Information" section for a summary of the WM5102 memory reset conditions.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R4352 (1100h) DSP1 Control 1	4	DSP1_MEM_EN A	1	DSP1 Memory Control 0 = Disabled 1 = Enabled The DSP1 Memory Control must be enabled for DSP1 firmware register access and also for firmware execution.
	2	DSP1_SYS_ENA	0	DSP1 Clock Enable 0 = Disabled 1 = Enabled The DSP1 Clock must be enabled for DSP1 firmware register access, code execution, or DMA operation. The DSP1 Core must be reset (DSP1_CORE_ENA=0), and all DMA channels disabled, when disabling the DSP1 Clock.
R4353 (1101h) DSP1 Clocking 1	2:0	DSP1_CLK_SEL [2:0]	000	DSP1 Clock Frequency Select 000 = 6.144MHz (5.6448MHz) 001 = 12.288MHz (11.2896MHz) 010 = 24.576MHz (22.5792MHz) 011 = 49.152MHz (45.1584MHz) The DSP1 Clock must be less than or equal to the SYSCLK frequency. The frequencies in brackets apply for 44.1kHz-related sample rates only (ie. SAMPLE_RATE_n = 01XXX).
R4356 (1104h) DSP1 Status 1	0	DSP1_RAM_RDY	0	DSP1 Memory Status 0 = Not ready 1 = Ready Note - DSP1 memory should not be accessed until this bit has been set.

Table 25 DSP Clocking Control



DSP FIRMWARE EXECUTION

After the DSP firmware has been loaded, and the clocks configured, the DSP block is enabled using the DSP1_CORE_ENA and DSP1_START register bits. Write '1' to both registers to enable and start the firmware execution.

The DSP1_CORE_ENA bit must be set to '1' to enable DSP firmware execution. Note that the usage of the DSP1_START bit may vary depending on the particular software that is being executed: in some applications, writing to the DSP1_START bit will not be required.

For read/write access to the DSP firmware memory registers, the respective firmware execution must be disabled by setting the DSP1_CORE_ENA bit to '0'.

The audio signal paths connecting to/from the DSP processing blocks are configured as described in the "Digital Core" section. Note that the DSP firmware must be loaded and enabled before audio signal paths can be enabled.

REGISTER ADDRESS		LABEL	DEFAULT	DESCRIPTION
R4352	1	DSP1_CORE_EN	0	DSP1 Enable
(1100h)		Α		Controls the DSP1 firmware execution
DSP1				0 = Disabled
Control 1				1 = Enabled
	0	DSP1_START		DSP1 Start
				Write '1' to Start DSP1 firmware execution

Table 26 DSP Firmware Execution

DSP DIRECT MEMORY ACCESS (DMA) CONTROL

The DSP provides a multi-channel DMA function; this is configured using the registers described in Table 27.

There are 8 WDMA channels and 6 RDMA channels; these are enabled using the DSP1_WDMA_CHANNEL_ENABLE and DSP1_RDMA_CHANNEL_ENABLE fields.

Note that, after disabling the DSP (ie. writing DSP1_CORE_ENA=0), the associated DMA must be disabled by setting the DSP1_WDMA_BUFFER_LENGTH, DSP1_WDMA_CHANNEL_ENABLE, and DSP1_RDMA_CHANNEL_ENABLE fields to 00h.

The DMA can access the X data memory or Y data memory associated with the DSP. The applicable memory is selected using bit [15] of the respective *_START_ADDRESS register.

The start address of each DMA channel is configured as described in Table 27. Note that the required address is defined relative to the base address of the selected (X data or Y data) memory.

The buffer length of the WDMA channels is configured using the DSP1_WDMA_BUFFER_LENGTH field. The selected buffer length applies to all enabled WDMA channels.

Note that the start address registers, and WDMA buffer length registers, are defined in 24-bit DSP data word units. This means that the LSB of these fields represents one 24-bit DSP memory word. (Note that this differs from the WM5102 register map layout, as described in Table 24).

The parameters of a DMA channel (ie. Start Address) must not be changed whilst the respective DMA is enabled. All of the WDMA channels must be disabled before changing the WDMA buffer length.

Further details of the DMA are provided in the software programming guide - please contact your local Wolfson representative if required.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R4368 (1110h)	15:0	DSP1_START_A DDRESS_WDMA	0000h	DSP1 WDMA Channel n Start Address
to		_BUFFER_n		Bit [15] = Memory select
R4375		[15:0]		0 = X Data memory
(1117h)				1 = Y Data memory
				Bits [14:0] = Address select
				The address is defined relative to the base
				address of the applicable data memory. The LSB represents one 24-bit DSP
				memory word.
R4384 (1120h)	15:0	DSP1_START_A DDRESS RDMA	0000h	DSP1 RDMA Channel n Start Address
to		_BUFFER_n		Bit [15] = Memory select
R4389		[15:0]		0 = X Data memory
(1125h)				1 = Y Data memory
				Bits [14:0] = Address select
				The address is defined relative to the base
				address of the applicable data memory.
				The LSB represents one 24-bit DSP memory word.
R4400	13:0	DSP1 WDMA B	0000h	DSP1 DMA Buffer Length
(1130h)		UFFER_LENGTH		Selects the amount of data transferred in
DSP1		[13:0]		each WDMA channel. The LSB represents
WDMA Config 1				one 24-bit DSP memory word.
				Note that this field must be set to 00h
				when DSP1 is disabled.
R4401 (1131h)	7:0	DSP1_WDMA_C HANNEL_ENABL	00h	DSP1 WDMA Channel Enable
DSP1		E [7:0]		There are 8 WDMA channels; each bit of this field enables the respective WDMA
WDMA				channel.
Config 2				Each bit is coded as:
				0 = Disabled 1 = Enabled
				i – Ellabled
				Note that this field must be set to 00h
Duc		D0D4 D5111 6	00.	when DSP1 is disabled.
R4404 (1134h)	5:0	DSP1_RDMA_C HANNEL ENABL	00h	DSP1 RDMA Channel Enable
DSP1		E [5:0]		There are 6 RDMA channels; each bit of this field enables the respective RDMA
RDMA				channel.
Config 1				Each bit is coded as:
				0 = Disabled
				1 = Enabled
				Note that this field must be set to 00h
				when DSP1 is disabled.

Table 27 DSP Direct Memory Access (DMA) Control



DSP DEBUG SUPPORT

General purpose 'scratch' registers are provided for the DSP. These have no assigned function, and can be used to assist in algorithm development.

The JTAG interface provides test and debug access to the WM5102, as described in the "JTAG Interface" section. The JTAG interface clock is enabled using the DSP1_DBG_CLK_ENA register bit.

When using the JTAG interface to access the DSP core, the DSP1_DBG_CLK_ENA, DSP1_SYS_ENA, and DSP1_CORE_ENA bits must all be set.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R4352	3	DSP1_DBG_CLK	0	DSP1 Debug Clock Enable
(1100h)		_ENA		0 = Disabled
DSP1				1 = Enabled
Control 1				
R4416	15:0	DSP1_SCRATCH	0000h	DSP1 Scratch Register 0
(1140h)		_0 [15:0]		
DSP1				
Scratch 0				
R4417	15:0	DSP1_SCRATCH	0000h	DSP1 Scratch Register 1
(1141h)		_1 [15:0]		
DSP1				
Scratch 1				
R4418	15:0	DSP1_SCRATCH	0000h	DSP1 Scratch Register 2
(1142h)		_2 [15:0]		
DSP1				
Scratch 2				
R4419	15:0	DSP1_SCRATCH	0000h	DSP1 Scratch Register 3
(1143h)		_3 [15:0]		
DSP1				
Scratch 3				

Table 28 DSP Debug Support



WM5102 Production Data

DIGITAL AUDIO INTERFACE

The WM5102 provides three audio interfaces, AIF1, AFI2 and AIF3. Each of these is independently configurable on the respective transmit (TX) and receive (RX) paths. AIF1 supports up to 8 channels of input and output signal paths; AIF2 and AIF3 each support up to 2 channels of input and output signal paths.

The data source(s) for the audio interface transmit (TX) paths can be selected from any of the WM5102 input signal paths, or from the digital core processing functions. The audio interface receive (RX) paths can be selected as inputs to any of the digital core processing functions or digital core outputs. See "Digital Core" for details of the digital core routing options.

The digital audio interfaces provide flexible connectivity for multiple processors and other audio devices. Typical connections include Applications Processor, Baseband Processor and Wireless Transceiver. Note that the SLIMbus interface also provides digital audio input/output paths, providing options for additional interfaces. A typical configuration is illustrated in Figure 42.

The audio interfaces AIF1, AIF2 and AIF3 are referenced to DBVDD1, DBVDD2 and DBVDD3 respectively, allowing the WM5102 to connect between application sub-systems on different voltage domains.

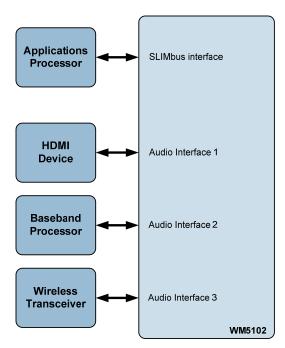


Figure 42 Typical AIF Connections

In the general case, the digital audio interface uses four pins:

TXDAT: Data output

RXDAT: Data input

BCLK: Bit clock, for synchronisation

LRCLK: Left/Right data alignment clock

In master interface mode, the clock signals BCLK and LRCLK are outputs from the WM5102. In slave mode, these signals are inputs, as illustrated below.

As an option, a GPIO pin can be configured as TXLRCLK, ie. the Left/Right clock for the TXDAT output. In this case, the LRCLK pin is dedicated to the RXDAT input, allowing the two sides to be clocked independently.



Four different audio data formats are supported by the digital audio interface:

- DSP mode A
- DSP mode B
- I2S
- Left Justified

The Left Justified and DSP-B modes are valid in Master mode only (ie. BCLK and LRCLK are outputs from the WM5102). These modes cannot be supported in Slave mode.

All four of these modes are MSB first. Data words are encoded in 2's complement format. Each of the audio interface modes is described in the following sections. Refer to the "Signal Timing Requirements" section for timing information.

Two variants of DSP mode are supported - 'Mode A' and 'Mode B'. Mono PCM operation can be supported using the DSP modes.

MASTER AND SLAVE MODE OPERATION

The WM5102 digital audio interfaces can operate as a master or slave as shown in Figure 43 and Figure 44. The associated control bits are described in "Digital Audio Interface Control".

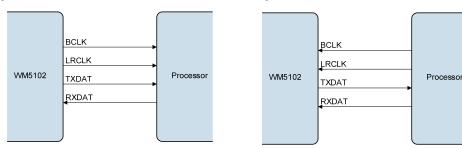


Figure 43 Master Mode

Figure 44 Slave Mode

AUDIO DATA FORMATS

The WM5102 digital audio interfaces can be configured to operate in l²S, Left-Justified, DSP-A or DSP-B interface modes. Note that Left-Justified and DSP-B modes are valid in Master mode only (ie. BCLK and LRCLK are outputs from the WM5102).

The digital audio interfaces also provide flexibility to support multiple 'slots' of audio data within each LRCLK frame. This flexibility allows multiple audio channels to be supported within a single LRCLK frame

The data formats described in this section are generic descriptions, assuming only one stereo pair of audio samples per LRCLK frame. In these cases, the AIF is configured to transmit (or receive) in the first available position in each frame (ie. the Slot 0 position).

The options for multi-channel operation are described in the following section ("AIF Timeslot Configuration").

The audio data modes supported by the WM5102 are described below. Note that the polarity of the BCLK and LRCLK signals can be inverted if required; the following descriptions all assume the default, non-inverted polarity of these signals.

In DSP mode, the left channel MSB is available on either the 1st (mode B) or 2nd (mode A) rising edge of BCLK following a rising edge of LRCLK. Right channel data immediately follows left channel data. Depending on word length, BCLK frequency and sample rate, there may be unused BCLK cycles between the LSB of the right channel data and the next sample.

In master mode, the LRCLK output will resemble the frame pulse shown in Figure 45 and Figure 46. In slave mode, it is possible to use any length of frame pulse less than 1/fs, providing the falling edge of the frame pulse occurs at least one BCLK period before the rising edge of the next frame pulse.

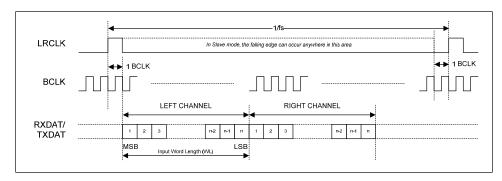


Figure 45 DSP Mode A Data Format

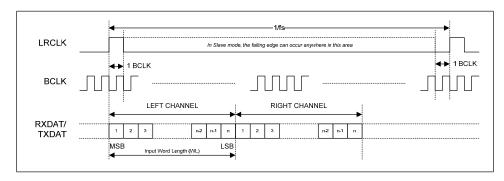


Figure 46 DSP Mode B Data Format

PCM operation is supported in DSP interface mode. WM5102 data that is output on the Left Channel will be read as mono PCM data by the receiving equipment. Mono PCM data received by the WM5102 will be treated as Left Channel data. This data may be routed to the Left/Right playback paths using the control fields described in the "Digital Core" section.

In l^2S mode, the MSB is available on the second rising edge of BCLK following a LRCLK transition. The other bits up to the LSB are then transmitted in order. Depending on word length, BCLK frequency and sample rate, there may be unused BCLK cycles between the LSB of one sample and the MSB of the next.

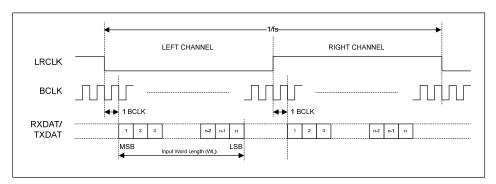


Figure 47 I2S Data Format (assuming n-bit word length)



In Left Justified mode, the MSB is available on the first rising edge of BCLK following a LRCLK transition. The other bits up to the LSB are then transmitted in order. Depending on word length, BCLK frequency and sample rate, there may be unused BCLK cycles before each LRCLK transition.

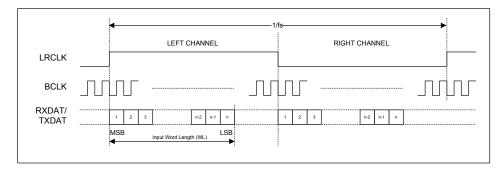


Figure 48 Left Justified Data Format (assuming n-bit word length)

AIF TIMESLOT CONFIGURATION

Digital audio interface AIF1 supports multi-channel operation; up to 8 input (RX) channels and 8 output (TX) channels can be supported simultaneously. A high degree of flexibility is provided to define the position of the audio samples within each LRCLK frame; the audio channel samples may be arranged in any order within the frame.

AIF2 and AIF3 also provide flexible configuration options, but support only 1 stereo input and 1 stereo output pair each.

Note that, on each interface, all input and output channels must operate at the same sample rate (fs).

Each of the audio channels can be enabled or disabled independently on the transmit (TX) and receive (RX) signal paths. For each enabled channel, the audio samples are assigned to one timeslot within the LRCLK frame.

In DSP modes, the timeslots are ordered consecutively from the start of the LRCLK frame. In I2S and Left-Justified modes, the even-numbered timeslots are arranged in the first half of the LRCLK frame, and the odd-numbered timeslots are arranged in the second half of the frame.

The timeslots are assigned independently for the transmit (TX) and receive (RX) signal paths. There is no requirement to assign every available timeslot to an audio sample; some slots may be unused, if desired. Care is required, however, to ensure that no timeslot is allocated to more than one audio channel.

The number of BCLK cycles within a slot is configurable; this is the Slot Length. The number of valid data bits within a slot is also configurable; this is the Word Length. The number of BCLK cycles per LRCLK frame must be configured; it must be ensured that there are enough BCLK cycles within each LRCLK frame to transmit or receive all of the enabled audio channels.

Examples of the AIF Timeslot Configurations are illustrated in Figure 49 to Figure 52. One example is shown for each of the four possible data formats.

Figure 49 shows an example of DSP Mode A format. Four enabled audio channels are shown, allocated to timeslots 0 through to 3.

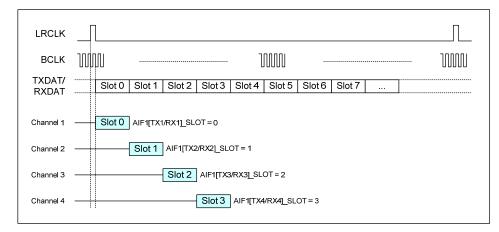


Figure 49 DSP Mode A Example

Figure 50 shows an example of DSP Mode B format. Six enabled audio channels are shown, with timeslots 4 and 5 unsused.

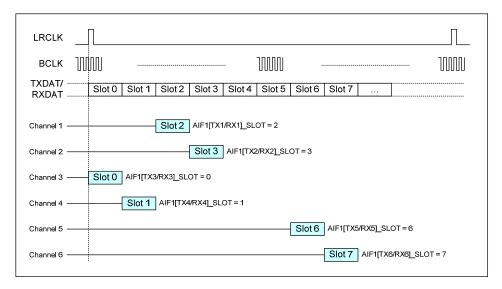


Figure 50 DSP Mode B Example

Figure 51 shows an example of I2S format. Four enabled channels are shown, allocated to timeslots 0 through to 3.

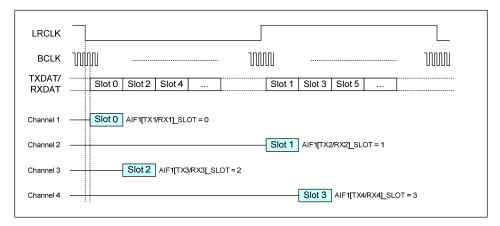


Figure 51 I2S Example

Figure 52 shows an example of Left Justified format. Six enabled channels are shown.

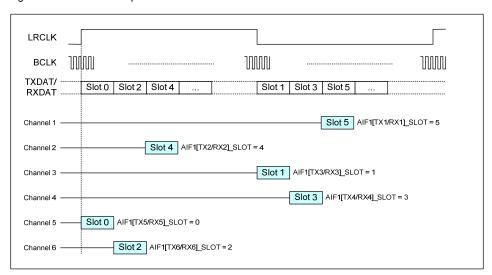


Figure 52 Left Justifed Example

TDM OPERATION BETWEEN THREE OR MORE DEVICES

The AIF operation described above illustrates how multiple audio channels can be interleaved on a single TXDAT or RXDAT pin. The interface uses Time Division Multiplexing (TDM) to allocate time periods to each of the audio channels in turn.

This form of TDM is implemented between two devices, using the electrical connections illustrated in Figure 43 or Figure 44.

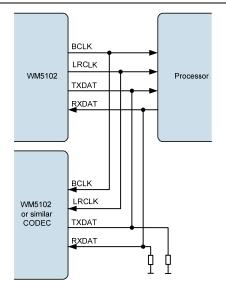
It is also possible to implement TDM between three or more devices. This allows one CODEC to receive audio data from two other devices simultaneously on a single audio interface, as illustrated in Figure 53, Figure 54 and Figure 55.

The WM5102 provides full support for TDM operation. The TXDAT pin can be tri-stated when not transmitting data, in order to allow other devices to transmit on the same wire. The behaviour of the TXDAT pin is configurable, to allow maximum flexibility to interface with other devices in this way.

Typical configurations of TDM operation between three devices are illustrated in Figure 53, Figure 54 and Figure 55.



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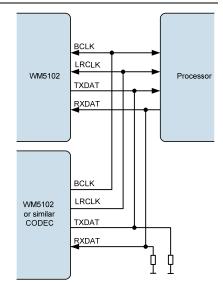


Figure 53 TDM with WM5102 as Master

Figure 54 TDM with Other CODEC as Master

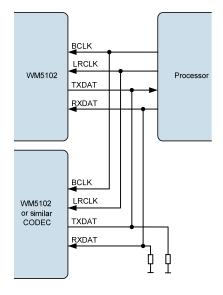


Figure 55 TDM with Processor as Master

Note:

The WM5102 is a 24-bit device. If the user operates the WM5102 in 32-bit mode then the 8 LSBs will be ignored on the receiving side and not driven on the transmitting side. It is therefore recommended to add a pull-down resistor if necessary to the RXDAT line and the TXDAT line in TDM mode.

DIGITAL AUDIO INTERFACE CONTROL

This section describes the configuration of the WM5102 digital audio interface paths.

AIF1 supports up to 8 input signal paths and up to 8 output signal paths. AIF2 and AIF3 support up to 2 input and output signal paths each. The digital audio interfaces AIF1, AIF2 and AIF3 can be configured as Master or Slave interfaces; mixed master/slave configurations are also possible.

Each input and output signal path can be independently enabled or disabled. The AIF output (TX) and AIF input (RX) paths can use a common LRCLK frame clock, or can use separate LRCLK signals if required.

The digital audio interface supports flexible data formats, selectable word-length, configurable timeslot allocations and TDM tri-state control.

AIF SAMPLE RATE CONTROL

The AIF RX inputs may be selected as input to the digital mixers or signal processing functions within the WM5102 digital core. The AIF TX outputs are derived from the respective output mixers.

The sample rate for each digital audio interface AIFn is configured using the respective AIFn_RATE register - see Table 21 within the "Digital Core" section.

Note that sample rate conversion is required when routing the AIF paths to any signal chain that is asynchronous and/or configured for a different sample rate.

AIF MASTER / SLAVE CONTROL

The digital audio interfaces can operate in Master or Slave modes and also in mixed master/slave configurations. In Master mode, the BCLK and LRCLK signals are generated by the WM5102 when any of the respective digital audio interface channels is enabled. In Slave mode, these outputs are disabled by default to allow another device to drive these pins.

Master mode is selected on the AIFnBCLK pin using the AIFn_BCLK_MSTR register bit. In Master mode, the AIFnBCLK signal is generated by the WM5102 when one or more AIFn channels is enabled.

When the AIFn_BCLK_FRC bit is set in BCLK master mode, the AIFnBCLK signal is output at all times, including when none of the AIFn channels is enabled.

The AIFnBCLK signal can be inverted in Master or Slave modes using the AIFn_BCLK_INV register.

Master mode is selected on the AIFnLRCLK pin using the AIFnRX_LRCLK_MSTR register bit. In Master mode, the AIFnRXLRCLK signal is generated by the WM5102 when one or more AIFn channels is enabled. (Note that, when GPIOn is configured as AIFnTXLRCLK, then only the AIFn RX channels will cause AIFnRXLRCLK to be output.)

When the AIFnRX_LRCLK_FRC bit is set in LRCLK master mode, the AIFnRXLRCLK signal is output at all times, including when none of the AIFn channels is enabled. Note that AIFnRXLRCLK is derived from AIFnBCLK, and an internal or external AIFnBCLK signal must be present to generate AIFnRXLRCLK.

The AIFnRXLRCLK signal can be inverted in Master or Slave modes using the AIFnRX_LRCLK_INV register.

Under default conditions, the AIFn input (RX) and output (TX) paths both use the AIFnRXLRCLK signal as the frame synchronisation clock. The AIFn output (TX) interface can be configured to use a separate frame clock, AIFnTXLRCLK, using the AIFnTX_LRCLK_SRC bit.

The AIFnTXLRCLK function, when used, must be selected on the GPIOn pin as described in the "General Purpose Input / Output" section.

The AIFnTXLRCLK function can operate in Master or Slave mode, and is controlled similarly to the AIFnRXLRCLK function using the register bits described in Table 29, Table 30 and Table 31 for AIF1, AIF2 and AIF3 respectively.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1280 (0500h) AIF1	7	AIF1_BCLK_INV	0	AIF1 Audio Interface BCLK Invert 0 = AIF1BCLK not inverted 1 = AIF1BCLK inverted
BCLK Ctrl	6	AIF1_BCLK_FRC	0	AIF1 Audio Interface BCLK Output Control 0 = Normal 1 = AIF1BCLK always enabled in Master mode
	5	AIF1_BCLK_MST R	0	AIF1 Audio Interface BCLK Master Select 0 = AIF1BCLK Slave mode 1 = AIF1BCLK Master mode
R1281 (0501h) AIF1 Tx Pin Ctrl	3	AIF1TX_LRCLK_ SRC	1	AIF1 Audio Interface TX path LRCLK Select 0 = AIF1TXLRCLK 1 = AIF1RXLRCLK Note that the TXLRCLK function, when used, must be configured on a GPIO pin.
	2	AIF1TX_LRCLK_I NV	0	AIF1 Audio Interface TX path LRCLK Invert 0 = AIF1TXLRCLK not inverted 1 = AIF1TXLRCLK inverted
	1	AIF1TX_LRCLK_ FRC	0	AIF1 Audio Interface TX path LRCLK Output Control 0 = Normal 1 = AIF1TXLRCLK always enabled in Master mode
	0	AIF1TX_LRCLK_ MSTR	0	AIF1 Audio Interface TX path LRCLK Master Select 0 = AIF1TXLRCLK Slave mode 1 = AIF1TXLRCLK Master mode
R1282 (0502h) AIF1 Rx	2	AIF1RX_LRCLK_ INV	0	AIF1 Audio Interface LRCLK Invert 0 = AIF1RXLRCLK not inverted 1 = AIF1RXLRCLK inverted
Pin Ctrl	1	AIF1RX_LRCLK_ FRC	0	AIF1 Audio Interface LRCLK Output Control 0 = Normal 1 = AIF1RXLRCLK always enabled in Master mode
	0	AIF1RX_LRCLK_ MSTR	0	AIF1 Audio Interface LRCLK Master Select 0 = AIF1RXLRCLK Slave mode 1 = AIF1RXLRCLK Master mode

Table 29 AIF1 Master / Slave Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1344	7	AIF2_BCLK_INV	0	AIF2 Audio Interface BCLK Invert
(0540h)				0 = AIF2BCLK not inverted
AIF2				1 = AIF2BCLK inverted
BCLK Ctrl	6	AIF2_BCLK_FRC	0	AIF2 Audio Interface BCLK Output Control
				0 = Normal
				1 = AIF2BCLK always enabled in Master mode



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	5	AIF2_BCLK_MST R	0	AIF2 Audio Interface BCLK Master Select 0 = AIF2BCLK Slave mode 1 = AIF2BCLK Master mode
R1345 (0541h) AIF2 Tx Pin Ctrl	3	AIF2TX_LRCLK_ SRC	1	AIF2 Audio Interface TX path LRCLK Select 0 = AIF2TXLRCLK 1 = AIF2RXLRCLK Note that the TXLRCLK function, when used, must be configured on a GPIO pin.
	2	AIF2TX_LRCLK_I NV	0	AIF2 Audio Interface TX path LRCLK Invert 0 = AIF2TXLRCLK not inverted 1 = AIF2TXLRCLK inverted
	1	AIF2TX_LRCLK_ FRC	0	AIF2 Audio Interface TX path LRCLK Output Control 0 = Normal 1 = AIF2TXLRCLK always enabled in Master mode
	0	AIF2TX_LRCLK_ MSTR	0	AIF2 Audio Interface TX path LRCLK Master Select 0 = AIF2TXLRCLK Slave mode 1 = AIF2TXLRCLK Master mode
R1346 (0542h) AIF2 Px	2	AIF2RX_LRCLK_ INV	0	AIF2 Audio Interface LRCLK Invert 0 = AIF2RXLRCLK not inverted 1 = AIF2RXLRCLK inverted
Pin Ctrl	1	AIF2RX_LRCLK_ FRC	0	AIF2 Audio Interface LRCLK Output Control 0 = Normal 1 = AIF2RXLRCLK always enabled in Master mode
	0	AIF2RX_LRCLK_ MSTR	0	AIF2 Audio Interface LRCLK Master Select 0 = AIF2RXLRCLK Slave mode 1 = AIF2RXLRCLK Master mode

Table 30 AIF2 Master / Slave Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1408	7	AIF3_BCLK_INV	0	AIF3 Audio Interface BCLK Invert
(0580h)				0 = AIF3BCLK not inverted
AIF3				1 = AIF3BCLK inverted
BCLK Ctrl	6	AIF3_BCLK_FRC	0	AIF3 Audio Interface BCLK Output Control
				0 = Normal
				1 = AIF3BCLK always enabled in Master
				mode
	5	AIF3_BCLK_MST	0	AIF3 Audio Interface BCLK Master Select
		R		0 = AIF3BCLK Slave mode
				1 = AIF3BCLK Master mode
R1409	3	AIF3TX_LRCLK_	1	AIF3 Audio Interface TX path LRCLK
(0581h)		SRC		Select
AIF3 Tx				0 = AIF3TXLRCLK
Pin Ctrl				1 = AIF3RXLRCLK
				Note that the TXLRCLK function, when
				used, must be configured on a GPIO pin.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	2	AIF3TX_LRCLK_I NV	0	AIF3 Audio Interface TX path LRCLK Invert
				0 = AIF3TXLRCLK not inverted
				1 = AIF3TXLRCLK inverted
	1	AIF3TX_LRCLK_ FRC	0	AIF3 Audio Interface TX path LRCLK Output Control
				0 = Normal
				1 = AIF3TXLRCLK always enabled in Master mode
	0	AIF3TX_LRCLK_ MSTR	0	AIF3 Audio Interface TX path LRCLK Master Select
				0 = AIF3TXLRCLK Slave mode
				1 = AIF3TXLRCLK Master mode
R1410	2	AIF3RX_LRCLK_	0	AIF3 Audio Interface LRCLK Invert
(0582h)		INV		0 = AIF3RXLRCLK not inverted
AIF3 Rx Pin Ctrl				1 = AIF3RXLRCLK inverted
Pin Cin	1	AIF3RX_LRCLK_ FRC	0	AIF3 Audio Interface LRCLK Output Control
				0 = Normal
				1 = AIF3RXLRCLK always enabled in Master mode
	0	AIF3RX_LRCLK_ MSTR	0	AIF3 Audio Interface LRCLK Master Select
				0 = AIF3RXLRCLK Slave mode
				1 = AIF3RXLRCLK Master mode

Table 31 AIF3 Master / Slave Control

AIF SIGNAL PATH ENABLE

The AIF1 interface supports up to 8 input (RX) channels and up to 8 output (TX) channels. Each of these channels can be enabled or disabled using the register bits defined in Table 32.

The AIF2 and AIF3 interfaces support up to 2 input (RX) channels and up to 2 output (TX) channels. Each of these channels can be enabled or disabled using the register bits defined in Table 33 and Table 34.

The system clock, SYSCLK, must be configured and enabled before any audio path is enabled. The ASYNCCLK may also be required, depending on the path configuration. See "Clocking and Sample Rates" for details of the system clocks.

The WM5102 performs automatic checks to confirm that the SYSCLK and ASYNCCLK frequencies are high enough to support the commanded signal paths and processing functions. If an attempt is made to enable an AIF signal path, and there are insufficient SYSCLK or ASYNCCLK cycles to support it, then the attempt will be unsuccessful. (Note that any signal paths that are already active will not be affected under these circumstances.)

The Underclocked Error conditions can be monitored using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.

REGISTER ADDRESS		LABEL	DEFAULT	DESCRIPTION
R1305	7	AIF1TX8_ENA	0	AIF1 Audio Interface TX Channel 8 Enable
(0519h)				0 = Disabled
AIF1 Tx				1 = Enabled
Enables	6	AIF1TX7_ENA	0	AIF1 Audio Interface TX Channel 7 Enable
				0 = Disabled
				1 = Enabled



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REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION
ADDRESS				
	5	AIF1TX6_ENA	0	AIF1 Audio Interface TX Channel 6 Enable
				0 = Disabled
				1 = Enabled
	4	AIF1TX5_ENA	0	AIF1 Audio Interface TX Channel 5 Enable
				0 = Disabled 1 = Enabled
	3	AIF1TX4_ENA	0	AIF1 Audio Interface TX Channel 4 Enable
	3	All ITA4_LINA	0	0 = Disabled
				1 = Enabled
	2	AIF1TX3_ENA	0	AIF1 Audio Interface TX Channel 3 Enable
		_		0 = Disabled
				1 = Enabled
	1	AIF1TX2_ENA	0	AIF1 Audio Interface TX Channel 2 Enable
				0 = Disabled
				1 = Enabled
	0	AIF1TX1_ENA	0	AIF1 Audio Interface TX Channel 1 Enable
				0 = Disabled
				1 = Enabled
R1306 (051Ah)	7	AIF1RX8_ENA	0	AIF1 Audio Interface RX Channel 8 Enable
AIF1 Rx				0 = Disabled
Enables				1 = Enabled
	6	AIF1RX7 ENA	0	AIF1 Audio Interface RX Channel 7
				Enable
				0 = Disabled
				1 = Enabled
	5	AIF1RX6_ENA	0	AIF1 Audio Interface RX Channel 6
				Enable
				0 = Disabled 1 = Enabled
	4	AIF1RX5_ENA	0	AIF1 Audio Interface RX Channel 5
	7	All HOO_LIVA		Enable
				0 = Disabled
				1 = Enabled
	3	AIF1RX4_ENA	0	AIF1 Audio Interface RX Channel 4
				Enable
				0 = Disabled
-	2	AIE1DV2 ENA	0	1 = Enabled AIF1 Audio Interface RX Channel 3
	2	AIF1RX3_ENA	0	Enable
				0 = Disabled
				1 = Enabled
	1	AIF1RX2_ENA	0	AIF1 Audio Interface RX Channel 2
				Enable 0 = Disabled
				1 = Enabled
	0	AIF1RX1_ENA	0	AIF1 Audio Interface RX Channel 1
	J	/ 11007_ENA		Enable
				0 = Disabled
				1 = Enabled

Table 32 AIF1 Signal Path Enable



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1369	1	AIF2TX2_ENA	0	AIF2 Audio Interface TX Channel 2 Enable
(0559h)				0 = Disabled
AIF2 TX				1 = Enabled
Enables	0	AIF2TX1_ENA	0	AIF2 Audio Interface TX Channel 1 Enable
				0 = Disabled
				1 = Enabled
R1370	1	AIF2RX2_ENA	0	AIF2 Audio Interface RX Channel 2
(055Ah)				Enable
AIF2 RX				0 = Disabled
Enables				1 = Enabled
	0	AIF2RX1_ENA	0	AIF2 Audio Interface RX Channel 1
				Enable
				0 = Disabled
				1 = Enabled

Table 33 AIF2 Signal Path Enable

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1433	1	AIF3TX2_ENA	0	AIF3 Audio Interface TX Channel 2 Enable
(0599h)				0 = Disabled
AIF3 TX				1 = Enabled
Enables	0	AIF3TX1_ENA	0	AIF3 Audio Interface TX Channel 1 Enable
				0 = Disabled
				1 = Enabled
R1434	1	AIF3RX2_ENA	0	AIF3 Audio Interface RX Channel 2
(059Ah)				Enable
AIF3 RX				0 = Disabled
Enables				1 = Enabled
	0	AIF3RX1_ENA	0	AIF3 Audio Interface RX Channel 1
				Enable
				0 = Disabled
				1 = Enabled

Table 34 AIF3 Signal Path Enable

AIF BCLK AND LRCLK CONTROL

The AIFnBCLK frequency is selected by the AIFn_BCLK_FREQ register. For each value of this register, the actual frequency depends upon whether AIFn is configured for a 48kHz-related sample rate or a 44.1kHz-related sample rate, as described below.

If AIFn_RATE<1000 (see Table 21), then AIFn is referenced to the SYSCLK clocking domain and the applicable frequency depends upon the SAMPLE_RATE_1, SAMPLE_RATE_2 or SAMPLE_RATE_3 registers.

If AIFn_RATE≥1000, then AIFn is referenced to the ASYNCCLK clocking domain and the applicable frequency depends upon the ASYNC_SAMPLE_RATE_1 or ASYNC_SAMPLE_RATE_2 registers.

The selected AIFnBCLK rate must be less than or equal to SYSCLK/2, or ASYNCCLK/2, as applicable. See "Clocking and Sample Rates" for details of SYSCLK and ASYNCCLK domains, and the associated control registers.

The AIFnRXLRCLK frequency is controlled relative to AIFnBCLK by the AIFnRX_BCPF divider.

Under default conditions, the AIFn input (RX) and output (TX) paths both use the AIFnRXLRCLK signal as the frame synchronisation clock. The AIFn output (TX) interface can be configured to use a separate frame clock, AIFnTXLRCLK, using the AIFnTX_LRCLK_SRC bit, as described in Table 29, Table 30 and Table 31 for AIF1, AIF2 and AIF3 respectively.

When the GPIOn pin is configured as AIFnTXLRCLK, then the AIFnTXLRCLK frequency is controlled relative to AIFnBCLK by the AIFnTX_BCPF divider. See "General Purpose Input / Output" for details of how to configure the GPIO1, GPIO2 or GPIO3 pins.

Note that the BCLK rate must be configured in Master or Slave modes, using the AIFn_BCLK_FREQ registers. The LRCLK rate(s) only require to be configured in Master mode.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	4:0	AIF1_BCLK_FRE Q [4:0]	01100	AIF1BCLK Rate 00000 = Reserved 00010 = 64kHz (58.8kHz) 00011 = 96kHz (88.2kHz) 00100 = 128kHz (117.6kHz) 00101 = 192kHz (176.4kHz) 00110 = 256kHz (235.2kHz) 00111 = 384kHz (352.8kHz) 01000 = 512kHz (470.4kHz) 01001 = 768kHz (705.6kHz) 01010 = 1.024MHz (940.8kHz) 01100 = 2.048MHz (1.8816MHz) 01101 = 3.072MHz (2.8824MHz) 01111 = 6.144MHz (5.6448MHz) 01111 = 6.144MHz (5.6448MHz) 10000 = 8.192MHz (7.5264MHz) 10001 = 12.288MHz (11.2896MHz) The frequencies in brackets apply for 44.1kHz-related sample rates only. If AIF1_RATE<1000, then AIF1 is referenced to SYSCLK and the 44.1kHz-related frequencies apply if SAMPLE_RATE_n = 01XXX. If AIF1_RATE>=1000, then AIF1 is referenced to ASYNCCLK and the 44.1kHz-related frequencies apply if ASYNC_SAMPLE_RATE_n = 01XXX.
				equal to SYSCLK/2, or ASYNCCLK/2, as applicable.
R1285 (0505h) AIF1 Tx BCLK Rate	12:0	AIF1TX_BCPF [12:0]	0040h	AIF1TXLRCLK Rate This register selects the number of BCLK cycles per AIF1TXLRCLK frame. AIF1TXLRCLK clock = AIF1BCLK / AIF1TX_BCPF Integer (LSB = 1), Valid from 88191
R1286 (0506h) AIF1 Tx BCLK Rate	12:0	AIF1RX_BCPF [12:0]	0040h	AIF1RXLRCLK Rate This register selects the number of BCLK cycles per AIF1RXLRCLK frame. AIF1RXLRCLK clock = AIF1BCLK / AIF1RX_BCPF Integer (LSB = 1), Valid from 8.8191

Table 35 AIF1 BCLK and LRCLK Control



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1344 (0540h) AIF2 BCLK Ctrl	4:0	AIF2_BCLK_FRE Q [4:0]	01100	AIF2BCLK Rate 00000 = Reserved 00001 = Reserved 00010 = 64kHz (58.8kHz) 00011 = 96kHz (88.2kHz) 00100 = 128kHz (117.6kHz) 00101 = 192kHz (176.4kHz) 00110 = 256kHz (235.2kHz) 00111 = 384kHz (352.8kHz) 01000 = 512kHz (470.4kHz) 01001 = 768kHz (705.6kHz) 01010 = 1.024MHz (940.8kHz) 01100 = 2.048MHz (1.4112MHz) 01101 = 3.072MHz (2.8824MHz) 01111 = 6.144MHz (5.6448MHz) 01111 = 6.144MHz (5.6448MHz) 10000 = 8.192MHz (7.5264MHz) 10001 = 12.288MHz (11.2896MHz) The frequencies in brackets apply for 44.1kHz-related sample rates only. If AIF2_RATE<1000, then AIF2 is referenced to SYSCLK and the 44.1kHz-related frequencies apply if SAMPLE_RATE_n = 01XXX. If AIF2_RATE>=1000, then AIF2 is referenced to ASYNCCLK and the 44.1kHz-related frequencies apply if ASYNC SAMPLE RATE n = 01XXX.
				The AIF2BCLK rate must be less than or equal to SYSCLK/2, or ASYNCCLK/2, as applicable.
R1349 (0545h) AIF2 Tx BCLK Rate	12:0	AIF2TX_BCPF [12:0]	0040h	AIF2TXLRCLK Rate This register selects the number of BCLK cycles per AIF2TXLRCLK frame. AIF2TXLRCLK clock = AIF2BCLK / AIF2TX_BCPF Integer (LSB = 1), Valid from 88191
R1350 (0546h) AIF2 Rx BCLK Rate	12:0	AIF2RX_BCPF [12:0]	0040h	AIF2RXLRCLK Rate This register selects the number of BCLK cycles per AIF2RXLRCLK frame. AIF2RXLRCLK clock = AIF2BCLK / AIF2RX_BCPF Integer (LSB = 1), Valid from 88191

Table 36 AIF2 BCLK and LRCLK Control



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	4:0	AIF3_BCLK_FRE Q [4:0]	01100	AIF3BCLK Rate 00000 = Reserved 00001 = Reserved 00011 = 96kHz (58.8kHz) 00100 = 128kHz (117.6kHz) 00101 = 192kHz (176.4kHz) 00110 = 256kHz (235.2kHz) 00111 = 384kHz (352.8kHz) 01000 = 512kHz (470.4kHz) 01001 = 768kHz (705.6kHz) 01010 = 1.024MHz (940.8kHz) 01011 = 1.536MHz (1.4112MHz) 01101 = 3.072MHz (2.8824MHz) 01101 = 3.072MHz (2.8824MHz) 01111 = 6.144MHz (5.6448MHz) 10000 = 8.192MHz (7.5264MHz) 10001 = 12.288MHz (11.2896MHz) The frequencies in brackets apply for 44.1kHz-related sample rates only. If AIF3_RATE<1000, then AIF3 is referenced to SYSCLK and the 44.1kHz-related frequencies apply if SAMPLE_RATE_n = 01XXX. If AIF3_RATE>=1000, then AIF3 is referenced to ASYNCCLK and the 44.1kHz-related frequencies apply if ASYNC_SAMPLE_RATE_n = 01XXX.
				The AIF3BCLK rate must be less than or equal to SYSCLK/2, or ASYNCCLK/2, as applicable.
R1413 (0585h) AIF3 Tx BCLK Rate	12:0	AIF3TX_BCPF [12:0]	0040h	AIF3TXLRCLK Rate This register selects the number of BCLK cycles per AIF3TXLRCLK frame. AIF3TXLRCLK clock = AIF3BCLK / AIF3TX_BCPF Integer (LSB = 1), Valid from 88191
R1414 (0586h) AIF3 Rx BCLK Rate	12:0	AIF3RX_BCPF [12:0]	0040h	AIF3RXLRCLK Rate This register selects the number of BCLK cycles per AIF3RXLRCLK frame. AIF3RXLRCLK clock = AIF3BCLK / AIF3RX_BCPF Integer (LSB = 1), Valid from 8.8191

Table 37 AIF3 BCLK and LRCLK Control

The WM5102 performs automatic checks to confirm that each AIF is configured with valid settings. Invalid settings include conditions where one or more audio channel timeslots are in conflict.

If an AIF1 configuration error, AIF2 configuration error or AIF3 configuration error is detected, this can be indicated using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.



AIF DIGITAL AUDIO DATA CONTROL

The register bits controlling the audio data format, word lengths and slot configurations for AIF1, AIF2 and AIF3 are described in Table 38, Table 39 and Table 40 respectively.

Note that Left-Justified and DSP-B modes are valid in Master mode only (ie. BCLK and LRCLK are outputs from the WM5102).

The AIFn Slot Length is the number of BCLK cycles in one timeslot within the overall LRCLK frame. The Word Length is the number of valid data bits within each timeslot. (If the word length is less than the slot length, then there will be unused BCLK cycles at the end of each timeslot.) The AIFn word length and slot length is independently selectable for the input (RX) and output (TX) paths.

For each AIF input (RX) and AIF output (TX) channel, the position of the audio data sample within the LRCLK frame is configurable. The _SLOT registers define the timeslot position of the audio sample for the associated audio channel. Valid selections are Slot 0 upwards. The timeslots are numbered as illustrated in Figure 49 through to Figure 52.

Note that, in DSP modes, the timeslots are ordered consecutively from the start of the LRCLK frame. In I2S and Left-Justified modes, the even-numbered timeslots are arranged in the first half of the LRCLK frame, and the odd-numbered timeslots are arranged in the second half of the frame.

REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION
ADDRESS	5	LABEL	JEI AGEI	DEGGINI HON
R1284	2:0	AIF1_FMT [2:0]	000	AIF1 Audio Interface Format
(0504h)				000 = DSP Mode A
AIF1				001 = DSP Mode B
Format				$010 = I^2S \text{ mode}$
				011 = Left Justified mode
				Other codes are Reserved
R1287	13:8	AIF1TX_WL [5:0]	18h	AIF1 TX Word Length
(0507h)				(Number of valid data bits per slot)
AIF1 Frame Ctrl				Integer (LSB = 1); Valid from 16 to 32
1	7:0	AIF1TX_SLOT_L	18h	AIF1 TX Slot Length
•		EN [7:0]		(Number of BCLK cycles per slot)
				Integer (LSB = 1); Valid from 16 to 128
R1288	13:8	AIF1RX_WL [5:0]	18h	AIF1 RX Word Length
(0508h)				(Number of valid data bits per slot)
AIF1 Frame Ctrl				Integer (LSB = 1); Valid from 16 to 32
2	7:0	AIF1RX_SLOT_L	18h	AIF1 RX Slot Length
_		EN [7:0]		(Number of BCLK cycles per slot)
				Integer (LSB = 1); Valid from 16 to 128
R1289	5:0	AIF1TX1_SLOT	0h	AIF1 TX Channel n Slot position
(0509h)		[5:0]	41	Defines the TX timeslot position of the
to	5:0	AIF1TX2_SLOT [5:0]	1h	Channel n audio sample
to	5:0	AIF1TX3 SLOT	2h	Integer (LSB=1); Valid from 0 to 63
R1296	5.0	[5:0]	211	
(0510h)	5:0	AIF1TX4_SLOT	3h	
,		[5:0]		
	5:0	AIF1TX5_SLOT	4h	
<u> </u>		[5:0]		
	5:0	AIF1TX6_SLOT	5h	
-	5.0	[5:0]	Ol-	
	5:0	AIF1TX7_SLOT [5:0]	6h	
	5:0	AIF1TX8_SLOT	7h	
	5.0	[5:0]	/ 11	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1297 (0511h)	5:0	AIF1RX1_SLOT [5:0]	0h	AIF1 RX Channel n Slot position Defines the RX timeslot position of the
to	5:0	AIF1RX2_SLOT [5:0]	1h	Channel n audio sample Integer (LSB=1); Valid from 0 to 63
R1304	5:0	AIF1RX3_SLOT [5:0]	2h	
(0518h)	5:0	AIF1RX4_SLOT [5:0]	3h	
	5:0	AIF1RX5_SLOT [5:0]	4h	
	5:0	AIF1RX6_SLOT [5:0]	5h	
	5:0	AIF1RX7_SLOT [5:0]	6h	
	5:0	AIF1RX8_SLOT [5:0]	7h	

Table 38 AIF1 Digital Audio Data Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1348	2:0	AIF2_FMT [2:0]	000	AIF2 Audio Interface Format
(0544h)				000 = DSP Mode A
AIF2				001 = DSP Mode B
Format				$010 = I^2S \text{ mode}$
				011 = Left Justified mode
				Other codes are Reserved
R1351	13:8	AIF2TX_WL [5:0]	18h	AIF2 TX Word Length
(0547h)				(Number of valid data bits per slot)
AIF2				Integer (LSB = 1); Valid from 16 to 32
Frame Ctrl	7:0	AIF2TX_SLOT_L	18h	AIF2 TX Slot Length
1		EN [7:0]		(Number of BCLK cycles per slot)
				Integer (LSB = 1); Valid from 16 to 128
R1352	13:8	AIF2RX_WL [5:0]	18h	AIF2 RX Word Length
(0548h)				(Number of valid data bits per slot)
AIF2				Integer (LSB = 1); Valid from 16 to 32
Frame Ctrl 2	7:0	AIF2RX_SLOT_L	18h	AIF2 RX Slot Length
2		EN [7:0]		(Number of BCLK cycles per slot)
				Integer (LSB = 1); Valid from 16 to 128
R1353	5:0	AIF2TX1_SLOT	0h	AIF2 TX Channel 1 Slot position
(0549h)		[5:0]		Defines the TX timeslot position of the
AIF2				Channel 1 audio sample
Frame Ctrl 3				Integer (LSB=1); Valid from 0 to 63
R1354	5:0	AIF2TX2_SLOT	1h	AIF2 TX Channel 2 Slot position
(054Ah)		[5:0]		Defines the TX timeslot position of the
AIF2				Channel 2 audio sample
Frame Ctrl 4				Integer (LSB=1); Valid from 0 to 63
R1361	5:0	AIF2RX1_SLOT	0h	AIF2 RX Channel 1 Slot position
(0551h)		[5:0]		Defines the RX timeslot position of the
AIF2				Channel 1 audio sample
Frame Ctrl 11				Integer (LSB=1); Valid from 0 to 63

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1362 (0552h) AIF2 Frame Ctrl 12	5:0	AIF2RX2_SLOT [5:0]	1h	AIF2 RX Channel 2 Slot position Defines the RX timeslot position of the Channel 2 audio sample Integer (LSB=1); Valid from 0 to 63

Table 39 AIF2 Digital Audio Data Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1412 (0584h) AIF3 Format	2:0	AIF3_FMT [2:0]	000	AIF3 Audio Interface Format 000 = DSP Mode A 001 = DSP Mode B 010 = I ² S mode 011 = Left Justified mode Other codes are Reserved
R1415 (0587h) AIF3	13:8	AIF3TX_WL [5:0]	18h	AIF3 TX Word Length (Number of valid data bits per slot) Integer (LSB = 1); Valid from 16 to 32
Frame Ctrl 1	7:0	AIF3TX_SLOT_L EN [7:0]	18h	AIF3 TX Slot Length (Number of BCLK cycles per slot) Integer (LSB = 1); Valid from 16 to 128
R1416 (0588h) AIF3	13:8	AIF3RX_WL [5:0]	18h	AIF3 RX Word Length (Number of valid data bits per slot) Integer (LSB = 1); Valid from 16 to 32
Frame Ctrl 2	7:0	AIF3RX_SLOT_L EN [7:0]	18h	AIF3 RX Slot Length (Number of BCLK cycles per slot) Integer (LSB = 1); Valid from 16 to 128
R1417 (0589h) AIF3 Frame Ctrl	5:0	AIF3TX1_SLOT [5:0]	0h	AIF3 TX Channel 1 Slot position Defines the TX timeslot position of the Channel 1 audio sample Integer (LSB=1); Valid from 0 to 63
R1418 (058Ah) AIF3 Frame Ctrl	5:0	AIF3TX2_SLOT [5:0]	1h	AIF3 TX Channel 2 Slot position Defines the TX timeslot position of the Channel 2 audio sample Integer (LSB=1); Valid from 0 to 63
R1425 (0591h) AIF3 Frame Ctrl	5:0	AIF3RX1_SLOT [5:0]	0h	AIF3 RX Channel 1 Slot position Defines the RX timeslot position of the Channel 1 audio sample Integer (LSB=1); Valid from 0 to 63
R1426 (0592h) AIF3 Frame Ctrl 12	5:0	AIF3RX2_SLOT [5:0]	1h	AIF3 RX Channel 2 Slot position Defines the RX timeslot position of the Channel 2 audio sample Integer (LSB=1); Valid from 0 to 63

Table 40 AIF3 Digital Audio Data Control

The WM5102 performs automatic checks to confirm that each AIF is configured with valid settings. Invalid settings include conditions where one or more audio channel timeslots are in conflict.

If an AIF1 configuration error, AIF2 configuration error or AIF3 configuration error is detected, this can be indicated using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.



AIF TDM AND TRI-STATE CONTROL

The AIFn output pins are tri-stated when the AIFn_TRI register is set. Note that, when a GPIOn pin is configured as a GPIO, this pin is not affected by the respective AIFn_TRI register. See "General Purpose Input / Output" to configure the GPIO pins.

Under default conditions, the AIFnTXDAT output is held at logic 0 when the WM5102 is not transmitting data (ie. during timeslots that are not enabled for output by the WM5102). When the AIFnTX_DAT_TRI register is set, the WM5102 tri-states the respective AIFnTXDAT pin when not transmitting data, allowing other devices to drive the AIFnTXDAT connection.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	
R1281 (0501h)	5	AIF1TX_DAT_TR I	0	AIF1TXDAT Tri-State Control 0 = Logic 0 during unused timeslots	
AIF1 Tx Pin Ctrl				1 = Tri-stated during unused timeslots	
R1283 (0503h) AIF1 Rate Ctrl	6	AIF1_TRI	0	AIF1 Audio Interface Tri-State Control 0 = Normal 1 = AIF1 Outputs are tri-stated Note that the GPIO1 pin is only tri-stated	
				by this register when it is configured as AIF1TXLRCLK.	

Table 41 AIF1 TDM and Tri-State Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	
R1345 (0541h)	5	AIF2TX_DAT_TR I	0	AIF2TXDAT Tri-State Control 0 = Logic 0 during unused timeslots	
AIF2 Tx Pin Ctrl				1 = Tri-stated during unused timeslots	
R1347 (0543h)	6	AIF2_TRI	0	AIF2 Audio Interface Tri-State Control 0 = Normal	
AIF2 Rate Ctrl				1 = AIF2 Outputs are tri-stated Note that the GPIO2 pin is only tri-stated by this register when it is configured as AIF2TXLRCLK.	

Table 42 AIF2 TDM and Tri-State Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	
R1409 (0581h)	5	AIF3TX_DAT_TR	0	AIF3TXDAT Tri-State Control 0 = Logic 0 during unused timeslots	
AIF3 Tx Pin Ctrl				1 = Tri-stated during unused timeslots	
R1411 (0583h) AIF3 Rate	6	AIF3_TRI	0	AIF3 Audio Interface Tri-State Control 0 = Normal 1 = AIF3 Outputs are tri-stated	
Ctrl				Note that the GPIO3 pin is only tri-stated by this register when it is configured as AIF3TXLRCLK.	

Table 43 AIF3 TDM and Tri-State Control



AIF DIGITAL PULL-UP AND PULL-DOWN

The WM5102 provides integrated pull-up and pull-down resistors on each of the AIFnLRCLK, AIFnBCLK and AIFnRXDAT pins. This provides a flexible capability for interfacing with other devices.

Each of the pull-up and pull-down resistors can be configured independently using the register bits described in Table 44, Table 45 and Table 46. Note that if the Pull-up and Pull-down are both enabled for any pin, then the pull-up and pull-down will be disabled.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3107	5	AIF1LRCLK_PU	0	AIF1LRCLK Pull-Up Control
(0C23h)				0 = Disabled
Misc Pad				1 = Enabled
Ctrl 4	4	AIF1LRCLK_PD	0	AIF1LRCLK Pull-Down Control
				0 = Disabled
				1 = Enabled
	3	AIF1BCLK_PU	0	AIF1BCLK Pull-Up Control
				0 = Disabled
				1 = Enabled
	2	AIF1BCLK_PD	0	AIF1BCLK Pull-Down Control
				0 = Disabled
				1 = Enabled
	1	AIF1RXDAT_PU	0	AIF1RXDAT Pull-Up Control
				0 = Disabled
				1 = Enabled
	0	AIF1RXDAT_PD	0	AIF1RXDAT Pull-Down Control
				0 = Disabled
				1 = Enabled

Table 44 AIF1 Digital Pull-Up and Pull-Down Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3108	5	AIF2LRCLK_PU	0	AIF2LRCLK Pull-Up Control
(0C24h)				0 = Disabled
Misc Pad				1 = Enabled
Ctrl 5	4	AIF2LRCLK_PD	0	AIF2LRCLK Pull-Down Control
				0 = Disabled
				1 = Enabled
	3	AIF2BCLK_PU	0	AIF2BCLK Pull-Up Control
				0 = Disabled
				1 = Enabled
	2	AIF2BCLK_PD	0	AIF2BCLK Pull-Down Control
				0 = Disabled
				1 = Enabled
	1	AIF2RXDAT_PU	0	AIF2RXDAT Pull-Up Control
				0 = Disabled
				1 = Enabled
	0	AIF2RXDAT_PD	0	AIF2RXDAT Pull-Down Control
				0 = Disabled
				1 = Enabled

Table 45 AIF2 Digital Pull-Up and Pull-Down Control

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3109	5	AIF3LRCLK_PU	0	AIF3LRCLK Pull-Up Control
(0C25h)				0 = Disabled
Misc Pad				1 = Enabled
Ctrl 6	4	AIF3LRCLK_PD	0	AIF3LRCLK Pull-Down Control
				0 = Disabled
				1 = Enabled
	3	AIF3BCLK_PU	0	AIF3BCLK Pull-Up Control
				0 = Disabled
				1 = Enabled
	2	AIF3BCLK_PD	0	AIF3BCLK Pull-Down Control
				0 = Disabled
				1 = Enabled
	1	AIF3RXDAT_PU	0	AIF3RXDAT Pull-Up Control
				0 = Disabled
				1 = Enabled
	0	AIF3RXDAT_PD	0	AIF3RXDAT Pull-Down Control
				0 = Disabled
				1 = Enabled

Table 46 AIF3 Digital Pull-Up and Pull-Down Control

SLIMBUS INTERFACE

The SLIMbus protocol is highly configurable and adaptable, supporting multiple audio signal paths, and mixed sample rates simultaneously. It also supports control messaging and associated communications between devices.

SLIMBUS DEVICES

The SLIMbus components comprise different device classes (Manager, Framer, Interface, Generic). Each component on the bus has an Interface Device, which provides bus management services for the respective component. One or more components on the bus will provide Manager and Framer Device functions; the Manager has the capabilities to administer the bus, whilst the Framer is responsible for driving the CLK line and for driving the DATA required to establish the Frame Structure on the bus. Note that only one Manager and one Framer Device will be active at any time. The Framer function can be transferred between Devices when required. Generic Devices provide the basic SLIMbus functionality for the associated Port(s), and for the Transport Protocol by which audio signal paths are established on the bus.

SLIMBUS FRAME STRUCTURE

The SLIMbus bit stream is formatted within a defined structure of Cells, Slots, Subframes, Frames, and Superframes:

- A single data bit is known as a Cell
- 4 Cells make a Slot
- 192 Slots make a Frame
- 8 Frames make a Superframe

The bit stream structure is configurable to some extent, but the Superframe definition always comprises 1536 slots. The transmitted/received bit rate is not fixed; it can be configured according to system requirements, and can be changed dynamically without interruption to active audio paths.

The SLIMbus CLK frequency (also the bus bit rate) is defined by a *Root Frequency (RF)* and a *Clock Gear (CG)*. In the top Clock Gear (Gear 10), the CLK frequency is equal to the Root Frequency. Each reduction in the Clock Gear halves the CLK frequency, and doubles the duration of the Superframe.

The SLIMbus bandwidth will typically comprise Control space (for bus messages, synchronisation etc.) and Data space (for audio paths). The precise allocation is configurable, and can be entirely Control space, if required.

The Subframe definition comprises the number of Slots per Subframe (6, 8, 24 or 32 Slots), and the number of these Slots (per Subframe) allocated as Control space. The applicable combination of Subframe length and Control space width are defined by the Subframe Mode (SM) parameter.

The SLIMbus Frame always comprises 192 Slots, regardless of the Subframe definition. A number of Slots are allocated to Control space, as noted above; the remaining Slots are allocated to Data space. Some of the Control space is required for Framing Information and for the Guide Channel (described below); the remainder of the Control space are allocated to the Message Channel.

CONTROL SPACE

Framing Information is provided in Slots 0 and 96 of every Frame. Slot 0 contains a 4-bit synchronisation code; Slot 96 contains the 32-bit Framing Information, transmitted 4 bits at a time over the 8 Frames that make up the SLIMbus Superframe. The Clock Gear, Root Frequency, Subframe configuration, along with some other parameters, are encoded within the Framing Information.

The Guide Channel occupies two Slots within Frame 0. This provides the necessary information for a SLIMbus component to acquire and verify the frame synchronisation. The Guide Channel occupies



the first two Control space Slots within the first Frame of the bit stream, excluding the Framing Information Slots. Note that the exact Slot allocation will depend upon the applicable Subframe mode.

The Message Channel is allocated all of the Control space not used by the Framing Information or the Guide Channel. The Message Channel enables SLIMbus devices to communicate with each other, using a priority-based mechanism defined in the MIPI specification.

Messages may be broadcast to all devices on the bus, or can be addressed to specific devices using their allocated *Logical Address (LA)* or *Enumeration Address (EA)*. Note that, device-specific messages are directed to a particular device (ie. Manager, Framer, Interface or Generic) within a component on the bus.

DATA SPACE

The Data space can be organised into a maximum of 256 Data Channels. Each Channel, identified by a unique *Channel Number (CN)*, is a stream of one or more contiguous Slots, organised in a consistent data structure that repeats at a fixed interval.

A Data Channel is defined by its *Segment Length (SL)* (number of contiguous Slots allocated), Segment Interval (spacing between the first Slots of successive Segments), and Segment Offset (the Slot Number of the first allocated Slot within the Superframe). The Segment Interval and Segment Offset are collectively defined by a *Segment Distribution (SD)*, by which the SLIMbus Manager may configure (or re-configure) any Data Channel.

Each Segment may comprise TAG, AUX and DATA portions. Any of these portions may be 0-length; the exact composition depends on the *Transport Protocol (TP)* for the associated Channel (see below). The DATA portion must be wide enough to accommodate one full word of the Data Channel contents (data words cannot be spread across multiple segments).

The Segment Interval for each Data Channel represents the minimum spacing between consecutive data samples for that Channel. (Note - the minimum spacing applies if every allocated segment is populated with new data; in many cases, additional bandwidth is allocated, as described below, and not every allocated segment is used.)

The Segment Interval gives rise to Segment Windows for each Data Channel, aligned to the start of every Superframe. The Segment Window boundaries define the times within which each new data sample must be buffered, ready for transmission - adherence to these fixed boundaries allows Slot allocations to be moved within a Segment Window, without altering the signal latency. The Segment Interval may be either shorter or longer than the Frame length, but there is always an integer number of Segment Windows per Superframe.

The *Transport Protocol (TP)* defines the flow control or handshaking method used by the Ports associated with a Data Channel. The applicable flow control mode(s) depend on the relationship between the audio sample rate (flow rate) and the SLIMbus CLK frequency. If the two rates are synchronised and integer-related, then no flow control is needed; in other cases, the flow may be regulated by the use of a 'Presence' bit. The Presence bit can either be set by the source Device ('pushed' protocol), or by the sink Device ('pulled' protocol).

The Data Channel structure is defined in terms of the *Transport Protocol (TP)*, *Segment Distribution (SD)*, and the *Segment Length (SL)* parameters. Each of these is described above.

The Data Channel content definition includes a *Presence Rate (PR)* parameter (describing the nominal sample rate for the audio channel) and a *Frequency Locked (FL)* bit (identifying whether the data source is synchronised to the SLIMbus CLK). The *Data Length (DL)* parameter defines the size of each data sample (number of Slots). The *Auxiliary Bits Format (AF)* and *Data Type (DT)* parameters provide support for non-PCM encoded data channels; the *Channel Link (CL)* parameter is an indicator that channel CN is related to the previous channel, CN-1.

For a given Root Frequency and Clock Gear, the Segment Length (SL) and Segment Distribution (SD) parameters define the amount of SLIMbus bandwidth that is allocated to a given Data Channel. The minimum bandwidth requirements of a Data Channel are represented by the Presence Rate (PR) and Data Length (DL) parameters. The allocated SLIMbus bandwidth must be equal to or greater than the bandwidth of the data to be transferred.

The Segment Interval (see above), defines the repetition rate of the SLIMbus Slots allocated to consecutive data samples for a given Data Channel. The *Presence Rate (PR)* is the nominal sample rate of the audio path. The Segment Interval must be equal to or greater than the Presence Rate for a given Data Channel.



In some applications, the allocated SLIMbus bandwidth must be greater than the data rate, to ensure that samples are not dropped as a result of clock drift etc. The SLIMbus bandwidth should only be set equal to the data rate if the data source is frequency-locked to the SLIMbus CLK (ie. the data source is synchronised to the SLIMbus Framer device).

SLIMBUS CONTROL SEQUENCES

This section describes the messages and general protocol associated with most aspects of the SLIMbus system.

Note that the SLIMbus specification permits some flexibility in Core Message support for different components. See "SLIMbus Interface Control" for details of which message(s) are supported on each of the SLIMbus devices that are present on the WM5102.

DEVICE MANAGEMENT & CONFIGURATION

This section describes the SLIMbus messages associated with configuring all devices on the SLIMbus interface

When the SLIMbus interface starts up, it is required that one (and only one) of the components provides the Manager and Framer Device functions. Other devices can request connection to the bus after they have gained synchronisation.

The REPORT_PRESENT (DC, DCV) message may be issued by devices attempting to connect to the bus. The payload of this message contains the *Device Class (DC)* and *Device Class Version (DCV)* parameters, describing the type of device that is attempting to connect. This message may be issued autonomously by the connecting device, or else in response to a REQUEST_SELF_ANNOUNCEMENT message from the Manager Device.

After positively acknowledging the REPORT_PRESENT message, the Manager Device will then issue the **ASSIGN_LOGICAL_ADDRESS (LA)** message to allow the other device to connect to the bus. The payload of this message contains the *Logical Address (LA)* parameter only; this is the unique address by which the connected device will send and receive SLIMbus messages. The device is then said to be 'enumerated'.

Once a device has been successfully connected to the bus, the Logical Address (LA) parameter can be changed at any time using the **CHANGE_LOGICAL_ADDRESS (LA)** message.

The **RESET_DEVICE** message commands an individual SLIMbus device to perform its reset procedure. As part of the reset, all associated ports will be reset, and any associated Data Channels will be cancelled. Note that, if the RESET_DEVICE command is issued to an Interface Device, it will cause a Component Reset (ie. all Devices within the associated component are reset). Under a Component Reset, every associated Device will release its Logical Address, and the Component will become disconnected from the bus.

INFORMATION MANAGEMENT

A memory map of Information Elements is defined for each Device. This is arranged in 3×1 kByte blocks, as described in the MIPI specification.

Read/Write access is implemented using the messages described below. Specific elements within the Information Map are identified using the *Element Code (EC)* parameter. In the case of Read access, a unique *Transaction ID (TID)* is assigned to each message relating to a particular read/write request.

The **REQUEST_INFORMATION (TID, EC)** message is used to instruct a device to respond with the indicated information. The payload of this message contains the *Transaction ID (TID)* and the *Element Code (EC)*.

The REQUEST_CLEAR_INFORMATION (TID, EC, CM) message is used to instruct a device to respond with the indicated information, and also to clear all, or parts, of the same information slice. The payload of this message contains the *Transaction ID (TID), Element Code (EC)*, and *Clear Mask (CM)*. The Clear Mask field is used to select which element(s) are to be cleared as part of the instruction.

The REPLY INFORMATION (TID, IS) message is used to provide readback of a requested



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parameter. The payload of this message contains the *Transaction ID (TID)* and the *Information Slice (IS)*. The Information Slice byte(s) contain the value of the requested parameter.

The **CLEAR_INFORMATION (EC, CM)** message is used to clear all, or parts, of the indicated information slice. The payload of this message contains the *Element Code (EC)* and *Clear Mask (CM)*. The Clear Mask field is used to select which element(s) are to be cleared as part of the instruction.

The **REPORT_INFORMATION** (**EC**, **IS**) message is used to inform other devices about a change in a specified element in the Information Map. The payload of this message contains the *Element Code* (*EC*) and the *Information Slice* (*IS*). The Information Slice byte(s) contain the new value of the applicable parameter.

VALUE MANAGEMENT (INCLUDING REGISTER ACCESS)

A memory map of Value Elements is defined for each Device. This is arranged in 3 x 1kByte blocks, as described in the MIPI specification. These elements are typically parameters used to configure Device behaviour.

The User Value Elements space within the Value Map are used on WM5102 to support Read/Write access to the Register Map. Details of how to access specific registers are described in the "SLIMbus Interface Control" section.

Read/Write access is implemented using the messages described below. Specific elements within the Value Map are identified using the *Element Code (EC)* parameter. In the case of Read access, a unique *Transaction ID (TID)* is assigned to each message relating to a particular read/write request.

The **REQUEST_VALUE** (**TID**, **EC**) message is used to instruct a device to respond with the indicated information. The payload of this message contains the *Transaction ID* (*TID*) and the *Element Code* (*EC*).

The **REPLY_VALUE (TID, VS)** message is used to provide readback of a requested parameter. The payload of this message contains the *Transaction ID (TID)* and the *Value Slice (VS)*. The Value Slice byte(s) contain the value of the requested parameter.

The **CHANGE_VALUE (EC, VU)** message is used to write data to a specified element in the Value Map. The payload of this message contains the *Element Code (EC)* and the *Value Update (VU)*. The Value Update byte(s) contain the new value of the applicable parameter.

FRAME & CLOCKING MANAGEMENT

This section describes the SLIMbus messages associated with changing the Frame or Clocking configuration. One or more configuration messages may be issued as part of a Reconfiguration Sequence; all of the updated parameters become active at once, when the Reconfiguration boundary is reached.

The **BEGIN_RECONFIGURATION** message is issued to define a Reconfiguration Boundary point: subsequent NEXT_* messages will become active at the first valid Superframe boundary following receipt of the **RECONFIGURE_NOW** message. (A valid boundary must be at least two Slots after the end of the RECONFIGURE_NOW message.) Both of these messages have no payload content.

The **NEXT_ACTIVE_FRAMER** (LAIF, **NCo**, **NCi**) message is used to select a new device as the active Framer. The payload of this message includes the *Logical Address, Incoming Framer* (*LAIF*). Two other fields (NCo, NCi) define the number of clock cycles for which the CLK line shall be inactive during the handover.

The **NEXT_SUBFRAME_MODE** (SM) and **NEXT_CLOCK_GEAR** (CG) messages are used to reconfigure the SLIMbus clocking or framing definition. The payload of each is the respective *Subframe Mode* (SM) or Clock Gear (CG) respectively.

The **NEXT_PAUSE_CLOCK (RT)** message instructs the active Framer to pause the bus. The payload of the message contains the Restart Time (RT), which indicates whether the interruption is to be of a specified time and/or phase duration.

The **NEXT_RESET_BUS** message instructs all components on the bus to be reset. In this case, all Devices on the bus are reset and are disconnected from the bus. Subsequent re-connection to the bus follows the same process as when the bus is first initialised.

The NEXT_SHUTDOWN_BUS message instructs all devices that the bus is to be shut down.



DATA CHANNEL CONFIGURATION

This section describes the procedure for configuring a SLIMbus Data Channel. Note that the Manager Device is responsible for allocating the available bandwidth as required for each Data Channel.

The CONNECT_SOURCE (PN, CN) and CONNECT_SINK (PN, CN) messages are issued to the respective devices, defining the Port(s) between which a Data Channel is to be established. Note that multiple destinations (sinks) can be configured for a channel, if required. The payload of each message contains the *Port Number (PN)* and the *Channel Number (CN)* parameters.

The **BEGIN_RECONFIGURATION** message is issued to define a Reconfiguration Boundary point: subsequent NEXT_* messages will become active at the first valid Superframe boundary following receipt of the **RECONFIGURE_NOW** message. (A valid boundary must be at least two Slots after the end of the RECONFIGURE_NOW message.)

The **NEXT_DEFINE_CHANNEL (CN, TP, SD, SL)** message informs the associated devices of the structure of the Data Channel. The payload of this message contains the *Channel Number (CN)*, *Transport Protocol (TP)*, *Segment Distribution (SD)*, and the *Segment Length (SL)* parameters for the Data Channel.

The NEXT_DEFINE_CONTENT (CN, FL, PR, AF, DT, CL, DL), or CHANGE_CONTENT (CN, FL, PR, AF, DT, CL, DL) message provides more detailed information about the Data Channel contents. The payload of this message contains the Channel Number (CN), Frequency Locked (FL), Presence Rate (PR), Auxiliary Bits Format (AF), Data Type (DT), Channel Link (CL), and Data Length (DL) parameters.

The **NEXT_ACTIVATE_CHANNEL (CN)** message instructs the channel to be activated at the next Reconfiguration boundary. The payload of this message contains the *Channel Number (CN)* only.

The **RECONFIGURE_NOW** message completes the Reconfiguration sequence, causing all of the 'NEXT_' messages since the BEGIN_RECONFIGURATION to become active at the next valid Superframe boundary. (A valid boundary must be at least two Slots after the end of the RECONFIGURE_NOW message.)

Active channels can be reconfigured using the **CHANGE_CONTENT**, **NEXT_DEFINE_CONTENT**, or **NEXT_DEFINE_CHANNEL** messages. Note that these changes can be effected without interrupting the data channel; the **NEXT_DEFINE_CHANNEL**, for example, may be used to change a Segment Distribution, in order to reallocate the SLIMbus bandwidth.

An active channel can be paused using the **NEXT_DEACTIVATE_CHANNEL** message, and reinstated using the **NEXT_ACTIVATE_CHANNEL** message.

Data channels can be disconnected using the **DISCONNECT_PORT** or **NEXT_REMOVE_CHANNEL** messages. These messages provide equivalent functionality, but use different parameters (PN or CN respectively) to identify the affected signal path.



WM5102 Production Data

SLIMBUS INTERFACE CONTROL

The WM5102 features a MIPI-compliant SLIMbus interface, providing 8 channels of audio input and 8 channels of audio output. Mixed audio sample rates are supported on the SLIMbus interface. The SLIMbus interface also supports read/write access to the WM5102 control registers.

The SLIMbus interface on WM5102 comprises a Generic Device, Framer Device, and Interface Device. A maximum of 16 Ports can be configured, providing up to 8 input (RX) channels and up to 8 output (TX) channels.

The audio paths associated with the SLIMbus interface are described in the "Digital Core" section.

The SLIMbus interface supports read/write access to the WM5102 control registers, as described later in this section.

The SLIMbus clocking rate and channel allocations are controlled by the Manager Device. The Message Channel and Data Channel bandwidth may be dynamically adjusted according to the application requirements. Note that the Manager Device functions are not implemented on the WM5102, and these bandwidth allocation requirements are outside the scope of this datasheet.

SLIMBUS DEVICE PARAMETERS

The SLIMbus interface on the WM5102 comprises three Devices. The Enumeration Address of each Device within the SLIMbus interface is derived from the parameters noted in Table 47.

DESCRIPTION	MANUFACTURER ID	PRODUCT CODE	DEVICE ID	INSTANCE VALUE	ENUMERATION ADDRESS
Generic	0x012F	0x5102	0x00	0x00	012F_5102_0000
Framer	0x012F	0x5102	0x55	0x00	012F_5102_5500
Interface	0x012F	0x5102	0x7F	0x00	012F_5102_7F00

Table 47 SLIMbus Device Parameters

SLIMBUS MESSAGE SUPPORT

The SLIMbus interface on the WM5102 supports bus messages as noted in Table 48.

Additional notes regarding SLIMbus message support are noted below, and also in Table 49.



MESSAGE CODE MC[6:0]	DESCRIPTION	GENERIC	FRAMER	INTERFACE
Device Manageme	nt Messages	1		•
0x01	REPORT_PRESENT (DC, DCV)	S	S	S
0x02	ASSIGN_LOGICAL_ADDRESS (LA)	D	D	D
0x04	RESET_DEVICE ()	D	D	D
0x08	CHANGE_LOGICAL_ADDRESS (LA)	D	D	D
0x09	CHANGE_ARBITRATION_PRIORITY (AP)			
0x0C	REQUEST_SELF_ANNOUNCEMENT ()	D	D	D
0x0F	REPORT_ABSENT ()			
Data Channel Man	agement Messages			
0x10	CONNECT_SOURCE (PN, CN)	D		
0x11	CONNECT_SINK (PN, CN)	D		
0x14	DISCONNECT_PORT (PN)	D		
0x18	CHANGE_CONTENT (CN, FL, PR, AF, DT, CL, DL)	D		
Information Manag	romant Massagas			
0x20	REQUEST_INFORMATION (TID, EC)	D	D	D
0x20	REQUEST_CLEAR_INFORMATION (TID, EC, CM)	D	<u>D</u>	D
0x24	REPLY_INFORMATION (TID, IS)	S	S	S
0x24 0x28	CLEAR_INFORMATION (EC, CM)	D	D	D
0x29	REPORT INFORMATION (EC, IS)	Б	<u> </u>	S
				-
Reconfiguration M	lessages			
0x40	BEGIN_RECONFIGURATION ()	D	D	D
0x44	NEXT_ACTIVE_FRAMER (LAIF, NCo, NCi)		D	
0x45	NEXT_SUBFRAME_MODE (SM)		D	D
0x46	NEXT_CLOCK_GEAR (CG)		D	
0x47	NEXT_ROOT_FREQUENCY (RF)		D	
0x4A	NEXT_PAUSE_CLOCK (RT)		D	
0x4B	NEXT_RESET_BUS ()		D	
0x4C	NEXT_SHUTDOWN_BUS ()		D	
0x50	NEXT_DEFINE_CHANNEL (CN, TP, SD, SL)	D		
0x51	NEXT_DEFINE_CONTENT (CN, FL, PR, AF, DT, CL, DL)	D		
0x54	NEXT_ACTIVATE_CHANNEL (CN)	D		
0x55	NEXT_DEACTIVATE_CHANNEL (CN)	D		
0x58	NEXT_REMOVE_CHANNEL (CN)	D		
0x5F	RECONFIGURE_NOW ()	D	D	D
Value Managemen	t Massages			
0x60	REQUEST_VALUE (TID, EC)			D
0x61	REQUEST_CHANGE_VALUE (TID, EC, VU)			
0x64	REPLY_VALUE (TID, VS)			S
0x68	CHANGE_VALUE (EC, VU)			D

Table 48 SLIMbus Message Support

S = supported as a Source Device only. D = supported as a Destination Device only.

Note that REQUEST_* messages are only supported from the Manager Device (ie. the Source Device must also be the Manager Device).

The WM5102 SLIMbus component must be reset prior to scheduling a Hardware Reset or Power-On Reset. This can be achieved using the RESET_DEVICE message (issued to the WM5102 Interface Device), or else using the NEXT_RESET_BUS message.



PARAMETER CODE	DESCRIPTION	COMMENTS
AF	Auxiliary Bits Format	
CG	Clock Gear	
CL	Channel Link	
СМ	Clear Mask	WM5102 does not fully support this function. The CM bytes of the REQUEST_CLEAR_INFORMATION or CLEAR_INFORMATION messages must not be sent to WM5102 Devices. When either of these messages is received, all bits within the specified Information Slice will be cleared.
CN	Channel Number	
DC	Device Class	
DCV	Device Class Variation	
DL	Data Length	
DT	Data Type	WM5102 supports the following DT codes: 0h - Not indicated 1h - LPCM audio Note that 2's complement PCM can be supported with DT=0h.
EC	Element Code	
FL	Frequency Locked	
IS	Information Slice	
LA	Logical Address	
LAIF	Logical Address, Incoming Framer	
NCi	Number of Incoming Framer Clock Cycles	
NCo	Number of Outgoing Framer Clock Cycles	
PN	Port Number	Note that the Port Numbers of the WM5102 SLIMbus paths are register-configurable, as described in Table 50.
PR	Presence Rate	Note that the Presence Rate must be the same as the Sample Rate selected for the associated WM5102 SLIMbus path.
RF	Root Frequency	WM5102 supports the following RF codes as Active Framer: 1h - 24.576MHz 2h - 22.5792MHz All codes are supported when WM5102 is not the Active Framer.
RT	Restart Time	WM5102 supports the following RT codes: 0h - Fast Recovery 2h - Unspecified Delay When either of these values is specified, the WM5102 will resume toggling the CLK line within four cycles of the CLK line frequency.
SD	Segment Distribution	Note that any data channels that are assigned the same SAMPLE_RATE_n or ASYNC_SAMPLE_RATE_n value must also be assigned the same Segment Interval.
SL	Segment Length	
SM	Subframe Mode	
TID	Transaction ID	
TP	Transport Protocol	WM5102 supports the following TP codes for TX channels: 0h - Isochronous Protocol 1h - Pushed Protocol WM5102 supports the following TP codes for RX channels: 0h - Isochronous Protocol 2h - Pulled Protocol
	Malara Olica	
VS	Value Slice	

Table 49 SLIMbus Parameter Support



SLIMBUS PORT NUMBER CONTROL

The WM5102 SLIMbus interface supports up to 8 input (RX) channels and up to 8 output (TX) channels. The SLIMbus port numbers for these audio channels are configurable using the registers described in Table 50.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1498 (05DAh)	13:8	SLIMRX2_PORT _ADDR [5:0]	1	SLIMbus RX Channel n Port number Valid from 063
SLIMbus RX Ports0	5:0	SLIMRX1_PORT _ADDR [5:0]	0	
R1499 (05DBh)	13:8	SLIMRX4_PORT _ADDR [5:0]	3	
SLIMbus RX Ports1	5:0	SLIMRX3_PORT _ADDR [5:0]	2	
R1500 (05DCh)	13:8	SLIMRX6_PORT _ADDR [5:0]	5	
SLIMbus RX Ports2	5:0	SLIMRX5_PORT _ADDR [5:0]	4	
R1501 (05DDh)	13:8	SLIMRX8_PORT _ADDR [5:0]	7	
SLIMbus RX Ports3	5:0	SLIMRX7_PORT _ADDR [5:0]	6	
R1502 (05DEh)	13:8	SLIMTX2_PORT_ ADDR [5:0]	9	SLIMbus TX Channel n Port number Valid from 063
SLIMbus TX Ports0	5:0	SLIMTX1_PORT_ ADDR [5:0]	8	
R1503 (05DFh)	13:8	SLIMTX4_PORT_ ADDR [5:0]	11	
SLIMbus TX Ports1	5:0	SLIMTX3_PORT_ ADDR [5:0]	10	
R1504 (05E0h)	13:8	SLIMTX6_PORT_ ADDR [5:0]	13	
SLIMbus TX Ports2	5:0	SLIMTX5_PORT_ ADDR [5:0]	12	
R1505 (05E1h)	13:8	SLIMTX8_PORT_ ADDR [5:0]	15	
SLIMbus TX Ports3	5:0	SLIMTX7_PORT_ ADDR [5:0]	14	

Table 50 SLIMbus Port Numbers

SLIMBUS SAMPLE RATE CONTROL

The SLIMbus RX inputs may be selected as input to the digital mixers or signal processing functions within the WM5102 digital core. The SLIMbus TX outputs are derived from the respective output mixers.

The sample rate for each SLIMbus channel is configured using the SLIMRXn_RATE and SLIMTXn_RATE registers - see Table 21 within the "Digital Core" section.

Note that the SLIMbus interface provides simultaneous support for SYSCLK-referenced and ASYNCCLK-referenced sample rates on different channels. For example, 48kHz and 44.1kHz SLIMbus audio paths can be simultaneously supported.

Sample rate conversion is required when routing the SLIMbus paths to any signal chain that is asynchronous and/or configured for a different sample rate.



SLIMBUS SIGNAL PATH ENABLE

The SLIMbus interface supports up to 8 input (RX) channels and up to 8 output (TX) channels. Each of these channels can be enabled or disabled using the register bits defined in Table 51.

Note that the SLIMbus audio channels can only be supported when the corresponding ports have been enabled by the Manager Device (ie. in addition to setting the respective enable bits). The status bits in Registers R1527 and R1528 indicate the status of each of the SLIMbus ports.

The system clock, SYSCLK, must be configured and enabled before any audio path is enabled. The ASYNCCLK may also be required, depending on the path configuration. See "Clocking and Sample Rates" for details of the system clocks.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1525	7	SLIMRX8_ENA	0	SLIMbus RX Channel n Enable
(05F5h)	6	SLIMRX7_ENA	0	0 = Disabled
SLIMbus	5	SLIMRX6_ENA	0	1 = Enabled
RX Channel	4	SLIMRX5_ENA	0	
Enable	3	SLIMRX4_ENA	0	
	2	SLIMRX3_ENA	0	
	1	SLIMRX2_ENA	0	
	0	SLIMRX1_ENA	0	
R1526	7	SLIMTX8_ENA	0	SLIMbus TX Channel n Enable
(05F6h)	6	SLIMTX7_ENA	0	0 = Disabled
SLIMbus	5	SLIMTX6_ENA	0	1 = Enabled
TX Channel	4	SLIMTX5_ENA	0	
Enable	3	SLIMTX4_ENA	0	
	2	SLIMTX3_ENA	0	
	1	SLIMTX2_ENA	0	
	0	SLIMTX1_ENA	0	
R1527	7	SLIMRX8_PORT_STS	0	SLIMbus RX Channel n Port Status
(05F7h)	6	SLIMRX7_PORT_STS	0	(Read only)
SLIMbus	5	SLIMRX6_PORT_STS	0	0 = Disabled
RX Port Status	4	SLIMRX5_PORT_STS	0	1 = Configured and active
Ciaias	3	SLIMRX4_PORT_STS	0	
	2	SLIMRX3_PORT_STS	0	
	1	SLIMRX2_PORT_STS	0	
	0	SLIMRX1_PORT_STS	0	
R1528	7	SLIMTX8_PORT_STS	0	SLIMbus TX Channel n Port Status
(05F8h)	6	SLIMTX7_PORT_STS	0	(Read only)
SLIMbus	5	SLIMTX6_PORT_STS	0	0 = Disabled
TX Port Status	4	SLIMTX5_PORT_STS	0	1 = Configured and active
Julius	3	SLIMTX4_PORT_STS	0	
	2	SLIMTX3_PORT_STS	0	
	1	SLIMTX2_PORT_STS	0	
	0	SLIMTX1_PORT_STS	0	

Table 51 SLIMbus Signal Path Enable

SLIMBUS CONTROL REGISTER ACCESS

Control register access is supported via the SLIMbus interface. Full read/write access to all registers is possible, via the "User Value Elements" portion of the Value Map.

Register Write operations are implemented using the "CHANGE_VALUE" message. A maximum of two messages may be required, depending on circumstances: the first "CHANGE_VALUE" message selects the register page (bits [23:8] of the Control Register address); the second message contains the data and bits [7:0] of the register address. The first message may be omitted if the register page is unchanged from the previous Read or Write operation.

The associated parameters are described in Table 52 and Table 53, for the generic case of writing the value 0xVVVV to control register address 0xYYYYZZ.

Write Message 1 – CHANGE_VALUE				
PARAMETER	VALUE	DESCRIPTION		
Source Address	0xFF	Identifies the Manager Device as the message source, using the 8-bit Logical Address. The value is always 0xFF.		
Destination Address	0xLL	'LL' is the 8-bit Logical Address of the message destination (ie. the WM5102 SLIMbus Interface Device). The value is assigned by the SLIMbus Manager Device.		
Access Mode	0b1	Selects Byte-based access mode.		
Byte Address	0x800	Identifies the User Value element for selecting the Control Register page address.		
Slice Size	0b001	Selects 2-byte slice size		
Value Update	0xYYYY	'YYYY' is bits [23:8] of the applicable Control Register address.		

Table 52 Register Write Message (1)

Write Message 2 – CHANGE_VALUE				
PARAMETER	VALUE	DESCRIPTION		
Source Address	0xFF	Identifies the Manager Device as the message source, using the 8-bit Logical Address. The value is always 0xFF.		
Destination Address	0xLL	'LL' is the 8-bit Logical Address of the message destination (ie. the WM5102 SLIMbus Interface Device). The value is assigned by the SLIMbus Manager Device.		
Access Mode	0b1	Selects Byte-based access mode.		
Byte Address	0xUUU	Specifies the Value Map address, calculated as 0xA00 + (2 x 0xZZ), where 'ZZ' is bits [7:0] of the applicable Control Register address.		
Slice Size	0b001	Selects 2-byte slice size		
Value Update	0xVVVV	'VVVV' is the 16-bit data to be written.		

Table 53 Register Write Message (2)

Note that the first message may be omitted if its contents are unchanged from the previous CHANGE_VALUE message sent to the WM5102.



Register Read operations are implemented using the "CHANGE_VALUE" and "REQUEST_VALUE" messages. A maximum of two messages may be required, depending on circumstances: the "CHANGE_VALUE" message selects the register page (bits [23:8] of the Control Register address); the "REQUEST_VALUE" message contains bits [7:0] of the register address. The first message may be omitted if the register page is unchanged from the previous Read or Write operation.

The associated parameters are described in Table 54 and Table 55, for the generic case of reading the contents of control register address 0xYYYYZZ.

Read Message 1 – CHANGE_VALUE				
PARAMETER	VALUE	DESCRIPTION		
Source Address	0xFF	Identifies the Manager Device as the message source, using the 8-bit Logical Address. The value is always 0xFF.		
Destination Address	0xLL	'LL' is the 8-bit Logical Address of the message destination (ie. the WM5102 SLIMbus Interface Device). The value is assigned by the SLIMbus Manager Device.		
Access Mode	0b1	Selects Byte-based access mode.		
Byte Address	0x800	Identifies the User Value element for selecting the Control Register page address.		
Slice Size	0b001	Selects 2-byte slice size		
Value Update	0xYYYY	'YYYY' is bits [23:8] of the applicable Control Register address.		

Table 54 Register Read Message (1)

Read Message 2 – REQ	Read Message 2 - REQUEST_VALUE			
PARAMETER	VALUE	DESCRIPTION		
Source Address	0xFF	Identifies the Manager Device as the message source, using the 8-bit Logical Address. The value is always 0xFF.		
Destination Address	0xLL	'LL' is the 8-bit Logical Address of the message destination (ie. the WM5102 SLIMbus Interface Device). The value is assigned by the SLIMbus Manager Device.		
Access Mode	0b1	Selects Byte-based access mode.		
Byte Address	0xUUU	Specifies the Value Map address, calculated as 0xA00 + (2 x 0xZZ), where 'ZZ' is bits [7:0] of the applicable Control Register address.		
Slice Size	0b001	Selects 2-byte slice size		
Transaction ID	0xTTTT	'TTTT' is the 16-bit Transaction ID for the message. The value is assigned by the SLIMbus Manager Device.		

Table 55 Register Read Message (2)

Note that the first message may be omitted if its contents are unchanged from the previous CHANGE_VALUE message sent to the WM5102.

The WM5102 will respond to the Register Read commands in accordance with the normal SLIMbus protocols.

Note that the WM5102 assumes that sufficient Control Space Slots are available in which to provide its response before the next REQUEST_VALUE message is received. The WM5102 response is made using a REPLY_VALUE message; the SLIMbus Manager should wait until the REPLY_VALUE message has been received before sending the next REQUEST_VALUE message. If additional REQUEST_VALUE message(s) are received before the WM5102 response has been made, then the earlier REQUEST_VALUE message(s) will be ignored (ie. only the last REQUEST_VALUE message will be serviced)



SLIMBUS CLOCKING CONTROL

The clock frequency of the SLIMbus interface is not fixed, and may be set according to the application requirements. The clock frequency can be reconfigured dynamically as required.

The WM5102 SLIMbus interface includes a Framer Device. When configured as the active Framer, the SLIMbus clock (SLIMCLK) is an output from the WM5102. At other times, SLIMCLK is an input. The Framer function can be transferred from one device to another; this is known as Framer Handover, and is controlled by the Manager Device.

The supported Root Frequencies in Active Framer mode are 24.576MHz or 22.5792MHz only. At other times, the supported Root Frequencies are as defined in the MIPI Alliance specification for SLIMbus.

Under normal operating conditions, the SLIMbus interface operates with a fixed Root Frequency (RF); dynamic updates to the bus rate are applied using a selectable Clock Gear (CG) function. The Root Frequency and the Clock Gear setting are controlled by the Manager Device; these parameters are transmitted in every SLIMbus superframe to all devices on the bus.

In Gear 10 (the highest Clock Gear setting), the SLIMCLK input (or output) frequency is equal to the Root Frequency. In lower gears, the SLIMCLK frequency is reduced by increasing powers of 2.

The Clock Gear definition is shown in Table 56. Note that 24.576MHz Root Frequency is an example only; other frequencies are also supported.

CLOCK GEAR	DESCRIPTION	SLIMCLK FREQUENCY (assuming 24.576MHz Root Frequency)
10	Divide by 1	24.576MHz
9	Divide by 2	12.288MHz
8	Divide by 4	6.144MHz
7	Divide by 8	3.072MHz
6	Divide by 16	1.536MHz
5	Divide by 32	768kHz
4	Divide by 64	384kHz
3	Divide by 128	192kHz
2	Divide by 256	96kHz
1	Divide by 512	48kHz

Table 56 SLIMbus Clock Gear Selection

When the WM5102 is the active Framer, the SLIMCLK output is synchronised to the SYSCLK or ASYNCCLK system clock, as selected by the SLIMCLK_SRC register bit.

The applicable system clock must be enabled, and configured at the SLIMbus Root Frequency, whenever the WM5102 is the active Framer. See "Clocking and Sample Rates" for details of the SYSCLK and ASYNCCLK system clocks.

When the WM5102 is not configured as the active Framer device, then the SLIMCLK input can be used to provide a reference source for the Frequency Locked Loops (FLLs). The frequency of this reference is controlled using the SLIMCLK_REF_GEAR register, as described in Table 57.

The SLIMbus clock reference is generated using an adaptive divider on the SLIMCLK input. The divider automatically adapts to the SLIMbus Clock Gear (CG).

Note that, if the Clock Gear (CG) on the bus is lower than the SLIMCLK_REF_GEAR, then the selected reference frequency cannot be supported, and the SLIMbus clock reference is disabled.

The SLIMbus clock reference is selected as input to the FLLs using the FLLn_REFCLK_SRC registers. See "Clocking and Sample Rates" for details of system clocking and the FLLs.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1507 (05E3h)	4	SLIMCLK_SRC	0	SLIMbus Clock source Selects the SLIMbus reference clock in
SLIMbus Framer				Active Framer mode. 0 = SYSCLK
Ref Gear				1 = ASYNCCLK
				Note that the applicable clock must be enabled, and configured at the SLIMbus Root Frequency, in Active Framer mode.
	3:0	SLIMCLK_REF_	4h	SLIMbus Clock Reference control.
		GEAR [3:0]		Sets the SLIMbus reference clock relative to the SLIMbus Root Frequency (RF).
				0h = Reserved
				1h = Gear 1 (RF / 512)
				2h = Gear 2 (RF / 256)
				3h = Gear 3 (RF / 128)
				4h = Gear 4 (RF / 64)
				5h = Gear 5 (RF / 32) 6h = Gear 6 (RF / 16)
				7h = Gear 7 (RF / 8)
				8h = Gear 8 (RF / 4)
				9h = Gear 9 (RF / 2)
				Ah = Gear 10 (RF)
				All other codes are Reserved

Table 57 SLIMbus Clock Reference Control



OUTPUT SIGNAL PATH

The WM5102 provides four stereo and one mono analogue output signal paths. These outputs comprise ground-referenced headphone drivers, a differential earpiece driver, differential speaker drivers and a digital output interface suitable for external speaker drivers. The output signal paths are summarised in Table 58.

SIGNAL PATH DESCRIPTIONS		OUTPUT PINS
OUT1L, OUT1R	Ground-referenced headphone output	HPOUT1L, HPOUT1R
OUT2L, OUT2R	Ground-referenced headphone output	HPOUT2L, HPOUT2R
OUT3	Differential (BTL) earpiece output	EPOUTP, EPOUTN
OUT4L, OUT4R	Differential speaker output	SPKOUTLN, SPKOUTLP, SPKOUTRP, SPKOUTRN
OUT5L, OUT5R	Digital speaker (PDM) output	SPKDAT, SPKCLK

Table 58 Output Signal Path Summary

The analogue output paths incorporate high performance 24-bit sigma-delta DACs.

Under default conditions, the headphone drivers provide a stereo, single-ended output. A mono mode is also available on each headphone output pair, providing a differential (BTL) configuration. The ground-referenced headphone output paths incorporate a common mode feedback path for rejection of system-related noise. These outputs support direct connection to headphone loads, with no requirement for AC coupling capacitors.

The earpiece path provides a differential (BTL) output, suitable for a typical earpiece load. The differential configuration offers built-in common mode noise rejection.

The speaker output paths are configured to drive a stereo pair of differential (BTL) outputs. The Class D design offers high efficiency at large signal levels. With a suitable choice of external speaker, the Class D output can drive loudspeakers directly, without any additional filter components.

The digital output path provides a stereo Pulse Density Modulation (PDM) output interface, for connection to external audio devices.

Digital volume control is available on all outputs (analogue and digital), with programmable ramp control for smooth, glitch-free operation. Any of the output signal paths may be selected as input to the Acoustic Echo Cancellation (AEC) loopback path.

The WM5102 output signal paths are illustrated in Figure 56.

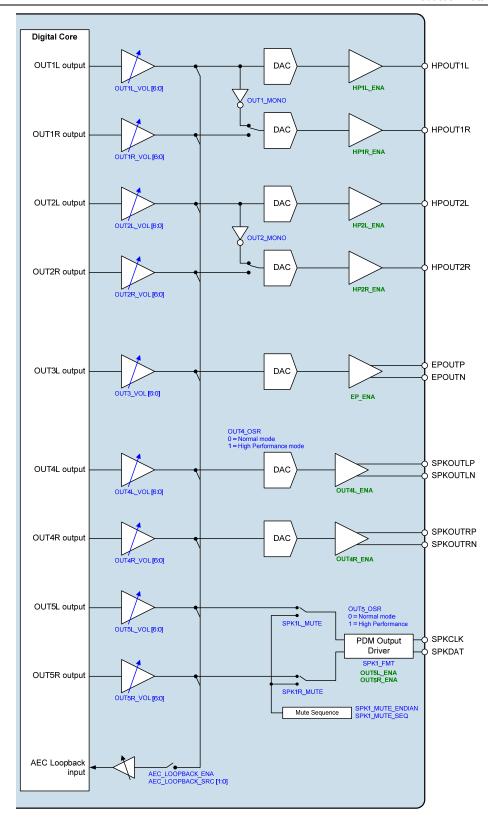


Figure 56 Output Signal Paths

OUTPUT SIGNAL PATH ENABLE

The output signal paths are enabled using the register bits described in Table 59. The respective bit(s) must be enabled for analogue or digital output on the respective output path(s).

The output signal paths are muted by default. It is recommended that de-selecting the mute should be the final step of the path enable control sequence. Similarly, the mute should be selected as the first step of the path disable control sequence. The output signal path mute functions are controlled using the register bits described in Table 64.

The supply rails for outputs (OUT1, OUT2 and OUT3) are generated using an integrated dual-mode Charge Pump, CP1. The Charge Pump is enabled automatically by the WM5102 when required by the output drivers. See the "Charge Pumps, Regulators and Voltage Reference" section for further details.

The WM5102 schedules a pop-suppressed control sequence to enable or disable the OUT1, OUT2 and OUT3 signal paths. This is automatically managed in response to setting the respective HPnx ENA or EP ENA register bits. See "Control Write Sequencer" for further details.

The system clock, SYSCLK, must be configured and enabled before any audio path is enabled. The ASYNCCLK may also be required, depending on the path configuration. See "Clocking and Sample Rates" for details of the system clocks.

The WM5102 performs automatic checks to confirm that the SYSCLK frequency is high enough to support the output signal paths and associated DACs. If an attempt is made to enable an output signal path, and there are insufficient SYSCLK cycles to support it, then the attempt will be unsuccessful. (Note that any signal paths that are already active will not be affected under these circumstances.)

The Underclocked Error condition can be monitored using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.

The status bits in Register R1025 and R1030 indicate the status of each of the output signal paths. If an Underclocked Error condition occurs, then these bits provide readback of which signal path(s) have been successfully enabled.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1024	9	OUT5L_ENA	0	Output Path 5 (Left) Enable
(0400h)				0 = Disabled
Output				1 = Enabled
Enables 1	8	OUT5R_ENA	0	Output Path 5 (Right) Enable
				0 = Disabled
				1 = Enabled
	7	OUT4L_ENA	0	Output Path 4 (Left) Enable
				0 = Disabled
				1 = Enabled
	6	OUT4R_ENA	0	Output Path 4 (Right) Enable
				0 = Disabled
				1 = Enabled
	5	EP_ENA	0	Output Path 3 Enable
				0 = Disabled
				1 = Enabled
	3	HP2L_ENA	0	Output Path 2 (Left) Enable
				0 = Disabled
				1 = Enabled
	2	HP2R_ENA	0	Output Path 2 (Right) Enable
				0 = Disabled
				1 = Enabled
	1	HP1L_ENA	0	Output Path 1 (Left) Enable
				0 = Disabled
				1 = Enabled



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	0	HP1R_ENA	0	Output Path 1 (Right) Enable 0 = Disabled 1 = Enabled
R1025 (0401h) Output	9	OUT5L_ENA_ST S	0	Output Path 5 (Left) Enable Status 0 = Disabled 1 = Enabled
Status 1	8	OUT5R_ENA_ST S	0	Output Path 5 (Right) Enable Status 0 = Disabled 1 = Enabled
	7	OUT4L_ENA_ST S	0	Output Path 4 (Left) Enable Status 0 = Disabled 1 = Enabled
	6	OUT4R_ENA_ST S	0	Output Path 4 (Right) Enable Status 0 = Disabled 1 = Enabled
R1030 (0406h) Raw	5	OUT3_ENA_STS	0	Output Path 3 Enable Status 0 = Disabled 1 = Enabled
Output Status 1	3	OUT2L_ENA_ST S	0	Output Path 2 (Left) Enable Status 0 = Disabled 1 = Enabled
	2	OUT2R_ENA_ST S	0	Output Path 2 (Right) Enable Status 0 = Disabled 1 = Enabled
	1	OUT1L_ENA_ST S	0	Output Path 1 (Left) Enable Status 0 = Disabled 1 = Enabled
	0	OUT1R_ENA_ST S	0	Output Path 1 (Right) Enable Status 0 = Disabled 1 = Enabled

Table 59 Output Signal Path Enable

OUTPUT SIGNAL PATH SAMPLE RATE CONTROL

The output signal paths are derived from the respective output mixers within the WM5102 digital core. The sample rate for the output signal paths is configured using the OUT_RATE register - see Table 21 within the "Digital Core" section.

Note that sample rate conversion is required when routing the output signal paths to any signal chain that is asynchronous and/or configured for a different sample rate.

OUTPUT SIGNAL PATH CONTROL

Under default register conditions, the output paths are configured for optimum power consumption. Audio performance can be improved using the register bits defined in Table 63, but power consumption is also increased.

A high performance mode can be selected on the output signal paths by setting the _OSR bits for the respective paths. When the OUTn_OSR bit is set, the audio performance is improved, but power consumption is also increased.

The DAC clocking frequency for outputs paths OUT1, OUT2 and OUT3 can be controlled using the DAC*n_*FREQ_LIM registers. Under normal operating conditions, the 6.144MHz (or 5.6448MHz) clock frequency is used. Under specific signal conditions, the use of higher clock frequencies can improve the noise performance. Note that the DAC*n_*FREQ_LIM registers select the upper frequency limit; the actual clock frequency is controlled dynamically according to the signal conditions.

The recommended options for configuring the Headphone output paths (OUT1 and OUT2) are noted in Table 60.

DESCRIPTION	OUT1_OSR, OUT2_OSR	DAC1_FREQ_LIM, DAC2_FREQ_LIM
Low Power (default)	0	00
Normal operation	1	01
High Performance	1	10

Table 60 Headphone Output Control

The recommended options for configuring the Earpiece output path (OUT3) are noted in Table 61.

DESCRIPTION	OUT3_OSR	DAC3_FREQ_LIM
Low Power (default)	0	00
Normal operation	1	01

Table 61 Earpiece Output Control

The SPKCLK frequency of the PDM output path (OUT5) is controlled by the OUT5_OSR register, as described in Table 62. When the OUT5_OSR bit is set, the audio performance is improved, but power consumption is also increased.

Note that the SPKCLK frequencies noted in Table 62 assume that the SYSCLK frequency is a multiple of 6.144MHz (SYSCLK_FRAC=0). If the SYSCLK frequency is a multiple of 5.6448MHz (SYSCLK_FRAC=1), then the SPKCLK frequencies will be scaled accordingly.

CONDITION	SPKCLK FREQUENCY
OUT5_OSR = 0	3.072MHz
OUT5_OSR = 1	6.144MHz

Table 62 SPKCLK Frequency

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1040 (0410h)	15:14	DAC1_FREQ_RA NGE_LIM [1:0]	00	Output Path 1 Clocking Frequency Limit
Output				When OUT1_OSR=0
Path				00 = 3.072MHz (2.8224MHz)
Config 1L				01 = 6.144MHz (5.6448MHz)
				10 = 12.288MHz (11.2896MHz)
				11 = Reserved
				When OUT1_OSR=1
				00 = 6.144MHz (5.6448MHz)
				01 = 6.144MHz (5.6448MHz)
				10 = 12.288MHz (11.2896MHz)
				11 = Reserved
				Note that the Clocking Frequency will be <= SYSCLK under all register settings. The frequencies in brackets apply for 44.1kHz-related sample rates only (ie.
				SAMPLE_RATE_n = 01XXX).
	13	OUT1_OSR	0	Output Path 1 Oversample Rate
				0 = Normal mode
				1 = High Performance mode
R1048 (0418h)	15:14	DAC2_FREQ_RA NGE_LIM [1:0]	00	Output Path 2 Clocking Frequency Limit
Output				When OUT2_OSR=0
Path Config 2L				00 = 3.072MHz (2.8224MHz)
Corning 2L				01 = 6.144MHz (5.6448MHz)
				10 = 12.288MHz (11.2896MHz)
				11 = Reserved
				When OUT2_OSR=1
				00 = 6.144MHz (5.6448MHz)
				01 = 6.144MHz (5.6448MHz)
				10 = 12.288MHz (11.2896MHz)
				11 = Reserved
				Note that the Clocking Frequency will be <= SYSCLK under all register settings. The frequencies in brackets apply for 44.1kHz-related sample rates only (ie. SAMPLE_RATE_n = 01XXX).
	13	OUT2_OSR	0	Output Path 2 Oversample Rate
				0 = Normal mode
				1 = High Performance mode



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1056 (0420h)	15:14	DAC3_FREQ_RA NGE_LIM [1:0]	00	Output Path 3 Clocking Frequency Limit
Output				When OUT3_OSR=0
Path				00 = 3.072MHz (2.8224MHz)
Config 3L				01 = 6.144MHz (5.6448MHz)
				10 = 12.288MHz (11.2896MHz)
				11 = Reserved
				When OUT3_OSR=1
				00 = 6.144MHz (5.6448MHz)
				01 = 6.144MHz (5.6448MHz)
				10 = 12.288MHz (11.2896MHz)
				11 = Reserved
				Note that the Clocking Frequency will be <= SYSCLK under all register settings. The frequencies in brackets apply for 44.1kHz-related sample rates only (ie. SAMPLE_RATE_n = 01XXX).
	13	OUT3_OSR	0	Output Path 3 Oversample Rate
				0 = Normal mode
				1 = High Performance mode
R1064	13	OUT4_OSR	0	Output Path 4 Oversample Rate
(0428h)				0 = Normal mode
Output Path				1 = High Performance mode
Config 4L				
R1072	13	OUT5_OSR	0	Output Path 5 Oversample Rate
(0430h)				0 = Normal mode
Output				1 = High Performance mode
Path Config 5L				

Table 63 Output Signal Path Control

OUTPUT SIGNAL PATH DIGITAL VOLUME CONTROL

A digital volume control is provided on each of the output signal paths, providing -64dB to +31.5dB gain control in 0.5dB steps. An independent mute control is also provided for each output signal path.

Whenever the gain or mute setting is changed, the signal path gain is ramped up or down to the new settings at a programmable rate. For increasing gain (or un-mute), the rate is controlled by the OUT_VI_RAMP register. For decreasing gain (or mute), the rate is controlled by the OUT_VD_RAMP register. Note that the OUT_VI_RAMP and OUT_VD_RAMP registers should not be changed while a volume ramp is in progress.

The OUT_VU bits control the loading of the output signal path digital volume and mute controls. When OUT_VU is set to 0, the digital volume and mute settings will be loaded into the respective control register, but will not actually change the signal path gain. The digital volume and mute settings on all of the output signal paths are updated when a 1 is written to OUT_VU. This makes it possible to update the gain of multiple signal paths simultaneously.

For correct gain ramp behaviour, the OUT_VU bits should not be written during the 0.28ms after any of the output path enable bits (see Table 59) have been asserted. It is recommended that the output path mute bit be set when the respective output driver is enabled; the signal path can then be unmuted after the 0.28ms has elapsed.

Note that, although the digital volume control registers provide 0.5dB steps, the internal circuits provide signal gain adjustment in 0.125dB steps. This allows a very high degree of gain control, and smooth volume ramping under all operating conditions.

The digital volume control register fields are described in Table 64 and Table 65.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1033 (0409h) Output Volume Ramp	6:4	OUT_VD_RAMP [2:0]	010	Output Volume Decreasing Ramp Rate (seconds/6dB) 000 = 0ms 001 = 0.5ms 010 = 1ms 011 = 2ms 100 = 4ms 101 = 8ms 110 = 15ms 111 = 30ms This register should not be changed while
	2:0	OUT_VI_RAMP [2:0]	010	a volume ramp is in progress. Output Volume Increasing Ramp Rate (seconds/6dB) 000 = 0ms 001 = 0.5ms 010 = 1ms 011 = 2ms 100 = 4ms 101 = 8ms 110 = 15ms 111 = 30ms This register should not be changed while a volume ramp is in progress.
R1041 (0411h) DAC Digital	9	OUT_VU		Output Signal Paths Volume Update Writing a 1 to this bit will cause the Output Signal Paths Volume and Mute settings to be updated simultaneously
Volume 1L	8	OUT1L_MUTE	1	Output Path 1 (Left) Digital Mute 0 = Un-mute 1 = Mute



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	7:0	OUT1L_VOL [7:0]	80h	Output Path 1 (Left) Digital Volume -64dB to +31.5dB in 0.5dB steps 00h = -64dB 01h = -63.5dB (0.5dB steps) 80h = 0dB (0.5dB steps) BFh = +31.5dB C0h to FFh = Reserved (See Table 65 for volume range)
R1045 (0415h) DAC Digital	9	OUT_VU		Output Signal Paths Volume Update Writing a 1 to this bit will cause the Output Signal Paths Volume and Mute settings to be updated simultaneously
Volume 1R	8	OUT1R_MUTE	1	Output Path 1 (Right) Digital Mute 0 = Un-mute 1 = Mute
	7:0	OUT1R_VOL [7:0]	80h	Output Path 1 (Right) Digital Volume -64dB to +31.5dB in 0.5dB steps 00h = -64dB 01h = -63.5dB (0.5dB steps) 80h = 0dB (0.5dB steps) BFh = +31.5dB C0h to FFh = Reserved (See Table 65 for volume range)
R1049 (0419h) DAC Digital	9	OUT_VU		Output Signal Paths Volume Update Writing a 1 to this bit will cause the Output Signal Paths Volume and Mute settings to be updated simultaneously
Volume 2L	8	OUT2L_MUTE	1	Output Path 2 (Left) Digital Mute 0 = Un-mute 1 = Mute
	7:0	OUT2L_VOL [7:0]	80h	Output Path 2 (Left) Digital Volume -64dB to +31.5dB in 0.5dB steps 00h = -64dB 01h = -63.5dB (0.5dB steps) 80h = 0dB (0.5dB steps) BFh = +31.5dB C0h to FFh = Reserved (See Table 65 for volume range)
R1053 (041Dh) DAC Digital	9	OUT_VU		Output Signal Paths Volume Update Writing a 1 to this bit will cause the Output Signal Paths Volume and Mute settings to be updated simultaneously
Volume 2R	8	OUT2R_MUTE	1	Output Path 2 (Right) Digital Mute 0 = Un-mute 1 = Mute



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	7:0	OUT2R_VOL [7:0]	80h	Output Path 2 (Right) Digital Volume -64dB to +31.5dB in 0.5dB steps 00h = -64dB 01h = -63.5dB (0.5dB steps) 80h = 0dB (0.5dB steps) BFh = +31.5dB C0h to FFh = Reserved (See Table 65 for volume range)
R1057 (0421h) DAC Digital	9	OUT_VU		Output Signal Paths Volume Update Writing a 1 to this bit will cause the Output Signal Paths Volume and Mute settings to be updated simultaneously
Volume 3L	8	OUT3_MUTE	1	Output Path 3 Digital Mute 0 = Un-mute 1 = Mute
	7:0	OUT3_VOL [7:0]	80h	Output Path 3 Digital Volume -64dB to +31.5dB in 0.5dB steps 00h = -64dB 01h = -63.5dB (0.5dB steps) 80h = 0dB (0.5dB steps) BFh = +31.5dB C0h to FFh = Reserved (See Table 65 for volume range)
R1065 (0429h) DAC Digital	9	OUT_VU		Output Signal Paths Volume Update Writing a 1 to this bit will cause the Output Signal Paths Volume and Mute settings to be updated simultaneously
Volume 4L	8	OUT4L_MUTE	1	Output Path 4 (Left) Digital Mute 0 = Un-mute 1 = Mute
	7:0	OUT4L_VOL [7:0]	80h	Output Path 4 (Left) Digital Volume -64dB to +31.5dB in 0.5dB steps 00h = -64dB 01h = -63.5dB (0.5dB steps) 80h = 0dB (0.5dB steps) BFh = +31.5dB C0h to FFh = Reserved (See Table 65 for volume range)
R1069 (042Dh) DAC Digital	9	OUT_VU		Output Signal Paths Volume Update Writing a 1 to this bit will cause the Output Signal Paths Volume and Mute settings to be updated simultaneously
Volume 4R	8	OUT4R_MUTE	1	Output Path 4 (Right) Digital Mute 0 = Un-mute 1 = Mute



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	7:0	OUT4R_VOL [7:0]	80h	Output Path 4 (Right) Digital Volume -64dB to +31.5dB in 0.5dB steps 00h = -64dB 01h = -63.5dB (0.5dB steps) 80h = 0dB (0.5dB steps) BFh = +31.5dB C0h to FFh = Reserved (See Table 65 for volume range)
R1073 (0431h) DAC Digital	9	OUT_VU		Output Signal Paths Volume Update Writing a 1 to this bit will cause the Output Signal Paths Volume and Mute settings to be updated simultaneously
Volume 5L	8	OUT5L_MUTE	1	Output Path 5 (Left) Digital Mute 0 = Un-mute 1 = Mute
	7:0	OUT5L_VOL [7:0]	80h	Output Path 5 (Left) Digital Volume -64dB to +31.5dB in 0.5dB steps 00h = -64dB 01h = -63.5dB (0.5dB steps) 80h = 0dB (0.5dB steps) BFh = +31.5dB C0h to FFh = Reserved (See Table 65 for volume range)
R1077 (0435h) DAC Digital	9	OUT_VU		Output Signal Paths Volume Update Writing a 1 to this bit will cause the Output Signal Paths Volume and Mute settings to be updated simultaneously
Volume 5R	8	OUT5R_MUTE	1	Output Path 5 (Right) Digital Mute 0 = Un-mute 1 = Mute
	7:0	OUT5R_VOL [7:0]	80h	Output Path 5 (Right) Digital Volume -64dB to +31.5dB in 0.5dB steps 00h = -64dB 01h = -63.5dB (0.5dB steps) 80h = 0dB (0.5dB steps) BFh = +31.5dB C0h to FFh = Reserved (See Table 65 for volume range)

Table 64 Output Signal Path Digital Volume Control

Output Volume Register	Volume (dB)	Output Volume Register	Volume (dB)	Output Volume Register	Volume (dB)	Output Volume Register	Volume (dB)
00h	-64.0	40h	-32.0	80h	0.0	C0h	Reserved
01h	-63.5	41h	-31.5	81h	0.5	C1h	Reserved
02h	-63.0	42h	-31.0	82h	1.0	C2h	Reserved
03h	-62.5	43h	-30.5	83h	1.5	C3h	Reserved
04h	-62.0	44h	-30.0	84h	2.0	C4h	Reserved
05h	-61.5	45h	-29.5	85h	2.5	C5h	Reserved
06h	-61.0	46h	-29.0	86h	3.0	C6h	Reserved
07h	-60.5	47h	-28.5	87h	3.5	C7h	Reserved
08h	-60.0	48h	-28.0	88h	4.0	C8h	Reserved
09h	-59.5	49h	-27.5	89h	4.5	C9h	Reserved
0Ah	-59.0	4Ah	-27.0	8Ah	5.0	CAh	Reserved
0Bh	-58.5	4Bh	-26.5	8Bh	5.5	CBh	Reserved
0Ch		4Ch				CCh	
	-58.0		-26.0	8Ch	6.0		Reserved
0Dh	-57.5	4Dh	-25.5	8Dh	6.5	CDh	Reserved
0Eh	-57.0	4Eh	-25.0	8Eh	7.0	CEh	Reserved
0Fh	-56.5	4Fh	-24.5	8Fh	7.5	CFh	Reserved
10h	-56.0	50h	-24.0	90h	8.0	D0h	Reserved
11h	-55.5	51h	-23.5	91h	8.5	D1h	Reserved
12h	-55.0	52h	-23.0	92h	9.0	D2h	Reserved
13h	-54.5	53h	-22.5	93h	9.5	D3h	Reserved
14h	-54.0	54h	-22.0	94h	10.0	D4h	Reserved
15h	-53.5	55h	-21.5	95h	10.5	D5h	Reserved
16h	-53.0	56h	-21.0	96h	11.0	D6h	Reserved
17h	-52.5	57h	-20.5	97h	11.5	D7h	Reserved
18h	-52.0	58h	-20.0	98h	12.0	D8h	Reserved
19h	-51.5	59h	-19.5	99h	12.5	D9h	Reserved
1Ah	-51.0	5Ah	-19.0	9Ah	13.0	DAh	Reserved
1Bh	-50.5	5Bh	-18.5	9Bh	13.5	DBh	Reserved
1Ch	-50.0	5Ch	-18.0	9Ch	14.0	DCh	Reserved
1Dh	-49.5	5Dh	-17.5	9Dh	14.5	DDh	Reserved
1Eh	-49.0	5Eh	-17.0	9Eh	15.0	DEh	Reserved
1Fh	-48.5	5Fh	-16.5	9Fh	15.5	DFh	Reserved
20h	-48.0	60h	-16.0	A0h	16.0	E0h	Reserved
21h	-47.5	61h	-15.5	A1h	16.5	E1h	Reserved
22h	-47.0	62h	-15.0	A2h	17.0	E2h	Reserved
23h	-46.5	63h	-14.5	A3h	17.5	E3h	Reserved
24h	-46.0	64h	-14.0	A4h	18.0	E4h	Reserved
25h	-45.5	65h	-13.5	A5h	18.5	E5h	Reserved
26h	-45.0	66h	-13.0	A6h	19.0	E6h	Reserved
27h	-44.5	67h	-12.5	A7h	19.5	E7h	Reserved
28h	-44.0	68h	-12.0	A8h	20.0	E8h	Reserved
29h	-43.5	69h	-11.5	A9h	20.5	E9h	Reserved
2Ah	-43.0	6Ah	-11.0	AAh	21.0	EAh	Reserved
2Bh	-42.5	6Bh	-10.5	ABh	21.5	EBh	Reserved
2Ch	-42.0	6Ch	-10.0	ACh	22.0	ECh	Reserved
2Dh	-41.5	6Dh	-9.5	ADh	22.5	EDh	Reserved
				AEh			
2Eh	-41.0	6Eh	-9.0		23.0	EEh	Reserved
2Fh	-40.5	6Fh	-8.5	AFh	23.5	EFh	Reserved
30h	-40.0	70h	-8.0	B0h	24.0	F0h	Reserved
31h	-39.5	71h	-7.5	B1h	24.5	F1h	Reserved
32h	-39.0	72h	-7.0	B2h	25.0	F2h	Reserved
33h	-38.5	73h	-6.5	B3h	25.5	F3h	Reserved
34h	-38.0	74h	-6.0	B4h	26.0	F4h	Reserve
35h	-37.5	75h	-5.5	B5h	26.5	F5h	Reserve
36h	-37.0	76h	-5.0	B6h	27.0	F6h	Reserve
37h	-36.5	77h	-4.5	B7h	27.5	F7h	Reserve
38h	-36.0	78h	-4.0	B8h	28.0	F8h	Reserve
39h	-35.5	79h	-3.5	B9h	28.5	F9h	Reserved
3Ah	-35.0	7Ah	-3.0	BAh	29.0	FAh	Reserved
3Bh	-34.5	7Bh	-2.5	BBh	29.5	FBh	Reserved
3Ch	-34.0	7Ch	-2.0	BCh	30.0	FCh	Reserved
3Dh	-33.5	7Dh	-1.5	BDh	30.5	FDh	Reserved
3Eh	-33.0	7Eh	-1.0	BEh	31.0	FEh	Reserved
3Fh	-32.5	7Fh	-0.5	BFh	31.5	FFh	Reserve

Table 65 Output Signal Path Digital Volume Range



OUTPUT SIGNAL PATH DIGITAL VOLUME LIMIT

A digital limit control is provided on each of the output signal paths. Any signal which exceeds the applicable limit will be clipped at that level. The limit control is implemented in the digital domain, before the output path DACs.

For typical applications, a limit of 0dBFS is recommended for the analogue output paths (OUT1, OUT2, OUT3 and OUT4).

The digital speaker output (OUT5) can handle signal levels up to +3dBFS; a maximum setting of +3dBFS is recommended for this output path.

Caution is advised when selecting other limits, as the output signal may clip in the digital and/or analogue stages of the respective signal path(s).

The digital limit register fields are described in Table 66 and Table 67.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1042 (0412h DAC Volume Limit 1L	7:0	OUT1L_VOL_LIM [7:0]	81h	Output Path 1 (Left) Digital Limit -6dBFS to +6dBFS in 0.5dB steps 00h to 73h = Reserved 74h = -6.0dBFS 75h = -5.5dBFS (0.5dB steps) 80h = 0.0dBFS (0.5dB steps) 8Bh = +5.5dBFS 8Ch = +6.0dBFS 8Dh to FFh = Reserved (see Table 67 for limit range)
R1046 (0416h DAC Volume Limit 1R	7:0	OUT1R_VOL_LI M [7:0]	81h	Output Path 1 (Right) Digital Limit -6dBFS to +6dBFS in 0.5dB steps 00h to 73h = Reserved 74h = -6.0dBFS 75h = -5.5dBFS (0.5dB steps) 80h = 0.0dBFS (0.5dB steps) 8Bh = +5.5dBFS 8Ch = +6.0dBFS 8Dh to FFh = Reserved (see Table 67 for limit range)
R1050 (041Ah DAC Volume Limit 2L	7:0	OUT2L_VOL_LIM [7:0]	81h	Output Path 2 (Left) Digital Limit -6dBFS to +6dBFS in 0.5dB steps 00h to 73h = Reserved 74h = -6.0dBFS 75h = -5.5dBFS (0.5dB steps) 80h = 0.0dBFS (0.5dB steps) 8Bh = +5.5dBFS 8Ch = +6.0dBFS 8Dh to FFh = Reserved (see Table 67 for limit range)



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1054 (041Eh DAC Volume Limit 2R	7:0	OUT2R_VOL_LI M [7:0]	81h	Output Path 2 (Right) Digital Limit -6dBFS to +6dBFS in 0.5dB steps 00h to 73h = Reserved 74h = -6.0dBFS 75h = -5.5dBFS (0.5dB steps) 80h = 0.0dBFS (0.5dB steps) 8Bh = +5.5dBFS 8Ch = +6.0dBFS 8Dh to FFh = Reserved (see Table 67 for limit range)
R1058 (0422h DAC Volume Limit 3L	7:0	OUT3_VOL_LIM [7:0]	81h	Output Path 3 Digital Limit -6dBFS to +6dBFS in 0.5dB steps 00h to 73h = Reserved 74h = -6.0dBFS 75h = -5.5dBFS (0.5dB steps) 80h = 0.0dBFS (0.5dB steps) 8Bh = +5.5dBFS 8Ch = +6.0dBFS 8Dh to FFh = Reserved (see Table 67 for limit range)
R1066 (042Ah Out Volume 4L	7:0	OUT4L_VOL_LIM [7:0]	81h	Output Path 4 (Left) Digital Limit -6dBFS to +6dBFS in 0.5dB steps 00h to 73h = Reserved 74h = -6.0dBFS 75h = -5.5dBFS (0.5dB steps) 80h = 0.0dBFS (0.5dB steps) 8Bh = +5.5dBFS 8Ch = +6.0dBFS 8Dh to FFh = Reserved (see Table 67 for limit range)
R1070 (042Eh Out Volume 4R	7:0	OUT4R_VOL_LI M [7:0]	81h	Output Path 4 (Right) Digital Limit -6dBFS to +6dBFS in 0.5dB steps 00h to 73h = Reserved 74h = -6.0dBFS 75h = -5.5dBFS (0.5dB steps) 80h = 0.0dBFS (0.5dB steps) 8Bh = +5.5dBFS 8Ch = +6.0dBFS 8Dh to FFh = Reserved (see Table 67 for limit range)



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1074	7:0	OUT5L_VOL_LIM	81h	Output Path 5 (Left) Digital Limit
(0432h		[7:0]		-6dBFS to +6dBFS in 0.5dB steps
DAC				00h to 73h = Reserved
Volume Limit 5L				74h = -6.0dBFS
LIIIII 5L				75h = -5.5dBFS
				(0.5dB steps)
				80h = 0.0dBFS
				(0.5dB steps)
				8Bh = +5.5dBFS
				8Ch = +6.0dBFS
				8Dh to FFh = Reserved
				(see Table 67 for limit range)
R1078	7:0	OUT5R_VOL_LI	81h	Output Path 5 (Right) Digital Limit
(0436h		M [7:0]		-6dBFS to +6dBFS in 0.5dB steps
DAC				00h to 73h = Reserved
Volume Limit 5R				74h = -6.0dBFS
LIIIII SK				75h = -5.5dBFS
				(0.5dB steps)
				80h = 0.0dBFS
				(0.5dB steps)
				8Bh = +5.5dBFS
				8Ch = +6.0dBFS
				8Dh to FFh = Reserved
				(see Table 67 for limit range)

Table 66 Output Signal Path Digital Limit Control



OUTnL_VOL_LIM[7:0], OUTnR_VOL_LIM[7:0]	LIMIT (dBFS)
00h to 73h	Reserved
74h	-6.0
75h	-5.5
76h	-5.0
77h	-4.5
78h	-4.0
79h	-3.5
7Ah	-3.0
7Bh	-2.5
7Ch	-2.0
7Dh	-1.5
7Eh	-1.0
7Fh	-0.5
80h	0.0
81h	+0.5
82h	+1.0
83h	+1.5
84h	+2.0
85h	+2.5
86h	+3.0
87h	+3.5
88h	+4.0
89h	+4.5
8Ah	+5.0
8Bh	+5.5
8Ch	+6.0
8Dh to FFh	Reserved

Table 67 Output Signal Path Digital Limit Range

OUTPUT SIGNAL PATH NOISE GATE CONTROL

The WM5102 provides a digital noise gate function for each of the output signal paths. The noise gate ensures best noise performance when the signal path is idle. When the noise gate is enabled, and the applicable signal level is below the noise gate threshold, then the noise gate is activated, causing the signal path to be muted.

The noise gate function is enabled using the NGATE_ENA register, as described in Table 68.

For each output path, the noise gate may be associated with one or more of the signal path threshold detection functions using the _NGATE_SRC register fields. When more than one signal threshold is selected, then the output path noise gate is only activated (ie. muted) when all of the respective signal thresholds are satisfied.

For example, if the OUT1L noise gate is associated with the OUT1L and OUT1R signal paths, then the OUT1L signal path will only be muted if both the OUT1L and OUT1R signal levels are below the respective thresholds.

The noise gate threshold (the signal level below which the noise gate is activated) is set using NGATE_THR. Note that, for each output path, the noise gate threshold represents the signal level at the respective output pin(s) - the threshold is therefore independent of the digital volume and PGA gain settings.

Note that, although there is only one noise gate threshold level (NGATE_THR), each of the output path noise gates may be activated independently, according to the respective signal content and the associated threshold configuration(s).

To prevent erroneous triggering, a time delay is applied before the gate is activated; the noise gate is only activated (ie. muted) when the output levels are below the applicable signal level threshold(s) for longer than the noise gate 'hold time'. The 'hold time' is set using the NGATE_HOLD register.

When the noise gate is activated, the WM5102 gradually attenuates the respective signal path at the rate set by the OUT_VD_RAMP register (see Table 64). When the noise gate is de-activated, the output volume increases at the rate set by the OUT_VI_RAMP register.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1043 (0413h) Noise Gate Select 1L	11:0	OUT1L_NGATE_ SRC [11:0]	001h	Output Signal Path Noise Gate Source Enables one of more signal paths as inputs to the respective noise gate. If more than one signal path is enabled as an input, the noise gate is only activated
R1047 (0417h) Noise Gate Select 1R	11:0	OUT1R_NGATE_ SRC [11:0]	002h	(ie. muted) when all of the respective signal thresholds are satisfied. [11] = Reserved [10] = Reserved
R1051 (041Bh) Noise Gate Select 2L	11:0	OUT2L_NGATE_ SRC [11:0]	004h	[9] = OUT5R [8] = OUT5L [7] = OUT4R [6] = OUT4L
R1055 (041Fh) Noise Gate Select 2R	11:0	OUT2R_NGATE_ SRC [11:0]	008h	[5] = Reserved [4] = OUT3 [3] = OUT2R [2] = OUT2L [1] = OUT1R
R1059 (0423h) Noise Gate Select 3L	11:0	OUT3_NGATE_S RC [11:0]	010h	[0] = OUT1L Each bit is coded as: 0 = Disabled



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1067 (042Bh) Noise Gate Select 4L	11:0	OUT4L_NGATE_ SRC [11:0]	040h	1 = Enabled
R1071 (042Fh) Noise Gate Select 4R	11:0	OUT4R_NGATE_ SRC [11:0]	080h	
R1075 (0433h) Noise Gate Select 5L	11:0	OUT5L_NGATE_ SRC [11:0]	100h	
R1079 (0437h) Noise Gate Select 5R	11:0	OUT5R_NGATE_ SRC [11:0]	200h	
R1112 (0458h) Noise Gate Control	5:4	NGATE_HOLD [1:0]	00	Output Signal Path Noise Gate Hold Time (delay before noise gate is activated) 00 = 30ms 01 = 120ms 10 = 250ms 11 = 500ms
	3:1	NGATE_THR [2:0]	000	Output Signal Path Noise Gate Threshold 000 = -60dB 001 = -66dB 010 = -72dB 011 = -78dB 100 = -84dB 101 = -90dB 110 = -96dB 111 = -102dB
	0	NGATE_ENA	1	Output Signal Path Noise Gate Enable 0 = Disabled 1 = Enabled

Table 68 Output Signal Path Noise Gate Control

OUTPUT SIGNAL PATH AEC LOOPBACK

The WM5102 incorporates loopback signal path, which is ideally suited as a reference for Acoustic Echo Cancellation (AEC) processing. Any of the output signal paths may be selected as the AEC loopback source.

When configured with suitable DSP firmware, the WM5102 can provide an integrated AEC capability. The AEC loopback feature also enables convenient hook-up to an external device for implementing the required signal processing algorithms.

The AEC Loopback source is connected after the respective digital volume controls, as illustrated in Figure 56. A digital gain control is incorporated in the AEC Loopback path, which is automatically set according to the PGA gain of the selected output path, where applicable. When OUT1n, OUT2n or OUT3 is selected as the AEC Loopback source, the loopback gain matches the corresponding PGA gain, ensuring that the loopback signal level will exactly match the selected output, regardless of the digital or analogue gain settings.

The AEC Loopback signal can be selected as input to any of the digital mixers within the WM5102 digital core. The sample rate for the AEC Loopback path is configured using the OUT_RATE register - see Table 21 within the "Digital Core" section.

The AEC loopback function is enabled using the AEC_LOOPBACK_ENA register. The source signal for the Transmit Path AEC function is selected using the AEC LOOPBACK SRC register.

The WM5102 performs automatic checks to confirm that the SYSCLK frequency is high enough to support the AEC Loopback function. If an attempt is made to enable this function, and there are insufficient SYSCLK cycles to support it, then the attempt will be unsuccessful. (Note that any signal paths that are already active will not be affected under these circumstances.)

The Underclocked Error condition can be monitored using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.

The AEC_ENA_STS register indicates the status of the AEC Loopback function. If an Underclocked Error condition occurs, then this bit can provide indication of whether the AEC Loopback function has been successfully enabled.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1104	5:2	AEC_LOOPBAC	0000	Input source for Tx AEC function
(0450h)		K_SRC [3:0]		0000 = OUT1L
DAC AEC				0001 = OUT1R
Control 1				0010 = OUT2L
				0011 = OUT2R
				0100 = OUT3
				0110 = OUT4L
				0111 = OUT4R
				1000 = OUT5L
				1001 = OUT5R
				All other codes are Reserved
	1	AEC_ENA_STS	0	Transmit (Tx) Path AEC Control Status
				0 = Disabled
				1 = Enabled
	0	AEC_LOOPBAC	0	Transmit (Tx) Path AEC Control
		K_ENA		0 = Disabled
				1 = Enabled

Table 69 Output Signal Path AEC Loopback Control



HEADPHONE/EARPIECE OUTPUTS AND MONO MODE

The headphone drivers can provide a mono differential (BTL) output; this is ideal for driving an earpiece or hearing aid coil. The mono differential (BTL) configuration is selected using the OUTn_MONO register bits. When the OUTn_MONO bit is set, then the respective Right channel output is an inverted copy of the Left channel output signal; this creates a differential output between the respective OUTnL and OUTnR pins.

In mono configuration, the effective gain of the signal path is increased by 6dB.

The mono (BTL) signal paths are illustrated in Figure 56.

The OUT1L and OUT1R output signal paths are associated with the analogue outputs HPOUT1L and HPOUT1R respectively.

The OUT2L and OUT2R output signal paths are associated with the analogue outputs HPOUT2L and HPOUT2R respectively.

The OUT3 output signal	path is associated	with the analogue of	outputs EPOUTF	and EPOUTN.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1040	12	OUT1_MONO	0	Output Path 1 Mono Mode
(0410h) Output				(Configures HPOUT1L and HPOUT1R as a mono differential output.)
Path				0 = Disabled
Config 1L				1 = Enabled
				The gain of the signal path is increased by 6dB in differential (mono) mode.
R1048	12	OUT2_MONO	0	Output Path 2 Mono Mode
(0418h) Output				(Configures HPOUT2L and HPOUT2R as a mono differential output.)
Path				0 = Disabled
Config 2L				1 = Enabled
				The gain of the signal path is increased by 6dB in differential (mono) mode.

Table 70 Headphone Driver Mono Mode Control

The headphone driver outputs HPOUT1L, HPOUT1R, HPOUT2L and HPOUT2R are suitable for direct connection to external headphones and earpieces. The outputs are ground-referenced, eliminating any requirement for AC coupling capacitors.

The headphone outputs incorporate a common mode, or ground loop, feedback path which provides rejection of system-related ground noise. The feedback pins must be connected to ground for normal operation of the headphone outputs.

Note that the feedback pins should be connected to GND close to the respective headphone jack, as illustrated in Figure 57. In mono (differential) mode, the feedback pin(s) should be connected to the ground plane that is physically closest to the earpiece output PCB tracks.

The ground feedback path for HPOUT1L and HPOUT1R is provided via the HPOUT1FB1 or HPOUT1FB2 pins; the applicable connection must be selected using the ACCDET_SRC register, as described in Table 71.

The ground feedback path for HPOUT2L and HPOUT2R is provided via the HPOUT2FB pin. No register configuration is required for the HPOUT2FB connection.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R659 (0293h)	13	ACCDET_SRC	0	Accessory Detect / Headphone Feedback pin select
Accessory Detect Mode 1				0 = Accessory detect on MICDET1, Headphone ground feedback on HPOUT1FB1
				1 = Accessory detect on MICDET2, Headphone ground feedback on HPOUT1FB2

Table 71 Headphone Output (HPOUT1) Ground Feedback Control

The earpiece driver outputs EPOUTP and EPOUTN are suitable for direct connection to an earpiece. The output configuration is differential (BTL), driving both ends of the external load directly - note that there is no associated ground connection.

The headphone and earpiece connections are illustrated in Figure 57.

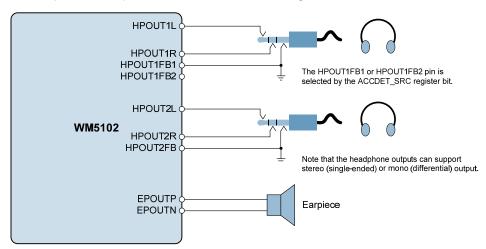


Figure 57 Headphone and Earpiece Connection

SPEAKER OUTPUTS (ANALOGUE)

The speaker driver outputs SPKOUTLP, SPKOUTLN, SPKOUTLP and SPKOUTLN provide two differential (BTL) outputs suitable for direct connection to external loudspeakers. The integrated Class D speaker driver provides high efficiency at large signal levels.

The speaker driver signal paths incorporate a boost function which shifts the signal levels between the AVDD and SPKVDD voltage domains. The boost is pre-configured (+12dB) for the recommended AVDD and SPKVDD operating voltages (see "Recommended Operating Conditions").

Ultra-low leakage and high PSRR allow the speaker supply SPKVDD to be connected directly to a lithium battery. Note that SPKVDDL powers the Left Speaker driver, and SPKVDDR powers the Right Speaker driver; it is assumed that SPKVDDL = SPKVDDR = SPKVDD.

Note that SYSCLK must be present and enabled when using the Class D speaker output; see "Clocking and Sample Rates" for details of SYSCLK and the associated register control fields.

The OUT4L and OUT4R output signal paths are associated with the analogue outputs SPKOUTLP, SPKOUTLN. SPKOUTLP and SPKOUTLN.

The Class D speaker output is a pulse width modulated signal, and requires external filtering in order to recreate the audio signal. With a suitable choice of external speakers, the speakers themselves can provide the necessary filtering. See "Applications Information" for further information on Class D speaker connections.

The external speaker connection is illustrated in Figure 58, assuming suitable speakers are chosen to provide the PWM filtering.

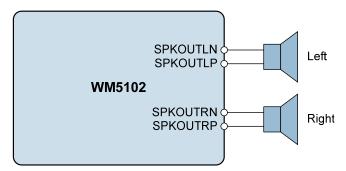


Figure 58 Speaker Connection

SPEAKER OUTPUTS (DIGITAL PDM)

The WM5102 supports a two-channel Pulse Density Modulation (PDM) digital speaker interface; the PDM outputs are associated with the OUT5L and OUT5R output signal paths.

The PDM digital speaker interface is illustrated in Figure 59.

The OUT5L and OUT5R output signal paths are interleaved on the SPKDAT output pin, and clocked using SPKCLK.

Note that the PDM interface supports two different operating modes; these are selected using the SPK1_FMT register bit. See "Signal Timing Requirements" for detailed timing information in both modes.

When SPK1_FMT = 0 (Mode A), then the Left PDM channel is valid at the rising edge of SPKCLK; the Right PDM channel is valid at the falling edge of SPKCLK.

When SPK1_FMT = 1 (Mode B), then the Left PDM channel is valid during the low phase of SPKCLK; the Right PDM channel is valid during the high phase of SPKCLK.



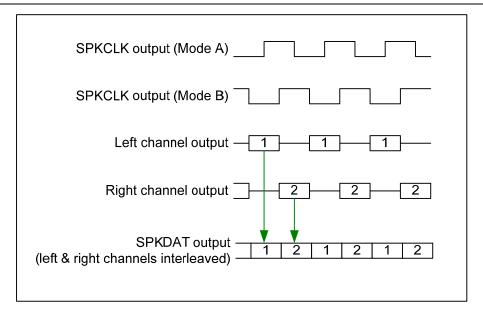


Figure 59 Digital Speaker (PDM) Interface Timing

Clocking for the PDM interface is derived from SYSCLK. Note that the SYSCLK_ENA register must also be set. See "Clocking and Sample Rates" for further details of the system clocks and control registers.

When the OUT5L or OUT5R output signal path is enabled, the PDM interface clock signal is output on the SPKCLK pin.

The output signal paths support normal and high performance operating modes, as described in the "Output Signal Path" section. The SPKCLK frequency is set according to the operating mode of the relevant output path, as described in Table 72.

Note that the SPKCLK frequencies noted in Table 72 assume that the SYSCLK frequency is a multiple of 6.144MHz (SYSCLK_FRAC=0). If the SYSCLK frequency is a multiple of 5.6448MHz (SYSCLK FRAC=1), then the SPKCLK frequency will be scaled accordingly.

OUT5_OSR	DESCRIPTION	SPKCLK FREQUENCY
0	Normal mode	3.072MHz
1	High Performance mode	6.144MHz

Table 72 SPKCLK Frequency

The PDM output channels can be independently muted. When muted, the default output on each channel is a DSD-compliant silent stream (0110_1001b). The mute output code can be programmed to other values if required, using the SPK1_MUTE_SEQ register field. The mute output code can be transmitted MSB-first or LSB-first; this is selectable using the SPK1_MUTE_ENDIAN register.

Note that the PDM Mute function is not a soft-mute; the audio output is interrupted immediately when the PDM mute is asserted. It is recommended to use the Output Signal Path mute function before applying the PDM mute. See Table 64 for details of the OUT5L_MUTE and OUT5R_MUTE registers.

The PDM output interface registers are described in Table 73.

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REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R1168	13	SPK1R_MUTE	0	PDM Speaker Output 1 (Right) Mute
(0490h)				0 = Audio output (OUT5R)
PDM				1 = Mute Sequence output
SPK1 CTRL 1	12	SPK1L_MUTE	0	PDM Speaker Output 1 (Left) Mute
OTIVE				0 = Audio output (OUT5L)
				1 = Mute Sequence output
	8	SPK1_MUTE_EN DIAN	0	PDM Speaker Output 1 Mute Sequence Control
				0 = Mute sequence is LSB first
				1 = Mute sequence output is MSB first
	7:0	SPK1_MUTE_SE	69h	PDM Speaker Output 1 Mute Sequence
		Q [7:0]		Defines the 8-bit code that is output on SPKDAT1 (left) or SPKDAT1 (right) when muted.
R1169	0	SPK1_FMT	0	PDM Speaker Output 1 timing format
(0491h)				0 = Mode A (PDM data is valid at the
PDM SPK1				rising/falling edges of SPKCLK)
CTRL 2				1 = Mode B (PDM data is valid during the high/low phase of SPKCLK)

Table 73 Digital Speaker (PDM) Output Control

The digital speaker (PDM) outputs SPKDAT and SPKCLK are intended for direct connection to a compatible external speaker driver. A typical configuration is illustrated in Figure 60.

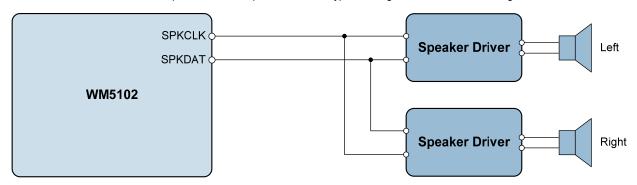


Figure 60 Digital Speaker (PDM) Connection

EXTERNAL ACCESSORY DETECTION

The WM5102 provides external accessory detection functions which can sense the presence and impedance of external components. This can be used to detect the insertion or removal of an external headphone or headset, and to provide an indication of key/button push events.

Jack insertion is detected using the JACKDET pin, which must be connected to a switch contact within the jack socket. An Interrupt event is generated whenever a jack insertion or jack removal event is detected. The jack detect function can also be used to trigger a Wake-Up transition (ie. exit from Sleep mode) and/or to trigger the Control Write Sequencer.

Suppression of pops and clicks caused by jack insertion or removal is provided using the MICDET clamp function. This function can also be used to trigger interrupt events, a Wake-Up transition (ie. exit from Sleep mode) and/or to trigger the Control Write Sequencer.

Microphones, push-buttons and other accessories can be detected via the MICDET1 or MICDET2 pins. The presence of a microphone, and the status of a hookswitch can be detected. This feature can also be used to detect push-button operation.

Headphone impedance can be detected via the HPDETL and HPDETR pins; this can be used to set different gain levels or other configuration settings according to the type of load connected. For example, different settings may be applicable to Headphone or Line output loads.

The MICVDD power domain must be enabled when using the Microphone Detect function. (Note that MICVDD is not required for the Jack Detect or Headphone Detect functios.) The MICVDD power domain is provided using an internal Charge Pump (CP2) and LDO Regulator (LDO2). See "Charge Pumps, Regulators and Voltage Reference" for details of these circuits.

The internal 32kHz clock must be present and enabled when using the jack insertion or accessory detection functions; see "Clocking and Sample Rates" for details of the internal 32kHz clock and associated register control fields.

JACK DETECT

The WM5102 provides support for jack insertion switch detection. The jack insertion status can be read using the relevant register status bit. A jack insertion or removal can also be used to trigger an interrupt (IRQ) event or to trigger the Control Write Sequencer.

When the WM5102 is in the low-power Sleep mode (see "Low Power Sleep Configuration"), the jack detect function can be used as a 'wake-up' input; a typical use case is where an application is idle in standby mode until a headphone or headset jack is inserted.

Jack insertion and removal is detected using the JACKDET pin. The recommended external connection circuit is illustrated in Figure 61.

The jack detect feature is enabled using JD1_ENA; the jack insertion status can be read using the JD1 STS register.

The JACKDET input de-bounce is selected using the JD1_DB register, as described in Table 74. Note that the de-bounce circuit uses the 32kHz clock, which must be enabled whenever input de-bounce functions are required.

Note that the Jack Detect signal, JD1, can be used as an input to the MICDET Clamp function. This provides additional functionality relating to jack insertion or jack removal events.

An Interrupt Request (IRQ) event is generated whenever a jack insertion or jack removal is detected (see "Interrupts"). Separate 'mask' bits are provided to enable IRQ events on the rising and/or falling edge of the JD1 status.

The Control Write Sequencer can be triggered by a jack insertion or jack removal detection. This is enabled using register bits described in the "Low Power Sleep Configuration" section.

The control registers associated with the Jack Detect function are described in Table 74.



WM5102 Production Data

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R723 (02D3h)	0	JD1_ENA	0	JACKDET enable 0 = Disabled
Jack detect analogue				1 = Enabled
R3413 (0D55h) AOD IRQ Raw Status	0	JD1_STS	0	JACKDET input status 0 = Jack not detected 1 = Jack is detected (Assumes the JACKDET pin is pulled 'low' on Jack insertion.)
R3414 (0D56h) Jack detect debounce	0	JD1_DB	0	JACKDET input de-bounce 0 = Disabled 1 = Enabled

Table 74 Jack Detect Control

A recommended connection circuit, including headphone output on HPOUT1 and microphone connections, is shown in Figure 61. See "Applications Information" for details of recommended external components.

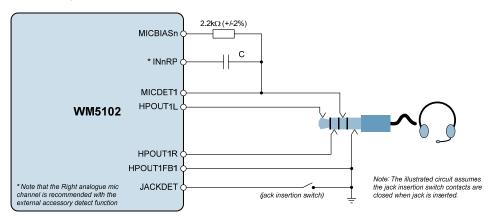


Figure 61 Jack Detect and External Accessory Connections

The internal comparator circuit used to detect the JACKDET status is illustrated in Figure 62.

The threshold voltages for the jack detect circuit are noted in the "Electrical Characteristics". Note that separate thresholds are defined for jack insertion and jack removal.

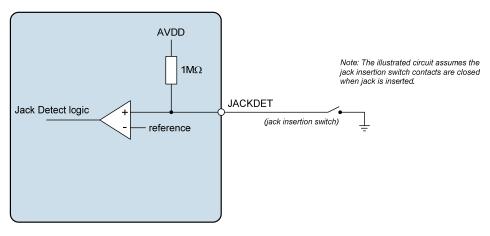


Figure 62 Jack Detect Comparator



JACK POP SUPPRESSION (MICDET CLAMP)

Under typical configuration of a 3.5mm headphone/accessory jack connection, there is a risk of pops and clicks arising from jack insertion or removal. This can occur when the headphone load makes momentary contact with the MICBIAS output when the jack is not fully inserted, as illustrated in Figure 63.

The WM5102 provides a MICDET Clamp function to suppress pops and clicks caused by jack insertion or removal. The clamp is activated by a configurable logic function derived from external logic inputs. The clamp status can be read using the relevant register status bit. The clamp status can also be used to trigger an interrupt (IRQ) event or to trigger the Control Write Sequencer.

When the WM5102 is in the low-power Sleep mode, the MICDET Clamp function can be used as a 'wake-up' input; a typical use case is where an application is idle in standby mode until a headphone or headset jack is inserted. This feature is enabled using the control bits described in Table 83 within the "Low Power Sleep Configuration" section.

The MICDET Clamp function is controlled by a selectable logic condition, derived from the JD1 and/or GP5 signals. The function is enabled and configured using the MICD_CLAMP_MODE register.

The JD1 signal is derived from the Jack Detect function (see Table 74). The GP5 signal is derived from the GPIO5 input pin (see "General Purpose Input / Output").

When the MICDET Clamp is active, the MICDET1/HPOUT1FB2 and HPOUT1FB1/MICDET2 pins are short-circuited to GND. Note that both pins are shorted, regardless of the ACCDET_SRC register.

The configurable logic provides flexibility in selecting the appropriate conditions for activating the MICDET Clamp. The clamp status can be read using the MICD_CLAMP_STS register.

The MICDET Clamp de-bounce is selected using the MICD_CLAMP_DB register, as described in Table 75. Note that the de-bounce circuit uses the 32kHz clock, which must be enabled whenever input de-bounce functions are required.

An Interrupt Request (IRQ) event is generated whenever the MICDET Clamp is asserted or deasserted (see "Interrupts"). Separate 'mask' bits are provided to enable IRQ events on the rising and/or falling edge of the MICDET Clamp status.

The Control Write Sequencer can be triggered by the MICDET Clamp status. This is enabled using register bits described in the "Low Power Sleep Configuration" section.

The MICDET Clamp function is illustrated in Figure 63. Note that the jack plug is shown partially removed, with the MICDET1 pin in contact with the headphone load.

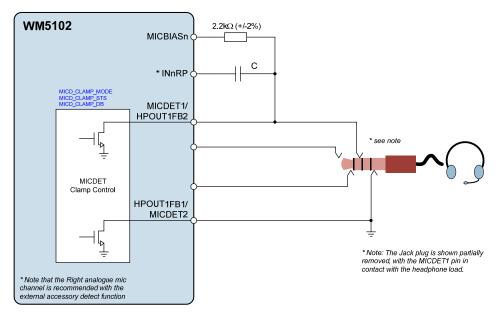


Figure 63 MICDET Clamp circuit



The control registers associated with the MICDET Clamp function are described in Table 75.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R674	3:0	MICD_CLAMP_M	0000	MICDET Clamp Mode
(02A2h)		ODE [3:0]		0h = Disabled
Micd Clamp control				1h = Active (MICDET1 and MICDET2 are shorted to GND)
				2h = Reserved
				3h = Reserved
				4h = Active when JD1=0
				5h = Active when JD1=1
				6h = Active when GP5=0
				7h = Active when GP5=1
				8h = Active when JD1=0 or GP5=0
				9h = Active when JD1=0 or GP5=1
				Ah = Active when JD1=1 or GP5=0
				Bh = Active when JD1=1 or GP5=1
				Ch = Active when JD1=0 and GP5=0
				Dh = Active when JD1=0 and GP5=1
				Eh = Active when JD1=1 and GP5=0
				Fh = Active when JD1=1 and GP5=1
R3413	3	MICD_CLAMP_S	0	MICDET Clamp status
(0D55h)		TS		0 = Clamp not active
AOD IRQ				1 = Clamp active
Raw Status				Note that the MICDET Clamp is effective on MICDET1 and MICDET2, regardless of the ACCDET_SRC register bit.
R3414	3	MICD_CLAMP_D	0	MICDET Clamp de-bounce
(0D56h)		В		0 = Disabled
Jack detect debounce				1 = Enabled

Table 75 MICDET Clamp Control

MICROPHONE DETECT

The WM5102 microphone detection circuit measures the impedance of an external load connected to one of the MICDET pins. This feature can be used to detect the presence of a microphone, and the status of the associated hookswitch. It can also be used to detect push-button status or the connection of other external accessories.

The microphone detection circuit measures the impedance connected to MICDET1 or MICDET2, and reports whether the measured impedance lies within one of 8 pre-defined levels (including the 'no accessory detected' level). This means it can detect the presence of a typical microphone and up to 6 push-buttons. One of the impedance levels is specifically designed to detect a video accessory (typical 75Ω) load if required.

The microphone detection circuit typically uses one of the MICBIAS outputs as a reference. The WM5102 will automatically enable the appropriate MICBIAS when required in order to perform the detection function; this allows the detection function to be supported in low-power standby operating conditions.

Note that the MICVDD power domain must be enabled when using the microphone detection function. This power domain is provided using an internal Charge Pump (CP2) and LDO Regulator (LDO2). See "Charge Pumps, Regulators and Voltage Reference" for details of these circuits.

To select microphone detection on one of the MICDET pins, the ACCDET_MODE register must be set to 00. The ACCDET_MODE register is defined in Table 76.



The WM5102 can only support one headphone or microphone detection function at any time. When the detection function is not in use, it is recommended to set ACCDET_MODE=00.

The microphone detection circuit can be enabled on the MICDET1 pin or the MICDET2 pin, selected by the ACCDET_SRC register.

The microphone detection circuit uses MICVDD, MICBIAS1, MICBIAS2 or MICBIAS3 as a reference. The applicable source is configured using the MICD_BIAS_SRC register.

When ACCDET_MODE is set to 00, then Microphone detection is enabled by setting MICD_ENA.

When microphone detection is enabled, the WM5102 performs a number of measurements in order to determine the MICDET impedance. The measurement process is repeated at a cyclic rate controlled by MICD_RATE. (The MICD_RATE register selects the delay between completion of one measurement and the start of the next.)

For best accuracy, the measured impedance is only deemed valid after more than one successive measurement has produced the same result. The MICD_DBTIME register provides control of the debounce period; this can be either 2 measurements or 4 measurements.

When the microphone detection result has settled (ie. after the applicable de-bounce period), the WM5102 indicates valid data by setting the MICD_VALID bit. The measured impedance is indicated using the MICD_LVL and MICD_STS register bits, as described in Table 76.

The MICD_VALID bit, when set, remains asserted for as long as the microphone detection function is enabled (ie. while MICD_ENA = 1). If the detected impedance changes, then the MICD_LVL and MICD_STS fields will change, but the MICD_VALID bit will remain set, indicating valid data at all times

The microphone detection reports a measurement result in one of the pre-defined impedance levels. Each measurement level can be enabled or disabled independently; this provides flexibility according to the required thresholds, and offers a faster measurement time in some applications. The MICD LVL SEL register is described in detail later in this section.

Note that the impedance levels quoted in the MICD_LVL description assume that a microphone (475 Ω to 30k Ω impedance) is also present on the MICDET pin. The limits quoted in the "Electrical Characteristics" refer to the combined effective impedance on the MICDET pin. Typical external components are described in the "Applications Information" section.

The microphone detection function is an input to the Interrupt control circuit and can be used to trigger an Interrupt event every time an accessory insertion, removal or impedance change is detected. See "Interrupts" for further details.

The microphone detection function can also generate a GPIO output, providing an external indication of the microphone detection. This GPIO output is pulsed every time an accessory insertion, removal or impedance change is detected. See "General Purpose Input / Output" to configure a GPIO pin for this function.

The register fields associated with Microphone Detection (or other accessories) are described in Table 76. The external circuit configuration is illustrated in Figure 64.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R659 (0293h)	13	ACCDET_SRC	0	Accessory Detect / Headphone Feedback pin select
Accessory Detect Mode 1				0 = Accessory detect on MICDET1, Headphone ground feedback on HPOUT1FB1
				1 = Accessory detect on MICDET2, Headphone ground feedback on HPOUT1FB2



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	1:0	ACCDET_MODE [1:0]	00	Accessory Detect Mode Select 00 = MICDET measurement 01 = HPDETL measurement 10 = HPDETR measurement 11 = MICDET measurement Note that the MICDET function is provided on the MICDET1 or MICDET2 pins, depending on the ACCDET_SRC
R675 (02A3h) Mic Detect 1	15:12	MICD_BIAS_STA RTTIME [3:0]	0001	register bit. Mic Detect Bias Startup Delay (If MICBIAS is not enabled already, this field selects the delay time allowed for MICBIAS to startup prior to performing the MICDET function.) 0000 = 0ms (continuous) 0001 = 0.25ms 0010 = 0.5ms 0011 = 1ms 0100 = 2ms 0111 = 16ms 1010 = 8ms 0111 = 16ms 1000 = 32ms 1001 = 64ms 1010 = 128ms 1011 = 256ms 1100 to 1111 = 512ms
	11:8	MICD_RATE [3:0]	0001	Mic Detect Rate (Selects the delay between successive MICDET measurements.) 0000 = 0ms (continuous) 0001 = 0.25ms 0010 = 0.5ms 0011 = 1ms 0100 = 2ms 0101 = 4ms 0110 = 8ms 0111 = 16ms 1000 = 32ms 1001 = 64ms 1010 = 128ms 1011 = 256ms 1100 to 1111 = 512ms
	5:4	MICD_BIAS_SRC [1:0]	00	Accessory Detect (MICDET) reference select 00 = MICVDD 01 = MICBIAS1 10 = MICBIAS2 11 = MICBIAS3
	1	MICD_DBTIME	1	Mic Detect De-bounce 0 = 2 measurements 1 = 4 measurements
	0	MICD_ENA	0	Mic Detect Enable 0 = Disabled 1 = Enabled



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R676 (02A4h) Mic Detect 2	7:0	MICD_LVL_SEL [7:0]	1001_ 1111	Mic Detect Level Select (enables Mic/Accessory Detection in specific impedance ranges) [7] = Enable >475 ohm detection [6] = Not used - must be set to 0 [5] = Not used - must be set to 0 [4] = Enable 375 ohm detection [3] = Enable 155 ohm detection [2] = Enable 73 ohm detection [1] = Enable 40 ohm detection [0] = Enable 18 ohm detection Note that the impedance values quoted assume that a microphone (475ohm-30kohm) is also present on the MICDET pin.
R677 (02A5h) Mic Detect 3	10:2	MICD_LVL [8:0]	0_0000_ 0000	Mic Detect Level (indicates the measured impedance) [8] = >475 ohm, <30k ohm [7] = Not used [6] = Not used [5] = 375 ohm [4] = 155 ohm [3] = 73 ohm [2] = 40 ohm [1] = 18 ohm [0] = <3 ohm Note that the impedance values quoted assume that a microphone (475ohm-30kohm) is also present on the MICDET pin.
	1	MICD_VALID	0	Mic Detect Data Valid 0 = Not Valid 1 = Valid
	0	MICD_STS	0	Mic Detect Status 0 = No Mic/Accessory present (impedance is >30k ohm) 1 = Mic/Accessory is present (impedance is <30k ohm)

Table 76 Microphone Detect Control

The external connections for the Microphone Detect circuit are illustrated in Figure 64. In typical applications, it can be used to detect a microphone or button press.

Note that, when using the Microphone Detect circuit, it is recommended to use one of the Right channel analogue microphone input paths, to ensure best immunity to electrical transients arising from the external accessory.

The voltage reference for the microphone detection is configured using the MICD_BIAS_SRC register, as described in Table 76. The microphone detection function will automatically enable the applicable reference when required for MICDET impedance measurement.

If the selected reference (MICBIAS1, MICBIAS2 or MICBIAS3) is not already enabled (ie. if $MICBn_ENA = 0$, where n is 1, 2 or 3 as appropriate), then the applicable MICBIAS source will be enabled for short periods of time only, every time the impedance measurement is scheduled. To allow time for the MICBIAS source to start-up, a time delay is applied before the measurement is performed; this is configured using the MICD_BIAS_STARTTIME register, as described in Table 76.

The MICD_BIAS_STARTTIME register should be set to 16ms or more if MICBn_RATE = 1 (pop-free



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start-up / shut-down). The MICD_BIAS_STARTTIME register should be set to 0.25ms or more if MICBn RATE = 0 (fast start-up / shut-down).

If the selected reference is not enabled continuously (ie. if $MICBn_ENA = 0$), then the applicable MICBIAS discharge bit ($MICBn_DISCH$) should be set to 0.

The MICBIAS sources are configured using the registers described in the "Charge Pumps, Regulators and Voltage Reference" section.

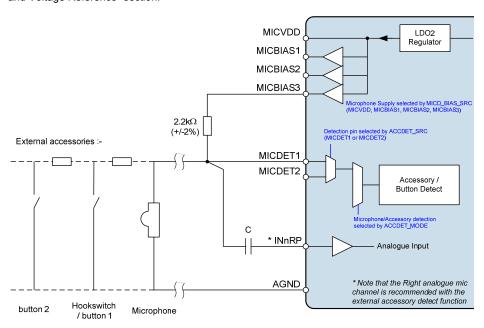


Figure 64 Microphone and Accessory Detect Interface

The MICD_LVL_SEL [7:0] register bits allow each of the impedance measurement levels to be enabled or disabled independently. This allows the function to be tailored to the particular application requirements.

If one or more bits within the MICD_LVL_SEL register is set to 0, then the corresponding impedance level will be disabled. Any measured impedance which lies in a disabled level will be reported as the next lowest, enabled level.

For example, the MICD_LVL_SEL [2] bit enables the detection of impedances around 73 Ω . If MICD_LVL_SEL [2] = 0, then an external impedance of 73 Ω will not be indicated as 73 Ω but will be indicated as 40 Ω ; this would be reported in the MICD_LVL register as MICD_LVL [2] = 1.

With all measurement levels enabled, the WM5102 can detect the presence of a typical microphone and up to 6 push-buttons. The microphone detect function is specifically designed to detect a video accessory (typical 75Ω) load if required.

See "Applications Information" for typical recommended external components for microphone, video or push-button accessory detection.

The microphone detection circuit assumes that a $2.2k\Omega$ (2%) resistor is connected to the selected MICBIAS reference, as illustrated. Different resistor values will lead to inaccuracy in the impedance measurement.

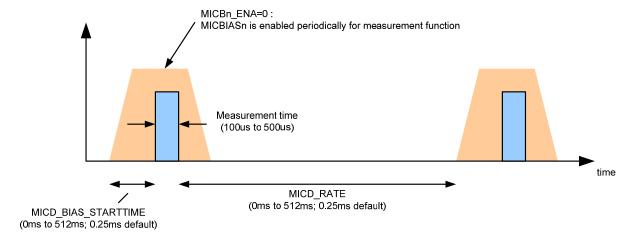
The accuracy of the microphone detect function is assured whenever the connected load is within the applicable limits specified in the "Electrical Characteristics". It is required that a $2.2k\Omega$ (2%) resistor must also be connected between MICDET and the selected MICBIAS reference; note that different resistor values will lead to inaccuracy in the impedance measurement.

Note that the connection of a microphone will change the measured impedance on the MICDET pin; see "Applications Information" for recommended components for typical applications.

The measurement time varies between $100\mu s$ and $500\mu s$ according to the impedance of the external load. A high impedance will be measured faster than a low impedance.



The timing of the microphone detect function is illustrated in Figure 65. Two different cases are shown, according to whether MICBIAS*n* is enabled periodically by the impedance measurement function (MICB*n* ENA=0), or is enabled at all times (MICB*n* ENA=1).



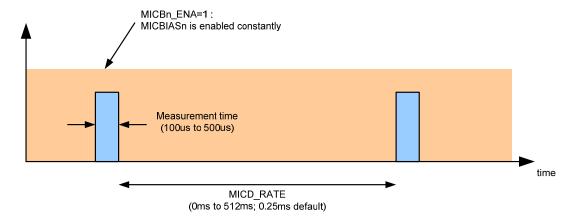


Figure 65 Microphone and Accessory Detect Timing

HEADPHONE DETECT

The WM5102 headphone detection circuit measures the impedance of an external headphone load. This feature can be used to set different gain levels or to apply other configuration settings according to the type of load connected. Separate monitor pins are provided for headphone detection on the left and right channels of HPOUT1.

Headphone detection may only be selected on one channel at a time. The available channels are the HPDETL pin or the HPDETR pin. The selected channel is determined by the ACCDET_MODE register as described in Table 79.

The WM5102 can only support one headphone or microphone detection function at any time. When the detection function is not in use, it is recommended to set ACCDET_MODE=00.

Headphone detection on the selected channel is commanded by writing a '1' to the HP_POLL register bit. The impedance measurement range is configured using the HP_IMPEDANCE_RANGE register.

Note that a number of separate measurements (for different impedance ranges) is typically required in order to determine the load impedance; the recommended control sequence is described below.

For correct operation, the respective output driver(s) must be disabled when headphone detection is commanded on HPOUT1L or HPOUT1R. The applicable ground clamp must also be disabled. These requirements are detailed in Table 77.



The HP1L_ENA and HP1R_ENA register bits are defined in Table 59. The RMV_SHRT_HP1L and RMV_SHRT_HP1R register bits are defined in Table 79.

Note that, when configuring the RMV_SHRT_HP1L or RMV_SHRT_HP1R bits, care is required not to change the value of other bits in the register, which may have changed from the default setting. Accordingly, a 'read-modify-write' sequence is required to implement this.

The applicable headphone output(s) configuration must be maintained until after the headphone detection has completed.

DESCRIPTION	REQUIREMENT	
Impedance measurement on HPOUT1L	HP1L_ENA = 0	
	RMV_SHRT_HP1L = 1	
Impedance measurement on HPOUT1R	HP1R_ENA = 0	
	RMV_SHRT_HP1R = 1	

Table 77 Output Configuration for Headphone Detect

When headphone detection is commanded, the WM5102 uses an adjustable current source to determine the connected impedance. A sweep of measurement currents is applied. The rate of this sweep can be adjusted using the HP_RATE register. To avoid audible clicks, the default step size should always be used (HP_RATE = 0).

The timing of the current source ramp is also controlled by the HP_HOLDTIME register. It is recommended that the default setting (001b) be used for this parameter.

Completion of each measurement is indicated by the HP_DONE register bit. When this bit is set, the measurement result can be read from the HP_DACVAL register. Note that the decoding equation of this register (to convert into 'ohms') varies according to the HP_IMPEDANCE_RANGE setting.

	HEADPHONE IMPEDANCE MEASUREMENT			
1	Trigger the HP measurement, with HP_IMPEDANCE_RANGE = 00			
2	If the HP_DACVAL result >= 100, then decode the impedance as follows:			
	Load Impedance (Ω) = $\frac{3600}{\text{HP_DACVAL} - 55}$			
	Otherwise, proceed to step 3.			
3	Trigger the HP measurement, with HP_IMPEDANCE_RANGE = 01			
4	If the HP_DACVAL result >= 169, then decode the impedance as follows:			
	Load Impedance (Ω) = $\frac{62000}{\text{HP_DACVAL} - 110}$			
	Otherwise, proceed to step 5.			
5	Trigger the HP measurement, with HP_IMPEDANCE_RANGE = 10			
6	If the HP_DACVAL result >= 169, then decode the impedance as follows:			
	Load Impedance (Ω) = $\frac{650000}{\text{HP_DACVAL} - 110}$			
	Otherwise, the impedance is out of range (too high).			

Table 78 Headphone Impedance Measurement Control Sequence

Each measurement is triggered by writing '1' to the HP_POLL bit. Completion of each measurement is indicated by the HP_DONE register bit. Note that, after the HP_DONE bit has been asserted, it will remain asserted until the next measurement has been commanded.

The headphone detection function is an input to the Interrupt control circuit and can be used to trigger an Interrupt event on completion of the headphone detection - see "Interrupts".



The headphone detection function can also generate a GPIO output, providing an external indication of the headphone detection. See "General Purpose Input / Output" to configure a GPIO pin for this function.

The register fields associated with Headphone Detection are described in Table 79. The external circuit configuration is illustrated in Figure 66.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R549 (0225h) HP Ctrl 1L	14	RMV_SHRT_HP1 L	0	HPOUT1L Ground Clamp 0 = Enabled 1 = Disabled This bit must be set to 1 when the
				Headphone Detection function is enabled on HPOUT1L. This bit is configured automatically when
				HPOUT1L is enabled or disabled.
R550	14	RMV_SHRT_HP1	0	HPOUT1R Ground Clamp
(0226h) HP Ctrl 1R		R		0 = Enabled
TIF CUITIK				1 = Disabled
				This bit must be set to 1 when the Headphone Detection function is enabled on HPOUT1R.
				This bit is configured automatically when HPOUT1R is enabled or disabled.
R659	1:0	ACCDET_MODE	00	Accessory Detect Mode Select
(0293h) Accessory		[1:0]		00 = MICDET measurement
Detect				01 = HPDETL measurement
Mode 1				10 = HPDETR measurement 11 = MICDET
				Note that the MICDET function is
				provided on the MICDET1 or MICDET2 pins, depending on the ACCDET_SRC register bit.
R667	10:9	HP_IMPEDANCE	00	Headphone Detect Range
(029Bh)		_RANGE [1:0]		00 = 4 ohms to 80 ohms
Headphone Detect 1				01 = 70 ohms to 1k ohms
Detect				10 = 1k ohms to 10k ohms
				11 = Reserved
	7:5	HP_HOLDTIME [2:0]	001	Headphone Detect Hold Time
		[2.0]		(Selects the hold time between ramp up and ramp down of the headphone detect current source.)
				000 = 31.25us
				001 = 125us
				010 = 500us
				011 = 2ms
				100 = 8ms
				101 = 16ms
				110 = 24ms
				111 = 32ms
	1	HP_RATE	0	Headphone Detect Ramp Rate
				0 = Normal rate
		HD DOLL		1 = Fast rate
	0	HP_POLL	0	Headphone Detect Enable Write 1 to start HP Detect function
				white I to start HP Detect function



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REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R668 (029Ch)	15	HP_DONE	0	Headphone Detect Status 0 = HP Detect not complete
Headphone Detect 2				1 = HP Detect done
R671 (029Fh)	9:0	HP_DACVAL [9:0]	000h	Headphone Detect Level (see separate description for decode)
Headphone Detect Test				,

Table 79 Headphone Detect Control

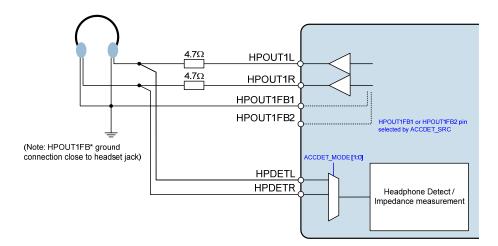


Figure 66 Headphone Detect Interface

The external connections for the Headphone Detect circuit are illustrated in Figure 66. Note that only the HPOUT1L or HPOUT1R headphone outputs should be connected to HPDETL or HPDETR pins - impedance measurement is not supported on HPOUT2L, HPOUT2R, EPOUTP or EPOUTN.

Note that, where external resistors are connected in series with the headphone load, as illustrated, it is recommended that the HPDET*n* connection is to the headphone side of the resistors. If the HPDET*n* connection is made to the WM5102 'end' of these resistors, this will lead to a corresponding offset in the measured impedance.

Note that the measurement accuracy of the headphone detect function may be up to +/-30%.

Under default conditions, the measurement time varies between 17ms and 61ms according to the impedance of the external load. A high impedance will be measured faster than a low impedance.

LOW POWER SLEEP CONFIGURATION

The WM5102 supports a low-power 'Sleep' mode, where most functions are disabled, and power consumption is minimised. A selectable 'Wake-Up' event can be configured to return the device to full operation and/or execute a specific response to the particular Wake-Up condition.

A Wake-Up event is triggered via hardware input pin(s); in typical applications, these inputs are associated with jack insert (via the JACKDET analogue input) or external push-button detection (via the GPIO5 digital input). A Wake-Up transition can also be triggered using the LDOENA pin to enable LDO1 (assuming that DCVDD is supplied by LDO1).

The WM5102 enters Sleep mode when LDO1 is disabled, causing the DCVDD supply to be removed. The AVDD, DBVDD1, and LDOVDD supplies must be present throughout the Sleep mode duration.

Note that it is assumed that DCVDD is supplied by LDO1; see "Charge Pumps, Regulators and Voltage Reference" for specific control requirements where DCVDD is not powered from LDO1.

SLEEP MODE

The WM5102 enters Sleep mode when LDO1 is disabled, causing the DCVDD supply to be removed; (LDO1 can be controlled using the LDO1_ENA register bit, or using the LDOENA pin; both of these controls must be de-asserted to disable the LDO.) The AVDD, DBVDD1, and LDOVDD supplies must be present throughout the Sleep mode; under these conditions, and with LDO1 disabled, most of the Digital Core (and control registers) are held in reset.

Note that it is assumed that DCVDD is supplied by LDO1; see "Charge Pumps, Regulators and Voltage Reference" for specific control requirements where DCVDD is not powered from LDO1.

The system clocks (SYSCLK, ASYNCCLK) are not required in Sleep mode, and the external clock inputs (MCLKn) may be stopped, except as described below.

If de-bounce is enabled on any of the configured Wake-Up signals (JACKDET or GPIO5), then the 32kHz clock must be active during Sleep mode (see "Clocking and Sample Rates"). The 32kHz clock must be derived from the MCLK2 pin in this case. The 32kHz clock must be configured using CLK_32K_ENA and CLK_32K_SRC before Sleep mode is entered.

The MCLK2 frequency limit in Sleep mode (see "Signal Timing Requirements") must be observed before entering Sleep mode, and maintained until after Wake-Up.

Selected functions and control registers are maintained via an 'Always-On' internal supply domain in Sleep mode. The 'Always-On' control registers are listed in Table 80. These registers are maintained (ie. not reset) in Sleep mode.

Note that the Control Interface is not supported in Sleep mode. Read/Write access to the 'Always-On' registers is not possible in Sleep mode.

REGISTER ADDRESS	LABEL	REFERENCE
40h	WKUP_MICD_CLAMP_FALL	See Table 83
	WKUP_MICD_CLAMP_RISE	
	WKUP_GP5_FALL	
	WKUP_GP5_RISE	
	WKUP_JD1_FALL	
	WKUP_JD1_RISE	
41h	WSEQ_ENA_MICD_CLAMP_FAL L	See Table 84
	WSEQ_ENA_MICD_CLAMP_RIS E	
	WSEQ_ENA_GP5_FALL	
	WSEQ_ENA_GP5_RISE	
	WSEQ_ENA_JD1_FALL	
	WSEQ_ENA_JD1_RISE	



REGISTER ADDRESS	LABEL	REFERENCE
66h	WSEQ_MICD_CLAMP_RISE_IND EX	See "Control Write Sequencer"
67h	WSEQ_MICD_CLAMP_FALL_IND EX	
68h	WSEQ_GP5_RISE_INDEX	
69h	WSEQ_GP5_FALL_INDEX	
6Ah	WSEQ_JD1_RISE_INDEX	
6Bh	WSEQ_JD1_FALL_INDEX	
100h	CLK_32K_ENA	See "Clocking and Sample Rates"
	CLK_32K_SRC	
210h	LDO1_VSEL	See "Charge Pumps, Regulators and
	LDO1_DISCH	Voltage Reference"
	LDO1_BYPASS	
	LDO1_ENA	
02A2h	MICD_CLAMP_MODE	See "External Accessory Detection"
02D3h	JD1_ENA	See "External Accessory Detection"
0C04h	GP5_DIR	See "General Purpose Input / Output"
	GP5_PU	
	GP5_PD	
	GP5_POL	
	GP5_OP_CFG	
	GP5_DB	
	GP5_LVL	
	GP5_FN	
0C0Fh	IRQ_POL	See "Interrupts"
	IRQ_OP_CFG	
0C10h	GP_DBTIME	See "General Purpose Input / Output"
0C20h	LDO1ENA_PD	See "Charge Pumps, Regulators and Voltage Reference"
	MCLK2_PD	See "Clocking and Sample Rates"
	RESET_PU	See "Software Reset, Wake-Up, and Device ID"
0D0Fh	IM_IRQ1	See "Interrupts"
0D1Fh	IM_IRQ2	
0D50h	MICD_CLAMP_FALL_TRIG_STS	See Table 82
	MICD_CLAMP_RISE_TRIG_STS	
	GP5_FALL_TRIG_STS	
	GP5_RISE_TRIG_STS	
	JD1_FALL_TRIG_STS	
	JD1_RISE_TRIG_STS	
0D51h	MICD_CLAMP_FALL_EINT1	See "Interrupts"
	MICD_CLAMP_RISE_EINT1	
	GP5_FALL_EINT1	
	GP5_RISE_EINT1	
	JD1_FALL_EINT1	
0055	JD1_RISE_EINT1	
0D52h	MICD_CLAMP_FALL_EINT2	See "Interrupts"
	MICD_CLAMP_RISE_EINT2	
	GP5_FALL_EINT2	
	GP5_RISE_EINT2	
	JD1_FALL_EINT2	
	JD1_RISE_EINT2	



REGISTER ADDRESS	LABEL	REFERENCE	
0D53h	IM_MICD_CLAMP_FALL_EINT1	See "Interrupts"	
	IM_MICD_CLAMP_RISE_EINT1		
	IM_GP5_FALL_EINT1		
	IM_GP5_RISE_EINT1		
	IM_JD1_FALL_EINT1		
	IM_JD1_RISE_EINT1		
0D54h	IM_MICD_CLAMP_FALL_EINT2	See "Interrupts"	
	IM_MICD_CLAMP_RISE_EINT2		
	IM_GP5_FALL_EINT2		
	IM_GP5_RISE_EINT2		
	IM_JD1_FALL_EINT2		
	IM_JD1_RISE_EINT2		
0D56h	MICD_CLAMP_DB	See "External Accessory Detection"	
	JD1_DB		
3000h to	WSEQ_DATA_WIDTHn	See "Control Write Sequencer"	
31FFh	WSEQ_ADDRn		
	WSEQ_DELAYn		
	WSEQ_DATA_STARTn		
	WSEQ_DATAn		

Table 80 Sleep Mode 'Always-On' Control Registers

The 'Always-On' digital input / output pins are listed in Table 81. All other digital input pins will have no effect in Sleep mode. The $\overline{\mbox{IRQ}}$ output is normally de-asserted in Sleep mode.

Note that, in Sleep mode, the $\overline{\mbox{IRQ}}$ output can only be asserted in response to the JD1 or GP5 control signals (these described in the following section). If the $\overline{\mbox{IRQ}}$ output is asserted in Sleep mode, it can only be de-asserted after a Wake-Up transition.

PIN NAME	DESCRIPTION	REFERENCE
LDOENA	Enable pin for LDO1	See "Charge Pumps, Regulators and Voltage Reference"
RESET	Digital Reset input (active low)	See "Software Reset, Wake-Up, and Device ID"
MCLK2	Master clock 2	See "Clocking and Sample Rates"
GPIO5	General Purpose pin GPIO5	See "General Purpose Input / Output"
ĪRQ	Interrupt Request (IRQ) output	See "Interrupts"

Table 81 Sleep Mode 'Always-On' Digital Input Pins

A Wake-Up transition is triggered using the JD1 or GP5 control signals (defined below).

It is assumed that DCVDD is supplied by LDO1. The AVDD, DBVDD1 and LDOVDD supplies must be present throughout the Sleep mode duration. See "Charge Pumps, Regulators and Voltage Reference" for specific control requirements where DCVDD is not powered from LDO1.

Note that a logic '1' applied to the LDOENA pin will also cause a Wake-Up transition. In this event, however, the configurable Wake-Up events (described below) are not applicable.



SLEEP CONTROL SIGNALS - JD1, GP5, MICDET CLAMP

The internal control signals JD1 and GP5 are provided to support the low-power Sleep mode. The MICDET Clamp status is controlled by a selectable logic function, derived from JD1 and/or GP5. A rising or falling edge of these signals can be used to trigger a Wake-Up transition (ie. exit from Sleep mode).

The JD1, GP5 and MICDET Clamp status signals can also be used to trigger the Control Write Sequencer and/or the Interrupt Controller.

Note that it is not possible to trigger the Control Write Sequencer from the same event used to trigger a Wake-Up transition. (This is because SYSCLK is disabled following a Wake-Up transition; a valid SYSCLK must be enabled before triggering the Control Write Sequencer.)

The JD1, GP5 and MICDET Clamp status signals are described in this section. The Wake-Up, Write Sequencer, and Interrupt actions are described in the sections that follow.

The JD1 signal is derived from the Jack Detect function (see "External Accessory Detection"). This input can be used to trigger Wake-Up or other actions in response to a jack insertion or jack removal detection.

When the JD1 signal is enabled, it indicates the status of the JACKDET input pin. See Table 74 for details of the associated control registers.

The GP5 signal is derived from the GPIO5 input pin (see "General Purpose Input / Output"). This input can be used to trigger Wake-Up or other actions in response to a logic level input detected on the GPIO5 pin.

When using the GP5 signal, the GPIO5 pin must be configured as a GPIO input (GP5_DIR=1, GP5_FN=01h). An internal pull-up or pull-down resistor may be enabled on the GPIO5 pin if required.

The GPIO pin control registers are defined in Table 85.

The MICDET Clamp status is controlled by the JD1 and/or GP5 signals (see "External Accessory Detection"). The configurable logic provides flexibility in selecting the appropriate conditions for activating the MICDET Clamp. The clamp status can be used to trigger Wake-Up or other actions in response to a jack insertion or jack removal detection.

The MICDET Clamp function is configured using the MICD_CLAMP_MODE register, as described in Table 75.

Whenever a rising or falling edge is detected on JD1, GP5 or MICDET Clamp status, the WM5102 will assert the respective trigger status (_TRIG_STS) bit. The trigger status bits are latching fields and, once they are set, they are not reset until a '1' is written to the respective register bit(s).

The JD1, GP5 and MICDET Clamp trigger status bits are described in Table 82.

The trigger status bits can be used to control Wake-Up and Write Sequencer actions. The JD1, GP5 and MICDET Clamp signals are inputs to the Interrupt Controller. Each of these functions is described in the following sections.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3408	7	MICD_CLAMP_FALL_T	0	MICDET Clamp Trigger Status
(0D50h)		RIG_STS		(Falling edge triggered)
AOD wkup				Note: Cleared when a '1' is written
and trig	6	MICD_CLAMP_RISE_T	0	MICDET Clamp Trigger Status
		RIG_STS		(Rising edge triggered)
				Note: Cleared when a '1' is written
	5	GP5_FALL_TRIG_STS	0	GP5 Trigger Status
				(Falling edge triggered)
				Note: Cleared when a '1' is written
	4	GP5_RISE_TRIG_STS	0	GP5 Trigger Status
				(Rising edge triggered)
				Note: Cleared when a '1' is written
	3	JD1_FALL_TRIG_STS	0	JD1 Trigger Status
				(Falling edge triggered)
				Note: Cleared when a '1' is written
	2	JD1_RISE_TRIG_STS	0	JD1 Trigger Status
				(Rising edge triggered)
				Note: Cleared when a '1' is written

Table 82 JD1, GP5 and MICDET Clamp Trigger Status Registers

Note that the de-bounce function on all inputs (including JD1, GP5 and MICDET Clamp status) use the 32kHz clock (see "Clocking and Sample Rates"). The 32kHz clock must be enabled whenever input de-bounce functions are required.

Note that the MCLK2 input pin is on the 'Always-On' domain, and is supported in Sleep mode. (MCLK1 input is not supported in Sleep mode.)

If input de-bounce is enabled in Sleep mode, the 32kHz clock must use MCLK2 (direct) input as its source (CLK_ $32K_SRC = 01$).

WAKE-UP TRANSITION

A Wake-Up transition (exit from Sleep) can be associated with any of the JD1, GP5 or MICDET Clamp trigger status bits. This is selected using the register bits described in Table 83.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R64 (0040h) Wake	7	WKUP_MICD_CLAMP_ FALL	0	MICDET Clamp (Falling) Wake-Up Select
Control				0 = Disabled
				1 = Enabled
	6	WKUP_MICD_CLAMP_ RISE	0	MICDET Clamp (Rising) Wake-Up Select
				0 = Disabled
				1 = Enabled
	5	WKUP_GP5_FALL	0	GP5 (Falling) Wake-Up Select
				0 = Disabled
				1 = Enabled
	4	WKUP_GP5_RISE	0	GP5 (Rising) Wake-Up Select
				0 = Disabled
				1 = Enabled
	3	WKUP_JD1_FALL	0	JD1 (Falling) Wake-Up Select
				0 = Disabled
				1 = Enabled
	2	WKUP_JD1_RISE	0	JD1 (Rising) Wake-Up Select
				0 = Disabled
				1 = Enabled

Table 83 JD1, GP5 and MICDET Clamp Wake-Up Control Registers

When a valid 'Wake-Up' event is detected, the WM5102 will enable LDO1 (and DCVDD), and return to the normal operating state. See "Software Reset, Wake-Up, and Device ID") for further details.

Note that the trigger status (_TRIG_STS) bits are latching fields. Care is required when resetting these bits, to ensure the intended device behaviour - resetting the _TRIG_STS register(s) may cause LDO1 (and DCVDD) to be disabled.

For normal device operation following a 'Wake-Up' transition, the LDO1_ENA register must be set before the _TRIG_STS bit(s) are reset.

WRITE SEQUENCE CONTROL

A Control Write Sequence can be associated with any of the JD1, GP5 or MICDET Clamp trigger status bits. This is selected using the register bits described in Table 84.

Note that the JD1, GP5 or MICDET Clamp trigger status bits can only be used to trigger the Control Write Sequencer during normal operation - it is not possible to trigger the Control Write Sequencer from the same event used to trigger a Wake-Up transition.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R65 (0041h) Sequence Control	7	WSEQ_ENA_MICD_CL AMP_FALL	0	MICDET Clamp (Falling) Write Sequencer Select 0 = Disabled 1 = Enabled
	6	WSEQ_ENA_MICD_CL AMP_RISE	0	MICDET Clamp (Rising) Write Sequencer Select 0 = Disabled 1 = Enabled
	5	WSEQ_ENA_GP5_FAL L	0	GP5 (Falling) Write Sequencer Select 0 = Disabled 1 = Enabled
	4	WSEQ_ENA_GP5_RIS E	0	GP5 (Rising) Write Sequencer Select 0 = Disabled 1 = Enabled
	3	WSEQ_ENA_JD1_FALL	0	JD1 (Falling) Write Sequencer Select 0 = Disabled 1 = Enabled
	2	WSEQ_ENA_JD1_RISE	0	JD1 (Rising) Write Sequencer Select 0 = Disabled 1 = Enabled

Table 84 JD1, GP5 and MICDET Clamp Write Sequencer Control Registers

When a valid 'Write Sequencer' control event is detected, the respective control sequence will be scheduled. See "Control Write Sequencer" for further details.

If desired, the Control Write Sequencer can be programmed to select the Sleep mode by writing '0' to the LDO1_ENA bit. (The LDOENA pin must not be asserted.)

See "Charge Pumps, Regulators and Voltage Reference" for details of the LDO1 ENA control bit.

INTERRUPT CONTROL

An Interrupt Request (IRQ) event can be associated with the JD1, GP5 or MICDET Clamp signals. Separate 'mask' bits are provided to enable IRQ events on the rising and/or falling edges of each signal.

See "Interrupts" for further details.



WM5102 Production Data

GENERAL PURPOSE INPUT / OUTPUT

The WM5102 provides a number of GPIO functions to enable interfacing and detection of external hardware and to provide logic outputs to other devices. The GPIO input functions can be used to generate an Interrupt (IRQ) event. The GPIO and Interrupt circuits support the following functions:

- Digital audio interface function (AIFnTXLRCLK)
- Logic input / Button detect (GPIO input)
- Logic '1' and logic '0' output (GPIO output)
- Interrupt (IRQ) status output
- DSP Status Flag (DSP IRQn) and RAM status output
- Clock output
- Frequency Locked Loop (FLL) status output
- Frequency Locked Loop (FLL) Clock output
- Pulse Width Modulation (PWM) Signal output
- Headphone Detection status output
- Microphone / Accessory Detection status output
- Asynchronous Sample Rate Converter (ASRC) Lock status and Configuration Error output
- Control Write Sequencer status output
- Over-Temperature status output
- Dynamic Range Control (DRC) status output
- Control Interface Error status output
- Clocking Error status output
- Digital audio interface Configuration Error status output

Note that the GPIO pins are referenced to different power domains (DBVDD1, DBVDD2 or DBVDD3), as noted in the "Pin Description" section.

In addition to the functions described in this section, the GPIO5 pin can be configured as an input to the Control Write Sequencer (see "Control Write Sequencer"). See also Table 84 for details of the associated register control fields.

The GPIO5 pin is one of the 'Always On' digital input / output pins and can be used as a 'Wake-Up' input in the low-power 'Sleep' mode. The GPIO5 pin can also be used as an input to the MICDET Clamp function, supporting additional functionality relating to jack insertion or jack removal events See "Low Power Sleep Configuration" for further details.



GPIO CONTROL

For each GPIO, the selected function is determined by the GPn_FN field, where n identifies the GPIO pin (1, 2, 3, 4 or 5). The pin direction, set by GPn_DIR , must be set according to function selected by GPn_FN .

When a pin is configured as a GPIO input ($GPn_DIR = 1$, $GPn_FN = 01h$), the logic level at the pin can be read from the respective GPn_LVL bit. Note that GPn_LVL is not affected by the GPn_POL bit.

A de-bounce circuit can be enabled on any GPIO input, to avoid false event triggers. This is enabled on each pin by setting the respective GPn_DB bit. The de-bounce circuit uses the 32kHz clock, which must be enabled whenever input de-bounce functions are required. The de-bounce time is configurable using the GP_DBTIME register. See "Clocking and Sample Rates" for further details of the WM5102 clocking configuration.

Each of the GPIO pins is an input to the Interrupt control circuit and can be used to trigger an Interrupt event. An interrupt event is triggered on the rising and falling edges of the GPIO input. The associated interrupt bit is latched once set; it can be polled at any time or used to control the IRQ signal. See "Interrupts" for more details of the Interrupt event handling.

When a pin is configured as a GPIO input, internal pull-up and pull-down resistors may be enabled using the GPn_PU and GPn_PD fields; this allows greater flexibility to interface with different signals from other devices. (Note that, if the pin is configured as an output, or if GPn_PU and GPn_PD are both set for any GPIO pin, then the pull-up and pull-down will be disabled.)

When a pin is configured as a GPIO output ($GPn_DIR = 0$, $GPn_FN = 01h$), its level can be set to logic 0 or logic 1 using the GPn_LVL field. Note that the GPn_LVL registers are 'write only' when the respective GPIO pin is configured as an output.

When a pin is configured as an output ($GPn_DIR = 0$), the polarity can be inverted using the GPn_POL bit. When $GPn_POL = 1$, then the selected output function is inverted. In the case of Logic Level output ($GPn_FN = 01h$), the external output will be the opposite logic level to GPn_LVL when $GPn_POL = 1$.

A GPIO output can be either CMOS driven or Open Drain. This is selected on each pin using the respective GPn_OP_CFG bit.

The register fields that control the GPIO pins are described in Table 85.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION	
R3072	15	GPn_DIR	1	GPIOn Pin Direction	
(0C00h)				0 = Output	
GPIO1 CTRL				1 = Input	
4-	14	GPn_PU	0	GPIOn Pull-Up Enable	
to				0 = Disabled	
R3076				1 = Enabled	
(0C04h)		00.00		(Only valid when GPn_DIR=1)	
GPIO5 CTRL	13	GPn_PD	1	GPIOn Pull-Down Enable	
				0 = Disabled	
				1 = Enabled	
	11	CDn 11/I	0	(Only valid when GPn_DIR=1) GPIOn level. Write to this bit to set	
	11	GPn_LVL	0	a GPIO output. Read from this bit to	
				read GPIO input level.	
				For output functions only, when	
				GPn_POL is set, the register is the	
				opposite logic level to the external pin.	
				Note that the GPn LVL register is	
				'write only' when GPn_DIR=0.	
	10	GPn_POL	0	GPIOn Output Polarity Select	
				0 = Non-inverted (Active High)	
				1 = Inverted (Active Low)	
	9	GPn_OP_CFG	0	GPIOn Output Configuration	
				0 = CMOS	
				1 = Open Drain	
	8	GPn_DB	1	GPIOn Input De-bounce	
				0 = Disabled	
				1 = Enabled	
	6:0	GPn_FN [6:0]	01h	GPIOn Pin Function	
				(see Table 86 or Table 87 for details)	
R3088	15:12	GP_DBTIME	0001	GPIO Input de-bounce time	
(0C10h)	13.12	[3:0]	0001	Oh = 100us	
GPIO				1h = 1.5ms	
Debounce				2h = 3ms	
Config				3h = 6ms	
				4h = 12ms	
				5h = 24ms	
				6h = 48ms	
				7h = 96ms	
				8h = 192ms	
				9h = 384ms	
				Ah = 768ms	
				Bh to Fh = Reserved	
Note: <i>n</i> is a number (1, 2, 3, 4 or 5) that identifies the individual GPIO.					

Table 85 GPIO Control



GPIO FUNCTION SELECT

The available GPIO functions for GPIO pins 1, 2, 3 and 4 are described in Table 86. A subset of these functions is available for GPIO5, as described in Table 87.

The function of each GPIO is set using the GPn_FN register, where n identifies the GPIO pin (1, 2, 3, 4 or 5). Note that the respective GPn_DIR must also be set according to whether the function is an input or output.

GPn_FN	DESCRIPTION	COMMENTS
00h	GPIO1 - AIF1TXLRCLK	Alternate Audio Interface connections for AIF1, AIF2 and
	GPIO2 - AIF2TXLRCLK	AIF3
	GPIO3 - AIF3TXLRCLK	
	GPIO4 - Reserved	
01h	Button detect input / Logic	GPn_DIR = 0: GPIO pin logic level is set by GPn_LVL.
	level output	GPn_DIR = 1: Button detect or logic level input.
02h	IRQ1 Output	Interrupt (IRQ1) output
		0 = IRQ1 not asserted
		1 = IRQ1 asserted
03h	IRQ2 Output	Interrupt (IRQ2) output
		0 = IRQ2 not asserted
		1 = IRQ2 asserted
04h	OPCLK Clock Output	Configurable clock output derived from SYSCLK
05h	FLL1 Clock	Clock output from FLL1
06h	FLL2 Clock	Clock output from FLL2
07h	Reserved	
08h	PWM1 Output	Configurable Pulse Width Modulation output PWM1
09h	PWM2 Output	Configurable Pulse Width Modulation output PWM2
0Ah	SYSCLK Underclocked Error	Indicates that an unsupported clocking configuration has been attempted
		0 = Normal
		1 = SYSCLK underclocking error
0Bh	ASYNCCLK Underclocked Error	Indicates that an unsupported clocking configuration has been attempted
		0 = Normal
		1 = ASYNCCLK underclocking error
0Ch	FLL1 Lock	Indicates FLL1 Lock status
		0 = Not locked
		1 = Locked
0Dh	FLL2 Lock	Indicates FLL2 Lock status
		0 = Not locked
		1 = Locked
0Eh	Reserved	
0Fh	FLL1 Clock OK	Indicates FLL1 Clock OK status
		0 = FLL1 Clock output is not active
		1 = FLL1 Clock output is active
10h	FLL2 Clock OK	Indicates FLL2 Clock OK status
		0 = FLL2 Clock output is not active
		1 = FLL2 Clock output is active
11h	Reserved	
	1	



GPn FN	DESCRIPTION	COMMENTS
12h	Headphone detect	Indicates Headphone Detection status
		0 = Headphone Detect not complete
		1 = Headphone Detect complete
13h	Microphone detect	Microphone Detect (MICDET accessory) IRQ output
		A single 31μs pulse is output whenever an accessory
		insertion, removal or impedance change is detected.
14h	Reserved	
15h	Write Sequencer status	Indicates Write Sequencer status
		A short pulse is output when the Write Sequencer has
		completed all scheduled sequences.
16h	Control Interface Address	Indicates Control Interface Address error
	Error	0 = Normal
		1 = Control Interface Address error
17h	Reserved	
18h	Reserved	
19h	Reserved	
1Ah	ASRC1 Lock	Indicates ASRC1 Lock status
		0 = Not locked
		1 = Locked
1Bh	ASRC2 Lock	Indicates ASRC2 Lock status
		0 = Not locked
		1 = Locked
1Ch	ASRC Configuration Error	Indicates ASRC configuration error
		0 = ASRC configuration OK
		1 = ASRC configuration error
1Dh	DRC1 Signal Detect	Indicates DRC1 Signal Detect status
		0 = Signal threshold not exceeded
		1 = Signal threshold exceeded
1Eh	DRC1 Anti-Clip Active	Indicates DRC1 Anti-Clip status
		0 = Anti-Clip is not active
451	DD04.D 4.11	1 = Anti-Clip is active
1Fh	DRC1 Decay Active	Indicates DRC1 Decay status
		0 = Decay is not active
001-	DDC4 Naine Cate Active	1 = Decay is active
20h	DRC1 Noise Gate Active	Indicates DRC1 Noise Gate status 0 = Noise Gate is not active
		1 = Noise Gate is not active
21h	DRC1 Quick Release	Indicates DRC1 Quick Release status
2111	Active	0 = Quick Release is not active
		1 = Quick Release is active
22h	Reserved	- Quion notocoo is delive
23h	Reserved	
24h	Reserved	
25h	Reserved	
26h	Reserved	
27h	Mixer Dropped Sample	Indicates a dropped sample in the digital core mixers
2/11	Error	0 = Normal
		1 = Mixer dropped sample error
28h	AIF1 Configuration Error	Indicates AIF1 configuration error
2511	i comgaration End	0 = AIF1 configuration OK
		1 = AIF1 configuration error
29h	AIF2 Configuration Error	Indicates AIF2 configuration error
	= 00.mgaradon Enoi	0 = AIF2 configuration OK
		1 = AIF2 configuration error
L	l	2 doining at a tion of tot



GPn FN	DESCRIPTION	COMMENTS
2Ah	AIF3 Configuration Error	Indicates AIF3 configuration error
27 111	7 0 00ga.a =	0 = AIF3 configuration OK
		1 = AIF3 configuration error
2Bh	Speaker Shutdown	Indicates Shutdown Temperature status
	Temperature	0 = Temperature is below shutdown level
		1 = Temperature is above shutdown level
2Ch	Speaker Warning	Indicates Warning Temperature status
	Temperature	0 = Temperature is below warning level
		1 = Temperature is above warning level
2Dh	Underclocked Error	Indicates insufficient SYSCLK or ASYNCCLK cycles for one or more of the selected signal paths or signal processing functions. Increasing the SYSCLK or ASYNCCLK frequency (as applicable) should allow the selected configuration to be supported. 0 = Normal 1 = Underclocked error
2Eh	Overclocked Error	Indicates that an unsupported device configuration has
ZLII	Overdocked Lifts	been attempted, as the clocking requirements of the requested configuration exceed the device limits. 0 = Normal 1 = Overclocked error
2Fh	Reserved	
30h	Reserved	
31h	Reserved	
32h	Reserved	
33h	Reserved	
34h	Reserved	
35h	DSP IRQ1 Flag	DSP Status flag (DSP_IRQ1) output 0 = DSP_IRQ1 not asserted 1 = DSP_IRQ1 asserted
36h	DSP IRQ2 Flag	DSP Status flag (DSP_IRQ2) output 0 = DSP_IRQ2 not asserted 1 = DSP_IRQ2 asserted
37h	Reserved	
38h	Reserved	
39h	Reserved	
3Ah	Reserved	
3Bh	Reserved	
3Ch	Reserved	
3Dh	OPCLK Async Clock Output	Configurable clock output derived from ASYNCCLK
3Eh	Reserved	
3Fh	Reserved	
40h	Reserved	
41h	Reserved	
42h	Reserved	
43h	Reserved	
44h	Reserved	
45h	DSP1 RAM Ready	DSP1 RAM Status 0 = Not ready 1 = Ready
46h	Reserved	
47h	Reserved	
48h	Reserved	



GPn_FN	DESCRIPTION	COMMENTS
49h	Reserved	
4Ah	Reserved	
4Bh	SYSCLK_ENA Status	SYSCLK_ENA Status
		0 = SYSCLK_ENA is enabled
		1 = SYSCLK_ENA is disabled
4Ch	ASYNC_CLK_ENA	ASYNC_CLK_ENA Status
	Status	0 = ASYNC_CLK_ENA is enabled
		1 = ASYNC_CLK_ENA is disabled

Table 86 GPIO Function Select (GPIO1, GPIO2, GPIO3, GPIO4)

GPn_FN	DESCRIPTION	COMMENTS
00h	Reserved	
01h	Button detect input / Logic	GPn_DIR = 0: GPIO pin logic level is set by GPn_LVL.
	level output	GPn_DIR = 1: Button detect or logic level input.
02h	IRQ1 Output	Interrupt (IRQ1) output
		0 = IRQ1 not asserted
		1 = IRQ1 asserted
03h	IRQ2 Output	Interrupt (IRQ2) output
		0 = IRQ2 not asserted
		1 = IRQ2 asserted
04h	OPCLK Clock Output	Configurable clock output derived from SYSCLK
05h	FLL1 Clock	Clock output from FLL1
06h	FLL2 Clock	Clock output from FLL2
07h	Reserved	
08h	PWM1 Output	Configurable Pulse Width Modulation output PWM1
09h	PWM2 Output	Configurable Pulse Width Modulation output PWM2
3Dh	OPCLK Async Clock	Configurable clock output derived from ASYNCCLK
	Output	

Table 87 GPIO Function Select (GPIO5)

DIGITAL AUDIO INTERFACE FUNCTION (AIFnTXLRCLK)

 $GPn_FN = 00h.$

The WM5102 provides three digital audio interfaces (AIF1, AIF2 and AIF3).

Under default conditions, the input (RX) and output (TX) paths of each interface use the respective AIFnRXLRCLK signal as the frame synchronisation clock. If desired, the output (TX) interface can be configured to use a separate frame clock, AIFnTXLRCLK, using the AIFnTX_LRCLK_SRC registers as described in "Digital Audio Interface Control".

The AIFnTXLRCLK function is selected on the respective GPIO pin by setting the GPIO registers as described in "GPIO Control".



BUTTON DETECT (GPIO INPUT)

GPn FN = 01h.

Button detect functionality can be selected on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control". The same functionality can be used to support a Jack Detect input function.

It is recommended to enable the GPIO input de-bounce feature when using GPIOs as button input or Jack Detect input.

The GPn_LVL fields may be read to determine the logic levels on a GPIO input, after the selectable de-bounce controls. Note that GPn_LVL is not affected by the GPn_POL bit.

The de-bounced GPIO signals are also inputs to the Interrupt control circuit. An interrupt event is triggered on the rising and falling edges of the GPIO input. The associated interrupt bits are latched once set; it can be polled at any time or used to control the IRQ signal. See "Interrupts" for more details of the Interrupt event handling.

LOGIC '1' AND LOGIC '0' OUTPUT (GPIO OUTPUT)

 $GPn_FN = 01h.$

The WM5102 can be programmed to drive a logic high or logic low level on any GPIO pin by selecting the "GPIO Output" function as described in "GPIO Control".

The output logic level is selected using the respective GP*n*_LVL bit. Note that the GP*n*_LVL registers are 'write only' when the respective GPIO pin is configured as an output.

The polarity of the GPIO output can be inverted using the GPn_POL registers. If $GPn_POL=1$, then the external output will be the opposite logic level to GPn_LVL .

INTERRUPT (IRQ) STATUS OUTPUT

 $GPn_FN = 02h, 03h.$

The WM5102 has an Interrupt Controller which can be used to indicate when any selected Interrupt events occur. An interrupt can be generated by any of the events described throughout the GPIO function definition above. Individual interrupts may be masked in order to configure the Interrupt as required. See "Interrupts" for further details.

The Interrupt Controller supports two separate Interrupt Request (IRQ) outputs. The IRQ1 or IRQ2 status may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control".

Note that the IRQ1 status is output on the IRQ pin at all times.



DSP STATUS FLAG (DSP IRQn) OUTPUT

 $GPn_FN = 35h, 36h, 45h.$

The WM5102 supports two DSP Status flags as outputs from the DSP block. These are configurable within the DSP to provide external indication of the required function(s). A status flag indicating the DSP1 RAM status is also supported. See "Digital Core" for more details of the DSP.

The DSP Status and DSP RAM Ready flags may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control". The DSP Status and DSP RAM Ready outputs are described in Table 88.

The DSP Status flags are inputs to the Interrupt Controller circuit. An interrupt event is triggered on the rising edge of the DSP Status (DSP_IRQn) flags or DSP RAM Ready flags. The associated interrupt bits are latched once set; they can be polled at any time or used to control the IRQ signal. See "Interrupts" for more details of the Interrupt event handling.

GPN_FN	DESCRIPTION	COMMENTS
35h	DSP Status (DSP_IRQ1)	External indication of DSP_IRQ1_STS
36h	DSP Status (DSP_IRQ2)	External indication of DSP_IRQ2_STS
45h	DSP1 RAM Ready	Indicates DSP1 RAM Ready status

Table 88 DSP Status and RAM Ready Indications

OPCLK AND OPCLK_ASYNC CLOCK OUTPUT

GPn FN = 04h, 3Dh.

A clock output (OPCLK) derived from SYSCLK can be output on any GPIO pin. The OPCLK frequency is controlled by OPCLK_DIV and OPCLK_SEL. The OPCLK output is enabled using the OPCLK_ENA register, as described in Table 89.

A clock output (OPCLK_ASYNC) derived from ASYNCCLK can be output on any GPIO pin. The OPCLK_ASYNC frequency is controlled by OPCLK_ASYNC_DIV and OPCLK_ASYNC_SEL. The OPCLK_ASYNC output is enabled using the OPCLK_ASYNC_ENA register

It is recommended to disable the clock output (OPCLK_ENA=0 or OPCLK_ASYNC_ENA=0) before making any change to the respective OPCLK_DIV, OPCLK_SEL, OPCLK_ASYNC_DIV or OPCLK ASYNC SEL registers.

The OPCLK or OPCLK_ASYNC Clock outputs can be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control".

Note that the OPCLK source frequency cannot be higher than the SYSCLK frequency. The OPCLK_ASYNC source frequency cannot be higher than the ASYNCCLK frequency. The maximum output frequency supported for GPIO output is noted in the "Electrical Characteristics".

See "Clocking and Sample Rates" for more details of the system clocks (SYSCLK and ASYNCCLK).

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R329	15	OPCLK_ENA	0	OPCLK Enable
(0149h)				0 = Disabled
Output				1 = Enabled
system clock	7:3	OPCLK_DIV [4:0]	00h	OPCLK Divider
CIOCK				00h = Divide by 1
				01h = Divide by 1
				02h = Divide by 2
				03h = Divide by 3
				1Fh = Divide by 31



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	2:0	OPCLK_SEL [2:0]	000	OPCLK Source Frequency
				000 = 6.144MHz (5.6448MHz)
				001 = 12.288MHz (11.2896MHz)
				010 = 24.576MHz (22.5792MHz)
				011 = 49.152MHz (45.1584MHz)
				All other codes are Reserved
				The frequencies in brackets apply for 44.1kHz-related SYSCLK rates only (ie. SAMPLE_RATE_n = 01XXX).
				The OPCLK Source Frequency must be less than or equal to the SYSCLK frequency.
R330	15	OPCLK_ASYNC_	0	OPCLK_ASYNC Enable
(014Ah)		ENA		0 = Disabled
Output				1 = Enabled
async clock	7:3	OPCLK_ASYNC_	00h	OPCLK_ASYNC Divider
		DIV [4:0]		00h = Divide by 1
				01h = Divide by 1
				02h = Divide by 2
				03h = Divide by 3
				1Fh = Divide by 31
	2:0	OPCLK_ASYNC_	000	OPCLK_ASYNC Source Frequency
		SEL [2:0]		000 = 6.144MHz (5.6448MHz)
				001 = 12.288MHz (11.2896MHz)
				010 = 24.576MHz (22.5792MHz)
				011 = 49.152MHz (45.1584MHz)
				All other codes are Reserved
				The frequencies in brackets apply for 44.1kHz-related ASYNCCLK rates only (ie. ASYNC_SAMPLE_RATE_n = 01XXX).
				The OPCLK_ASYNC Source Frequency must be less than or equal to the ASYNCCLK frequency.

Table 89 OPCLK and OPCLK_ASYNC Control

FREQUENCY LOCKED LOOP (FLL) STATUS OUTPUT

 $GPn_FN = 0Ch, 0Dh, 0Fh, 10h.$

The WM5102 supports FLL status flags, which may be used to control other events. See "Clocking and Sample Rates" for more details of the FLL.

The 'FLL Clock OK' signals indicate that the respective FLL has started up and is providing an output clock. The 'FLL Lock' signals indicate whether FLL Lock has been achieved.

The FLL Clock OK and FLL Lock signals may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control".

The FLL Clock OK and FLL Lock signals are inputs to the Interrupt Controller circuit. An interrupt event is triggered on the rising and falling edges of these signals. The associated interrupt bits are latched once set; they can be polled at any time or used to control the IRQ signal. See "Interrupts" for more details of the Interrupt event handling.



FREQUENCY LOCKED LOOP (FLL) CLOCK OUTPUT

 $GPn_FN = 05h, 06h.$

Clock outputs derived from the FLLs may be output on any GPIO pin. The GPIO output from each FLLn (where 'n' is 1 or 2) is controlled by the respective FLLn_GPCLK_DIV and FLLn_GPCLK_ENA registers, as described in Table 90.

It is recommended to disable the clock output (FLLn_GPCLK_ENA=0) before making any change to the respective FLLn_GPCLK_DIV register.

Note that the FLLn_GPCLK_DIV and FLLn_GPCLK_ENA registers affect the GPIO outputs only; they do not affect the FLL frequency. The maximum output frequency supported for GPIO output is noted in the "Electrical Characteristics".

The Frequency Locked Loop (FLL) Clock outputs may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control".

See "Clocking and Sample Rates" for more details of the WM5102 system clocking and for details of how to configure the FLLs.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R394	7:1	FLL1_GPCLK_DI	02h	FLL1 GPIO Clock Divider
(018Ah)		V [6:0]		00h = Divide by 1
FLL1 GPIO				01h = Divide by 1
Clock				02h = Divide by 2
				03h = Divide by 3
				7Fh = Divide by 127
				$(F_{GPIO} = F_{VCO} / FLL1_GPCLK_DIV)$
	0	FLL1_GPCLK_EN	0	FLL1 GPIO Clock Enable
		Α		0 = Disabled
				1 = Enabled
R426	7:1	FLL2_GPCLK_DI	02h	FLL2 GPIO Clock Divider
(01AAh)		V [6:0]		00h = Divide by 1
FLL2 GPIO				01h = Divide by 1
Clock				02h = Divide by 2
				03h = Divide by 3
				7Fh = Divide by 127
				$(F_{GPIO} = F_{VCO} / FLL2_GPCLK_DIV)$
	0	FLL2_GPCLK_EN	0	FLL2 GPIO Clock Enable
		Α		0 = Disabled
				1 = Enabled

Table 90 FLL Clock Output Control

PULSE WIDTH MODULATION (PWM) SIGNAL OUTPUT

 $GPn_FN = 08h, 09h.$

The WM5102 incorporates two Pulse Width Modulation (PWM) signal generators which can be enabled as GPIO outputs. The duty cycle of each PWM signal can be modulated by an audio source, or can be set to a fixed value using a control register setting.

The Pulse Width Modulation (PWM) outputs may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control".

See "Digital Core" for details of how to configure the PWM signal generators.



HEADPHONE DETECTION STATUS OUTPUT

GPn FN = 12h.

The WM5102 provides a headphone detection circuit on the HPDETL and HPDETR pins to measure the impedance of an external load connected to the headphone outputs. See "External Accessory Detection" for further details.

A logic signal from the headphone detection circuit may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control". This logic signal is set low when a Headphone Detect measurement is triggered, and is set high when the Headphone Detect function has completed. A rising edge indicates completion of a Headphone Detect measurement.

The headphone detection circuit is also an input to the Interrupt control circuit. An interrupt event is triggered whenever a headphone detection measurement has completed. Note that the HPDET_EINT flag is also asserted when the headphone detection is initiated. The associated interrupt bit is latched once set; it can be polled at any time or used to control the IRQ signal. See "Interrupts" for more details of the Interrupt event handling.

MICROPHONE / ACCESSORY DETECTION STATUS OUTPUT

 $GPn_FN = 13h.$

The WM5102 provides an impedance measurement circuit on the MICDETn pins to detect the connection of a microphone or other external accessory. See "External Accessory Detection" for further details.

A logic signal from the microphone detect circuit may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control". This logic signal is set high for a pulse duration of 31μ s whenever an accessory insertion, removal or impedance change is detected.

The microphone detection circuit is also an input to the Interrupt control circuit. An interrupt event is triggered whenever an accessory insertion, removal or impedance change is detected. The associated interrupt bit is latched once set; it can be polled at any time or used to control the IRQ signal. See "Interrupts" for more details of the Interrupt event handling.

ASYNCHRONOUS SAMPLE RATE CONVERTER (ASRC) LOCK STATUS OUTPUT

 $GPn_FN = 1Ah, 1Bh.$

The WM5102 maintains a flag indicating the lock status of the Asynchronous Sample Rate Converters (ASRCs), which may be used to control other events if required. See "Digital Core" for more details of the ASRCs.

The ASRC Lock signals may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control".

The ASRC Lock signals are inputs to the Interrupt control circuit. An interrupt event is triggered on the rising and falling edges of the ASRC Lock signals. The associated interrupt bits are latched once set; they can be polled at any time or used to control the IRQ signal. See "Interrupts" for more details of the Interrupt event handling.



ASYNCHRONOUS SAMPLE RATE CONVERTER (ASRC) CONFIGURATION ERROR STATUS OUTPUT

GPn FN = 1Ch.

The WM5102 performs automatic checks to confirm that the ASRCs are configured with valid settings. Invalid settings include conditions where one of the associated sample rates is higher than 48kHz. If an invalid ASRC configuration is detected, this can be indicated using the GPIO and/or Interrupt functions.

The ASRC Configuration Error signal may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control".

The ASRC Configuration Error signal is an input to the Interrupt Controller circuit. An interrupt event is triggered on the rising and falling edges of the ASRC Configuration Error signal. The associated interrupt bit is latched once set; it can be polled at any time or used to control the IRQ signal. See "Interrupts" for more details of the Interrupt event handling.

OVER-TEMPERATURE STATUS OUTPUT

 $GPn_FN = 2Bh, 2Ch.$

The WM5102 incorporates a temperature sensor which detects when the device temperature is within normal limits or if the device is approaching a hazardous temperature condition.

The temperature status may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control". Any GPIO pin can be used to indicate either a Warning Temperature event or the Shutdown Temperature event.

The Warning Temperature and Shutdown Temperature status are inputs to the Interrupt control circuit. An interrupt event may be triggered on the rising and falling edges of these signals. The associated interrupt bit is latched once set; it can be polled at any time or used to control the IRQ signal. See "Interrupts" for more details of the Interrupt event handling.

It is strongly recommended that the speaker drivers be disabled if the Shutdown Temperature condition occurs.

DYNAMIC RANGE CONTROL (DRC) STATUS OUTPUT

 $GPn_FN = 1Dh, 1Eh, 1Fh, 20h, 21h.$

The Dynamic Range Control (DRC) circuit provides status outputs, which may be used to control other events if required.

The DRC status flags may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control". The DRC status outputs are described in Table 91.

See "Digital Core" for more details of the DRC.

GPN_FN	DESCRIPTION	COMMENTS
1Dh	DRC1 Signal Detect	Indicates a signal is present on the respective DRC path. The threshold level is configurable (see Table 14).
1Eh	DRC1 Anti-Clip Active	Indicates the DRC anti-clip function has been triggered; the DRC gain is decreasing in response to a rising signal level.
1Fh	DRC1 Decay Active	Indicates that the DRC gain is increasing in response to a low-level signal input.
20h	DRC1 Noise Gate Active	Indicates that the DRC noise gate has been triggered; an idle signal condition has been detected.
21h	DRC1 Quick Release Active	Indicates that the DRC quick-release function has been triggered; the DRC gain is increasing rapidly following detection of a short transient peak.

Table 91 Dynamic Range Control (DRC) Status Indications



CONTROL WRITE SEQUENCER STATUS OUTPUT

 $GPn_FN = 15h.$

The WM5102 Control Write Sequencer (WSEQ) can be used to execute a sequence of register write operations in response to a simple trigger event. See "Control Write Sequencer" for details of the Control Write Sequencer.

The WSEQ_BUSY register bit (see Table 116) indicates the status of the Control Write Sequencer. When WSEQ_BUSY=1, this indicates that one or more Write Sequence operations are in progress or are queued for sequential execution.

A logic signal from the Write Sequencer function may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control". This logic signal is set high for a short pulse duration (approx. 100ns) whenever the Write Sequencer has completed all scheduled sequences, and there are no more pending operations.

The Write Sequencer status is an input to the Interrupt control circuit. An interrupt event is triggered on completion of a Control Sequence. The associated interrupt bit is latched once set; it can be polled at any time or used to control the IRQ signal. See "Interrupts" for more details of the Interrupt event handling.

CONTROL INTERFACE ERROR STATUS OUTPUT

 $GPn_FN = 16h.$

The WM5102 is controlled by writing to registers through a 2-wire (I2C) or 4-wire (SPI) serial control interface, as described in the "Control Interface" section. The SLIMbus interface also supports read/write access to the control registers, as described in the "SLIMbus Interface Control" section.

The WM5102 performs automatic checks to confirm if a register access is successful. Register access will be unsuccessful if an invalid register address is selected. Read/write access to the DSP firmware memory will be unsuccessful if the associated clocking is not enabled. If an invalid or unsuccessful register operation is attempted, this can be indicated using the GPIO and/or Interrupt functions.

The Control Interface Error signal may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control".

The Control Interface Error signal is an input to the Interrupt Controller circuit. An interrupt event is triggered on the rising edge of the Control Interface Error signal. The associated interrupt bit is latched once set; it can be polled at any time or used to control the IRQ signal. See "Interrupts" for more details of the Interrupt event handling.

SYSTEM CLOCKS ENABLE STATUS OUTPUT

 $GPn_FN = 4Bh, 4Ch.$

The WM5102 requires a system clock (SYSCLK) for its internal functions and to support the input/output signal paths. The WM5102 can support two independent clock domains, with selected functions referenced to the ASYNCCLK clock domain. See "Clocking and Sample Rates" for details of these clocks.

The SYSCLK_ENA and ASYNC_CLK_ENA registers (see Table 100) control the SYSCLK and ASYNCCLK signals respectively. When '0' is written to these registers, the host processor must wait until the WM5102 has shut down the associated functions before issuing any other register write commands.

The SYSCLK Enable and ASYNCCLK Enable status may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control".

The SYSCLK Enable and ASYNCCLK Enable signals are inputs to the Interrupt Controller circuit. An interrupt event is triggered when the respective clock functions have been shut down. The associated interrupt bit is latched once set; it can be polled at any time or used to control the IRQ signal. See "Interrupts" for more details of the Interrupt event handling.



CLOCKING ERROR STATUS OUTPUT

 $GPn_FN = 0Ah, 0Bh, 27h, 2Dh, 2Eh.$

The WM5102 performs automatic checks to confirm that the system clocks are correctly configured according to the commanded functionality. An invalid configuration is one where there are insufficient clock cycles to support the digital processing required by the commanded signal paths.

An Underclocked Error condition is where there are insufficient clock cycles for the requested functionality, and increasing the SYSCLK or ASYNCCLK frequency (as applicable) should allow the selected configuration to be supported.

An Overclocked Error condition is where the requested functionality cannot be supported, as the clocking requirements of the requested configuration exceed the device limits.

The system clocks (SYSCLK and, where applicable, ASYNCCLK) must be enabled before any signal path is enabled. If an attempt is made to enable a signal path, and there are insufficient clock cycles to support that path, then the attempt will be unsuccessful. Note that any signal paths that are already active will not be affected under these circumstances.

The Clocking Error signals may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control". The Clocking Error conditions are described in Table 92.

The Clocking Error signals are inputs to the Interrupt Controller circuit. An interrupt event is triggered on the rising and falling edges of the Clocking Error signals. The associated interrupt bits are latched once set; they can be polled at any time or used to control the IRQ signal. See "Interrupts" for more details of the Interrupt event handling.

GPN_FN	DESCRIPTION	COMMENTS		
0Ah	SYSCLK Underclocked	Indicates insufficient SYSCLK cycles for the commanded functionality.		
0Bh	ASYNCCLK Underclocked	Indicates insufficient ASYNCCLK cycles for the commanded functionality.		
27h	Mixer Dropped Sample Error	Indicates a dropped sample in the digital core mixer function.		
2Dh	Underclocked Error	Indicates insufficient SYSCLK or ASYNCCLK cycles for one or more of the selected signal paths or signal processing functions. Increasing the SYSCLK or ASYNCCLK frequency (as applicable) should allow the selected configuration to be supported. Status bits associated with specific sub-systems provide further de-bug capability.		
		The INnx_ENA_STS bits in register R769 indicate the status of each of the input (analogue or digital microphone) signal paths.		
		The OUTnx_ENA_STS bits in registers R1025 and R1030 indicate the status of each of the output (Headphone, Speaker or PDM) signal paths.		
		The ASRCnx_ENA_STS bits in register R3809 indicate the status of each of the ASRC signal paths.		
		The FX_STS field in register R3585 indicates the status of each of the Effects (EQ, DRC or LHPF) signal paths.		
		The *MIX_STSn fields in registers R1600 to R2920 indicate the status of each of the Digital Core mixer signal paths.		
		The ISRCn and AIFn functions are also inputs to the Underclocked Error status indication, but there are no specific _STS register bits associated with these.		
2Eh	Overclocked Error	Indicates that an unsupported device configuration has been attempted, as the clocking requirements of the requested configuration exceed the device limits.		

Table 92 Clocking Error Status Indications



DIGITAL AUDIO INTERFACE CONFIGURATION ERROR STATUS OUTPUT

GPn_FN = 28h, 29h, 2Ah.

The WM5102 performs automatic checks to confirm that AIF1, AIF2 and AIF3 are configured with valid settings. Invalid settings include conditions where one or more audio channel timeslots are in conflict.

If an invalid AIF1, AIF2 or AIF3 configuration is detected, this can be indicated using the GPIO and/or Interrupt functions.

The AIF Configuration Error signals may be output directly on any GPIO pin by setting the respective GPIO registers as described in "GPIO Control".

The AIF Configuration Error signals are an input to the Interrupt Controller circuit. An interrupt event is triggered on the rising and falling edges of the AIF Configuration Error signal. The associated interrupt bit is latched once set; it can be polled at any time or used to control the IRQ signal. See "Interrupts" for more details of the Interrupt event handling.



WM5102 Production Data

INTERRUPTS

The Interrupt Controller has multiple inputs. These include the Jack Detect and GPIO input pins, DSP_IRQn flags, headphone / accessory detection, FLL / ASRC Lock detection, and Clocking configuration error indications. Any combination of these inputs can be used to trigger an Interrupt Request (IRQ) event.

The Interrupt Controller supports two sets of interrupt registers. This allows two separate Interrupt Request (IRQ) outputs to be generated, and for each IRQ to report a different set of input or status conditions.

For each Interrupt Request (IRQ1 and IRQ2) output, there is an Interrupt register field associated with each of the interrupt inputs. These fields are asserted whenever a logic edge is detected on the respective input. Some inputs are triggered on rising edges only; some are triggered on both edges. Separate rising and falling interrupt registers are provided for the JD1 and GP5 signals. The Interrupt register fields for IRQ1 are described in Table 94. The Interrupt register fields for IRQ2 are described in Table 95. The Interrupt flags can be polled at any time, or else in response to the Interrupt Request (IRQ) output being signalled via the IRQ pin or a GPIO pin.

All of the Interrupts are edge-triggered, as noted above. Many of these are triggered on both the rising and falling edges and, therefore, the Interrupt registers cannot indicate which edge has been detected. The "Raw Status" fields described in Table 96 provide readback of the current value of the corresponding inputs to the Interrupt Controller. Note that the status of any GPIO inputs can be read using the GPn_LVL registers, as described in Table 85.

The UNDERCLOCKED_STS and OVERCLOCKED_STS registers represent the logical 'OR' of status flags from multiple sub-systems. The status bits in registers R3364 to R3366 (see Table 96) provide readback of these lower-level signals. See "Clocking and Sample Rates" for a description of the Underclocked and Overclocked Error conditions.

Individual mask bits can enable or disable different functions from the Interrupt controller. The mask bits are described in Table 94 (for IRQ1) and Table 95 (for IRQ2). Note that a masked interrupt input will not assert the corresponding interrupt register field, and will not cause the associated Interrupt Request (IRQ) output to be asserted.

The Interrupt Request (IRQ) outputs represent the logical 'OR' of the associated interrupt registers. (IRQ1 is derived from the _EINT1 registers; IRQ2 is derived from the _EINT2 registers). The Interrupt register fields are latching fields and, once they are set, they are not reset until a '1' is written to the respective register bit(s). The Interrupt Request (IRQ) outputs are not reset until each of the associated interrupts has been reset.

A de-bounce circuit can be enabled on any GPIO input, to avoid false event triggers. This is enabled on each pin using the register bits described in Table 85.

The IRQ outputs can be globally masked using the IM_IRQ1 and IM_IRQ2 register bits. When not masked, the IRQ status can be read from IRQ1_STS and IRQ2_STS for the respective IRQ outputs.

The IRQ1 output is provided externally on the IRQ pin. Under default conditions, this output is 'Active Low'. The polarity can be inverted using the IRQ_POL register. The IRQ output can be either CMOS driven or Open Drain; this is selected using the IRQ_OP_CFG register.

The IRQ1 and IRQ2 signals may be output on a GPIO pin - see "General Purpose Input / Output".

The WM5102 Interrupt Controller circuit is illustrated in Figure 67. (Note that not all interrupt inputs are shown.) The associated control fields are described in Table 93 to Table 96.

Note that, under default register conditions, the 'Boot Done' status is the only un-masked interrupt source; a falling edge on the IRQ pin will indicate completion of the Boot Sequence.



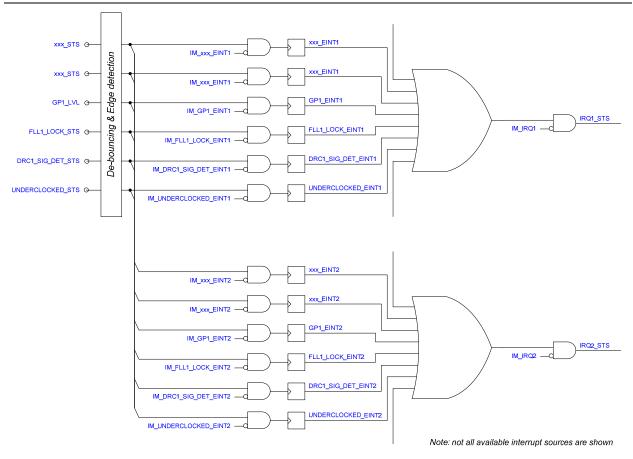


Figure 67 Interrupt Controller

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3087 (0C0Fh)	10	IRQ_POL	1	IRQ Output Polarity Select 0 = Non-inverted (Active High)
IRQ CTRL				1 = Inverted (Active Low)
1	9	IRQ_OP_CFG	0	IRQ Output Configuration 0 = CMOS
				1 = Open Drain

Table 93 IRQ Output Control Registers

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3328	3	GP4_EINT1	0	GPIO4 Interrupt
(0D00h)				(Rising and falling edge triggered)
Interrupt				Note: Cleared when a '1' is written.
Status 1	2	GP3_EINT1	0	GPIO3 Interrupt
				(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	1	GP2_EINT1	0	GPIO2 Interrupt
				(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	0	GP1_EINT1	0	GPIO1 Interrupt
				(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
R3329	8	DSP1_RAM_RDY	0	DSP1 RAM Ready Interrupt
(0D01h)		_EINT1		(Rising edge triggered)
Interrupt				Note: Cleared when a '1' is written.
Status 2	1	DSP_IRQ2_EINT	0	DSP IRQ2 Interrupt
		1		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	0	DSP_IRQ1_EINT	0	DSP IRQ1 Interrupt
		1		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
R3330	15	SPK_SHUTDOW	0	Speaker Shutdown Warning Interrupt
(0D02h)		N_WARN_EINT1		(Rising and falling edge triggered)
Interrupt				Note: Cleared when a '1' is written.
Status 3	14	SPK_SHUTDOW	0	Speaker Shutdown Interrupt
		N_EINT1		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	13	HPDET_EINT1	0	Headphone Detect Interrupt
				(Rising edge triggered)
				Note: Cleared when a '1' is written.
	12	MICDET_EINT1	0	Microphone / Accessory Detect Interrupt
				(Detection event triggered)
				Note: Cleared when a '1' is written.
	11	WSEQ_DONE_EI	0	Write Sequencer Done Interrupt
		NT1		(Rising edge triggered)
				Note: Cleared when a '1' is written.
	9	DRC1_SIG_DET	0	DRC1 Signal Detect Interrupt
		_EINT1		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	8	ASRC2_LOCK_E	0	ASRC2 Lock Interrupt
		INT1		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	7	ASRC1_LOCK_E	0	ASRC1 Lock Interrupt
		INT1		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	6	UNDERCLOCKE	0	Underclocked Error Interrupt
		D_EINT1		(Rising edge triggered)
				Note: Cleared when a '1' is written.
	5	OVERCLOCKED	0	Overclocked Error Interrupt
		_EINT1		(Rising edge triggered)
				Note: Cleared when a '1' is written.



REGISTER	BIT	LABEL	DEFAULT	DESCRIPTION
ADDRESS				
	3	FLL2_LOCK_EIN	0	FLL2 Lock Interrupt
		T1		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	2	FLL1_LOCK_EIN	0	FLL1 Lock Interrupt
		T1		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	1	CLKGEN_ERR_E	0	SYSCLK Underclocked Error Interrupt
		INT1		(Rising edge triggered)
				Note: Cleared when a '1' is written.
	0	CLKGEN_ERR_A SYNC_EINT1	0	ASYNCCLK Underclocked Error Interrupt
		STINC_EINTT		(Rising edge triggered)
				Note: Cleared when a '1' is written.
R3331 (0D03h)	15	ASRC_CFG_ER R EINT1	0	ASRC Configuration Error Interrupt
Interrupt		K_EINTT		(Rising edge triggered)
Status 4	- 4 4	ALEO EDD EINT		Note: Cleared when a '1' is written.
	14	AIF3_ERR_EINT 1	0	AIF3 Configuration Error Interrupt
		1		(Rising edge triggered)
	40	ALEO EDD EINT	0	Note: Cleared when a '1' is written.
	13	AIF2_ERR_EINT 1	0	AIF2 Configuration Error Interrupt
		'		(Rising edge triggered)
	40	AIE4 EDD EINT	0	Note: Cleared when a '1' is written.
	12	AIF1_ERR_EINT 1	0	AIF1 Configuration Error Interrupt
		'		(Rising edge triggered)
	44	CTDLIE EDD EL	0	Note: Cleared when a '1' is written.
	11	CTRLIF_ERR_EI NT1	0	Control Interface Error Interrupt
		1311		(Rising edge triggered) Note: Cleared when a '1' is written.
	10	MIXER DROPPE	0	Mixer Dropped Sample Interrupt
	10	D_SAMPLE_EIN	U	(Rising edge triggered)
		T1		Note: Cleared when a '1' is written.
	9	ASYNC_CLK_EN	0	ASYNC_CLK_ENA Interrupt
	3	A_LOW_EINT1	U	(Triggered on ASYNCCLK shut-down)
				Note: Cleared when a '1' is written.
	8	SYSCLK_ENA_L	0	SYSCLK_ENA Interrupt
		OW_EINT1		(Triggered on SYSCLK shut-down)
		_		Note: Cleared when a '1' is written.
	7	ISRC1_CFG_ER	0	ISRC1 Configuration Error Interrupt
	·	R_EINT1		(Rising edge triggered)
				Note: Cleared when a '1' is written.
	6	ISRC2_CFG_ER	0	ISRC2 Configuration Error Interrupt
		R_EINT1		(Rising edge triggered)
				Note: Cleared when a '1' is written.
R3332	8	BOOT_DONE_EI	0	Boot Done Interrupt
(0D04h)		NT1		(Rising edge triggered)
Interrupt				Note: Cleared when a '1' is written.
Status 5	7	DCS_DAC_DON	0	DC Servo DAC Interrupt
		E_EINT1		(Rising edge triggered)
				Note: Cleared when a '1' is written.
	6	DCS_HP_DONE_	0	DC Servo HPOUT Interrupt
		EINT1		(Rising edge triggered)
				Note: Cleared when a '1' is written.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	1	FLL2_CLOCK_O K_EINT1	0	FLL2 Clock OK Interrupt
		K_EINTT		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	0	FLL1_CLOCK_O	0	FLL1 Clock OK Interrupt
		K_EINT1		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
R3336 (0D08h) to		IM_*	(see note)	For each *_EINT1 interrupt register in R3328 to R3332, a corresponding mask bit (IM_*) is provided in R3336 to R3340.
R3340				The mask bits are coded as:
(0D0Ch)				0 = Do not mask interrupt
				1 = Mask interrupt
		Note : The BOOT_I other interrupts are		l interrupt is '0' (un-masked) by default; all by default.
R3343	0	IM_IRQ1	0	IRQ1 Output Interrupt mask.
(0D0Fh)				0 = Do not mask interrupt.
Interrupt Control				1 = Mask interrupt.
R3409	7	MICD_CLAMP_F	0	MICDET Clamp Interrupt
(0D51h)		ALL_EINT1		(Falling edge triggered)
AOD IRQ1				Note: Cleared when a '1' is written.
	6	MICD_CLAMP_R	0	MICDET Clamp Interrupt
		ISE_EINT1		(Rising edge triggered)
				Note: Cleared when a '1' is written.
	5	GP5_FALL_EINT	0	GP5 Interrupt
		1		(Falling edge triggered)
				Note: Cleared when a '1' is written.
	4	GP5_RISE_EINT	0	GP5 Interrupt
		1		(Rising edge triggered)
				Note: Cleared when a '1' is written.
	3	JD1_FALL_EINT	0	JD1 Interrupt
		1		(Falling edge triggered)
				Note: Cleared when a '1' is written.
	2	JD1_RISE_EINT1	0	JD1 Interrupt
	_			(Rising edge triggered)
				Note: Cleared when a '1' is written.
R3411 (0D53h) AOD IRQ		IM_*	1	For each *_EINT1 interrupt register in R3409, a corresponding mask bit (IM_*) is provided in R3411.
Mask IRQ1				The mask bits are coded as:
				0 = Do not mask interrupt
				1 = Mask interrupt

Table 94 Interrupt 1 Control Registers

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3344	3	GP4_EINT2	0	GPIO4 Interrupt
(0D10h)				(Rising and falling edge triggered)
IRQ2				Note: Cleared when a '1' is written.
Status 1	2	GP3_EINT2	0	GPIO3 Interrupt
				(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
ADDRESS	1	GP2_EINT2	0	GPIO2 Interrupt
	'	GFZ_LIN1Z	U	(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	0	GP1_EINT2	0	GPIO1 Interrupt
		OI I_LIIVIZ	0	(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
R3345	8	DSP1_RAM_RDY	0	DSP1 RAM Ready Interrupt
(0D11h)		_EINT2		(Rising edge triggered)
IRQ2		_		Note: Cleared when a '1' is written.
Status 2	1	DSP_IRQ2_EINT	0	DSP IRQ2 Interrupt
		2	Ŭ	(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	0	DSP_IRQ1_EINT	0	DSP IRQ1 Interrupt
		2	Ů	(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
R3346	15	SPK SHUTDOW	0	Speaker Shutdown Warning Interrupt
(0D12h)		N_WARN_EINT2		(Rising and falling edge triggered)
IRQ2				Note: Cleared when a '1' is written.
Status 3	14	SPK SHUTDOW	0	Speaker Shutdown Interrupt
		N_EINT2		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	13	HPDET_EINT2	0	Headphone Detect Interrupt
		_		(Rising edge triggered)
				Note: Cleared when a '1' is written.
	12	MICDET_EINT2	0	Microphone / Accessory Detect Interrupt
		_		(Detection event triggered)
				Note: Cleared when a '1' is written.
	11	WSEQ_DONE_EI	0	Write Sequencer Done Interrupt
		NT2		(Rising edge triggered)
				Note: Cleared when a '1' is written.
	9	DRC1_SIG_DET	0	DRC1 Signal Detect Interrupt
		_EINT2		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	8	ASRC2_LOCK_E	0	ASRC2 Lock Interrupt
		INT2		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	7	ASRC1_LOCK_E	0	ASRC1 Lock Interrupt
		INT2		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	6	UNDERCLOCKE	0	Underclocked Error Interrupt
		D_EINT2		(Rising edge triggered)
				Note: Cleared when a '1' is written.
	5	OVERCLOCKED	0	Overclocked Error Interrupt
		_EINT2		(Rising edge triggered)
				Note: Cleared when a '1' is written.
	3	FLL2_LOCK_EIN	0	FLL2 Lock Interrupt
		T2		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.
	2	FLL1_LOCK_EIN	0	FLL1 Lock Interrupt
		T2		(Rising and falling edge triggered)
				Note: Cleared when a '1' is written.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	1	CLKGEN_ERR_E INT2	0	SYSCLK Underclocked Error Interrupt (Rising edge triggered) Note: Cleared when a '1' is written.
	0	CLKGEN_ERR_A SYNC_EINT2	0	ASYNCCLK Underclocked Error Interrupt (Rising edge triggered) Note: Cleared when a '1' is written.
R3347 (0D13h) IRQ2	15	ASRC_CFG_ER R_EINT2	0	ASRC Configuration Error Interrupt (Rising edge triggered) Note: Cleared when a '1' is written.
Status 4	14	AIF3_ERR_EINT 2	0	AIF3 Configuration Error Interrupt (Rising edge triggered) Note: Cleared when a '1' is written.
	13	AIF2_ERR_EINT 2	0	AIF2 Configuration Error Interrupt (Rising edge triggered) Note: Cleared when a '1' is written.
	12	AIF1_ERR_EINT 2	0	AIF1 Configuration Error Interrupt (Rising edge triggered) Note: Cleared when a '1' is written.
	11	CTRLIF_ERR_EI NT2	0	Control Interface Error Interrupt (Rising edge triggered) Note: Cleared when a '1' is written.
	10	MIXER_DROPPE D_SAMPLE_EIN T2		Mixer Dropped Sample Interrupt (Rising edge triggered) Note: Cleared when a '1' is written.
	9	ASYNC_CLK_EN A_LOW_EINT2	0	ASYNC_CLK_ENA Interrupt (Triggered on ASYNCCLK shut-down) Note: Cleared when a '1' is written.
	8	SYSCLK_ENA_L OW_EINT2	0	SYSCLK_ENA Interrupt (Triggered on SYSCLK shut-down) Note: Cleared when a '1' is written.
	7	ISRC1_CFG_ER R_EINT2	0	ISRC1 Configuration Error Interrupt (Rising edge triggered) Note: Cleared when a '1' is written.
	6	ISRC2_CFG_ER R_EINT2	0	ISRC2 Configuration Error Interrupt (Rising edge triggered) Note: Cleared when a '1' is written.
R3348 (0D14h) IRQ2	8	BOOT_DONE_EI NT2	0	Boot Done Interrupt (Rising edge triggered) Note: Cleared when a '1' is written.
Status 5	7	DCS_DAC_DON E_EINT2	0	DC Servo DAC Interrupt (Rising edge triggered) Note: Cleared when a '1' is written.
	6	DCS_HP_DONE_ EINT2	0	DC Servo HPOUT Interrupt (Rising edge triggered) Note: Cleared when a '1' is written.
	1	FLL2_CLOCK_O K_EINT2	0	FLL2 Clock OK Interrupt (Rising and falling edge triggered) Note: Cleared when a '1' is written.
	0	FLL1_CLOCK_O K_EINT2	0	FLL1 Clock OK Interrupt (Rising and falling edge triggered) Note: Cleared when a '1' is written.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3352 (0D18h) to		IM_*	(see note)	For each *_EINT2 interrupt register in R3344 to R3348, a corresponding mask bit (IM_*) is provided in R3352 to R3356.
R3356				The mask bits are coded as:
(0D1Ch)				0 = Do not mask interrupt
				1 = Mask interrupt
		Note : The BOOT_E other interrupts are		2 interrupt is '0' (un-masked) by default; all by default.
R3359	0	IM_IRQ2	0	IRQ2 Output Interrupt mask.
(0D1Fh)				0 = Do not mask interrupt.
IRQ2 Control				1 = Mask interrupt.
R3410	7	MICD_CLAMP_F	0	MICDET Clamp Interrupt
(0D52h)		ALL_EINT2		(Falling edge triggered)
AOD IRQ2				Note: Cleared when a '1' is written.
	6	MICD_CLAMP_R	0	MICDET Clamp Interrupt
		ISE_EINT2		(Rising edge triggered)
				Note: Cleared when a '1' is written.
	5	GP5_FALL_EINT	0	GP5 Interrupt
		2		(Falling edge triggered)
				Note: Cleared when a '1' is written.
	4	GP5_RISE_EINT	0	GP5 Interrupt
		2		(Rising edge triggered)
				Note: Cleared when a '1' is written.
	3	JD1_FALL_EINT	0	JD1 Interrupt
		2		(Falling edge triggered)
				Note: Cleared when a '1' is written.
	2	JD1_RISE_EINT2	0	JD1 Interrupt
				(Rising edge triggered)
				Note: Cleared when a '1' is written.
R3412 (0D54h) AOD IRQ		IM_*	1	For each *_EINT2 interrupt register in R3410, a corresponding mask bit (IM_*) is provided in R3412.
Mask IRQ2				The mask bits are coded as:
				0 = Do not mask interrupt
				1 = Mask interrupt

Table 95 Interrupt 2 Control Registers

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R3360	8	DSP1_RAM_RDY	0	DSP1 RAM Status
(0D20h)		_STS		0 = Not ready
Interrupt				1 = Ready
Raw Status 2	1	DSP_IRQ2_STS	0	DSP IRQ2 Status
2				0 = Not asserted
				1 = Asserted
	0	DSP_IRQ1_STS	0	DSP IRQ1 Status
				0 = Not asserted
				1 = Asserted
R3361	15	SPK_SHUTDOW	0	Speaker Shutdown Warning Status
(0D21h)		N_WARN_STS		0 = Normal
Interrupt				1 = Warning temperature exceeded



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
Raw Status	14	SPK_SHUTDOW	0	Speaker Shutdown Status
2		N_STS		0 = Normal
				1 = Shutdown temperature exceeded
	11	WSEQ_DONE_S	0	Write Sequencer Status
		TS		0 = Busy (sequence in progress)
				1 = Idle (sequence completed)
	9	DRC1_SIG_DET	0	DRC1 Signal Detect Status
		_STS		0 = Normal
				1 = Signal detected
	8	ASRC2_LOCK_S	0	ASRC2 Lock Status
		TS		0 = Not locked
				1 = Locked
	7	ASRC1_LOCK_S	0	ASRC1 Lock Status
		TS		0 = Not locked
				1 = Locked
	6	UNDERCLOCKE	0	Underclocked Error Status
		D_STS		0 = Normal
				1 = Underclocked Error
	5	OVERCLOCKED	0	Overclocked Error Status
		_STS		0 = Normal
				1 = Overclocked Error
	3	FLL2_LOCK_STS	0	FLL2 Lock Status
				0 = Not locked
				1 = Locked
	2	FLL1_LOCK_STS	0	FLL1 Lock Status
				0 = Not locked
				1 = Locked
	1	CLKGEN_ERR_S	0	SYSCLK Underclocked Error Status
		TS		0 = Normal
				1 = Underclocked Error
	0	CLKGEN_ERR_A	0	ASYNCCLK Underclocked Error Status
		SYNC_STS		0 = Normal
				1 = Underclocked Error
R3362	15	ASRC_CFG_ER	0	ASRC Configuration Error Interrupt
(0D22h)		R_STS		0 = Normal
Interrupt Raw Status				1 = Configuration Error
4	14	AIF3_ERR_STS	0	AIF3 Configuration Error Status
				0 = Normal
				1 = Configuration Error
	13	AIF2_ERR_STS	0	AIF2 Configuration Error Status
				0 = Normal
				1 = Configuration Error
	12	AIF1_ERR_STS	0	AIF1 Configuration Error Status
				0 = Normal
				1 = Configuration Error
	11	CTRLIF_ERR_ST	0	Control Interface Error Status
		S		0 = Normal
				1 = Control Interface Error
	10	MIXER_DROPPE		Mixer Dropped Sample Status
		D_SAMPLE_STS		0 = Normal
				1 = Dropped Sample Error



REGISTER ADDRESS	ВІТ	LABEL	DEFAULT	DESCRIPTION
	9	ASYNC_CLK_EN A_LOW_STS	0	ASYNC_CLK_ENA Status 0 = ASYNC_CLK_ENA is enabled 1 = ASYNC_CLK_ENA is disabled When a '0' is written to ASYNCCLK_ENA, then no other control register writes should be attempted until ASYNC_CLK_ENA_LOW_STS=1.
	8	SYSCLK_ENA_L OW_STS	0	SYSCLK_ENA Status 0 = SYSCLK_ENA is enabled 1 = SYSCLK_ENA is disabled When a '0' is written to SYSCLK_ENA, then no other control register writes should be attempted until SYSCLK_ENA_LOW_STS=1.
	7	ISRC1_CFG_ER R_STS	0	ISRC1 Configuration Error Interrupt 0 = Normal 1 = Configuration Error
	6	ISRC2_CFG_ER R_STS	0	ISRC2 Configuration Error Interrupt 0 = Normal 1 = Configuration Error
R3363 (0D23h) Interrupt Raw Status 5	8	BOOT_DONE_S TS	0	Boot Status 0 = Busy (boot sequence in progress) 1 = Idle (boot sequence completed) Control register writes should not be attempted until Boot Sequence has completed.
	7	DCS_DAC_DON E_STS	0	DC Servo DAC Status 0 = Busy (DC Servo in progress) 1 = Idle (DC Servo completed)
	6	DSC_HP_DONE_ STS	0	DC Servo HPOUT Status 0 = Busy (DC Servo in progress) 1 = Idle (DC Servo completed)
	1	FLL2_CLOCK_O K_STS	0	FLL2 Clock OK Interrupt 0 = FLL2 Clock is not OK 1 = FLL2 Clock is OK
	0	FLL1_CLOCK_O K_STS	0	FLL1 Clock OK Interrupt 0 = FLL1 Clock is not OK 1 = FLL1 Clock is OK
R3364 (0D24h)	13	PWM_OVERCLO CKED_STS	0	Indicates an Overclocked Error condition for each respective sub-system.
Interrupt Raw Status	12	FX_CORE_OVE RCLOCKED_STS	0	The bits are coded as: 0 = Normal
6	10	DAC_SYS_OVER CLOCKED_STS	0	1 = Overclocked The OVERCLOCKED STS bit will be
	9	DAC_WARP_OV ERCLOCKED_ST S	0	asserted whenever any of these register bits is asserted.
	8	ADC_OVERCLO CKED_STS	0	
	7	MIXER_OVERCL OCKED_STS	0	
	6	AIF3_ASYNC_O VERCLOCKED_ STS	0	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	5	AIF2_ASYNC_O VERCLOCKED_ STS	0	
	4	AIF1_ASYNC_O VERCLOCKED_ STS	0	
	3	AIF3_SYNC_OV ERCLOCKED_ST S	0	
	2	AIF2_SYNC_OV ERCLOCKED_ST S	0	
	1	AIF1_SYNC_OV ERCLOCKED_ST S	0	
	0	PAD_CTRL_OVE RCLOCKED_STS	0	
R3365 (0D25h) Interrupt	15	SLIMBUS_SUBS YS_OVERCLOC KED_STS	0	Indicates an Overclocked Error condition for each respective sub-system. The bits are coded as:
Raw Status 7	14	SLIMBUS_ASYN C_OVERCLOCK ED_STS	0	0 = Normal 1 = Overclocked The OVERCLOCKED, STS bit will be
	13	SLIMBUS_SYNC _OVERCLOCKE D_STS	0	The OVERCLOCKED_STS bit will be asserted whenever any of these register bits is asserted.
	12	ASRC_ASYNC_S YS_OVERCLOC KED_STS	0	
	11	ASRC_ASYNC_ WARP_OVERCL OCKED_STS	0	
	10	ASRC_SYNC_SY S_OVERCLOCK ED_STS	0	
	9	ASRC_SYNC_W ARP_OVERCLO CKED_STS	0	
	3	DSP1_OVERCLO CKED_STS	0	
	1	ISRC2_OVERCL OCKED_STS	0	
	0	ISRC1_OVERCL OCKED_STS	0	
R3366 (0D26h)	10	AIF3_UNDERCL OCKED_STS	0	Indicates an Underclocked Error condition for each respective sub-
Interrupt Raw Status	9	AIF2_UNDERCL OCKED_STS	0	system. The bits are coded as:
8	8	AIF1_UNDERCL OCKED_STS	0	0 = Normal 1 = Overclocked
	6	ISRC2_UNDERC LOCKED_STS	0	The UNDERCLOCKED_STS bit will be asserted whenever any of these register
	5	ISRC1_UNDERC LOCKED_STS	0	bits is asserted.
	4	FX_UNDERCLO CKED_STS	0	
	3	ASRC_UNDERC LOCKED_STS	0	



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	2	DAC_UNDERCL OCKED_STS	0	
	1	ADC_UNDERCL OCKED_STS	0	
	0	MIXER_UNDERC LOCKED_STS	0	
R3392	1	IRQ2_STS	0	IRQ2 Status
(0D40h) Interrupt				IRQ2_STS is the logical 'OR' of all unmasked _EINT2 interrupts.
Pin Status				0 = Not asserted
				1 = Asserted
	0	IRQ1_STS	0	IRQ1 Status
				IRQ1_STS is the logical 'OR' of all unmasked _EINT1 interrupts.
				0 = Not asserted
				1 = Asserted
R3413	3	MICD_CLAMP_S	0	MICDET Clamp status
(0D55h)		TS		0 = Clamp not active
AOD IRQ				1 = Clamp active
Raw Status				Note that the MICDET Clamp is provided on the MICDET1 or MICDET2 pins, depending on the ACCDET_SRC register bit.
	2	GP5_STS	0	GP5 Status
				0 = Not asserted
				1 = Asserted
	0	JD1_STS	0	JACKDET input status
				0 = Jack not detected
				1 = Jack is detected
				(Assumes the JACKDET pin is pulled 'low' on Jack insertion.)

Table 96 Interrupt Status

WM5102 Production Data

CLOCKING AND SAMPLE RATES

The WM5102 requires a clock reference for its internal functions and also for the input (ADC) paths, output (DAC) paths and digital audio interfaces. Under typical clocking configurations, all commonly-used audio sample rates can be derived directly from the external reference; for additional flexibility, the WM5102 incorporates two Frequency Locked Loop (FLL) circuits to perform frequency conversion and filtering.

External clock signals may be connected via MCLK1 and MCLK2. (These inputs are referenced to the DBVDD1 power domain.) In AIF Slave modes, the BCLK signals may be used as a reference for the system clocks. The SLIMbus interface can provide the clock reference, when used as the input to one of the FLLs. To avoid audible glitches, all clock configurations must be set up before enabling playback.

SYSTEM CLOCKING

The WM5102 supports two independent clock domains, referenced to the SYSCLK and ASYNCCLK system clocks respectively.

Up to five different sample rates may be independently selected for specific audio interfaces and other input/output signal paths. Each selected sample rate must be synchronised either to SYSCLK or to ASYNCCLK, as described later.

The two system clocks are independent (ie. not synchronised). Stereo full-duplex sample rate conversion is supported, allowing asynchronous audio data to be mixed and to be routed between independent interfaces. See "Digital Core" for further details.

Each subsystem within the WM5102 digital core is clocked at a dynamically-controlled rate, limited by the SYSCLK (or ASYNCCLK) frequency, as applicable. For maximum signal mixing and processing capacity, it is recommended that the highest possible SYSCLK and ASYNCCLK frequencies are configured.

If the SUBSYS_MAX_FREQ bit is set to '0', then the digital core clocking rate is restricted to a maximum of 24.576MHz (or 22.5792MHz), even if a higher system clock frequency is configured.

The maximum digital core clocking rates of 49.152MHz (or 45.1584MHz) are only supported when SUBSYS_MAX_FREQ is set to '1', and the DCVDD voltage is 1.8V (nominal).

See "Recommended Operating Conditions" for details of the DCVDD operating conditions. Note that, if DCVDD is less than the minimum level for >24.576MHz clocking, then SUBSYS_MAX_FREQ must be set to '0'.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R353 (0161h)	0	SUBSYS_MAX_F REQ	0	Digital Core Clocking Limit
Dynamic Frequency Scaling 1		KEQ		Sets the maximum digital core clocking rate. The higher rate should only be selected when the DCVDD voltage is 1.8V (nominal).
				0 = 24.576MHz (22.5792MHz)
				1 = 49.152MHz (45.1584MHz)

Table 97 System Clocking

SAMPLE RATE CONTROL

The WM5102 supports two independent clock domains, referenced to SYSCLK and ASYNCCLK respectively.

Different sample rates may be selected for each of the audio interfaces (AIF1, AIF2, AIF3, SLIMbus), and for the input (ADC) and output (DAC) paths. Each of these must be referenced either to SYSCLK or to ASYNCCLK. (Note that the SLIMbus interface supports multiple sample rates, selected independently for each input or output channel.)

The WM5102 can support a maximum of five different sample rates at any time. The supported



sample rates range from 4kHz to 192kHz.

Up to three different sample rates can be selected using the SAMPLE_RATE_1, SAMPLE_RATE_2 and SAMPLE_RATE_3 registers. These must each be numerically related to each other and to the SYSCLK frequency (further details of these requirements are provided in Table 98 and the accompanying text).

The remaining two sample rates can be selected using the ASYNC_SAMPLE_RATE_1 and ASYNC_SAMPLE_RATE_2 registers. These sample rates must be numerically related to each other and to the ASYNCCLK frequency (further details of these requirements are provided in Table 99 and the accompanying text).

Each of the audio interfaces, input paths and output paths is associated with one of the sample rates selected by the SAMPLE_RATE_n or ASYNC_SAMPLE_RATE_n registers.

Note that if any two interfaces are operating at the same sample rate, but are not synchronised, then one of these must be referenced to the ASYNCCLK domain, and the other to the SYSCLK domain.

Note that, when any of the SAMPLE_RATE_n or ASYNC_SAMPLE_RATE_n registers is written to, the activation of the new setting is automatically synchronised by the WM5102 to ensure continuity of all active signal paths. The SAMPLE_RATE_n_STS and ASYNC_SAMPLE_RATE_n_STS registers provide readback of the sample rate selections that have been implemented.

There are some restrictions to be observed regarding the sample rate control configuration, as noted below:

- The input (ADC / Digital Microphone) and output (DAC) signal paths must always be associated with the SYSCLK clocking domain.
- All external clock references (MCLK input or Slave mode AIF input) must be within 1% of the applicable register setting(s).
- The input (ADC / DMIC) sample rate is valid from 8kHz to 192kHz.
- The output (DAC) sample rate is valid from 8kHz to 192kHz.
- The Mic Mute mixer sample rate is valid from 8kHz to 192kHz.
- The Effects (EQ, DRC, LHPF) sample rate is valid from 8kHz to 192kHz. When the DRC is enabled, the maximum sample rate for these functions is 96kHz.
- The Tone Generator sample rate is valid from 8kHz to 192kHz.
- The Haptic Signal Generator sample rate is valid from 8kHz to 192kHz.
- The Asynchronous Sample Rate Converter (ASRC) supports sample rates 8kHz to 48kHz.
 The associated SYSCLK and ASYNCCLK sample rates must both be 8kHz to 48kHz.
- The Isochronous Sample Rate Converters (ISRCs) support sample rates 8kHz to 192kHz.
 For each ISRC, the higher sample rate must be an integer multiple of the lower rate. Integer ratios in the range 1 to 6 are supported.

AUTOMATIC SAMPLE RATE DETECTION

The WM5102 supports automatic sample rate detection on the digital audio interfaces (AIF1, AIF2 and AIF3). Note that this is only possible when the respective interface is operating in Slave mode (ie. when LRCLK and BCLK are inputs to the WM5102).

Automatic sample rate detection is enabled using the RATE_EST_ENA register bit. The LRCLK input pin selected for sample rate detection is set using the LRCLK_SRC register.

Up to four audio sample rates can be configured for automatic detection; these sample rates are selected using the SAMPLE_RATE_DETECT_n registers. Note that the function will only detect sample rates that match one of the SAMPLE_RATE_DETECT_n registers.

If one of the selected audio sample rates is detected on the selected LRCLK input, then a Control Write Sequence will be triggered. A unique sequence of actions may be programmed for each of the detected sample rates. Note that the applicable control sequences must be programmed by the user



for each detection outcome. See "Control Write Sequencer" for further details.

The TRIG_ON_STARTUP register controls whether the sample rate detection circuit responds to the initial detection of the applicable interface (ie. when the AIFn interface starts up).

When TRIG_ON_STARTUP=0, then the detection circuit will only respond (ie. trigger the Control Write Sequencer) to a change in the detected sample rate - the initial sample rate detection will be ignored. (Note that the 'initial sample rate detection' is the first detection of a sample rate that matches one of the SAMPLE_RATE_DETECT_n registers.)

When TRIG_ON_STARTUP=1, then the detection circuit will trigger the Control Write Sequencer whenever a selected sample rate is detected, including when the AIF interface starts up, or when the sample rate detection is first enabled.

There are some restrictions to be observed regarding the sample rate control configuration, as noted below:

- The same sample rate must not be selected on more than one of the SAMPLE_RATE_DETECT_n registers.
- Sample rates 192kHz and 176.4kHz must not be selected concurrently.
- Sample rates 96kHz and 88.2kHz must not be selected concurrently.

The control registers associated with the automatic sample rate detection function are described in Table 100.

SYSCLK AND ASYNCCLK CONTROL

The SYSCLK and ASYNCCLK clocks may be provided directly from external inputs (MCLK, or slave mode BCLK inputs). Alternatively, the SYSCLK and ASYNCCLK clocks can be derived using the integrated FLL(s), with MCLK, BCLK, LRCLK or SLIMCLK as a reference.

The required SYSCLK frequency is dependent on the SAMPLE_RATE_n registers. Table 98 illustrates the valid SYSCLK frequencies for every supported sample rate.

The SYSCLK_FREQ and SYSCLK_FRAC registers are used to identify the applicable SYSCLK frequency. It is recommended that the highest possible SYSCLK frequency is selected.

The chosen SYSCLK frequency must be valid for all of the SAMPLE_RATE_n registers. It follows that all of the SAMPLE_RATE_n registers must select numerically-related values, ie. all from the same cell as represented in Table 98.

Sample Rate	SAMPLE_RATE_n	SYSCLK Frequency	SYSCLK_FREQ	SYSCLK_FRAC
12kHz	01h			
24kHz	02h			
48kHz	03h	6.144MHz,	000.	
96kHz	04h	12.288MHz,	001,	
192kHz	05h	24.576MHz,	010,	0
4kHz	10h	or	or	
8kHz	11h	49.152MHz	011	
16kHz	12h			
32kHz	13h			
11.025kHz	09h	5.6448MHz,	000.	
22.05kHz	0Ah	11.2896MHz,	001,	
44.1kHz	0Bh	22.5792MHz,	010,	1
88.2kHz	0Ch	or	or	
176.4kHz	0Dh	45.1584MHz	011	

Note that each of the SAMPLE_RATE_n registers must select a sample rate value from the same group in the two lists above.

Table 98 SYSCLK Frequency Selection



The required ASYNCCLK frequency is dependent on the ASYNC_SAMPLE_RATE_n registers. Table 99 illustrates the valid ASYNCCLK frequencies for every supported sample rate.

The ASYNC_CLK_FREQ register is used to identify the applicable ASYNCCLK frequency. It is recommended that the highest possible ASYNCCLK frequency is selected.

Note that, if all the sample rates in the system are synchronised to SYSCLK, then the ASYNCCLK may not be required at all. In this case, the ASYNCCLK should be disabled (see Table 100), and the associated register values are not important.

Sample Rate	ASYNC_SAMPLE_RATE_n	ASYNCCLK Frequency	ASYNC_CLK_FREQ
12kHz	01h		
24kHz	02h		
48kHz	03h	6.144MHz.	000.
96kHz	04h	12.288MHz,	001,
192kHz	05h	24.576MHz,	010,
4kHz	10h	or	or
8kHz	11h	49.152MHz	011
16kHz	12h		
32kHz	13h		
11.025kHz	09h	5.6448MHz.	000,
22.05kHz	0Ah	11.2896MHz,	001,
44.1kHz	0Bh	22.5792MHz	010,
88.2kHz	0Ch	or	or
176.4kHz	0Dh	45.1584MHz	011

Note that each of the ASYNC_SAMPLE_RATE_n registers must select a sample rate value from the same group in the two lists above.

Table 99 ASYNCCLK Frequency Selection

The WM5102 supports automatic clocking configuration. The programmable dividers associated with the ADCs, DACs and all DSP functions are configured automatically, with values determined from the SYSCLK_FREQ, SAMPLE_RATE_n, ASYNC_CLK_FREQ and ASYNC_SAMPLE_RATE_n fields.

Note that the digital audio interface (AIF) clocking rates must be configured separately.

The sample rates of each AIF, the input (ADC) paths, output (DAC) paths and DSP functions are selected as described in the respective sections. Stereo full-duplex sample rate conversion is supported in multiple configurations to allow digital audio to be routed between interfaces and for asynchronous audio data to be mixed. See "Digital Core" for further details.

The SYSCLK_SRC register is used to select the SYSCLK source, as described in Table 100. The source may be MCLKn, AlFnBCLK or FLLn. If one of the Frequency Locked Loop (FLL) circuits is selected as the source, then the relevant FLL must be enabled and configured, as described later.

The SYSCLK_FREQ and SYSCLK_FRAC registers are set according to the frequency of the selected SYSCLK source.

The SYSCLK-referenced circuits within the digital core are clocked at a dynamically-controlled rate, limited by the SYSCLK frequency itself. For maximum signal mixing and processing capacity, it is recommended that the highest possible SYSCLK frequency is configured.

If the SUBSYS_MAX_FREQ bit is set to '0', then the digital core clocking rate is restricted to a maximum of 24.576MHz (or 22.5792MHz), even if a higher SYSCLK frequency is configured. The SUBSYS_MAX_FREQ should only be set to '1' when the applicable DCVDD condition is satisfied, as described in Table 97.

The SAMPLE_RATE_n registers are set according to the sample rate(s) that are required by one or more of the WM5102 audio interfaces. The WM5102 supports sample rates ranging from 4kHz to 192kHz.



The SYSCLK signal is enabled by the register bit SYSCLK_ENA. The applicable clock source (MCLKn, AIFnBCLK or FLLn) must be enabled before setting SYSCLK_ENA=1. This bit should be set to 0 when reconfiguring the clock sources (see below for additional requirements when setting SYSCLK_ENA=0).

When disabling SYSCLK, note that all of the input, output or digital core functions associated with the SYSCLK clock domain must be disabled before setting SYSCLK_ENA=0.

When '0' is written to SYSCLK_ENA, the host processor must wait until the WM5102 has shut down the associated functions before issuing any other register write commands. The SYSCLK Enable status can be polled via the SYSCLK_ENA_LOW_STS bit (see Table 96), or else monitored using the Interrupt or GPIO functions.

The SYSCLK Enable status is an input to the Interrupt control circuit and can be used to trigger an Interrupt event - see "Interrupts". The corresponding Interrupt event indicates that the WM5102 has shut down the SYSCLK functions and is ready to accept register write commands.

The SYSCLK Enable status can be output directly on a GPIO pin as an external indication of the SYSCLK status. See "General Purpose Input / Output" to configure a GPIO pin for this function.

The required control sequence for disabling SYSCLK is summarised below:

- Disable all SYSCLK-associated functions (inputs, outputs, digital core)
- Set SYSCLK ENA = 0
- Wait until SYSCLK_ENA_LOW = 1 (or wait for the corresponding IRQ/GPIO event)

The ASYNC_CLK_SRC register is used to select the ASYNCCLK source, as described in Table 100. The source may be MCLKn, AIFnBCLK or FLLn. If one of the Frequency Locked Loop (FLL) circuits is selected as the source, then the relevant FLL must be enabled and configured, as described later.

The ASYNC_CLK_FREQ register is set according to the frequency of the selected ASYNCCLK source.

The ASYNCCLK-referenced circuits within the digital core are clocked at a dynamically-controlled rate, limited by the ASYNCCLK frequency itself. For maximum signal mixing and processing capacity, it is recommended that the highest possible ASYNCCLK frequency is configured.

If the SUBSYS_MAX_FREQ bit is set to '0', then the digital core clocking rate is restricted to a maximum of 24.576MHz (or 22.5792MHz), even if a higher ASYNCCLK frequency is configured. The SUBSYS_MAX_FREQ should only be set to '1' when the applicable DCVDD condition is satisfied, as described in Table 97.

The ASYNC_SAMPLE_RATE_n registers are set according to the sample rate(s) of any audio interface that is not synchronised to the SYSCLK clock domain.

The ASYNCCLK signal is enabled by the register bit ASYNC_CLK_ENA. The applicable clock source (MCLKn, AIFnBCLK or FLLn) must be enabled before setting ASYNC_CLK_ENA=1. This bit should be set to 0 when reconfiguring the clock sources (see below for additional requirements when setting ASYNC_CLK_ENA=0).

When disabling ASYNCCLK, note that all of the input, output or digital core functions associated with the ASYNCCLK clock domain must be disabled before setting ASYNC_CLK_ENA=0.

When '0' is written to ASYNC_CLK_ENA, the host processor must wait until the WM5102 has shut down the associated functions before issuing any other register write commands. The ASYNCCLK Enable status can be polled via the ASYNC_CLK_ENA_LOW_STS bit (see Table 96), or else monitored using the Interrupt or GPIO functions.

The ASYNCCLK Enable status is an input to the Interrupt control circuit and can be used to trigger an Interrupt event - see "Interrupts". The corresponding Interrupt event indicates that the WM5102 has shut down the ASYNCCLK functions and is ready to accept register write commands.

The ASYNCCLK Enable status can be output directly on a GPIO pin as an external indication of the ASYNCCLK status. See "General Purpose Input / Output" to configure a GPIO pin for this function.



The required control sequence for disabling ASYNCCLK is summarised below:

- Disable all ASYNCCLK-associated functions (inputs, outputs, digital core)
- Set ASYNCCLK_ENA = 0
- Wait until ASYNCCLK ENA LOW = 1 (or wait for the corresponding IRQ/GPIO event)

The SYSCLK (and ASYNCCLK, when applicable) clocks must be configured and enabled before any audio path is enabled.

The WM5102 performs automatic checks to confirm that the SYSCLK and ASYNCCLK frequencies are high enough to support the commanded signal paths and processing functions. If an attempt is made to enable a signal path or processing function, and there are insufficient SYSCLK or ASYNCCLK cycles to support it, then the attempt will be unsuccessful. (Note that any signal paths that are already active will not be affected under these circumstances.)

An Underclocked Error condition is where there are insufficient clock cycles for the requested functionality, and increasing the SYSCLK or ASYNCCLK frequency (as applicable) should allow the selected configuration to be supported.

An Overclocked Error condition is where the requested functionality cannot be supported, as the clocking requirements of the requested configuration exceed the device limits.

The SYSCLK Underclocked condition, ASYNCCLK Underclocked condition, and other Clocking Error conditions can be monitored using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.

MISCELLANEOUS CLOCK CONTROLS

The WM5102 requires a 32kHz clock for miscellaneous de-bounce functions. This can be generated automatically from SYSCLK, or may be input directly as MCLK1 or MCLK2. The 32kHz clock source is selected using the CLK_32K_SRC register. The 32kHz clock is enabled using the CLK_32K_ENA register.

A clock output (OPCLK) derived from SYSCLK can be output on a GPIO pin. See "General Purpose Input / Output" to configure a GPIO pin for this function.

A clock output (OPCLK_ASYNC) derived from ASYNCCLK can be output on a GPIO pin. See "General Purpose Input / Output" to configure a GPIO pin for this function.

The WM5102 provides integrated pull-down resistors on the MCLK1 and MCLK2 pins. This provides a flexible capability for interfacing with other devices.

The clocking scheme for the WM5102 is illustrated in Figure 68.



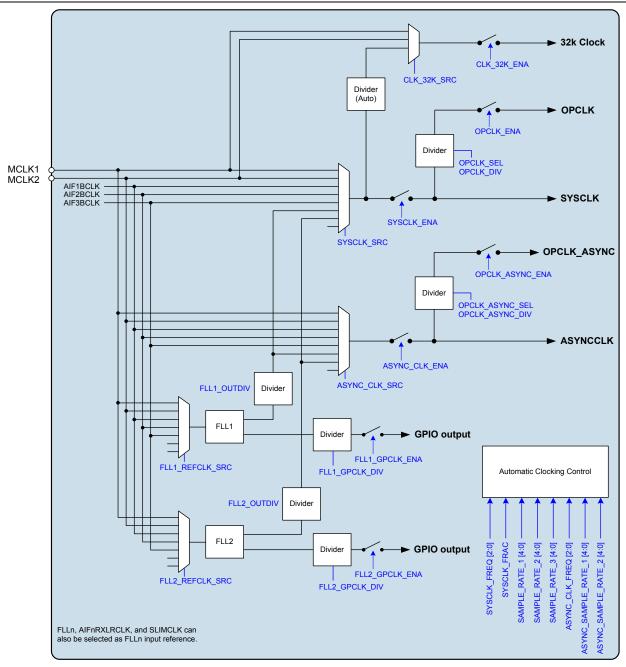


Figure 68 System Clocking

The WM5102 clocking control registers are described in Table 100.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R256 (0100h) Clock 32k	6	CLK_32K_ENA	0	32kHz Clock Enable 0 = Disabled 1 = Enabled
1	1:0	CLK_32K_SRC [1:0]	10	32kHz Clock Source 00 = MCLK1 (direct) 01 = MCLK2 (direct) 10 = SYSCLK (automatically divided) 11 = Reserved
R257 (0101h) System	15	SYSCLK_FRAC	0	SYSCLK Frequency 0 = SYSCLK is a multiple of 6.144MHz 1 = SYSCLK is a multiple of 5.6448MHz
Clock 1	10:8	SYSCLK_FREQ [2:0]	011	SYSCLK Frequency 000 = 6.144MHz (5.6448MHz) 001 = 12.288MHz (11.2896MHz) 010 = 24.576MHz (22.5792MHz) 011 = 49.152MHz (45.1584MHz) All other codes are Reserved The frequencies in brackets apply for 44.1kHz-related sample rates only (ie. SAMPLE_RATE_n = 01XXX).
	6	SYSCLK_ENA	0	SYSCLK Control 0 = Disabled 1 = Enabled SYSCLK should only be enabled after the applicable clock source has been configured and enabled. Set this bit to 0 when reconfiguring the clock sources.
	3:0	SYSCLK_SRC [3:0]	0100	SYSCLK Source 0000 = MCLK1 0001 = MCLK2 0100 = FLL1 0101 = FLL2 1000 = AIF1BCLK 1001 = AIF2BCLK All other codes are Reserved

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R258 (0102h) Sample rate 1	4:0	SAMPLE_RATE_ 1 [4:0]	10001	Sample Rate 1 Select 00h = None 01h = 12kHz 02h = 24kHz 03h = 48kHz 04h = 96kHz 05h = 192kHz 09h = 11.025kHz 09h = 22.05kHz 0Ah = 22.05kHz 0Bh = 44.1kHz 0Ch = 88.2kHz 0Dh = 176.4kHz 10h = 4kHz 11h = 8kHz 12h = 16kHz 13h = 32kHz All other codes are Reserved
R259 (0103h) Sample rate 2	4:0	SAMPLE_RATE_ 2 [4:0]	10001	Sample Rate 2 Select Register coding is same as SAMPLE_RATE_1.
R260 (0104h) Sample rate 3	4:0	SAMPLE_RATE_ 3 [4:0]	10001	Sample Rate 3 Select Register coding is same as SAMPLE_RATE_1.
R266 (010Ah) Sample rate 1 status	4:0	SAMPLE_RATE_ 1_STS [4:0]	00000	Sample Rate 1 Status (Read only) Register coding is same as SAMPLE_RATE_1.
R267 (010Bh) Sample rate 2 status	4:0	SAMPLE_RATE_ 2_STS [4:0]	00000	Sample Rate 2 Status (Read only) Register coding is same as SAMPLE_RATE_1.
R268 (010Ch) Sample rate 3 status	4:0	SAMPLE_RATE_ 3_STS [4:0]	00000	Sample Rate 3 Status (Read only) Register coding is same as SAMPLE_RATE_1.
R274 (0112h) Async clock 1	10:8	ASYNC_CLK_FR EQ [2:0]	011	ASYNCCLK Frequency 000 = 6.144MHz (5.6448MHz) 001 = 12.288MHz (11.2896MHz) 010 = 24.576MHz (22.5792MHz) 011 = 49.152MHz (45.1584MHz) All other codes are Reserved The frequencies in brackets apply for 44.1kHz-related sample rates only (ie. ASYNC_SAMPLE_RATE_n = 01XXX).
	6	ASYNC_CLK_EN A	0	ASYNCCLK Control 0 = Disabled 1 = Enabled ASYNCCLK should only be enabled after the applicable clock source has been configured and enabled. Set this bit to 0 when reconfiguring the clock sources.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	3:0	ASYNC_CLK_SR C [3:0]	0101	ASYNCCLK Source 0000 = MCLK1 0001 = MCLK2 0100 = FLL1 0101 = FLL2 1000 = AIF1BCLK 1001 = AIF2BCLK All other codes are Reserved
R275 (0113h) Async sample rate 1	4:0	ASYNC_SAMPLE _RATE_1 [4:0]	10001	ASYNC Sample Rate 1 Select 00h = None 01h = 12kHz 02h = 24kHz 03h = 48kHz 04h = 96kHz 05h = 192kHz 09h = 11.025kHz 09h = 11.025kHz 0Ah = 22.05kHz 0Bh = 44.1kHz 0Ch = 88.2kHz 0Dh = 176.4kHz 10h = 4kHz 11h = 8kHz 12h = 16kHz 13h = 32kHz All other codes are Reserved
R276 (0114h) Async sample rate 2	4:0	ASYNC_SAMPLE _RATE_2 [4:0]	10001	ASYNC Sample Rate 2 Select Register coding is same as ASYNC_SAMPLE_RATE_1.
R283 (011Bh) Async sample rate 1 status	4:0	ASYNC_SAMPLE _RATE_1_STS [4:0]	00000	ASYNC Sample Rate 1 Status (Read only) Register coding is same as ASYNC_SAMPLE_RATE_1.
R284 (011Ch) Async sample rate 2 status	4:0	ASYNC_SAMPLE _RATE_2_STS [4:0]	00000	ASYNC Sample Rate 2 Status (Read only) Register coding is same as ASYNC_SAMPLE_RATE_1.
R329 (0149h) Output	15	OPCLK_ENA	0	OPCLK Enable 0 = Disabled 1 = Enabled
system clock	7:3	OPCLK_DIV [4:0]	00h	OPCLK Divider 00h = Divide by 1 01h = Divide by 1 02h = Divide by 2 03h = Divide by 3 1Fh = Divide by 31



	REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
		2:0	OPCLK_SEL [2:0]	000	OPCLK Source Frequency 000 = 6.144MHz (5.6448MHz) 001 = 12.288MHz (11.2896MHz) 010 = 24.576MHz (22.5792MHz) 011 = 49.152MHz (45.1584MHz) All other codes are Reserved The frequencies in brackets apply for 44.1kHz-related SYSCLK rates only (ie. SAMPLE_RATE_n = 01XXX). The OPCLK Source Frequency must be less than or equal to the SYSCLK
	R330 (014Ah) Output	15	OPCLK_ASYNC_ ENA	0	frequency. OPCLK_ASYNC Enable 0 = Disabled 1 = Enabled
	async clock	7:3	OPCLK_ASYNC_ DIV [4:0]	00h	OPCLK_ASYNC Divider 00h = Divide by 1 01h = Divide by 1 02h = Divide by 2 03h = Divide by 3 1Fh = Divide by 31
		2:0	OPCLK_ASYNC_ SEL [2:0]	000	OPCLK_ASYNC Source Frequency 000 = 6.144MHz (5.6448MHz) 001 = 12.288MHz (11.2896MHz) 010 = 24.576MHz (22.5792MHz) 011 = 49.152MHz (45.1584MHz) All other codes are Reserved The frequencies in brackets apply for 44.1kHz-related ASYNCCLK rates only (ie. ASYNC_SAMPLE_RATE_n = 01XXX). The OPCLK_ASYNC Source Frequency must be less than or equal to the ASYNCCLK frequency.
•	R338 (0152h) Rate Estimator	4	TRIG_ON_STAR TUP	0	Automatic Sample Rate Detection Start- Up select 0 = Do not trigger Write Sequence on initial detection 1 = Always trigger the Write Sequencer on sample rate detection
		3:1	LRCLK_SRC [2:0]	000	Automatic Sample Rate Detection source 000 = AIF1RXLRCLK 001 = AIF1TXLRCLK 010 = AIF2RXLRCLK 011 = AIF2TXLRCLK 100 = AIF3RXLRCLK 101 = AIF3TXLRCLK 101 = RESERVED 111 = RESERVED
		0	RATE_EST_ENA	0	Automatic Sample Rate Detection control 0 = Disabled 1 = Enabled



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R339	4:0	SAMPLE_RATE_	00h	Automatic Detection Sample Rate A
(0153h) Rate		DETECT_A [4:0]		(Up to four different sample rates can be configured for automatic detection.)
Estimator 2				Register coding is same as SAMPLE_RATE_n.
R340	4:0	SAMPLE_RATE_	00h	Automatic Detection Sample Rate B
(0154h) Rate		DETECT_B [4:0]		(Up to four different sample rates can be configured for automatic detection.)
Estimator 3				Register coding is same as SAMPLE_RATE_n.
R341	4:0	SAMPLE_RATE_	00h	Automatic Detection Sample Rate C
(0155h) Rate		DETECT_C [4:0]		(Up to four different sample rates can be configured for automatic detection.)
Estimator 4				Register coding is same as SAMPLE_RATE_n.
R342	4:0	SAMPLE_RATE_	00h	Automatic Detection Sample Rate D
(0156h) Rate		DETECT_D [4:0]		(Up to four different sample rates can be configured for automatic detection.)
Estimator 5				Register coding is same as SAMPLE_RATE_n.
R3104	13	MCLK2_PD	0	MCLK2 Pull-Down Control
(0C20h)				0 = Disabled
Misc Pad Ctrl 1				1 = Enabled
R3105	12	MCLK1_PD	0	MCLK1 Pull-Down Control
(0C21h)				0 = Disabled
Misc Pad Ctrl 2				1 = Enabled

Table 100 Clocking Control

In AIF Slave modes, it is important to ensure the applicable clock domain (SYSCLK or ASYNCCLK) is synchronised with the associated external LRCLK. This can be achieved by selecting an MCLK input that is derived from the same reference as the LRCLK, or can be achieved by selecting the external BCLK or LRCLK signal as a reference input to one of the FLLs, as a source for SYSCLK or ASYNCCLK.

If the AIF clock domain is not synchronised with the LRCLK, then clicks arising from dropped or repeated audio samples will occur, due to the inherent tolerances of multiple, asynchronous, system clocks. See "Applications Information" for further details on valid clocking configurations.

BCLK AND LRCLK CONTROL

The digital audio interfaces (AIF1, AIF2 and AIF3) use BCLK and LRCLK signals for synchronisation. In master mode, these are output signals, generated by the WM5102. In slave mode, these are input signals to the WM5102. It is also possible to support mixed master/slave operation.

The BCLK and LRCLK signals are controlled as illustrated in Figure 69. See the "Digital Audio Interface Control" section for further details of the relevant control registers.

Note that the BCLK and LRCLK signals are synchronised to SYSCLK or ASYNCCLK, depending upon the applicable clocking domain for the respective interface. See "Digital Core" for further details.

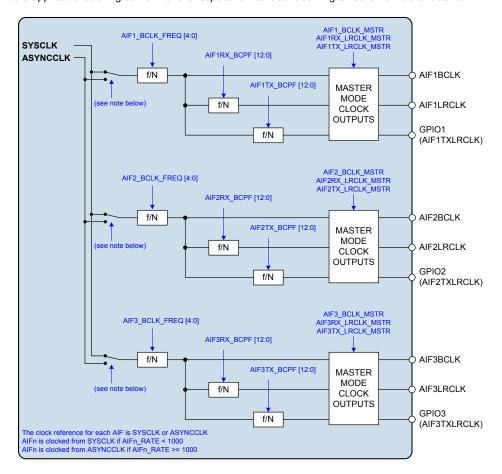


Figure 69 BCLK and LRCLK Control

CONTROL INTERFACE CLOCKING

Register map access is possible with or without a system clock. Clocking is provided from SYSCLK; the SYSCLK_SRC register selects the applicable SYSCLK source.

See "Control Interface" for further details of control register access.

FREQUENCY LOCKED LOOP (FLL)

Two integrated FLLs are provided to support the clocking requirements of the WM5102. These can be enabled and configured independently according to the available reference clocks and the application requirements. The reference clock may be a high frequency (eg. 12.288MHz) or low frequency (eg. 32.768kHz).

The FLL is tolerant of jitter and may be used to generate a stable output clock from a less stable input reference. The FLL characteristics are summarised in "Electrical Characteristics". Note that the FLL can be used to generate a free-running clock in the absence of an external reference source. This is described in the "Free-Running FLL Mode" section below. Configurable spread-spectrum modulation can be applied to the FLL outputs, to control EMI effects.

Each of the FLLs comprises two sub-systems - the 'main' loop and the 'synchroniser' loop; these can be used together to maintain best frequency accuracy and noise (jitter) performance across multiple use-cases. The two-loop design enables the FLL to synchronise effectively to an input clock that may be intermittent or noisy, whilst also achieving the performance benefits of a stable clock reference that may be asynchronous to the audio data.

The main loop takes a constant and stable clock reference as its input. For best performance, a high frequency (eg. 12.288MHz) reference is recommended. The main FLL loop will free-run without any clock reference if the input signal is removed; it can also be configured to initiate an output in the absence of any reference signal.

The synchroniser loop takes a separate clock reference as its input. The synchroniser input may be intermittent (eg. during voice calls only). The FLL uses the synchroniser input, when available, as the frequency reference. To achieve the designed performance advantage, the synchroniser input must be synchronous with the audio data.

Note that, if only a single clock input reference is used, this must be configured as the main FLL input reference. The synchroniser should be disabled in this case.

The synchroniser loop should only be used when the main loop clock reference is present. If the input reference to the main FLL is intermittent, or may be interrupted unexpectedly, then the synchroniser should be disabled.

The FLL is enabled using the FLLn_ENA register bit (where n = 1 or 2 for the corresponding FLL). The FLL Synchroniser is enabled using the FLLn_SYNC_ENA register bit.

Note that the other FLL registers should be configured before enabling the FLL; the FLLn_ENA and FLLn SYNC ENA register bits should be set as the final step of the FLLn enable sequence.

The FLL supports configurable free-running operation, using the FLLn_FREERUN register bits described in the next section. Note that, once the FLL output has been established, the FLL will always free-run when the input reference clock is stopped, regardless of the FLLn_FREERUN bits.

To disable the FLL while the input reference clock has stopped, the respective FLLn_FREERUN bit must be set to '1', before setting the FLLn_ENA bit to '0'.

When changing FLL settings, it is recommended that the digital circuit be disabled via $FLLn_ENA$ and then re-enabled after the other register settings have been updated. When changing the input reference frequency F_{REF} , it is recommended that the FLL be reset by setting $FLLn_ENA$ to 0.

Note that some of the FLL configuration registers can be updated while the FLL is enabled, as described below. As a general rule, however, it is recommended to configure the FLL (and FLL Synchroniser, if applicable), before setting the corresponding _ENA register bit(s).

The FLL configuration requirements are illustrated in Figure 70.



WM5102 Production Data

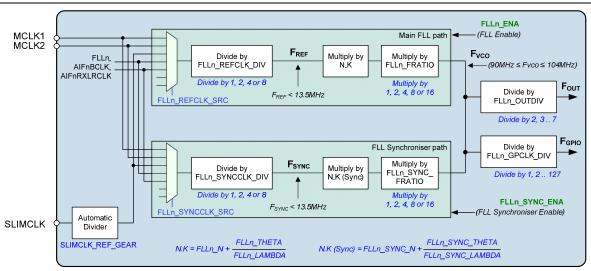


Figure 70 FLL Configuration

The procedure for configuring the FLL is described below. Note that the configuration of the main FLL path and the FLL Synchroniser path are very similar. One or both paths must be configured, depending on the application requirements:

- If a single clock input reference is used, then only the main FLL should be used.
- If the input reference to the main FLL is intermittent, or may be interrupted unexpectedly, then only the main FLL path should be used.
- If two clock input references are used, then the constant or low-noise clock is configured on the main FLL path, and the high-accuracy clock is configured on the FLL synchroniser path. Note that the synchroniser input must be synchronous with the audio data.

The following description is applicable to FLL1 and FLL2. The associated register control fields are described in Table 104 and Table 105 respectively.

The main input reference is selected using FLLn_REFCLK_SRC. The synchroniser input reference is selected using FLLn_SYNCCLK_SRC. The available options in each case comprise MCLK1, MCLK2, SLIMCLK, AIFnBCLK, AIFnRXLRCLK, or the output from another FLL.

The SLIMCLK reference is controlled by an adaptive divider on the external SLIMCLK input. The divider automatically adapts to the SLIMbus Clock Gear, to provide a constant reference frequency for the FLL. See "SLIMbus Interface Control" for details.

The FLLn_REFCLK_DIV field controls a programmable divider on the main input reference. The FLLn_SYNCCLK_DIV field controls a programmable divider on the synchroniser input reference. Each input can be divided by 1, 2, 4 or 8. These registers should be set to bring each reference down to 13.5MHz or below. For best performance, it is recommended that the highest possible frequency—within the 13.5MHz limit—should be selected.

The FLL output frequency, relative to the main input reference F_{REF} , is directly determined from $FLLn_FRATIO$, $FLLn_OUTDIV$ and the real number represented by N.K.

The integer value, N, is held in the FLLn_N register field. The fractional portion, K, is determined by the ratio FLLn_THETA / FLLn_LAMBDA.



The FLL output frequency is generated according to the following equation:

$$F_{OUT} = (F_{VCO} / FLLn_OUTDIV)$$

The FLL operating frequency, F_{VCO} is set according to the following equation:

$$F_{VCO} = (F_{REF} \times N.K \times FLLn_FRATIO)$$

F_{REF} is the input frequency, as determined by FLLn_REFCLK_DIV.

F_{VCO} must be in the range 90MHz to 104MHz. Frequencies outside this range cannot be supported.

Note that the output frequencies that do not lie within the ranges quoted above cannot be guaranteed across the full range of device operating conditions.

In order to follow the above requirements for F_{VCO} , the value of $FLLn_OUTDIV$ should be selected according to the desired output F_{OUT} . The divider, $FLLn_OUTDIV$, must be set so that F_{VCO} is in the range 90MHz to 104MHz. Supported settings of $FLLn_OUTDIV$ are noted in Table 101.

OUTPUT FREQUENCY Fout	FLLn_OUTDIV
22.5 MHz to 26 MHz	100 (divide by 4)
45 MHz to 50 MHz	010 (divide by 2)

Table 101 Selection of FLLn_OUTDIV

The FLLn_FRATIO field selects the frequency division ratio of the FLL input. The FLLn_GAIN field is used to optimise the FLL, according to the input frequency. These fields should be set as described in Table 102.

REFERENCE FREQUENCY F _{REF}	FLLn_FRATIO	FLL <i>n</i> _GAIN	
1MHz - 13.5MHz	0h (divide by 1)	4h (16x gain)	
256kHz - 1MHz	1h (divide by 2)	2h (4x gain)	
128kHz - 256kHz	2h (divide by 4)	0h (1x gain)	
64kHz - 128kHz	3h (divide by 8)	0h (1x gain)	
Less than 64kHz	4h (divide by 16)	0h (1x gain)	

Table 102 Selection of FLLn_FRATIO and FLLn_GAIN

In order to determine the remaining FLL parameters, the FLL operating frequency, F_{VCO} , must be calculated, as given by the following equation:

$$F_{VCO} = (F_{OUT} \times FLLn_OUTDIV)$$

The value of N.K can then be determined as follows:

$$N.K = F_{VCO} / (FLLn_FRATIO \times F_{REF})$$

Note that, in the above equations:

 $FLLn_OUTDIV$ is the F_{OUT} clock ratio.

F_{REF} is the input frequency, after division by FLLn_REFCLK_DIV, where applicable.

FLLn_FRATIO is the F_{VCO} clock ratio (1, 2, 4, 8 or 16).



The value of N is held in the FLLn_N register field.

The value of K is determined by the ratio FLL*n*_THETA / FLL*n*_LAMBDA.

The $FLLn_N$, $FLLn_THETA$ and $FLLn_LAMBDA$ fields are all coded as integers (LSB = 1).

If the FLLn_N or FLLn_THETA registers are updated while the FLL is enabled (FLLn_ENA=1), then the new values will only be effective when a '1' is written to the FLLn_CTRL_UPD bit. This makes it possible to update the two registers simultaneously, without disabling the FLL.

Note that, when the FLL is disabled (FLLn_ENA=0), then the FLLn_N and FLLn_THETA registers can be updated without writing to the FLLn_CTRL_UPD bit.

The values of FLLn_THETA and FLLn_LAMBDA can be calculated as described later.

A similar procedure applies for the deriviation of the FLL Synchroniser parameters - assuming that this function is used.

The FLLn_SYNC_FRATIO field selects the frequency division ratio of the FLL synchroniser input. The FLLn_GAIN and FLLn_SYNC_DFSAT fields are used to optimise the FLL, according to the input frequency. These fields should be set as described in Table 103.

SYNCHRONISER FREQUENCY F _{SYNC}	FLLn_SYNC_FRATIO	FLLn_SYNC_GAIN	FLLn_SYNC_DFSAT
1MHz - 13.5MHz	0h (divide by 1)	4h (16x gain)	0 (wide bandwidth)
256kHz - 1MHz	1h (divide by 2)	2h (4x gain)	0 (wide bandwidth)
128kHz - 256kHz	2h (divide by 4)	0h (1x gain)	0 (wide bandwidth)
64kHz - 128kHz	3h (divide by 8)	0h (1x gain)	1 (narrow bandwidth)
Less than 64kHz	4h (divide by 16)	0h (1x gain)	1 (narrow bandwidth)

Table 103 Selection of FLLn_SYNC_FRATIO, FLLn_SYNC_GAIN, FLLn_SYNC_DFSAT

The FLL operating frequency, F_{VCO}, is the same frequency calculated as described above.

The value of N.K (Sync) can then be determined as follows:

N.K (Sync) =
$$F_{VCO}$$
 / (FLLn_SYNC_FRATIO x F_{SYNC})

Note that, in the above equations:

 F_{SYNC} is the synchroniser input frequency, after division by $\text{FLL} n_\text{SYNCCLK_DIV}$, where applicable.

FLLn_SYNC_FRATIO is the F_{VCO} clock ratio (1, 2, 4, 8 or 16).

The value of N (Sync) is held in the FLLn_SYNC_N register field.

The value of K (Sync) is determined by the ratio FLLn_SYNC_THETA / FLLn_SYNC_LAMBDA.

The $FLLn_SYNC_N$, $FLLn_SYNC_THETA$ and $FLLn_SYNC_LAMBDA$ fields are all coded as integers (LSB = 1).



In Fractional Mode (FLLn_THETA > 0), the register fields FLLn_THETA and FLLn_LAMBDA can be calculated as described below.

Note that an equivalent procedure is also used to derive the $FLLn_SYNC_THETA$ and $FLLn_SYNC_LAMBDA$ register values from the corresponding synchroniser parameters.

Calculate GCD(FLL) using the 'Greatest Common Denominator' function:

 $GCD(FLL) = GCD(FLLn_FRATIO \times F_{REF}, F_{VCO})$

where GCD(x, y) is the greatest common denominator of x and y

F_{REF} is the input frequency, after division by FLL*n*_REFCLK_DIV, where applicable.

Next, calculate FLL*n*_THETA and FLL*n*_LAMBDA using the following equations:

 $FLLn_THETA = (F_{VCO} - (FLL_N \times FLLn_FRATIO \times F_{REF})) / GCD(FLL)$

 $FLLn_LAMBDA = (FLLn_FRATIO \times F_{REF}) / GCD(FLL)$

Note that, in Fractional Mode, the values of FLLn_THETA and FLLn_LAMBDA must be co-prime (ie. not divisible by any common integer). The calculation above ensures that the values will be co-prime.

The value of K must be a fraction less than 1 (ie. FLLn_THETA must be less than FLLn_LAMBDA).

The FLL control registers are described in Table 104 and Table 105. Example settings for a variety of reference frequencies and output frequencies are shown in Table 108.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R369	0	FLL1_ENA	0	FLL1 Enable
(0171h)				0 = Disabled
FLL1 Control 1				1 = Enabled
Control i				This should be set as the final step of the
				FLL1 enable sequence, ie. after the other FLL registers have been configured.
R370	15	FLL1 CTRL UP	0	FLL1 Control Update
(0172h)	15	D	U	Write '1' to apply the FLL1 N and
FLL1				FLL1 THETA register settings.
Control 2				(Only valid when FLL1 ENA=1)
	9:0	FLL1_N [9:0]	008h	FLL1 Integer multiply for F _{REF}
				(LSB = 1)
				If updated while the FLL is enabled, the
				new value is only effective when a '1' is written to FLL1_CTRL_UPD.
R371	15:0	FLL1_THETA	0018h	FLL1 Fractional multiply for F _{REF}
(0173h)		[15:0]		This field sets the numerator (multiply)
FLL1 Control 3				part of the FLL1_THETA / FLL1_LAMBDA ratio.
				Coded as LSB = 1.
				If updated while the FLL is enabled, the
				new value is only effective when a '1' is written to FLL1_CTRL_UPD.
R372	15:0	FLL1_LAMBDA	007Dh	FLL1 Fractional multiply for F _{REF}
(0174h)		[15:0]		This field sets the denominator (dividing)
FLL1 Control 4				part of the FLL1_THETA / FLL1_LAMBDA ratio.
				Coded as LSB = 1.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R373 (0175h) FLL1	10:8	FLL1_FRATIO [2:0]	000	FLL1 F _{VCO} clock divider 000 = 1 001 = 2
Control 5				010 = 4 011 = 8
			0.10	1XX = 16
	3:1	FLL1_OUTDIV [2:0]	010	FLL1 F _{OUT} clock divider
		[2.0]		000 = Reserved 001 = Reserved
				010 = Divide by 2
				011 = Divide by 3
				100 = Divide by 4
				101 = Divide by 5
				110 = Divide by 6
				111 = Divide by 7
				$(F_{OUT} = F_{VCO} / FLL1_OUTDIV)$
R374	7:6	FLL1_REFCLK_D	00	FLL1 Clock Reference Divider
(0176h)		IV [1:0]		00 = 1
FLL1 Control 6				01 = 2
Control o				10 = 4
				11 = 8
				MCLK (or other input reference) must be divided down to <=13.5MHz.
				For lower power operation, the reference clock can be divided down further if desired.
	3:0	FLL1_REFCLK_S	0000	FLL1 Clock source
		RC		0000 = MCLK1
				0001 = MCLK2
				0011 = SLIMCLK
				0100 = FLL1
				0101 = FLL2
				1000 = AIF1BCLK 1001 = AIF2BCLK
				1001 = AIF2BCLK 1010 = AIF3BCLK
				1100 = AIF 1RXLRCLK
				1101 = AIF2RXLRCLK
				1110 = AIF3RXLRCLK
				All other codes are Reserved
R377	5:2	FLL1_GAIN [3:0]	0000	FLL1 Gain
(0179h)				0000 = 1
FLL1				0001 = 2
Control 7				0010 = 4
				0011 = 8
				0100 = 16
				0101 = 32
				0110 = 64 0111 = 128
				1000 to 1111 = 256
	l			1000 10 1111 - 200



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R385 (0181h) FLL1 Synchroni ser 1	0	FLL1_SYNC_EN A	0	FLL1 Synchroniser Enable 0 = Disabled 1 = Enabled This should be set as the final step of the FLL1 synchroniser enable sequence, ie. after the other synchroniser registers have been configured.
R386 (0182h) FLL1 Synchroni ser 2	9:0	FLL1_SYNC_N [9:0]	000h	FLL1 Integer multiply for F _{SYNC} (LSB = 1)
R387 (0183h) FLL1 Synchroni ser 3	15:0	FLL1_SYNC_TH ETA [15:0]	0000h	FLL1 Fractional multiply for F _{SYNC} This field sets the numerator (multiply) part of the FLL1_SYNC_THETA / FLL1_SYNC_LAMBDA ratio. Coded as LSB = 1.
R388 (0184h) FLL1 Synchroni ser 4	15:0	FLL1_SYNC_LA MBDA [15:0]	0000h	FLL1 Fractional multiply for F _{SYNC} This field sets the denominator (dividing) part of the FLL1_SYNC_THETA / FLL1_SYNC_LAMBDA ratio. Coded as LSB = 1.
R389 (0185h) FLL1 Synchroni ser 5	10:8	FLL1_SYNC_FR ATIO [2:0]	000	FLL1 Synchroniser F _{VCO} clock divider 000 = 1 001 = 2 010 = 4 011 = 8 1XX = 16
R390 (0186h) FLL1 Synchroni ser 6	7:6	FLL1_SYNCCLK _DIV [1:0]	00	FLL1 Synchroniser Clock Reference Divider 00 = 1 01 = 2 10 = 4 11 = 8 MCLK (or other input reference) must be divided down to <=13.5MHz. For lower power operation, the reference clock can be divided down further if desired.
	3:0	FLL1_SYNCCLK _SRC	0000	FLL1 Synchroniser Clock source 0000 = MCLK1 0001 = MCLK2 0011 = SLIMCLK 0100 = FLL1 0101 = FLL2 1000 = AIF1BCLK 1001 = AIF2BCLK 1010 = AIF3BCLK 1110 = AIF2RXLRCLK 1111 = AIF3RXLRCLK All other codes are Reserved



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R391 (0187h) FLL1 Synchroni ser 7	5:2	FLL1_SYNC_GAI N [3:0]	0000	FLL1 Synchroniser Gain 0000 = 1 0001 = 2 0010 = 4 0011 = 8 0100 = 16 0101 = 32 0110 = 64 0111 = 128 1000 to 1111 = 256
	0	FLL1_SYNC_DF SAT	1	FLL1 Synchroniser Bandwidth 0 = Wide bandwidth 1 = Narrow bandwidth

Table 104 FLL1 Register Map

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R401	0	FLL2_ENA	0	FLL2 Enable
(0191h)				0 = Disabled
FLL2				1 = Enabled
Control 1				This should be set as the final step of the FLL2 enable sequence, ie. after the other FLL registers have been configured.
R402	15	FLL2_CTRL_UP	0	FLL2 Control Update
(0192h) FLL2		D		Write '1' to apply the FLL2_N and FLL2_THETA register settings.
Control 2				(Only valid when FLL2_ENA=1)
	9:0	FLL2_N [9:0]	008h	FLL2 Integer multiply for FREF
				(LSB = 1)
				If updated while the FLL is enabled, the new value is only effective when a '1' is written to FLL2_CTRL_UPD.
R403	15:0	FLL2_THETA	0018h	FLL2 Fractional multiply for F _{REF}
(0193h) FLL2 Control 3		[15:0]		This field sets the numerator (multiply) part of the FLL2_THETA / FLL2_LAMBDA ratio.
				Coded as LSB = 1.
				If updated while the FLL is enabled, the new value is only effective when a '1' is written to FLL2_CTRL_UPD.
R404	15:0	FLL2_LAMBDA	007Dh	FLL2 Fractional multiply for F _{REF}
(0194h) FLL2 Control 4		[15:0]		This field sets the denominator (dividing) part of the FLL2_THETA / FLL2_LAMBDA ratio.
				Coded as LSB = 1.
R405	10:8	FLL2_FRATIO	000	FLL2 F _{VCO} clock divider
(0195h)		[2:0]		000 = 1
FLL2				001 = 2
Control 5				010 = 4
				011 = 8
				1XX = 16



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	3:1	FLL2_OUTDIV [2:0]	010	FLL2 F _{OUT} clock divider 000 = Reserved
				001 = Reserved
				010 = Divide by 2
				011 = Divide by 3
				100 = Divide by 4
				101 = Divide by 5
				110 = Divide by 6
				111 = Divide by 7
				$(F_{OUT} = F_{VCO} / FLL2_OUTDIV)$
R406	7:6	FLL2_REFCLK_D	00	FLL2 Clock Reference Divider
(0196h)		IV [1:0]		00 = 1
FLL2				01 = 2
Control 6				10 = 4
				11 = 8
				MCLK (or other input reference) must be divided down to <=13.5MHz.
				For lower power operation, the reference clock can be divided down further if
				desired.
	3:0	FLL2_REFCLK_S	0000	FLL2 Clock source
		RC		0000 = MCLK1
				0001 = MCLK2
				0011 = SLIMCLK
				0100 = FLL1
				0101 = FLL2
				1000 = AIF1BCLK
				1001 = AIF2BCLK
				1010 = AIF3BCLK
				1100 = AIF1RXLRCLK
				1101 = AIF2RXLRCLK
				1110 = AIF3RXLRCLK
				All other codes are Reserved
R409	5:2	FLL2_GAIN [3:0]	0000	FLL2 Gain
(0199h)				0000 = 1
FLL2				0001 = 2
Control 7				0010 = 4
				0011 = 8
				0100 = 16
				0101 = 32
				0110 = 64
				0111 = 128
				1000 to 1111 = 256
R417	0	FLL2_SYNC_EN	0	FLL2 Synchroniser Enable
(01A1h)		Α		0 = Disabled
FLL2 Synobroni				1 = Enabled
Synchroni ser 1				This should be set as the final step of the
				FLL2 synchroniser enable sequence, ie.
				after the other synchroniser registers have been configured.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R418 (01A2h) FLL2 Synchroni ser 2	9:0	FLL2_SYNC_N [9:0]	000h	FLL2 Integer multiply for F _{SYNC} (LSB = 1)
R419 (01A3h) FLL2 Synchroni ser 3	15:0	FLL2_SYNC_TH ETA [15:0]	0000h	FLL2 Fractional multiply for F _{SYNC} This field sets the numerator (multiply) part of the FLL2_SYNC_THETA / FLL2_SYNC_LAMBDA ratio. Coded as LSB = 1.
R420 (01A4h) FLL2 Synchroni ser 4	15:0	FLL2_SYNC_LA MBDA [15:0]	0000h	FLL2 Fractional multiply for F _{SYNC} This field sets the denominator (dividing) part of the FLL2_SYNC_THETA / FLL2_SYNC_LAMBDA ratio. Coded as LSB = 1.
R421 (01A5h) FLL2 Synchroni ser 5	10:8	FLL2_SYNC_FR ATIO [2:0]	000	FLL2 Synchroniser F _{VCO} clock divider 000 = 1 001 = 2 010 = 4 011 = 8 1XX = 16
R422 (01A6h) FLL2 Synchroni ser 6	7:6	FLL2_SYNCCLK _DIV [1:0]	00	FLL2 Synchroniser Clock Reference Divider 00 = 1 01 = 2 10 = 4 11 = 8 MCLK (or other input reference) must be divided down to <=13.5MHz. For lower power operation, the reference clock can be divided down further if desired.
	3:0	FLL2_SYNCCLK _SRC	0000	FLL2 Synchroniser Clock source 0000 = MCLK1 0001 = MCLK2 0011 = SLIMCLK 0100 = FLL1 0101 = FLL2 1000 = AIF1BCLK 1001 = AIF2BCLK 1010 = AIF3BCLK 1100 = AIF1RXLRCLK 1110 = AIF3RXLRCLK All other codes are Reserved
R423 (01A7h) FLL2 Synchroni ser 7	5:2	FLL2_SYNC_GAI N [3:0]	0000	FLL2 Synchroniser Gain 0000 = 1 0001 = 2 0010 = 4 0011 = 8 0100 = 16 0101 = 32 0110 = 64 0111 = 128 1000 to 1111 = 256



REGISTER ADDRESS		LABEL	DEFAULT	DESCRIPTION
	0	FLL2_SYNC_DF SAT	1	FLL2 Synchroniser Bandwidth 0 = Wide bandwidth 1 = Narrow bandwidth

Table 105 FLL2 Register Map

FREE-RUNNING FLL MODE

The FLL can generate a clock signal even when no external reference is available. This may be because the normal input reference has been interrupted, or may be during a standby or start-up period when no initial reference clock is available.

Free-running FLL mode is enabled using the FLLn_FREERUN register. (Note that FLLn_ENA must also be enabled in Free-running FLL mode.)

In Free-running FLL mode, the normal feedback mechanism of the FLL is halted, and the FLL oscillates independently of the external input reference(s).

If the FLL was previously operating normally, (with an input reference clock), then the FLL output frequency will remain unchanged when Free-running FLL mode is enabled. The FLL output will be independent of the input reference while operating in free-running mode with FLLn_FREERUN=1.

The main FLL loop will always continue to free-run if the input reference clock is stopped (regardless of the FLLn_FREERUN setting). If FLLn_FREERUN=0, the FLL will re-lock to the input reference whenever it is available.

If the FLL is started up in free-running mode, (ie. it was not previously running), then the FLL output frequency will be as specified in the "Electrical Characteristics" section.

Note that the FLL integrator setting does not ensure a specific output frequency for the FLL across all devices and operating conditions; a significant level of variation will apply, especially if the FLL is operating independently of any input reference.

Note that the free-running FLL clock may be selected as the SYSCLK source or ASYNCCLK source as shown Figure 68.

The Free-running FLL mode is enabled using the register bits described in Table 106.

REGISTER ADDRESS	ВІТ	LABEL	DEFAULT	DESCRIPTION
R369 (0171h)	1	FLL1_FREERUN	1	FLL1 Free-Running Mode Enable 0 = Disabled
FLL1 Control 1				1 = Enabled The FLL feedback mechanism is halted in
				Free-Running mode, and the latest integrator setting is maintained
R401	1	FLL2_FREERUN	0	FLL2 Free-Running Mode Enable
(0191h)				0 = Disabled
FLL2				1 = Enabled
Control 1				The FLL feedback mechanism is halted in
				Free-Running mode, and the latest
				integrator setting is maintained

Table 106 Free-Running FLL Mode Control



SPREAD SPECTRUM FLL CONTROL

The WM5102 can apply modulation to the FLL outputs, using spread spectrum techniques. This can be used to control the EMI characteristics of the circuits that are clocked via the FLLs.

Each of the FLLs can be individually configured for Triangle modulation, Zero Mean Frequency Modulation (ZMFM) or Dither. The amplitude and frequency parameters of the spread spectrum functions is also programmable, using the registers described in Table 107.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R393 (0189h) FLL1 Spread Spectrum	5:4	FLL1_SS_AMPL [1:0]	00	FLL1 Spread Spectrum Amplitude Controls the extent of the spread- spectrum modulation. 00 = 0.7% (triangle), 0.7% (ZMFM, dither) 01 = 1.1% (triangle), 1.3% (ZMFM, dither) 10 = 2.3% (triangle), 2.6% (ZMFM, dither) 11 = 4.6% (triangle), 5.2% (ZMFM, dither)
	3:2	FLL1_SS_FREQ [1:0]	00	FLL1 Spread Spectrum Frequency Controls the spread spectrum modulation frequency in Triangle mode. $00 = 439 \text{kHz}$ $01 = 878 \text{kHz}$ $10 = 1.17 \text{MHz}$ $11 = 1.76 \text{MHz}$
	1:0	FLL1_SS_SEL [1:0]	00	FLL1 Spread Spectrum Select 00 = Disabled 01 = Triangle 10 = Zero Mean Frequency (ZMFM) 11 = Dither
R425 (01A9h) FLL2 Spread Spectrum	5:4	FLL2_SS_AMPL [1:0]	00	FLL2 Spread Spectrum Amplitude Controls the extent of the spread- spectrum modulation. 00 = 0.7% (triangle), 0.7% (ZMFM, dither) 01 = 1.1% (triangle), 1.3% (ZMFM, dither) 10 = 2.3% (triangle), 2.6% (ZMFM, dither) 11 = 4.6% (triangle), 5.2% (ZMFM, dither)
	3:2	FLL2_SS_FREQ [1:0]	00	FLL2 Spread Spectrum Frequency Controls the spread spectrum modulation frequency in Triangle mode. $00 = 439 \text{kHz}$ $01 = 878 \text{kHz}$ $10 = 1.17 \text{MHz}$ $11 = 1.76 \text{MHz}$
	1:0	FLL2_SS_SEL [1:0]	00	FLL2 Spread Spectrum Select 00 = Disabled 01 = Triangle 10 = Zero Mean Frequency (ZMFM) 11 = Dither

Table 107 FLL Spread Spectrum Control

GPIO OUTPUTS FROM FLL

For each FLL, the WM5102 supports an 'FLL Clock OK' signal which, when asserted, indicates that the FLL has started up and is providing an output clock. Each FLL also supports an 'FLL Lock' signal which indicates whether FLL Lock has been achieved.

The FLL Clock OK status and FLL Lock status are inputs to the Interrupt control circuit and can be used to trigger an Interrupt event - see "Interrupts".

The FLL Clock OK and FLL Lock signals can be output directly on a GPIO pin as an external indication of the FLL status. See "General Purpose Input / Output" to configure a GPIO pin for these functions.

Clock output signals derived from the FLL can be output on a GPIO pin. See "General Purpose Input / Output" to configure a GPIO pin for this function.

The FLL clocking configuration is illustrated in Figure 70.

EXAMPLE FLL CALCULATION

The following example illustrates how to derive the FLL1 registers to generate 49.152 MHz output (F_{OUT}) from a 12.000 MHz reference clock (F_{REF}) :

- Set FLL1_REFCLK_DIV in order to generate F_{REF} <=13.5MHz: FLL1_REFCLK_DIV = 00 (divide by 1)
- Set FLL1_OUTDIV for the required output frequency as shown in Table 101:-F_{OUT} = 49.152 MHz, therefore FLL1_OUTDIV = 2h (divide by 2)
- Set FLL1_FRATIO for the given reference frequency as shown in Table 102:
 F_{REF} = 12MHz, therefore FLL1_FRATIO = 0h (divide by 1)
- Calculate F_{VCO} as given by F_{VCO} = F_{OUT} x FLL1_OUTDIV:-F_{VCO} = 49.152 x 2 = 98.304MHz
- Calculate N.K as given by N.K = F_{VCO} / (FLL1_FRATIO x F_{REF}): N.K = 98.304 / (1 x 12) = 8.192
- Determine FLL1_N from the integer portion of N.K:-FLL1_N = 8 (008h)
- Determine GCD(FLL), as given by GCD(FLL) = GCD(FLL1_FRATIO x F_{REF}, F_{VCO}): GCD(FLL) = GCD(1 x 12000000, 98304000) = 96000
- Determine FLL1_THETA, as given by $FLL1_THETA = (F_{VCO} (FLL1_N \times FLL1_FRATIO \times F_{REF})) / GCD(FLL): \\ FLL1_THETA = (98304000 (8 \times 1 \times 12000000)) / 96000 \\ FLL1_THETA = 24 (0018h)$
- Determine FLL_LAMBDA, as given by FLL1_LAMBDA = (FLL1_FRATIO x F_{REF}) / GCD(FLL): FLL1_LAMBDA = (1 x 12000000) / 96000 FLL1_LAMBDA = 125 (007Dh)



WM5102

EXAMPLE FLL SETTINGS

Table 108 provides example FLL settings for generating 49.152MHz or 24.576MHz SYSCLK from a variety of low and high frequency reference inputs.

F _{SOURCE}	F _{OUT} (MHz)	F _{REF} Divider	N.K	FRATIO	F _{vco} (MHz)	OUTDIV	FLLn_N	FLLn_ THETA	FLLn_ LAMBDA
32.000 kHz	49.152	1	192	16	98.304	2	0C0h		
32.000 kHz	24.576	1	192	16	98.304	4	0C0h		
32.768 kHz	49.152	1	187.5	16	98.304	2	0BBh	0001h	0002h
32.768 kHz	24.576	1	187.5	16	98.304	4	0BBh	0001h	0002h
48 kHz	49.152	1	128	16	98.304	2	080h		
48 kHz	24.576	1	128	16	98.304	4	080h		
128 kHz	49.152	1	96	8	98.304	2	060h		
128 kHz	24.576	1	96	8	98.304	4	060h		
512 kHz	49.152	1	96	2	98.304	2	060h		
512 kHz	24.576	1	96	2	98.304	4	060h		
1.536 MHz	49.152	1	64	1	98.304	2	040h		
1.536 MHz	24.576	1	64	1	98.304	4	040h		
3.072 MHz	49.152	1	32	1	98.304	2	020h		
3.072 MHz	24.576	1	32	1	98.304	4	020h		
11.2896 MHz	49.152	1	8.7075	1	98.304	2	008h	0068h	0093h
11.2896 MHz	24.576	1	8.7075	1	98.304	4	008h	0068h	0093h
12.000 MHz	49.152	1	8.192	1	98.304	2	008h	0018h	007Dh
12.000 MHz	24.576	1	8.192	1	98.304	4	008h	0018h	007Dh
12.288 MHz	49.152	1	8	1	98.304	2	008h		
12.288 MHz	24.576	1	8	1	98.304	4	008h		
13.000 MHz	49.152	1	7.5618	1	98.304	2	007h	0391h	0659h
13.000 MHz	24.576	1	7.5618	1	98.304	4	007h	0391h	0659h
19.200 MHz	49.152	2	10.24	1	98.304	2	00Ah	0006h	0019h
19.200 MHz	24.576	2	10.24	1	98.304	4	00Ah	0006h	0019h
24 MHz	49.152	2	8.192	1	98.304	2	008h	0018h	007Dh
24 MHz	24.576	2	8.192	1	98.304	4	008h	0018h	007Dh
26 MHz	49.152	2	7.5618	1	98.304	2	007h	0391h	0659h
26 MHz	24.576	2	7.5618	1	98.304	4	007h	0391h	0659h
27 MHz	49.152	2	7.2818	1	98.304	2	007h	013Dh	0465h
27 MHz	24.576	2	7.2818	1	98.304	4	007h	013Dh	0465h

F_{OUT} = (F_{SOURCE} / F_{REF} Divider) * N.K * FRATIO / OUTDIV

The values of N and K are contained in the FLLn_N, FLLn_THETA and FLLn_LAMBDA registers as shown above.

See Table 104 and Table 105 for the coding of the FLLn_REFCLK_DIV, FLLn_FRATIO and FLLn_OUTDIV registers.

Table 108 Example FLL Settings



CONTROL INTERFACE

The WM5102 is controlled by writing to its control registers. Readback is available for all registers. Two independent Control Interfaces are provided, giving flexible capability as described below. Note that the SLIMbus interface also supports read/write access to the WM5102 control registers - see "SLIMbus Interface Control"

Note that the Control Interface function can be supported with or without system clocking. Where applicable, the register map access is synchronised with SYSCLK in order to ensure predictable operation of cross-domain functions. See "Clocking and Sample Rates" for further details of Control Interface clocking.

When SYSCLK is present and enabled, register access is possible on all of the Control Interfaces (including SLIMbus) simultaneously.

When SYSCLK is disabled, then register access will only be supported on whichever interface (I2C, SPI, or SLIMbus) is the first to attempt any register access after SYSCLK has stopped. Full access via all interfaces will be restored when SYSCLK is enabled.

Following Power-On Reset (POR), Hardware Reset, Software Reset, or Wake-Up (from Sleep mode), a sequence of device initialisation writes must be executed. The host system should ensure that the WM5102 is ready before attempting these (or any other) Control Register writes. See "Power-On Reset (POR) and Hardware Reset" and "Software Reset, Wake-Up, and Device ID" for further details.

The WM5102 performs automatic checks to confirm that the control interface does not attempt a Read or Write operation to an invalid register address. The Control Interface Address Error condition can be monitored using the GPIO and/or Interrupt functions. See "General Purpose Input / Output" and "Interrupts" for further details.

Control Interface 1 (CIF1) is a 2-wire (I2C) interface, comprising the following pins:

- CIF1SDA serial interface data input/output
- CIF1SCLK serial interface clock input
- CIF1ADDR logic level controlling the I2C device ID

Control Interface 2 (CIF2) is a 4-wire (SPI) interface, comprising the following pins:

- CIF2MOSI SPI data input
- CIF2MISO SPI data output
- CIF2SCLK SPI clock input
- CIF1SS SPI Slave Select input (active low)

A detailed description of the 2-wire (I2C) interface and 4-wire (SPI) interfaces is provided in the following sections. The Control Interface configuration registers are described in Table 109.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R8 (08h)	4	SPI_CFG	1	CIF2MISO pin configuration
Ctrl IF SPI				(applies to SPI mode only)
CFG 1				0 = CMOS
				1 = Wired 'OR'.
	1:0	SPI_AUTO_INC	01	CIF2 SPI Address auto-increment select
		[1:0]		00 = Disabled
				01 = Increment by 1 on each access
				10 = Increment by 2 on each access
				11 = Increment by 3 on each access



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R9 (09h) Ctrl IF I2C1 CFG 1	1:0	I2C1_AUTO_IN C [1:0]	01	CIF1 I2C Address auto-increment select 00 = Disabled 01 = Increment by 1 on each access 10 = Increment by 2 on each access 11 = Increment by 3 on each access
R3105 (0C21h) Misc Pad Ctrl 2	0	ADDR_PD	1	CIF1ADDR Pull-down enable 0 = Disabled 1 = Enabled

Table 109 Control Interface Configuration

2-WIRE (I2C) CONTROL MODE

The 2-wire (I2C) Control Interface mode is supported on CIF1 only, and uses the corresponding SCLK, SDA pins. The ADDR pin is also used to select the I2C Device ID.

In 2-wire (I2C) mode, the WM5102 is a slave device on the control interface; SCLK is a clock input, while SDA is a bi-directional data pin. To allow arbitration of multiple slaves (and/or multiple masters) on the same interface, the WM5102 transmits logic 1 by tri-stating the SDA pin, rather than pulling it high. An external pull-up resistor is required to pull the SDA line high so that the logic 1 can be recognised by the master.

In order to allow many devices to share a single 2-wire control bus, every device on the bus has a unique 8-bit device ID (this is not the same as the address of each register in the WM5102).

The CIF1 device ID is selectable using the CIF1ADDR pin, as described in Table 110. The LSB of the Device ID is the Read/Write bit; this bit is set to logic 1 for "Read" and logic 0 for "Write".

The CIF1ADDR logic level is referenced to the DBVDD1 power domain. An internal pull-down resistor is enabled by default on the CIF1ADDR pin; this can be configured using the ADDR_PD register bit described in Table 109.

CIF1ADDR	DEVICE ID (CIF1)
Logic 0	0011 010x = 34h (write) / 35h (read)
Logic 1	0011 011x = 36h (write) / 37h (read)

Table 110 Control Interface Device ID Selection

The WM5102 operates as a slave device only. The controller indicates the start of data transfer with a high to low transition on SDA while SCLK remains high. This indicates that a device ID, and subsequent address/data bytes will follow. The WM5102 responds to the start condition and shifts in the next eight bits on SDA (8-bit device ID, including Read/Write bit, MSB first). If the device ID received matches the device ID of the WM5102, then the WM5102 responds by pulling SDA low on the next clock pulse (ACK). If the device ID is not recognised or the R/W bit is set incorrectly, the WM5102 returns to the idle condition and waits for a new start condition and valid address.

If the device ID matches the device ID of the WM5102, the data transfer continues as described below. The controller indicates the end of data transfer with a low to high transition on SDA while SCLK remains high. After receiving a complete address and data sequence the WM5102 returns to the idle state and waits for another start condition. If a start or stop condition is detected out of sequence at any point during data transfer (i.e. SDA changes while SCLK is high), the device returns to the idle condition.



The WM5102 supports the following read and write operations:

- Single write
- Single read
- Multiple write (with optional auto-increment)
- Multiple read (with optional auto-increment)

The sequence of signals associated with a single register write operation is illustrated in Figure 71.

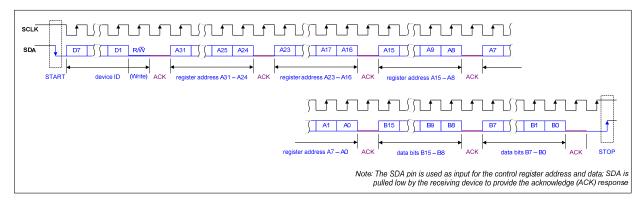


Figure 71 Control Interface 2-wire (I2C) Register Write

The sequence of signals associated with a single register read operation is illustrated in Figure 72.

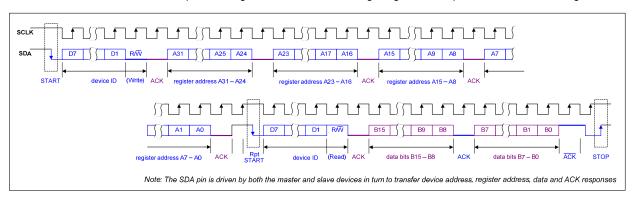


Figure 72 Control Interface 2-wire (I2C) Register Read

The Control Interface also supports other register operations, as listed above. The interface protocol for these operations is summarised below. The terminology used in the following figures is detailed in Table 111.

Note that, for multiple write and multiple read operations, the auto-increment option may be enabled. The I2C multiple transfers illustrated below assume that "auto-increment by 1" is selected in each case. Auto-increment is enabled by default, as noted in Table 109.

TERMINOLOGY	DESCRIPTION		
S	Start Co	ondition	
Sr	Repeat	ed start	
Α	Acknowledge	e (SDA Low)	
Ā	Not Acknowledge (SDA High)		
Р	Stop Condition		
R/W	ReadNotWrite	0 = Write	
		1 = Read	
[White field]	Data flow from bus master to WM5102		
[Grey field]	Data flow from WM	5102 to bus master	

Table 111 Control Interface (I2C) Terminology

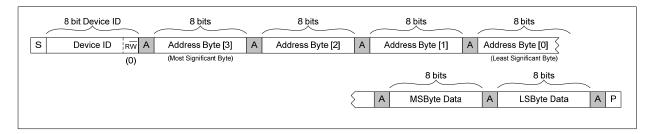


Figure 73 Single Register Write to Specified Address

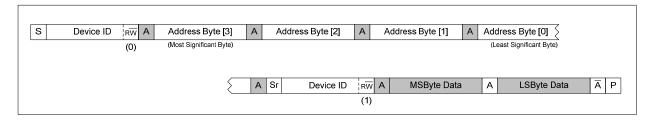


Figure 74 Single Register Read from Specified Address

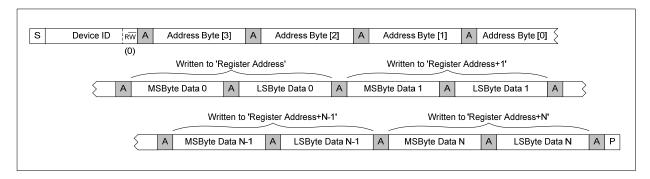


Figure 75 Multiple Register Write to Specified Address using Auto-increment

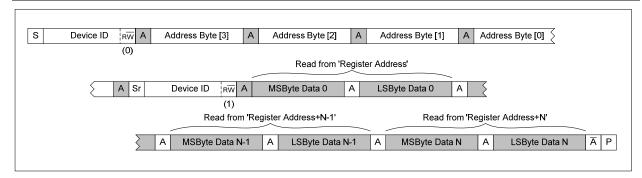


Figure 76 Multiple Register Read from Specified Address using Auto-increment

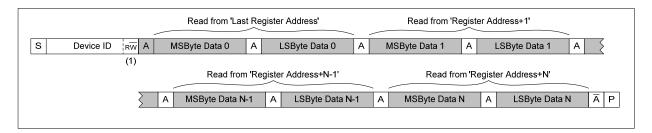


Figure 77 Multiple Register Read from Last Address using Auto-increment

Continuous read and write modes enable multiple register operations to be scheduled faster than is possible with single register operations. The auto-increment function supports selectable address increments for each successive register access. This function is controlled using the I2C1_AUTO_INC register. Auto-increment (by 1) is enabled by default, as described in Table 109.

4-WIRE (SPI) CONTROL MODE

The 4-wire (SPI) Control Interface mode is supported on CIF2 only, and uses the corresponding \overline{SS} , SCLK, MOSI and MISO pins.

The MISO output pin can be configured as CMOS or 'Wired OR', as described in Table 109. In CMOS mode, MISO is driven low when not outputting register data bits. In 'Wired OR' mode, MISO is undriven (high impedance) when not outputting register data bits.

In Write operations (R/W=0), all MOSI bits are driven by the controlling device.

In Read operations (R/W=1), the MOSI pin is ignored following receipt of the valid register address. MISO is driven by the WM5102.

Continuous read and write modes enable multiple register operations to be scheduled faster than is possible with single register operations. The auto-increment function supports selectable address increments for each successive register access. This function is controlled using the SPI_AUTO_INC register. Auto-increment (by 1) is enabled by default, as described in Table 109.

When auto-increment is enabled, the WM5102 will increment the register address at the end of the sequences illustrated below, and every 16 clock cycles thereafter, for as long as \$\overline{S}\$ is held low and SCLK is toggled. Successive data words can be input/output every 16 clock cycles.

The 4-wire (SPI) protocol is illustrated in Figure 78 and Figure 79.

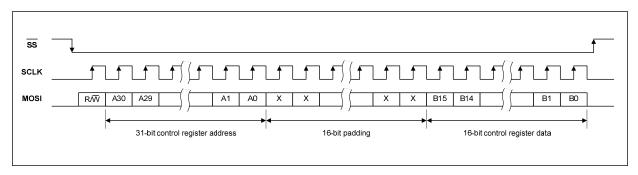


Figure 78 Control Interface 4-wire (SPI) Register Write

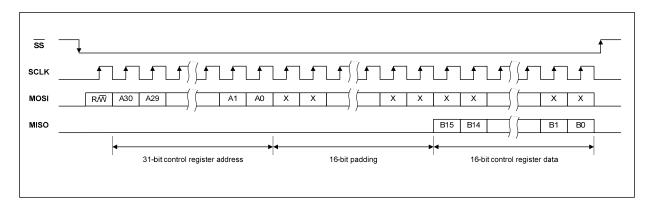


Figure 79 Control Interface 4-wire (SPI) Register Read

CONTROL WRITE SEQUENCER

The Control Write Sequencer is a programmable unit that forms part of the WM5102 control interface logic. It provides the ability to perform a sequence of register write operations with the minimum of demands on the host processor - the sequence may be initiated by a single operation from the host processor and then left to execute independently.

Default sequences for pop-suppressed start-up and shut-down of each headphone/earpiece output driver are provided (these are scheduled automatically when the respective output paths are enabled or disabled). Other control sequences can be programmed, and may be associated with Jack Detect, Wake-Up or Sample Rate Detection functions - these sequences are automatically scheduled whenever a corresponding event is detected.

When a sequence is initiated, the sequencer performs a series of pre-defined register writes. The 'start index' of a control sequence within the sequencer's memory may be commanded directly by the host processor. In the case of a headphone or earpiece enable/disable event, or sequences associated with Jack Detect, Sleep Control or Sample Rate Detection, the applicable 'start index' is held in a user-programmed control register for each sequence.

The Control Write Sequencer may be triggered in a number of ways, as described above. Multiple sequences will be queued if necessary, and each is scheduled in turn. When all of the queued sequences have completed, the sequencer stops, and an Interrupt status flag is asserted.

A valid clock (SYSCLK) must be enabled whenever a Control Write Sequence is scheduled. See "Clocking and Sample Rates" for further details.

INITIATING A SEQUENCE

The Register fields associated with running the Control Write Sequencer are described in Table 112.

The Write Sequencer is enabled using the WSEQ_ENA bit. The index location of the first command in the selected sequence is held in the WSEQ_START_INDEX register.

Writing a '1' to the WSEQ_START bit commands the sequencer to execute a control sequence, starting at the given index. Note that, if the sequencer is already running, then the WSEQ_START command will be queued, and will be executed later when the sequencer becomes available.

The Write Sequencer can be interrupted by writing a '1' to the WSEQ_ABORT bit. Note that this command will only abort a sequence that is currently running; if other sequence commands are pending and not yet started, these sequences will not be aborted by writing to the WSEQ_ABORT bit.

The Write Sequencer stores up to 256 register write commands. These are defined in Registers R12288 (3000h) to R12799 (31FFh). Each of the 256 possible commands is defined in 2 control registers - see Table 117 for a description of these registers.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R22 (0016h)	11	WSEQ_ABORT	0	Writing a 1 to this bit aborts the current sequence.
Write Sequencer Ctrl 0	10	WSEQ_START	0	Writing a 1 to this bit starts the write sequencer at the index location selected by WSEQ_START_INDEX. At the end of the sequence, this bit will be reset by the Write Sequencer.
	9	WSEQ_ENA	0	Write Sequencer Enable 0 = Disabled
				1 = Enabled
				Only applies to sequences triggered using the WSEQ_START bit.
	8:0	WSEQ_START_I	000h	Sequence Start Index
		NDEX [8:0]		This field contains the index location in the sequencer memory of the first command in the selected sequence.
				Only applies to sequences triggered using the WSEQ_START bit.
				Valid from 0 to 255 (0FFh).

Table 112 Write Sequencer Control - Initiating a Sequence

AUTOMATIC SAMPLE RATE DETECTION SEQUENCES

The WM5102 supports automatic sample rate detection on the digital audio interfaces (AIF1, AIF2 and AIF3), when operating in AIF Slave mode. Automatic sample rate detection is enabled using the RATE_EST_ENA register bit (see Table 100).

Up to four audio sample rates can be configured for automatic detection; these sample rates are selected using the SAMPLE_RATE_DETECT_n registers. If one of the selected audio sample rates is detected, then the Control Write Sequencer will be triggered. The applicable start index location within the sequencer memory is separately configurable for each detected sample rate.

The WSEQ_SAMPLE_RATE_DETECT_A_INDEX register defines the sequencer start index corresponding to the SAMPLE_RATE_DETECT_A sample rate. Equivalent start index values are defined for the other sample rates, as described in Table 113.

Note that a sequencer start index of 1FFh will cause the respective sequence to be aborted.

The automatic sample rate detection control sequences are undefined following initial power-up, but can be user-programmed during normal operation. Note that all control sequences are retained in the sequencer memory through Hardware Reset and Software Reset, provided DCVDD is held above its reset threshold. The control sequence memory is always retained in Sleep mode. Excluding Sleep mode, the control sequence memory is cleared if DCVDD falls below its reset threshold. See the "Applications Information" section for a summary of the WM5102 memory reset conditions.

See "Clocking and Sample Rates" for further details of the automatic sample rate detection function.



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R97 (0061h) Sample Rate Sequence Select 1	8:0	WSEQ_SAMPLE _RATE_DETECT _A_INDEX [8:0]	1FFh	Sample Rate A Write Sequence start index This field contains the index location in the sequencer memory of the first command in the sequence associated with Sample Rate A detection. Valid from 0 to 255 (0FFh).
R98 (0062h) Sample Rate Sequence Select 2	8:0	WSEQ_SAMPLE _RATE_DETECT _B_INDEX [8:0]	1FFh	Sample Rate B Write Sequence start index This field contains the index location in the sequencer memory of the first command in the sequence associated with Sample Rate B detection. Valid from 0 to 255 (0FFh).
R99 (0063h) Sample Rate Sequence Select 3	8:0	WSEQ_SAMPLE _RATE_DETECT _C_INDEX [8:0]	1FFh	Sample Rate C Write Sequence start index This field contains the index location in the sequencer memory of the first command in the sequence associated with Sample Rate C detection. Valid from 0 to 255 (0FFh).
R100 (0064h) Sample Rate Sequence Select 4	8:0	WSEQ_SAMPLE _RATE_DETECT _D_INDEX [8:0]	1FFh	Sample Rate D Write Sequence start index This field contains the index location in the sequencer memory of the first command in the sequence associated with Sample Rate D detection. Valid from 0 to 255 (0FFh).

Table 113 Write Sequencer Control - Automatic Sample Rate Detection

JACK DETECT, GPIO, MICDET CLAMP, AND WAKE-UP SEQUENCES

The WM5102 supports external accessory detection and GPIO functions. The JD1 signal (associated with external accessory detection) and the GP5 signal (associated with the GPIO5 pin) can be used to trigger the Control Write Sequencer.

The JD1 signal is configured using the register bits described in Table 74. The GP5 signal is derived from the GPIO5 pin, which is configured using the register bits described in Table 85.

The MICDET Clamp is controlled by the JD1 and/or GP5 signals, as described in Table 75. The MICDET Clamp status can also be used to trigger the Control Write Sequencer.

A Control Write Sequence can be associated with a rising edge and/or a falling edge of the JD1, GP5 or MICDET Clamp. This is configured using the register bits described in Table 84.

If one of the selected logic conditions is detected, then the Control Write Sequencer will be triggered. The applicable start index location within the sequencer memory is separately configurable for each logic condition.

The WSEQ_GP5_RISE_INDEX register defines the sequencer start index corresponding to a GP5 Rising Edge event. Equivalent start index values are defined for the other logic conditions, as described in Table 114.

Note that a sequencer start index of 1FFh will cause the respective sequence to be aborted.

The JD1, GP5 and MICDET Clamp control sequences are undefined following initial power-up, but can be user-programmed during normal operation. Note that all control sequences are retained in the sequencer memory through Hardware Reset and Software Reset, provided DCVDD is held above its reset threshold. The control sequence memory is always retained in Sleep mode. Excluding Sleep mode, the control sequence memory is cleared if DCVDD falls below its reset threshold. See the "Applications Information" section for a summary of the WM5102 memory reset conditions.



See "Low Power Sleep Configuration" for further details of the JD1, GP5 and MICDET Clamp status signals. See also "General Purpose Input / Output" for details of the GPIO5 pin.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R102 (0066h) Always On Triggers Sequence Select 1	8:0	WSEQ_MICD_CL AMP_RISE_INDE X [8:0]	1FFh	MICDET Clamp (Rising) Write Sequence start index This field contains the index location in the sequencer memory of the first command in the sequence associated with MICDET Clamp (Rising) detection. Valid from 0 to 255 (0FFh).
R103 (0067h) Always On Triggers Sequence Select 2	8:0	WSEQ_MICD_CL AMP_FALL_INDE X [8:0]	1FFh	MICDET Clamp (Falling) Write Sequence start index This field contains the index location in the sequencer memory of the first command in the sequence associated with MICDET Clamp (Falling) detection. Valid from 0 to 255 (0FFh).
R104 (0068h) Always On Triggers Sequence Select 3	8:0	WSEQ_GP5_RIS E_INDEX [8:0]	1FFh	GP5 (Rising) Write Sequence start index This field contains the index location in the sequencer memory of the first command in the sequence associated with GP5 (Rising) detection. Valid from 0 to 255 (0FFh).
R105 (0069h) Always On Triggers Sequence Select 4	8:0	WSEQ_GP5_FAL L_INDEX [8:0]	1FFh	GP5 (Falling) Write Sequence start index This field contains the index location in the sequencer memory of the first command in the sequence associated with GP5 (Falling) detection. Valid from 0 to 255 (0FFh).
R106 (006Ah) Always On Triggers Sequence Select 5	8:0	WSEQ_JD1_RIS E_INDEX [8:0]	1FFh	JD1 (Rising) Write Sequence start index This field contains the index location in the sequencer memory of the first command in the sequence associated with JD1 (Rising) detection. Valid from 0 to 255 (0FFh).
R107 (006Bh) Always On Triggers Sequence Select 6	8:0	WSEQ_JD1_FAL L_INDEX [8:0]	1FFh	JD1 (Falling) Write Sequence start index This field contains the index location in the sequencer memory of the first command in the sequence associated with JD1 (Falling) detection. Valid from 0 to 255 (0FFh).

Table 114 Write Sequencer Control - JD1, GP5 and MICDET Clamp

DRC SIGNAL DETECT SEQUENCES

The Dynamic Range Control (DRC) function within the WM5102 Digital Core provides a configurable signal detect function. This allows the signal level at the DRC input to be monitored and used to trigger other events.

The DRC Signal Detect function is enabled and configured using the register fields described in Table 14

A Control Write Sequence can be associated with a rising edge and/or a falling edge of the DRC Signal Detect output. This is enabled using the DRC1_WSEQ_SIG_DET_ENA register bit.

When the DRC Signal Detect sequence is enabled, the Control Write Sequencer will be triggered whenever the Signal Detect output transitions (high or low). The applicable start index location within the sequencer memory is separately configurable for each logic condition.

The WSEQ_DRC1_SIG_DET_RISE_SEQ_INDEX register defines the sequencer start index corresponding to a DRC Signal Detect Rising Edge event, as described in Table 115. The WSEQ_DRC1_SIG_DET_FALL_SEQ_INDEX register defines the sequencer start index corresponding to a DRC Signal Detect Falling Edge event.

Note that a sequencer start index of 1FFh will cause the respective sequence to be aborted.

The DRC Signal Detect sequences cannot be independently enabled for rising and falling edges. Instead, a start index of 1FFh can be used to disable the sequence for either edge, if required.

The DRC Signal Detect control sequences are undefined following initial power-up, but can be user-programmed during normal operation. Note that all control sequences are retained in the sequencer memory through Hardware Reset and Software Reset, provided DCVDD is held above its reset threshold. The control sequence memory is always retained in Sleep mode. Excluding Sleep mode, the control sequence memory is cleared if DCVDD falls below its reset threshold. See the "Applications Information" section for a summary of the WM5102 memory reset conditions.

See "Digital Core"	for furthe	r details of the	Dynamic Rang	ge Control	(DRC) functio	n.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R110 (006Eh) Trigger Sequence Select 32	8:0	WSEQ_DRC1_SI G_DET_RISE_IN DEX [8:0]	1FFh	DRC1 Signal Detect (Rising) Write Sequence start index This field contains the index location in the sequencer memory of the first command in the sequence associated with DRC1 Signal Detect (Rising) detection. Valid from 0 to 255 (0FFh).
R111 (006Fh) Trigger Sequence Select 33	8:0	WSEQ_DRC1_SI G_DET_FALL_IN DEX [8:0]	1FFh	DRC1 Signal Detect (Falling) Write Sequence start index This field contains the index location in the sequencer memory of the first command in the sequence associated with DRC1 Signal Detect (Falling) detection. Valid from 0 to 255 (0FFh).

Table 115 Write Sequencer Control - DRC Signal Detect



SEQUENCER OUTPUTS AND READBACK

The status of the Write Sequencer can be read using the WSEQ_BUSY and WSEQ_CURRENT_INDEX registers, as described in Table 116.

When the WSEQ BUSY bit is asserted, this indicates that the Write Sequencer is busy.

The index address of the most recent Write Sequencer command can be read from the WSEQ_CURRENT_INDEX field. This can be used to provide a precise indication of the Write Sequencer progress.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R23 (0017h) Write	9	WSEQ_BUSY (read only)	0	Sequencer Busy flag (Read Only). 0 = Sequencer idle 1 = Sequencer busy
Sequencer Ctrl 1	8:0	WSEQ_CURREN T_INDEX [8:0] (read only)	000h	Sequence Current Index. This indicates the memory location of the most recently accessed command in the write sequencer memory. Coding is the same as WSEQ_START_INDEX.

Table 116 Write Sequencer Control - Status Readback

The Write Sequencer status is an input to the Interrupt control circuit and can be used to trigger an Interrupt event - see "Interrupts".

The Write Sequencer status can be output directly on a GPIO pin as an external indication of the Write Sequencer. See "General Purpose Input / Output" to configure a GPIO pin for this function.

PROGRAMMING A SEQUENCE

A Control Write Sequence comprises a series of write operations to data bits (or groups of bits) within the control register map. Each write operation is defined by a block of 2 registers, each containing 5 fields, as described below.

The block of 2 registers is replicated 256 times, defining each of the sequencer's 256 possible index addresses. Many sequences can be stored in the sequencer memory at the same time, with each assigned a unique range of index addresses.

The WSEQ DELAYn register is used to identify the 'end of sequence' position, as described below.

Note that, in the following descriptions, the term 'n' denotes the sequencer index address (valid from 0 to 255).

WSEQ_DATA_WIDTH*n* is a 3-bit field which identifies the width of the data block to be written. Note that the maximum value of this field selects a width of 8-bits; writing to register fields greater than 8 bits wide must be performed using two separate operations of the Write Sequencer.

WSEQ_ADDRn is a 13-bit field containing the register address in which the data should be written.

WSEQ_DELAYn is a 4-bit field which controls the waiting time between the current step and the next step in the sequence (ie. the delay occurs after the write in which it was called). The total delay time per step (including execution) is defined below, giving a useful range of execution/delay times from $3.3\mu s$ up to 1s per step. Setting this field to 0xF identifies the step as the last in the sequence.

If WSEQ_DELAYn = 0h or Fh, the step execution time is $3.3\mu s$

For all other values, the step execution time is 61.44µs x ((2 $^{\text{WSEQ_DELAY}}$) - 1)



WSEQ_DATA_STARTn is a 4-bit field which identifies the LSB position within the selected control register to which the data should be written. For example, setting WSEQ_DATA_STARTn = 0100 will select bit 4 as the LSB position of the data to be written.

WSEQ_DATA*n* is an 8-bit field which contains the data to be written to the selected control register. The WSEQ_DATA_WIDTH*n* field determines how many of these bits are written to the selected control register; the most significant bits (above the number indicated by WSEQ_DATA_WIDTH*n*) are ignored.

The register definitions for Step 0 are described in Table 117. The equivalent definitions also apply to Step 1 through to Step 255, in the subsequent register address locations.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R12288 (3000h) WSEQ Sequence 1	15:13	WSEQ_DATA_ WIDTH0 [2:0]	0h	Width of the data block written in this sequence step. 000 = 1 bit 001 = 2 bits 010 = 3 bits 011 = 4 bits 100 = 5 bits 101 = 6 bits 110 = 7 bits
	12:0	WSEQ_ADDR0 [12:0]	225h	111 = 8 bits Control Register Address to be written to in this sequence step.
R12289 (3001h) WSEQ Sequence 2	15:12	WSEQ_DELAY0 [3:0]	0h	Time delay after executing this step. 00h = 3.3us 01h to 0Eh = 61.44us x ((2^WSEQ_DELAY)-1) 0Fh = End of sequence marker
	11:8	WSEQ_DATA_S TART0 [3:0]	0h	Bit position of the LSB of the data block written in this sequence step. 0000 = Bit 0 1111 = Bit 15
	7:0	WSEQ_DATA0 [7:0]	01h	Data to be written in this sequence step. When the data width is less than 8 bits, then one or more of the MSBs of WSEQ_DATAn are ignored. It is recommended that unused bits be set to 0.

Table 117 Write Sequencer Control - Programming a Sequence

SEQUENCER MEMORY DEFINITION

The Write Sequencer memory defines up to 256 write operations; these are indexed as 0 to 255 in the sequencer memory map.

Following Power-On Reset (POR), the sequence memory will contain only the Headphone/Earpiece Enable and Headphone/Earpiece Disable sequence definitions. The remainder of the sequence memory will be undefined on power-up.

User-defined sequences can be programmed after power-up. Note that all control sequences are retained in the sequencer memory through Hardware Reset and Software Reset, provided DCVDD is held above its reset threshold. The control sequence memory is always retained in Sleep mode. Excluding Sleep mode, the control sequence memory is cleared if DCVDD falls below its reset threshold. See the "Applications Information" section for a summary of the WM5102 memory reset conditions.

The default control sequences can be overwritten in the sequencer memory, if required. Note that the headphone and earpiece output path enable registers (HPnx_ENA, EPn_ENA) will always trigger the Write Sequencer (at the pre-determined start index addresses).



Writing '1' to the WSEQ_LOAD_MEM bit will clear the sequencer memory to the POR state.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R24 (0018h) Write	0	WSEQ_LOAD_ MEM	0	Writing a 1 to this bit resets the sequencer memory to the POR state.
Sequencer Ctrl 2				

Table 118 Write Sequencer Control - Load Memory Control

User-defined sequences must be assigned space within the Write Sequencer memory. The start index for the user-defined sequences is configured using the registers described in Table 113 and Table 114.

The sequencer memory is illustrated in Figure 80. The pre-programmed sequencer index locations are highlighted. User-defined sequences should be programmed in other areas of the sequencer memory.

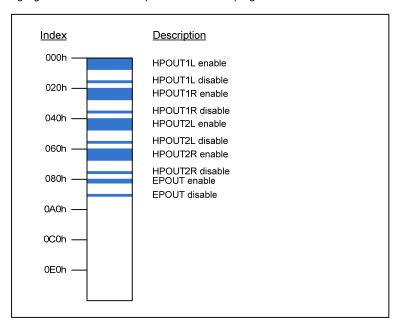


Figure 80 Write Sequencer Memory

Further details of the pre-programmed sequencer index locations are provided in Table 119.

SEQUENCE NAME	START INDEX	DEFAULT SEQUENCE INDEX RANGES
HPOUT1L Enable	0 (000h)	0 to 11
HPOUT1L Disable	24 (018h)	24 to 27
HPOUT1R Enable	32 (020h)	32 to 43
HPOUT1R Disable	56 (038h)	56 to 59
HPOUT2L Enable	64 (040h)	64 to 74
HPOUT2L Disable	88 (058h)	88 to 91
HPOUT2R Enable	96 (060h)	96 to 107
HPOUT2R Disable	120 (078h)	120 to 123
EPOUT Enable	128 (080h)	128 to 137
EPOUT Disable	144 (090h)	144 to 147

Table 119 Default Sequencer Memory Allocation



CHARGE PUMPS, REGULATORS AND VOLTAGE REFERENCE

The WM5102 incorporates two Charge Pump circuits and two LDO Regulator circuits to generate supply rails for internal functions and to support external microphone requirements. The WM5102 also provides three MICBIAS generators which provide low noise reference voltages suitable for biasing electret condenser (ECM) type microphones or powering digital microphones.

Refer to the "Applications Information" section for recommended external components.

CHARGE PUMPS AND LDO2 REGULATOR

Charge Pump 1 (CP1) is used to generate the positive and negative supply rails for the analogue output drivers. CP1 is enabled automatically by the WM5102 when required by the output drivers.

Charge Pump 2 (CP2) powers LDO2, which provides the supply rail for analogue input circuits and for the MICBIAS generators. CP2 and LDO2 are enabled using the CP2 ENA register bit.

The 32kHz clock must be configured and enabled when using CP2. See "Clocking and Sample Rates" for details of the system clocks.

When CP2 and LDO2 are enabled, the MICVDD voltage can be selected using the LDO2_VSEL control field. Note that, when one or more of the MICBIAS generators is operating in normal (regulator) mode, then the MICVDD voltage must be at least 200mV greater than the highest selected MICBIASn output voltage(s).

When CP2 and LDO2 are enabled, an internal bypass path may be selected, connecting the MICVDD pin directly to the CPVDD supply. This path is controlled using the CP2_BYPASS register. Note that the bypass path is only supported when CP2 is enabled.

When CP2 is disabled, the CP2VOUT pin can be configured to be floating or to be actively discharged. This is selected using the CP2_DISCH register bit.

When LDO2 is disabled, the MICVDD pin can be configured to be floating or to be actively discharged. This is selected using the LDO2_DISCH register bit.

The MICVDD pin is connected to the output of LDO2. Note that the MICVDD does not support direct connection to an external supply; MICVDD is always powered internally to the WM5102.

The Charge Pumps and LDO2 Regulator circuits are illustrated in Figure 81. The associated register control bits are described in Table 120.

Note that decoupling capacitors and flyback capacitors are required for these circuits. Refer to the "Applications Information" section for recommended external components.

MICBIAS BIAS (MICBIAS) CONTROL

There are three MICBIAS generators which provide low noise reference voltages suitable for biasing electret condenser (ECM) type microphones or powering digital microphones. Refer to the "Applications Information" section for recommended external components.

The MICBIAS generators are powered from MICVDD, which is generated by an internal Charge Pump and LDO, as illustrated in Figure 81.

The MICBIAS outputs can be independently enabled using the MICBn_ENA register bits (where n = 1, 2 or 3 for MICBIAS1, 2 or 3 respectively).

When a MICBIAS output is disabled, the output pin can be configured to be floating or to be actively discharged. This is selected using the MICBn_DISCH register bits.

The MICBIAS generators can each operate as a voltage regulator or in bypass mode. The applicable mode is selected using the MICBn_BYPASS registers.

In Regulator mode, the output voltage is selected using the MICBn_LVL register bits. In this mode, MICVDD must be at least 200mV greater than the required MICBIAS output voltages. The MICBIAS



outputs are powered from the MICVDD pin, and use the internal bandgap circuit as a reference.

In Regulator mode, the MICBIAS regulators are designed to operate without external decoupling capacitors. The regulators can be configured to support a capacitive load if required, using the MICBn_EXT_CAP register bits. (This may be appropriate for a digital microphone supply.) It is important that the external capacitance is compatible with the applicable MICBn_EXT_CAP setting. The compatible load conditions are detailed in the "Electrical Characteristics" section.

In Bypass mode, the output pin (MICBIAS1, MICBIAS2 or MICBIAS3) is connected directly to MICVDD. This enables a low power operating state. Note that the MICBn_EXT_CAP register settings are not applicable in Bypass mode; there are no restrictions on the external MICBIAS capacitance in Bypass mode.

The MICBIAS generators incorporate a pop-free control circuit to ensure smooth transitions when the MICBIAS outputs are enabled or disabled in Bypass mode; this feature is enabled using the MICBn_RATE registers.

The MICBIAS generators are illustrated in Figure 81. The MICBIAS control register bits are described in Table 120.

The maximum output current for each MICBIAS n pin is noted in the "Electrical Characteristics". This limit must be observed on each MICBIAS output, especially if more than one microphone is connected to a single MICBIAS pin. Note that the maximum output current differs between Regulator mode and Bypass mode.

VOLTAGE REFERENCE CIRCUIT

The WM5102 incorporates a voltage reference circuit, powered by AVDD. This circuit ensures the accuracy of the LDO Regulator and MICBIAS voltage settings.

LDO1 REGULATOR AND DCVDD SUPPLY

The LDO1 voltage regulator is intended for generating the DCVDD domain, which powers the digital core functions on the WM5102. In this configuration, the LDO output (LDOVOUT) should be connected to the DCVDD pin. Note that the use of the LDO1 regulator to power external circuits cannot be supported by the WM5102.

LDO1 is powered by LDOVDD and can be controlled using hardware or software controls. Note that, depending on the application requirements, it may be necessary to use both the hardware and software enables for LDO1, as described below.

Under hardware control, LDO1 is enabled when a logic '1' is applied to the LDOENA pin. The logic level is determined with respect to the DBVDD1 voltage domain. LDO1 is also enabled when the LDO1_ENA software control register is set to 1. Note that, to disable LDO1, the hardware and software controls must both be de-asserted.

When LDO1 is enabled, an internal bypass path may be selected, connecting the LDOVOUT pin directly to the LDOVDD supply. This path is controlled using the LDO1_BYPASS register. Note that the bypass path is only supported when LDO1 is enabled.

When LDO1 is disabled, the LDOVOUT pin can be configured to be floating or to be actively discharged. This is selected using the LDO1_DISCH register bit.

When LDO1 is enabled, the LDOVOUT voltage can be controlled using the LDO1_VSEL register. Setting LDO1_HI_PWR=1 will override the LDO1_VSEL register and select 1.8V LDO output voltage. Note that, under default conditions, LDO1_HI_PWR is set to '1'.

It is possible to supply DCVDD from an external supply. In this configuration, the LDOVOUT pin should be left floating; the LDOVOUT pin must not be connected to the DCVDD pin in this case.

For recommended use of the Sleep / Wake-Up functions (see "Low Power Sleep Configuration"), it is assumed that DCVDD is powered from the output of LDO1. In this case, Sleep mode is selected when LDO1 is disabled, causing the DCVDD supply to be removed. Note that the AVDD, DBVDD1, and LDOVDD supplies must be present throughout the Sleep mode duration.

If DCVDD is powered externally (not from LDO1), then the ISOLATE_DCVDD1 register bit must be



controlled as described in Table 120 when selecting WM5102 Sleep mode. In this case, Sleep mode is selected by setting the ISOLATE_DCVDD1 register bit, and then removing the DCVDD supply. For applications where DCVDD is powered externally, only the AVDD and DBVDD1 supplies are required in Sleep mode.

An internal pull-down resistor is enabled by default on the LDOENA pin. This is configurable using the LDO1ENA_PD register bit.

If DCVDD is powered from LDO1, then a logic '1' must be applied to the LDOENA pin during powerup, to enable LDO1. The LDO must also be enabled using the LDOENA pin following a Hardware Reset or Software Reset, to allow the device to re-start. (It is recommended that the LDOENA pin is asserted before any reset, and is held at logic '1' until after the reset is complete; this ensures the Write Sequencer and DSP firmware memory contents are retained, and also allows faster reset time.)

For normal operation following Power-On Reset (POR), Hardware Reset, or Software Reset, LDO1 must be enabled using the hardware or software controls described above. Note that when the LDO1_ENA bit is set to 1, the LDOENA pin has no effect and may be de-asserted - the LDO is then under software control, allowing Sleep mode to be selected under register control, including via the Control Write Sequencer.

See "Power-On Reset (POR) and Hardware Reset" and "Software Reset, Wake-Up, and Device ID" for details of WM5102 Resets. See also "Low Power Sleep Configuration" for details of the Sleep / Wake-up functions.

The LDO1 Regulator circuit is illustrated in Figure 81. The associated register control bits are described in Table 120.

Note that a decoupling capacitor is recommended. Refer to the "Applications Information" section for recommended external components.

BLOCK DIAGRAM AND CONTROL REGISTERS

The Charge Pump and Regulator circuits are illustrated in Figure 81. Note that decoupling capacitors and flyback capacitors are required for these circuits. Refer to the "Applications Information" section for recommended external components.



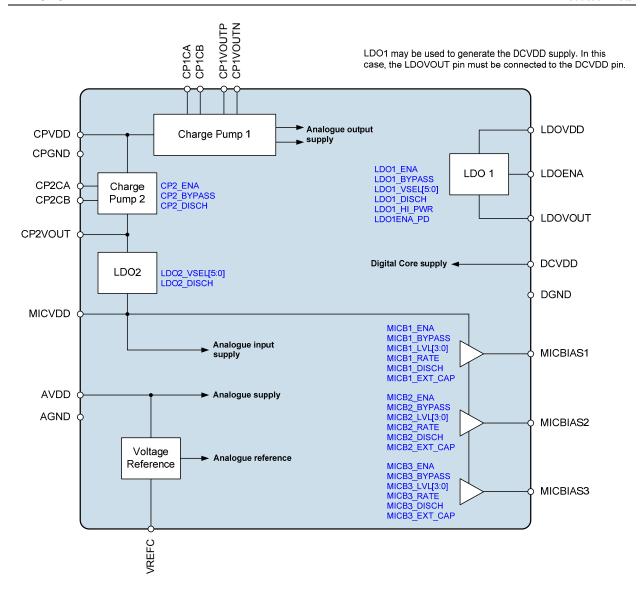


Figure 81 Charge Pumps and Regulators

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R512	2	CP2_DISCH	1	Charge Pump 2 Discharge
(0200h)				0 = CP2VOUT floating when disabled
Mic				1 = CP2VOUT discharged when disabled
Charge Pump 1	1	CP2_BYPASS	1	Charge Pump 2 and LDO2 Bypass Mode
Fullip I				0 = Normal
				1 = Bypass mode
				In Bypass mode, CPVDD is connected directly to MICVDD.
				Note that CP2_ENA must also be set.
	0	CP2_ENA	0	Charge Pump 2 and LDO2 Control
				(Provides analogue input and MICVDD supplies)
				0 = Disabled
				1 = Enabled

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R528 (0210h) LDO1 Control 1	10:5	LDO1_VSEL [5:0]	06h	LDO1 Output Voltage Select Controls the LDO1 output voltage when LDO1_HI_PWR=0. 00h = 0.9V 01h = 0.95V 02h = 1.0V 03h = 1.05V 04h = 1.1V 05h = 1.15V 06h = 1.2V 07h to 3Fh = Reserved
	2	LDO1_DISCH	1	LDO1 Discharge 0 = LDOVOUT floating when disabled 1 = LDOVOUT discharged when disabled
	1	LDO1_BYPASS	0	LDO1 Bypass Mode 0 = Normal 1 = Bypass mode In Bypass mode, LDOVDD is connected directly to LDOVOUT. Note that LDO1 ENA must also be set.
	0	LDO1_ENA	0	LDO1 Control 0 = Disabled 1 = Enabled
R530 (0212h) LDO1 Control 2	0	LDO1_HI_PWR	1	LDO1 Output Voltage Control 0 = Set by LDO1_VSEL 1 = 1.8V
R531 (0213h) LDO2 Control 1	10:5	LDO2_VSEL [5:0]	1Ah	LDO2 Output Voltage Select 00h = 1.7V 01h = 1.75V 02h = 1.8V 03h = 1.85V (50mV steps) 1Dh = 3.15V 1Eh = 3.2V 1Fh = 3.3V 20h to 3Fh = Reserved (See Table 121 for voltage range)
	2	LDO2_DISCH	1	LDO2 Discharge 0 = MICVDD floating when disabled 1 = MICVDD discharged when disabled
R536 (218h) Mic Bias Ctrl 1	15	MICB1_EXT_CA P	0	Microphone Bias 1 External Capacitor (when MICB1_BYPASS = 0). Configures the MICBIAS1 regulator according to the specified capacitance connected to the MICBIAS1 output. 0 = No external capacitor 1 = External capacitor connected
	8:5	MICB1_LVL [3:0]	Dh	Microphone Bias 1 Voltage Control (when MICB1_BYPASS = 0) 0h = 1.5V 1h = 1.6V (0.1V steps) Ch = 2.7V Dh to Fh = 2.8V



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION					
7.221.200	3	MICB1_RATE	0	Microphone Bias 1 Rate (Bypass mode) 0 = Fast start-up / shut-down 1 = Pop-free start-up / shut-down					
	2	MICB1_DISCH	1	Microphone Bias 1 Discharge 0 = MICBIAS1 floating when disabled 1 = MICBIAS1 discharged when disabled					
	1	MICB1_BYPASS	1	Microphone Bias 1 Mode 0 = Regulator mode 1 = Bypass mode					
	0	MICB1_ENA	0	Microphone Bias 1 Enable 0 = Disabled 1 = Enabled					
R537 (219h) Mic Bias Ctrl 2	15	MICB2_EXT_CA P	0	Microphone Bias 2 External Capacitor (when MICB2_BYPASS = 0). Configures the MICBIAS2 regulator according to the specified capacitance connected to the MICBIAS2 output. 0 = No external capacitor 1 = External capacitor connected					
	8:5	MICB2_LVL [3:0]	Dh	Microphone Bias 2 Voltage Control (when MICB2_BYPASS = 0) 0h = 1.5V 1h = 1.6V (0.1V steps) Ch = 2.7V Dh to Fh = 2.8V					
	3	MICB2_RATE	0	Microphone Bias 2 Rate (Bypass mode) 0 = Fast start-up / shut-down 1 = Pop-free start-up / shut-down					
	2	MICB2_DISCH	1	Microphone Bias 2 Discharge 0 = MICBIAS2 floating when disabled 1 = MICBIAS2 discharged when disabled					
	1	MICB2_BYPASS	1	Microphone Bias 2 Mode 0 = Regulator mode 1 = Bypass mode					
	0	MICB2_ENA	0	Microphone Bias 2 Enable 0 = Disabled 1 = Enabled					
R538 (21Ah) Mic Bias Ctrl 3	15	MICB3_EXT_CA P	0	Microphone Bias 3 External Capacitor (when MICB3_BYPASS = 0). Configures the MICBIAS3 regulator according to the specified capacitance connected to the MICBIAS3 output. 0 = No external capacitor 1 = External capacitor connected					
	8:5	MICB3_LVL [3:0]	Dh	Microphone Bias 3 Voltage Control (when MICB3_BYPASS = 0) 0h = 1.5V 1h = 1.6V (0.1V steps) Ch = 2.7V Dh to Fh = 2.8V					
	3	MICB3_RATE	0	Microphone Bias 3 Rate (Bypass mode) 0 = Fast start-up / shut-down 1 = Pop-free start-up / shut-down					



REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
	2	MICB3_DISCH	1	Microphone Bias 3 Discharge
				0 = MICBIAS3 floating when disabled
				1 = MICBIAS3 discharged when disabled
	1	MICB3_BYPASS	1	Microphone Bias 3 Mode
				0 = Regulator mode
				1 = Bypass mode
	0	MICB3_ENA	0	Microphone Bias 3 Enable
				0 = Disabled
				1 = Enabled
R3104	15	LDO1ENA_PD	1	LDOENA Pull-Down Control
(0C20h)				0 = Disabled
Misc Pad Ctrl 1				1 = Enabled
R715	0	ISOLATE_DCVD	0	Always-On power domain isolate control
(02CBh) Isolation control		D1		Set this bit to 1 to isolate the 'Always-On' domain from the DCVDD pin.
				If DCVDD is powered externally (not from LDO1), this bit must be set before selecting Sleep mode (ie. before removing the external DCVDD supply).
				If DCVDD is powered from LDO1, then there is no requirement to set this bit.
				This bit is automatically reset to 0 following a Wake-up transition (from Sleep mode).

Table 120 Charge Pump and LDO Control Registers

LDO2_VSEL [5:0]	LDO2 OUTPUT	LDO2_VSEL [5:0]	LDO2 OUTPUT
00h	1.70V	10h	2.50V
01h	1.75V	11h	2.55V
02h	1.80V	12h	2.60V
03h	1.85V	13h	2.65V
04h	1.90V	14h	2.70V
05h	1.95V	15h	2.75V
06h	2.00V	16h	2.80V
07h	2.05V	17h	2.85V
08h	2.10V	18h	2.90V
09h	2.15V	19h	2.95V
0Ah	2.20V	1Ah	3.00V
0Bh	2.25V	1Bh	3.05V
0Ch	2.30V	1Ch	3.10V
0Dh	2.35V	1Dh	3.15V
0Eh	2.40V	1Eh	3.20V
0Fh	2.45V	1Fh	3.30V

Table 121 LDO2 Voltage Control

JTAG INTERFACE

The JTAG interface provides test and debug access to the WM5102 DSP core. The interface comprises 5 pins, as detailed below.

TCK: Clock input

TDI: Data input

TDO: Data output

• TMS: Mode select input

TRST: Test Access Port reset input (active low, internal pull-down)

For normal operation (test and debug access disabled), the JTAG interface should be held in reset (ie. TRST should be at logic 0). An internal pull-down resistor holds the TRST pin low when not actively driven.

The other JTAG input pins (TCK, TDI, TMSDSP) should also be held at logic 0 for normal operation.

THERMAL SHUTDOWN

The WM5102 incorporates a temperature sensor which detects when the device temperature is within normal limits or if the device is approaching a hazardous temperature condition.

The temperature sensor is an input to the Interrupt control circuit and can be used to trigger an Interrupt event - see "Interrupts".

The Warning Temperature and Shutdown Temperature status flags can be output directly on a GPIO pin as an external indication of the temperature sensor. See "General Purpose Input / Output" to configure a GPIO pin for this function.

It is strongly recommended that the speaker drivers be disabled if the Shutdown Temperature condition occurs.



POWER-ON RESET (POR) AND HARDWARE RESET

The WM5102 will remain in the reset state until AVDD, DBVDD1 and DCVDD are all above their respective reset thresholds. Note that specified device performance is not assured outside the voltage ranges defined in the "Recommended Operating Conditions" section.

The RESET input must be asserted (logic 0) during power-up, and held asserted until after the AVDD, DBVDD1 and DCVDD supplies are within the recommended operating limits. If DCVDD is powered from internal LDO, then the DCVDD supply must be enabled using the LDOENA pin, and the RESET pin held asserted until at least 1.5ms after the LDO has been enabled.

Refer to "Recommended Operating Conditions" for the WM5102 power-up sequencing requirements.

If DCVDD is powered from LDO1, then the DCVDD supply must be enabled using the LDOENA pin for the initial power-up. Note that subsequent interruption to DCVDD should only be permitted as part of a control sequence for entering Sleep mode.

After the initial power-up, the Power-On Reset will be re-scheduled following an interruption to the DBVDD1 or AVDD supplies. Note that the AVDD supply must always be maintained whenever the DCVDD supply is present.

The WM5102 provides a Hardware Reset function, which is executed whenever the RESET input is asserted (logic 0). The RESET input is active low and is referenced to the DBVDD1 power domain.

A Hardware Reset causes most of the WM5102 control registers to be reset to their default states. Note that the Control Write Sequencer memory and DSP firmware memory contents are retained during Hardware Reset - provided DCVDD is held above its reset threshold.

See the "Applications Information" section for a summary of the WM5102 memory reset conditions.

If DCVDD is powered from LDO1, it is recommended that the LDOENA pin is asserted (logic 1) before the Hardware Reset; this ensures the Write Sequencer and DSP memory contents are retained, and also allows faster reset time. If LDOENA is not asserted prior to the reset, then LDO1 will be disabled, and the power-up requirements described above must be followed.

If the WM5102 SLIMbus component is in its operational state, then it must be reset prior to scheduling a Hardware Reset or Power-On Reset. See "SLIMbus Interface Control" for details of the SLIMbus reset control messages.

An internal pull-up resistor is enabled by default on the RESET pin; this can be configured using the RESET_PU register bit described in Table 122.

REGISTER ADDRESS		LABEL	DEFAULT	DESCRIPTION
R3104 (0C20h) Misc Pad Ctrl 1	1	RESET_PU	1	RESET Pull-up enable 0 = Disabled 1 = Enabled

Table 122 Reset Pull-Up Configuration



Following Power-On Reset (POR), Hardware Reset or Software Reset, a Boot Sequence is executed. The BOOT_DONE_STS register is asserted on completion of the Boot Sequence, as described in Table 123. Control register writes should not be attempted until the BOOT_DONE_STS register has been asserted.

The BOOT_DONE_STS signal is an input to the Interrupt control circuit and can be used to trigger an Interrupt event - see "Interrupts". Under default register conditions, (including following POR, Hardware Reset or Software Reset), a falling edge on the $\overline{\mbox{IRQ}}$ pin will indicate completion of the Boot Sequence.

REGISTER ADDRESS		LABEL	DEFAULT	DESCRIPTION
R3363 (0D23h)	8	BOOT_DONE_S TS	0	Boot Status 0 = Busy (boot sequence in progress)
Interrupt Raw Status 5				1 = Idle (boot sequence completed) Control register writes should not be attempted until Boot Sequence has completed.

Table 123 Device Boot-Up Status

Following Power-On Reset (POR), Hardware Reset, Software Reset, or Wake-Up (from Sleep mode), a sequence of device initialisation writes must be executed, as detailed in Table 124.

The host system should ensure that the WM5102 is ready before attempting these (or any other) Control Register writes.

In the case of Power-On Reset (POR), Hardware Reset or Software Reset, the initialisation settings should be written after the BOOT_DONE_STS bit has been asserted (also indicated by a falling edge of the $\overline{\text{IRQ}}$ pin).

In the case of Wake-Up (from Sleep mode), then at least 1.5ms must be allowed from the Wake-Up event before writing to any Control Registers. Note that, in a typical implementation, the Interrupt circuit is configured to provide indication of the Wake-Up event.

	WM5102 INITIALISATION								
1	Write 0x0001 to Register R25 (0x0019)								
2	Write 0xE022 to Register R129 (0x0081)								
3	Write 0x0000 to Register R724 (0x02D4)								
4	Write 0x000C to Register R862 (0x035E)								
5	Write 0xDC1A to Register R1091 (0x0443)								
6	Write 0x0066 to Register R1200 (0x04B0								
7	Write 0x0001 to Register R1307 (0x051B)								
8	Write 0x0001 to Register R1371 (0x055B)								
9	Write 0x0001 to Register R1435 (0x059B)								

Table 124 Device Initialisation Register Settings

The WM5102 is in Sleep mode when AVDD and DBVDD1 are present, and DCVDD is below its reset threshold. (Note that specific control requirements are also applicable for entering Sleep mode, as described in "Low Power Sleep Configuration".)

In Sleep mode, most of the Digital Core (and control registers) are held in reset; selected functions and control registers are maintained via an 'Always-On' internal supply domain. See "Low Power Sleep Configuration" for details of the 'Always-On' functions.

See "Software Reset, Wake-Up, and Device ID" for details of the Wake-Up transition (exit from Sleep mode).



Table 125 describes the default status of the WM5102 digital I/O pins on completion of Power-On Reset or Hardware Reset, prior to any register writes. The same default conditions are also applicable on completion of a Hardware Reset or Software Reset (see "Software Reset, Wake-Up, and Device ID").

The same default conditions are applicable following a Wake-Up transition, except for the GPIO5, IRQ, LDOENA, MCLK2 and RESET pins. These are 'Always-On' pins whose configuration is unchanged in Sleep mode and during a Wake-Up transition.

PIN NO	NAME	TYPE	RESET STATUS				
MICVDD p	ower domain						
E3	IN1LN / DMICCLK1	Analogue Input / Digital Output	Analogue input				
E1	IN1RN / DMICDAT1	Analogue input / Digital Input	Analogue input				
C1	IN2LN / DMICCLK2	Analogue Input / Digital Output	Analogue input				
D1	IN2RN / DMICDAT2	Analogue input / Digital Input	Analogue input				
A1	IN3LN / DMICCLK3	Analogue Input / Digital Output	Analogue input				
B1	IN3RN / DMICDAT3	Analogue input / Digital Input	Analogue input				
DBVDD1 p	ower domain						
J13	AIF1BCLK	Digital Input / Output	Digital input				
J11	AIF1RXDAT	Digital Input	Digital input				
J12	AIF1LRCLK	Digital Input / Output	Digital input				
J8	AIF1TXDAT	Digital Output	Digital output				
L13	CIF1ADDR	Digital Input	Digital input,				
			Pull-down to DGND				
K12	CIF1SCLK	Digital Input	Digital input				
K11	CIF1SDA	Digital Input / Output	Digital input				
M13	CIF2MOSI	Digital Input	Digital input				
K9	CIF2MISO	Digital Output	Digital output				
L12	CIF2SCLK	Digital Input	Digital input				
L11	CIF2SS	Digital Input	Digital input				
K13	GPIO1	Digital Input / Output	Digital input, Pull-down to DGND				
K10	GPIO4	Digital Input / Output	Digital input, Pull-down to DGND				
G10	GPIO5	Digital Input / Output	Digital input, Pull-down to DGND				
F13	ĪRQ	Digital Output	Digital output				
F11	LDOENA	Digital Input	Digital input, Pull-down to DGND				
H13	MCLK1	Digital Input	Digital input				
F12	MCLK2	Digital Input	Digital input				
E13	RESET	Digital Input	Digital input, Pull-up to DBVDD1				
H12	SLIMCLK	Digital Input / Output	Digital input				
H11	SLIMDAT	Digital Input / Output	Digital input				
L10	SPKCLK	Digital Output	Digital output				
K8	SPKDAT	Digital Output	Digital output				
L9	TCK	Digital Input	Digital input				
M11	TDI	Digital Input	Digital input				
K6	TDO	Digital Output	Digital output				
K7	TMS	Digital Input	Digital input				
M12	TRST	Digital Input	Digital input, Pull-down to DGND				



PIN NO	NAME	TYPE	RESET STATUS				
	ower domain	11112	RESET STATES				
K5	AIF2BCLK	Digital Input / Output	Digital input				
M9	AIF2RXDAT	Digital Input	Digital input				
L8	AIF2LRCLK	Digital Input / Output	Digital input				
L6	AIF2TXDAT	Digital Output	Digital output				
L7	GPIO2	Digital Input / Output	Digital input, Pull-down to DGND				
DBVDD3 p	ower domain	•					
L5	AIF3BCLK	Digital Input / Output	Digital input				
K4	AIF3RXDAT	Digital Input	Digital input				
M5	AIF3LRCLK	Digital Input / Output	Digital input				
L4	AIF3TXDAT	Digital Output	Digital output				
K3	GPIO3	Digital Input / Output	Digital input, Pull-down to DGND				

Table 125 WM5102 Digital I/O Status in Reset

Note that the dual function INnLN/DMICCLKn and INnRN/DMICDATn pins default to their respective analogue input functions after Power-On Reset is completed. The analogue input functions are referenced to the MICVDD power domain.

SOFTWARE RESET, WAKE-UP, AND DEVICE ID

A Software Reset is executed by writing any value to register R0. A Software Reset causes most of the WM5102 control registers to be reset to their default states. Note that the Control Write Sequencer memory and DSP firmware memory contents are retained during Software Reset.

A Wake-Up transition (from Sleep mode) is similar to a Software Reset, but selected functions and control registers are maintained via an 'Always-On' internal supply domain. The 'Always-On' registers are not reset during Wake-Up. See "Low Power Sleep Configuration" for details of the 'Always-On' functions

The Control Write Sequencer and DSP Firmware memory contents are retained during Software Reset - provided DCVDD is held above its reset threshold.

The Control Write Sequencer memory contents are retained during Sleep mode; the DSP memory contents are reset during Sleep mode.

See the "Applications Information" section for a summary of the WM5102 memory reset conditions.

If DCVDD is powered from LDO1, it is recommended that the LDOENA pin is asserted (logic 1) before a Software Reset; this ensures the Write Sequencer and DSP memory contents are retained, and also allows faster reset time. If LDOENA is not asserted prior to the reset, then LDO1 will be disabled, and the power-up sequencing requirements described in "Power-On Reset (POR) and Hardware Reset" must be followed.

Following Power-On Reset (POR), Hardware Reset or Software Reset, a Boot Sequence is executed. The BOOT_DONE_STS register (see Table 123) is de-asserted during any Reset, and is asserted on completion of the boot-up sequence. Control register writes should not be attempted until the BOOT_DONE_STS register has been asserted.

The BOOT_DONE_STS signal is an input to the Interrupt control circuit and can be used to trigger an Interrupt event - see "Interrupts".

Following Power-On Reset (POR), Hardware Reset, Software Reset, or Wake-Up (from Sleep mode), a sequence of device initialisation writes must be executed, as detailed in Table 126.

The host system should ensure that the WM5102 is ready before attempting these (or any other) Control Register writes.

In the case of Power-On Reset (POR), Hardware Reset or Software Reset, the initialisation settings should be written after the BOOT_DONE_STS bit has been asserted (also indicated by a falling edge of the $\overline{\text{IRQ}}$ pin).

In the case of Wake-Up (from Sleep mode), then at least 1.5ms must be allowed from the Wake-Up event before writing to any Control Registers. Note that, in a typical implementation, the Interrupt circuit is configured to provide indication of the Wake-Up event.

	WM5102 INITIALISATION								
1	Write 0x0001 to Register R25 (0x0019)								
2	Write 0xE022 to Register R129 (0x0081)								
3	Write 0x0000 to Register R724 (0x02D4)								
4	Write 0x000C to Register R862 (0x035E)								
5	Write 0xDC1A to Register R1091 (0x0443)								
6	Write 0x0066 to Register R1200 (0x04B0								
7	Write 0x0001 to Register R1307 (0x051B)								
8	Write 0x0001 to Register R1371 (0x055B)								
9	Write 0x0001 to Register R1435 (0x059B)								

Table 126 Device Initialisation Register Settings



The status of the WM5102 digital I/O pins following Hardware Reset, Software Reset or Wake-Up is described in the "Power-On Reset (POR) and Hardware Reset" section.

The Device ID can be read back from Register R0. The Revision can be read back from Register R1.

REGISTER ADDRESS	BIT	LABEL	DEFAULT	DESCRIPTION
R0 (0000h) Software	15:0	SW_RST_DEV_ ID [15:0]	5102h	Writing to this register resets all registers to their default state.
Reset				Reading from this register will indicate Device ID 5102h.
R1 (0001h) Device Revision	7:0	DEVICE_REVIS ION [7:0]		Device revision

Table 127 Device Reset and ID

REGISTER MAP

The WM5102 control registers are listed below. Note that only the register addresses described here should be accessed; writing to other addresses may result in undefined behaviour. Register bits that are not documented should not be changed from the default values.

values.	1		T	1	T	1	T	T	T	1	1	T	1	T	1	1	1	1
REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R0 (0h)	Software Reset		1		1		1	i '	_RST_DEV_ID [15:0]							5102h		
R1 (1h)	Device Revision	0	0	0	0	0	0	0	0 DEVICE_REVISION [7:0]									
R8 (8h)	Ctrl IF SPI CFG 1	0	0	0	0	0	0	0	0	0	0	0	SPI_C FG	0	0	SPI_AUTO_IN C [1:0]		0011h
R9 (9h)	Ctrl IF I2C1 CFG 1	0	0	0	0	0	0	0	0	0	0	0	0	0	0		UTO_IN [1:0]	0001h
R22 (16h)	Write Sequencer Ctrl 0	0	0	0	0	WSEQ _ABO RT	WSEQ _STAR T	WSEQ _ENA	WSEQ_START_INDEX [8:0]							0000h		
R23 (17h)	Write Sequencer Ctrl 1	0	0	0	0	0	0	WSEQ _BUS Y							0000h			
R24 (18h)	Write Sequencer Ctrl 2	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	WSEQ _LOA D_ME M	0000h
R32 (20h)	Tone Generator 1	0	7	TONE_R	ATE [3:0)]	0		' 					TONE 1_ENA	0000h			
R33 (21h)	Tone Generator 2							1	TONE1_LVL [23:8]							1000h		
R34 (22h)	Tone Generator 3	0	0	0	0	0	0	0	0 TONE1_LVL [7:0]							0000h		
R35 (23h)	Tone Generator 4		•					1	ONE2_I	LVL [23:8	8]							1000h
R36 (24h)	Tone Generator 5	0	0	0	0	0	0	0	0				TONE2	LVL [7:0	1			0000h
R48 (30h)	PWM Drive 1	0		PWM_R	ATE [3:0]	PWM_	PWM_CLK_SEL [2:0]						PWM1 _ENA	0000h			
R49 (31h)	PWM Drive 2	0	0	0	0	0	0			1	II.	PWM1_	LVL [9:0]		II.			0100h
R50 (32h)	PWM Drive 3	0	0	0	0	0	0					PWM2_	LVL [9:0]					0100h
R64 (40h)	Wake control	0	0	0	0	0	0	0	0	WKUP _MICD _CLA MP_F ALL	WKUP _MICD _CLA MP_RI SE		WKUP _GP5_ RISE	WKUP _JD1_ FALL	WKUP _JD1_ RISE	0	0	0000h
R65 (41h)	Sequence control	0	0	0	0	0	0	0	0	WSEQ _ENA_ MICD_ CLAM P_FAL L	WSEQ _ENA_ MICD_ CLAM P_RIS E	WSEQ _ENA_ GP5_F ALL	WSEQ _ENA_ GP5_ RISE	WSEQ _ENA_ JD1_F ALL	WSEQ _ENA_ JD1_R ISE	0	0	0000h
R97 (61h)	Sample Rate Sequence Select 1	0	0	0	0	0	0	0		WS	EQ_SAN	IPLE_R/	ATE_DE	TECT_A	_INDEX	[8:0]		01FFh
R98 (62h)	Sample Rate Sequence Select 2	0	0	0	0	0	0	0		WS	EQ_SAN	IPLE_R/	ATE_DE	TECT_B	_INDEX	[8:0]		01FFh
R99 (63h)	Sample Rate Sequence Select 3	0	0	0	0	0	0	0		WSI	EQ_SAN	IPLE_R/	ATE_DE	TECT_C	_INDEX	[8:0]		01FFh
R100 (64h)	Sample Rate Sequence Select 4	0	0	0	0	0	0	0		WSI	EQ_SAN	IPLE_R/	ATE_DE	TECT_D	_INDEX	[8:0]		01FFh
R102 (66h)	Always On Triggers Sequence Select 1	0	0	0	0	0	0	0			WSEQ_	MICD_C	LAMP_F	RISE_INI	DEX [8:0]		01FFh
R103 (67h)	Always On Triggers Sequence Select 2	0	0	0	0	0	0	0			WSEQ_	MICD_C	LAMP_F	ALL_INI	DEX [8:0]		01FFh
R104 (68h)	Always On Triggers Sequence Select 3	0	0	0	0	0	0	0			WS	SEQ_GP	5_RISE_	INDEX [[8:0]			01FFh



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REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R105 (69h)	Always On Triggers Sequence Select 4	0	0	0	0	0	0	0			WS	SEQ_GP	5_FALL_	INDEX	[8:0]			01FFh
R106 (6Ah)	Always On Triggers Sequence Select 5	0	0	0	0	0	0	0	WSEQ_JD1_RISE_INDEX [8:0]									01FFh
R107 (6Bh)	Always On Triggers Sequence Select 6	0	0	0	0	0	0	0	WSEQ_JD1_FALL_INDEX [8:0]								01FFh	
R110 (6Eh)	Trigger Sequence Select 32	0	0	0	0	0	0	0		١	WSEQ_D	RC1_SI	G_DET_	RISE_IN	IDEX [8:	0]		01FFh
R111 (6Fh)	Trigger Sequence Select 33	0	0	0	0	0	0	0) WSEQ_DRC1_SIG_DET_FALL_INDEX [8:0]						01FFh			
R112 (70h)	Comfort Noise Generator	0	NOI	SE_GEN	N_RATE	[3:0]	0	0	0	0	0	NOISE _GEN ENA		NOISE_	_GEN_G	AIN [4:0]		0000h
R144 (90h)	Haptics Control 1	0		HAP_RA	ATE [3:0]		0	0	0 0 0 0 ONES HAP_CTRL HAP_ 0 HOT_ [1:0] ACT						0000h			
R145 (91h)	Haptics Control 2	0					1		LRA	_FREQ	[14:0]		1			1		7FFFh
R146 (92h)	Haptics phase 1 intensity	0	0	0	0	0	0	0	0		-	PHA	SE1_IN1	ENSITY	′ [7:0 <u>]</u>			0000h
R147 (93h)	Haptics phase 1 duration	0	0	0	0	0	0	0			F	PHASE1	_DURA1	10N [8:0)]			0000h
R148 (94h)	Haptics phase 2 intensity	0	0	0	0	0	0	0	0	PHASE2_INTENSITY [7:0]							0000h	
R149 (95h)	Haptics phase 2 duration	0	0	0	0	0				F	PHASE2_	DURAT	ION [10:	0]				0000h
R150 (96h)	Haptics phase 3 intensity	0	0	0	0	0	0	0	0			PHA	SE3_IN1	ENSITY	′ [7:0 <u>]</u>			0000h
R151 (97h)	Haptics phase 3 duration	0	0	0	0	0	0	0			F	PHASE3	_DURAT	10N [8:0)]			0000h
R152 (98h)	Haptics Status	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	ONES HOT_ STS	0000h
R256 (100h)	Clock 32k 1	0	0	0	0	0	0	0	0	0	CLK_3 2K_EN A	0	0	0	0		2K_SRC :0]	0002h
R257 (101h)	System Clock 1	SYSC LK_FR AC	0	0	0	0	SYSC	LK_FRE	Q [2:0]	0	SYSC LK_EN A	0	0	S	SYSCLK	_SRC [3:	0]	0304h
R258 (102h)	Sample rate 1	0	0	0	0	0	0	0	0	0	0	0		SAMPL	E_RATI	E_1 [4:0]		0011h
R259 (103h)	Sample rate 2	0	0	0	0	0	0	0	0	0	0	0		SAMPL	E_RATI	 2 [4:0]		0011h
R260 (104h)	Sample rate 3	0	0	0	0	0	0	0	0	0	0	0		SAMPL	E_RATI	E_3 [4:0]		0011h
R266 (10Ah)	Sample rate 1 status	0	0	0	0	0	0	0	0	0	0	0	S	AMPLE_	RATE_	1_STS [4	:0]	0000h
R267 (10Bh)	Sample rate 2 status	0	0	0	0	0	0	0	0	0	0	0	S	AMPLE_	RATE_2	2_STS [4	:0]	0000h
R268 (10Ch)	Sample rate 3 status	0	0	0	0	0	0	0	0	0	0	0	S	AMPLE_	RATE_3	3_STS [4	:0]	0000h
R274 (112h)	Async clock 1	0	0	0	0	0	ASYN	C_CLK_ [2:0]	FREQ	0	ASYN C_CLK _ENA	0	0	AS'	YNC_CL	K_SRC	[3:0]	0305h
R275 (113h)	Async sample rate	0	0	0	0	0	0	0	0	0	0	0	AS'	YNC_SA	MPLE_F	RATE_1	[4:0]	0011h
R276 (114h)	Async sample rate 2	0	0	0	0	0	0	0	0	0	0	0	AS	YNC_SA	MPLE_F	RATE_2	[4:0]	0011h
R283 (11Bh)	Async sample rate 1 status	0	0	0	0	0	0	0	0	0	0	0	ASYN	C_SAMF	PLE_RA	TE_1_ST	TS [4:0]	0000h



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REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT					
R284 (11Bh)	Async sample rate 2 status	0	0	0	0	0	0	0	0	0	0	0	ASYN	C_SAMF	PLE_RAT	1E_2_S7	S [4:0]	0000h					
R329 (149h)	Output system clock	OPCL K_EN A	0	0	0	0	0	0	0		OPC	CLK_DIV	[4:0]		OPC	CLK_SEL	. [2:0]	0000h					
R330 (14Ah)	Output async clock	OPCL K_ASY NC_E NA	0	0	0	0	0	0	0		OPCLK_	ASYNC.	_DIV [4:()]	OPCLI	K_ASYN [2:0]	IC_SEL	0000h					
R338 (152h)	Rate Estimator 1	0	0	0	0	0	0	0	0	0	0	0	TRIG_ ON_S TART UP	LRC	LK_SRC	[2:0]	RATE_ EST_E NA	0000h					
R339 (153h)	Rate Estimator 2	0	0	0	0	0	0	0	0	0	0	0	SAN	IPLE_R	ATE_DE	TECT_A	[4:0]	0000h					
R340 (154h)	Rate Estimator 3	0	0	0	0	0	0	0	0	0	0	0	SAN	IPLE_R	ATE_DE	TECT_B	[4:0]	0000h					
R341 (155h)	Rate Estimator 4	0	0	0	0	0	0	0	0	0	0	0	SAN	IPLE_RA	ATE_DE	TECT_C	[4:0]	0000h					
R342 (156h)	Rate Estimator 5	0	0	0	0	0	0	0	0	0	0	0	SAN	IPLE_R	ATE_DE	TECT_D	[4:0]	0000h					
R353 (161h)	Dynamic Frequency Scaling 1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	SUBS YS_M AX_FR EQ	0000h					
R369 (171h)	FLL1 Control 1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	FLL1_ FREE RUN	FLL1_ ENA	0002h					
R370 (172h)	FLL1 Control 2	FLL1_ CTRL_ UPD	0	0	0	0	0					FLL1_	LL1_N [9:0]										
R371 (173h)	FLL1 Control 3							F	LL1_TH	ETA [15:	0]							0018h					
R372 (174h)	FLL1 Control 4		1				1	FL	L1_LAN	1BDA [15	5:0]							007Dh					
R373 (175h)	FLL1 Control 5	0	0	0	0	0	FLL1	_FRATIO) [2:0]	0	0	0	0	FLL1	_OUTDI	V [2:0]	0	0004h					
R374 (176h)	FLL1 Control 6	0	0	0	0	0	0	0	0		REFCLK ' [1:0]	0	0	FLL	1_REFC	LK_SRC	[3:0]	0000h					
R377 (179h)	FLL1 Control 7	0	0	0	0	0	0	0	0	0	0		FLL1_G	AIN [3:0]	0	0	0000h					
R385 (181h)	FLL1 Synchroniser 1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	FLL1_ SYNC _ENA	0000h					
R386 (182h)	FLL1 Synchroniser 2	0	0	0	0	0	0				F	LL1_SY	NC_N [9	:0]				0000h					
R387 (183h)	FLL1 Synchroniser 3							FLL1	_SYNC_	_THETA	[15:0]							0000h					
R388 (184h)	FLL1 Synchroniser 4							FLL1_	_SYNC_I	LAMBDA	[15:0]							0000h					
R389 (185h)	FLL1 Synchroniser 5	0	0	0	0	0	FLL1_	SYNC_F [2:0]	RATIO	0	0	0	0	0	0	0	0	0000h					
R390 (186h)	FLL1 Synchroniser 6	0	0	0	0	0	0	0	0	FLL1_S K_DI	SYNCCL V [1:0]	0	0	FLL1	_SYNC0	CLK_SR	C [3:0]	0000h					
R391 (187h)	FLL1 Synchroniser 7	0	0	0	0	0	0	0	0	0	0	FLI	FLL1_SYNC_GAIN [3:0] 0 FLL1_ SYNC _DFSA 										
R393 (189h)	FLL1 Spread Spectrum	0	0	0	0	0	0	0	0	0	0		SS_AMP 1:0]		SS_FRE [1:0]		SS_SEL :0]	0000h					
R394 (18Ah)	FLL1 GPIO Clock	0	0	0	0	0	0	0	0	FLL1_GPCLK_DIV [6:0] FLL1_ GPCL K_EN A													



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R401 (191h)	FLL2 Control 1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	FLL2_ FREE RUN	FLL2_ ENA	0000h
R402 (192h)	FLL2 Control 2	FLL2_ CTRL_ UPD	0	0	0	0	0					FLL2_	N [9:0]	ı				0008h
R403 (193h)	FLL2 Control 3			•			•	F	LL2_TH	ETA [15:	0]							0018h
R404 (194h)	FLL2 Control 4							FLL2_LAMBDA [15:0]										007Dh
R405 (195h)	FLL2 Control 5	0	0	0	0	0	FLL2	_FRATIC	0 [2:0]	0	0	0	0	FLL2	_OUTDI	V [2:0]	0	0004h
R406 (196h)	FLL2 Control 6	0	0	0	0	0	0	0	0	0 FLL2_REFCLK 0 0 FLL2_REFCLK_SRC [3:0]DIV [1:0]								0000h
R409 (199h)	FLL2 Control 7	0	0	0	0	0	0	0	0	0	0		FLL2_G	AIN [3:0]		0	0	0000h
R417 (1A1h)	FLL2 Synchroniser 1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	FLL2_ SYNC _ENA	0000h
R418 (1A2h)	FLL2 Synchroniser 2	0	0	0	0	0	0				F	LL2_SYI	_SYNC_N [9:0]					
R419 (1A3h)	FLL2 Synchroniser 3							FLL2	SYNC_	_THETA	[15:0]			0000h				
R420 (1A4h)	FLL2 Synchroniser 4						ī	FLL2_	SYNC_	LAMBDA	[15:0]	ı	1	ī	ı	ı	ı	0000h
R421 (1A5h)	FLL2 Synchroniser 5	0	0	0	0	0	FLL2_	SYNC_F [2:0]	RATIO	0	0	0	0	0	0	0	0	0000h
R422 (1A6h)	FLL2 Synchroniser 6	0	0	0	0	0	0	0	0	FLL2_S K_DI	YNCCL V [1:0]	0	0	FLL2	_SYNC0	CLK_SR(C [3:0]	0000h
R423 (1A7h)	FLL2 Synchroniser 7	0	0	0	0	0	0	0	0	0	0	FLL	2_SYN	C_GAIN	[3:0]	0	FLL2_ SYNC _DFSA T	0001h
R425 (1A9h)	FLL2 Spread Spectrum	0	0	0	0	0	0	0	0	0	0		S_AMP 1:0]	FLL2_S	SS_FRE [1:0]		SS_SEL :0]	0000h
R426 (1AAh)	FLL2 GPIO Clock	0	0	0	0	0	0	0	0			FLL2_G	SPCLK_I	DIV [6:0]			FLL2_ GPCL K_EN A	0004h
R512 (200h)	Mic Charge Pump 1	0	0	0	0	0	0	0	0	0	0	0	0	0	CP2_D ISCH	CP2_B YPAS S	CP2_E NA	0006h
R528 (210h)	LDO1 Control 1	0	0	0	0	0			LDO1_V	'SEL [5:0]		0	0	LDO1_ DISCH	LDO1_ BYPA SS	LDO1_ ENA	00D4h
R530 (212h)	LDO1 Control 2	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	LDO1_ HI_PW R	0001h
R531 (213h)	LDO2 Control 1	0	0	0	0	0			LDO2_V	SEL [5:0]		0	0	LDO2_ DISCH	0	0	0344h
R536 (218h)	Mic Bias Ctrl 1	MICB1 _EXT_ CAP	0	0	0	0	0	0		MICB1_	LVL [3:0]	0	MICB1 _RATE		MICB1 _BYPA SS		01A6h
R537 (219h)	Mic Bias Ctrl 2	MICB2 _EXT_ CAP	0	0	0	0	0	0		MICB2_LVL [3:0] 0 MICB2 MICB2 MICB2 MICB					01A6h			
R538 (21Ah)	Mic Bias Ctrl 3	MICB3 _EXT_ CAP	0	0	0	0	0	0		_RATE _DISC _B					MICB3 _BYPA SS		01A6h	
R549 (0225h)	HP Ctrl 1L	0	RMV_ SHRT _HP1L	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0400h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R550 (0226h)		0	RMV	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0400h
			SHRT _HP1R															
R659 (293h)	Accessory Detect Mode 1	0	0	ACCD ET_SR C	0	0	0	0	0	0	0	0	0	0	0		T_MOD 1:0]	0000h
R667 (29Bh)	Headphone Detect 1	0	0	0	0	0	CE_R	PEDAN ANGE :0]	0	HP_H	OLDTIM	E [2:0]	0	0	0	HP_R ATE	HP_P OLL	0020h
R668 (29Ch)	Headphone Detect 2	HP_D ONE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0000h
R671 (29Fh)	Headphone Detect Test	0	0	0	0	0	0				ŀ	HP_DAC	VAL [9:0)]				0000h
R674 (2A2h)	Micd Clamp control	0	0	0	0	0	0	0	0	0	0	0	0	MICE	D_CLAMI	P_MODE	[3:0]	0000h
R675 (2A3h)	Mic Detect 1	MICD_	BIAS_S	ΓARTTIN	ME [3:0]		MICD_R	ATE [3:0]	0	0	_	BIAS_S [1:0]	0	0	MICD_ DBTIM E	MICD_ ENA	1102h
R676 (2A4h)	Mic Detect 2	0	0	0	0	0	0	0	0			М	ICD_LVL	_SEL [7	7:0]			009Fh
R677 (2A5h)	Mic Detect 3	0	0	0	0	0				MIC	CD_LVL	[8:0]				MICD_ VALID	MICD_ STS	0000h
R707 (2C3h)	Mic noise mix control 1	0	MI	CMUTE_	RATE [3	3:0]	0	0	0	MICM UTE_ NOISE _ENA	MICM UTE_ MIX_E NA	0	0	0	0	0	0	0000h
R715 (2CBh)	Isolation control	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	ISOLA TE_D CVDD 1	0000h
R723 (2D3h)	Jack detect analogue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	JD1_E NA	0000h
R768 (300h)	Input Enables	0	0	0	0	0	0	0	0	0	0	IN3L_ ENA	IN3R_ ENA	IN2L_ ENA	IN2R_ ENA	IN1L_ ENA	IN1R_ ENA	0000h
R769 (301h)	Input Enables Status	0	0	0	0	0	0	0	0	0	0	IN3L_ ENA_ STS	IN3R_ ENA_ STS	IN2L_ ENA_ STS	IN2R_ ENA_ STS	IN1L_ ENA_ STS	IN1R_ ENA_ STS	0000h
R776 (308h)	Input Rate	0		IN_RA	TE [3:0]		0	0	0	0	0	0	0	0	0	0	0	0000h
R777 (309h)	Input Volume Ramp	0	0	0	0	0	0	0	0	0	IN_V	D_RAMF	P [2:0]	0	IN_V	'I_RAMP	[2:0]	0022h
R784 (310h)	IN1L Control	0	IN1_08	SR [1:0]		/IIC_SU 1:0]	_	MODE :0]	0			IN1L_	PGA_VC	DL [6:0]			0	2080h
R785 (311h)	ADC Digital Volume 1L	0	0	0	0	0	0	IN_VU	IN1L_ MUTE				IN1L_V	OL [7:0]				0180h
R786 (312h)	DMIC1L Control	0	0	0	0	0	0	0	0	0	0		IN	1_DMIC	L_DLY [5	5:0]	T	0000h
R788 (314h)	IN1R Control	0	0	0	0	0	0	0	0			IN1R_	PGA_VC	DL [6:0]			0	0080h
R789 (315h)	ADC Digital Volume 1R	0	0	0	0	0	0	IN_VU	IN1R_ MUTE		ı		IN1R_V	OL [7:0]				0180h
R790 (316h)	DMIC1R Control	0	0	0	0	0	0	0	0	0	0		IN	1_DMICI	R_DLY [5:0]	1	0000h
R792 (318h)	IN2L Control	0	IN2_08	SR [1:0]	IN2_DN P [MIC_SU 1:0]	_	MODE :0]	0			IN2L_PGA_VOL [6:0] 0						2080h
R793 (319h)	ADC Digital Volume 2L	0	0	0	0	0	0	IN_VU	IN2L_ MUTE		ı		IN2L_V	OL [7:0]				0180h
R794 (31Ah)	DMIC2L Control	0	0	0	0	0	0	0	0	0	0		IN	2_DMIC	L_DLY [5	5:0]	,	0000h
R796 (31Ch)	IN2R Control	0	0	0	0	0	0	0	0			IN2R_	PGA_VC				0	0080h
R797 (31Dh)	ADC Digital Volume 2R	0	0	0	0	0	0	IN_VU	IN2R_ MUTE		í		IN2R_VOL [7:0]					
R798 (31Eh)	DMIC2R Control	0	0	0	0	0	0	0	0	0	0		IN:	2_DMICI	R_DLY [5:0]		0000h



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REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT	
R800 (320h)	IN3L Control	0	IN3_08	SR [1:0]	IN3_DN P [MIC_SU 1:0]	_	MODE :0]	0			IN3L_	PGA_VC	DL [6:0]			0	2080h	
R801 (321h)	ADC Digital Volume 3L	0	0	0	0	0	0	IN_VU	IN3L_ MUTE				IN3L_V	OL [7:0]				0180h	
R802 (322h)	DMIC3L Control	0	0	0	0	0	0	0	0	0	0		IN	3_DMIC	L_DLY [5:0]		0000h	
R804 (324h)	IN3R Control	0	0	0	0	0	0	0	0	IN3R_PGA_VOL [6:0] 0									
R805 (325h)	ADC Digital Volume 3R	0	0	0	0	0	0	IN_VU	IN3R_ MUTE		IN3R_VOL [7:0]								
R806 (326h)	DMIC3R Control	0	0	0	0	0	0	0	0	0	0		IN:	3_DMICI	R_DLY [5:0]		0000h	
R1024 (400h)	Output Enables 1	0	0	0	0	0	0	OUT5L _ENA	OUT5 R_EN A	OUT4L _ENA	OUT4 R_EN A	EP_E NA	0	HP2L_ ENA	HP2R_ ENA	HP1L_ ENA	HP1R_ ENA	0000h	
R1025 (401h)	Output Status 1	0	0	0	0	0	0	OUT5L _ENA_ STS	OUT5 R_EN A_STS	OUT4L _ENA_ STS	OUT4 R_EN A_STS	0	0	0	0	0	0	0000h	
R1030 (406h)	Raw Output Status 1	0	0	0	0	0	0	0	0	0	0	OUT3_ ENA_ STS	0	OUT2L _ENA_ STS	OUT2 R_EN A_STS	OUT1L _ENA_ STS	OUT1 R_EN A_STS	0000h	
R1032 (408h)	Output Rate 1	0		OUT_RA	ATE [3:0]		0	0	0	0	0	0	0	0	0	0	0	0000h	
R1033 (409h)	Output Volume Ramp	0	0	0	0	0	0	0	0	0	OUT_	VD_RAM	1P [2:0]	0	OUT_	VI_RAM	P [2:0]	0022h	
R1040 (410h)	Output Path Config 1L		FREQ_ E_LIM :0]	OUT1_ OSR	OUT1_ MONO	0	0	0	0	1	0	0	0	0	0	0	0	0080h	
R1041 (411h)	DAC Digital Volume 1L	0	0	0	0	0	0	OUT_ VU	OUT1L _MUT E	OUT1L_VOL [7:0]									
R1042 (412h)	DAC Volume Limit 1L	0	0	0	0	0	0	0	0			Ol	JT1L_VC	DL_LIM [7:0]			0081h	
R1043 (413h)	Noise Gate Select 1L	0	0	0	0					OUT	L_NGA	TE_SRC	[11:0]	_		_		0001h	
R1044 (414h)	Output Path Config 1R	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0080h	
R1045 (415h)	DAC Digital Volume 1R	0	0	0	0	0	0	OUT_ VU	OUT1 R_MU TE			(OUT1R_	VOL [7:0	0]			0180h	
R1046 (416h)	DAC Volume Limit 1R	0	0	0	0	0	0	0	0			OL	JT1R_VC	OL_LIM [[7:0]			0081h	
R1047 (417h)	Noise Gate Select 1R	0	0	0	0					OUT1	R_NGA	TE_SRC	[11:0]					0002h	
R1048 (418h)	Output Path Config 2L		FREQ_ E_LIM :0]	OUT2_ OSR	OUT2_ MONO	0	0	0	0	1	0	0	0	0	0	0	0	0080h	
R1049 (419h)	DAC Digital Volume 2L	0	0	0	0	0	0	OUT_ VU	OUT2L _MUT _E				OUT2L_	VOL [7:0)]			0180h	
R1050 (41Ah)	DAC Volume Limit 2L	0	0	0	0	0	0	0	0	OUT2L_VOL_LIM [7:0]							0081h		
R1051 (41Bh)	Noise Gate Select 2L	0	0	0	0					OUT2L_NGATE_SRC [11:0]							0004h		
R1052 (41Ch)	Output Path Config 2R	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0080h	
R1053 (41Dh)	DAC Digital Volume 2R	0	0	0	0	0	0	OUT_ VU	OUT2 R_MU TE									0180h	
R1054 (41Eh)	DAC Volume Limit 2R	0	0	0	0	0	0	0	0			OL	JT2R_VC	OL_LIM [[7:0]			0081h	



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT	
R1055 (41Fh)	Noise Gate Select 2R	0	0	0	0					OUT2	R_NGA	TE_SRC	[11:0]					0008h	
R1056 (420h)	Output Path Config 3L		FREQ_ E_LIM :0]	OUT3_ OSR	OUT3_ MONO	0	0	0	0	1	0	0	0	0	0	0	0	0080h	
R1057 (421h)	DAC Digital Volume 3L	0	0	0	0	0	0	OUT_ VU	OUT3_ MUTE				OUT3_\	/OL [7:0]]			0180h	
R1058 (422h)	DAC Volume Limit 3L	0	0	0	0	0	0	0	0			Ol	JT3_VO	L_LIM [7	7:0]			0081h	
R1059 (423h)	Noise Gate Select 3L	0	0	0	0					OUT	3_NGAT	E_SRC	[11:0]					0010h	
R1064 (428h)	Output Path Config 4L	0	0	OUT4_ OSR	0	0	0	0	0	0	0	0	0	0	0	0	0	0000h	
R1065 (429h)	DAC Digital Volume 4L	0	0	0	0	0	0	OUT_ VU	OUT4L _MUT E				OUT4L_'	VOL [7:0)]			0180h	
R1066 (42Ah)	Out Volume 4L	0	0	0	0	0	0	0	0			OL	JT4L_VC	L_LIM [7:0]			0081h	
R1067 (42Bh)	Noise Gate Select 4L	0	0	0	0					OUT4	IL_NGA	TE_SRC	[11:0]					0040h	
R1069 (42Dh)	DAC Digital Volume 4R	0	0	0	0	0	0	OUT_ VU	OUT4 R_MU TE			(OUT4R_	VOL [7:0)]			0180h	
R1070 (42Eh)	Out Volume 4R	0	0	0	0	0	0	0	0			OU	IT4R_VC	L_LIM [7:0]			0081h	
R1071 (42Fh)	Noise Gate Select 4R	0	0	0	0					OUT4	R_NGA	TE_SRC	[11:0]					0080h	
R1072 (430h)	Output Path Config 5L	0	0	OUT5_ OSR	0	0	0	0	0	0	0	0	0	0	0	0	0	0000h	
R1073 (431h)	DAC Digital Volume 5L	0	0	0	0	0	0	OUT_ VU	OUT5L _MUT E			1	OUT5L_'	VOL [7:0)]			0180h	
R1074 (432h)	DAC Volume Limit 5L	0	0	0	0	0	0	0	0			OL	JT5L_VC)L_LIM [7:0]			0081h	
R1075 (433h)	Noise Gate Select 5L	0	0	0	0					OUTS	SL_NGA	TE_SRC	[11:0]					0100h	
R1077 (435h)	DAC Digital Volume 5R	0	0	0	0	0	0	OUT_ VU	OUT5 R_MU TE			(OUT5R_	VOL [7:0)]			0180h	
R1078 (436h)	DAC Volume Limit 5R	0	0	0	0	0	0	0	0			OU	IT5R_VC	DL_LIM [7:0]			0081h	
R1079 (437h)	Noise Gate Select 5R	0	0	0	0					OUT5	iR_NGA	TE_SRC	[11:0]					0200h	
R1104 (450h)	DAC AEC Control 1	0	0	0	0	0	0	0	0	0	0	AEC_	LOOPBA	ACK_SR	C [3:0]	AEC_ ENA_ STS	AEC_L OOPB ACK_ ENA	0000h	
R1112 (458h)	Noise Gate Control	0	0	0	0	0	0	0	0	0 0 NGATE_HOLD NGATE_THR [2:0] NGAT [1:0]								0001h	
R1168 (490h)	PDM SPK1 CTRL 1	0	0	SPK1 R_MU TE	SPK1L _MUT E	0	0	0	SPK1_ MUTE _ENDI AN		SPK1_MUTE_SEQ [7:0]								
R1169 (491h)	PDM SPK1 CTRL 2	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	SPK1_ FMT	0000h	
R1280 (500h)	AIF1 BCLK Ctrl	0	0	0	0	0	0	0	0	AIF1_ AIF1_ AIF1_BCLK_FREQ [4:0]								000Ch	



UEC	MAME	45	4.4	42	42	44	40	^	0	7	e	_	4	•	•	4	^	DEEALUT			
REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT			
R1281 (501h)	AIF1 IX PIN CTI	0	0	0	0	0	0	0	0	0	0	AIF1T X_DAT	0	AIF1T	AIF1T X_LRC	AIF1T	AIF1T	0008h			
												_TRI		_	LK_IN	_	_				
														С	٧	С	STR				
R1282 (502h)	AIF1 Rx Pin Ctrl	0	0	0	0	0	0	0	0	0	0	0	0	0		AIF1R	AIF1R	0000h			
															_	X_LRC	_				
															LK_IN V	LK_FR C	STR				
R1283 (503h)	AIF1 Rate Ctrl	0		AIF1_RA	TF [3:0]		0	0	0	0	AIF1_	0	0	0	0	0	0	0000h			
111200 (00011)		Ŭ		TRI											000011						
R1284 (504h)	AIF1 Format	0	0	0	0	0	0	0	0	0	0	0	0	0	AIF	1_FMT [2:0]	0000h			
R1285 (505h)	AIF1 Tx BCLK	0	0	0 AIF1TX_BCPF [12:0]										0040h							
	Rate																				
,	AIF1 Rx BCLK	0	0	0 AIF1RX_BCPF [12:0]												0040h					
	Rate									1								1818h			
	AIF1 Frame Ctrl 1	0	0				WL [5:0]						AIF1TX_SLOT_LEN [7:0]								
(/	AIF1 Frame Ctrl 2	0	0				_WL [5:0]					AIF1		DT_LEN				1818h			
	AIF1 Frame Ctrl 3	0	0	0	0	0	0	0	0	0	0		Al	F1TX1_	SLOT [5	:0]		0000h			
	AIF1 Frame Ctrl 4	0	0	0	0	0	0	0	0	0	0		Al	F1TX2_	SLOT [5	0]		0001h			
	AIF1 Frame Ctrl 5	0	0	0	0	0	0	0	0	0	0		Al	F1TX3_	SLOT [5	:0]		0002h			
R1292 (50Ch)	AIF1 Frame Ctrl 6	0	0	0	0	0	0	0	0	0	0		Al	F1TX4_S	SLOT [5	:0]		0003h			
R1293 (50Dh)	AIF1 Frame Ctrl 7	0	0	0	0	0	0	0	0	0	0		Al	F1TX5_	SLOT [5	:0]		0004h			
R1294 (50Eh)	AIF1 Frame Ctrl 8	0	0	0	0	0	0	0	0	0	0		Al	F1TX6_	SLOT [5	:0]		0005h			
R1295 (50Fh)	AIF1 Frame Ctrl 9	0	0	0	0	0	0	0	0	0	0		Al	F1TX7_S	SLOT [5	:0]		0006h			
R1296 (510h)	AIF1 Frame Ctrl 10	0	0	0	0	0	0	0	0	0	0		Al	F1TX8_	SLOT [5	:0]		0007h			
R1297 (511h)	AIF1 Frame Ctrl 11	0	0	0	0	0	0	0	0	0	0		Al	F1RX1_	SLOT [5	:0]		0000h			
R1298 (512h)	AIF1 Frame Ctrl 12	0	0	0	0	0	0	0	0	0	0		Al	F1RX2_	SLOT [5	:0]		0001h			
R1299 (513h)	AIF1 Frame Ctrl 13	0	0	0	0	0	0	0	0	0	0		Al	F1RX3_	SLOT [5	:0]		0002h			
R1300 (514h)	AIF1 Frame Ctrl 14	0	0	0	0	0	0	0	0	0	0		Al	F1RX4_	SLOT [5	:0]		0003h			
R1301 (515h)	AIF1 Frame Ctrl 15	0	0	0	0	0	0	0	0	0	0		Al	F1RX5_	SLOT [5	:0]		0004h			
R1302 (516h)	AIF1 Frame Ctrl 16	0	0	0	0	0	0	0	0	0	0		Al	F1RX6_	SLOT [5	:0]		0005h			
R1303 (517h)	AIF1 Frame Ctrl 17	0	0	0	0	0	0	0	0	0	0		Al	F1RX7_	SLOT [5	:0]		0006h			
R1304 (518h)	AIF1 Frame Ctrl 18	0	0	0	0	0	0	0	0	0	0		Al	F1RX8_	SLOT [5	:0]		0007h			
R1305 (519h)	AIF1 Tx Enables	0	0	0	0	0	0	0	0	AIF1T	AIF1T	AIF1T	AIF1T	AIF1T	AIF1T	AIF1T	AIF1T	0000h			
, ,														X4_EN							
										Α	Α	Α	Α	Α	Α	Α	Α				
R1306 (51Ah)	AIF1 Rx Enables	0	0	0	0	0	0	0	0	AIF1R	AIF1R			AIF1R		AIF1R		0000h			
										X8_EN	X/_EN A	X6_EN	X5_EN A	X4_EN A	X3_EN	X2_EN A	X1_EN A				
R1344 (540h)	AIE2 BCLK Ctrl	0	0	0	0	0	0	0	0	AIF2_	AIF2_	AIF2	- / \	AIF2_B				000Ch			
K1344 (34011)	All 2 BOLK Out	U	U	U	U	U	U	0	U	BCLK_	BCLK_	BCLK_		All Z_D	OLN_I IN	LQ [4.0]		0000011			
										INV	FRC	MSTR									
R1345 (541h)	AIF2 Tx Pin Ctrl	0	0	0	0	0	0	0	0	0	0	AIF2T	0		AIF2T			0008h			
												X_DAT		X_LRC							
												_TRI		LK_SR C	LK_IN	C C	STR				
R1346 (542h)	AIF2 Rx Pin Ctrl	0	0	0	0	0	0	0	0	0	0	0	0	0		AIF2R		0000h			
0 10 (07211)	2	Ĭ								ľ						X_LRC		000011			
															LK_IN	LK_FR	LK_M				
															V	С	STR				
R1347 (543h)	AIF2 Rate Ctrl	0		AIF2_RA	ATE [3:0]		0	0	0	0	AIF2_	0	0	0	0	0	0	0000h			
D4240 (544b)	AIE2 Format		0	_	0	_			_	_	TRI	_	0 0 AIF2_FMT [2:0]								
R1348 (544h)		0	0	0	0	0	0	0	0	0	0 X_BCPF	0	U	U	AIF	∠_rMI[∠:U]	0000h 0040h			
R1349 (545h)	ALEO TA DOLLA	0																			



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT			
R1350 (546h)	AIF2 Rx BCLK Rate	0	0	0						AIF2R	X_BCPF	[12:0]						0040h			
R1351 (547h)	AIF2 Frame Ctrl 1	0	0			AIF2TX_	WL [5:0	1				AIF2	TX_SL	OT_LEN	[7:0]			1818h			
	AIF2 Frame Ctrl 2	0	0			AIF2RX_								OT_LEN				1818h			
R1353 (549h)	AIF2 Frame Ctrl 3	0	0	0	0	0	0	0	0	0	0		Α	IF2TX1_	SLOT [5	5:0]		0000h			
R1354 (54Ah)	AIF2 Frame Ctrl 4	0	0	0	0	0	0	0	0	0	0		Α	IF2TX2_	SLOT [5	5:0]		0001h			
R1361 (551h)	AIF2 Frame Ctrl 11	0	0	0	0	0	0	0	0	0	0		Α	IF2RX1_	SLOT [5	5:0]		0000h			
R1362 (552h)	AIF2 Frame Ctrl 12	0	0	0	0	0	0	0	0 0 0 AIF2RX2_SLOT [5:0]												
R1369 (559h)	AIF2 Tx Enables	0	0	0	0	0	0	0	0	0	0	0	0	0	0	AIF2T X2_EN A	AIF2T X1_EN A	0000h			
R1370 (55Ah)	AIF2 Rx Enables	0	0	0	0	0	0	0	0	0	0	0	0	0	0	AIF2R X2_EN A	AIF2R X1_EN A	0000h			
R1408 (580h)	AIF3 BCLK Ctrl	0	0	0	0	0	0	0	0	AIF3_ BCLK_ INV	AIF3_ BCLK_ FRC	AIF3_ BCLK_ MSTR	CLK_								
R1409 (581h)	AIF3 Tx Pin Ctrl	0	0	0	0	0	0	0	0	0	0	AIF3T X_DAT _TRI	0	X_LRC	_	AIF3T X_LRC LK_FR C	_	0008h			
R1410 (582h)	AIF3 Rx Pin Ctrl	0	0	0	0	0	0	0	0	0	0	0	0	0	X_LRC	AIF3R X_LRC LK_FR C		0000h			
R1411 (583h)	AIF3 Rate Ctrl	0		AIF3_RA	ATE [3:0]		0	0	0	0	AIF3_ TRI	3_ 0 0 0 0 0 0									
R1412 (584h)	AIF3 Format	0	0	0	0	0	0	0	0	0	0	0	0	0	Alf	-3_FMT [2:0]	0000h			
R1413 (585h)	AIF3 Tx BCLK Rate	0	0	0						AIF3T	X_BCPF	[12:0]						0040h			
R1414 (586h)	AIF3 Rx BCLK Rate	0	0	0						AIF3R	X_BCPF	[12:0]						0040h			
R1415 (587h)	AIF3 Frame Ctrl 1	0	0			AIF3TX_	_WL [5:0]					AIF3	STX_SL	OT_LEN	[7:0]			1818h			
R1416 (588h)	AIF3 Frame Ctrl 2	0	0			AIF3RX_	_WL [5:0					AIF3	RX_SL	OT_LEN	[7:0]			1818h			
R1417 (589h)	AIF3 Frame Ctrl 3	0	0	0	0	0	0	0	0	0	0		Α	IF3TX1_	SLOT [5	5:0]		0000h			
	AIF3 Frame Ctrl 4	0	0	0	0	0	0	0	0	0	0		Α	IF3TX2_	SLOT [5	5:0]		0001h			
	AIF3 Frame Ctrl 11	0	0	0	0	0	0	0	0	0	0		Α	IF3RX1_	SLOT [5	5:0]		0000h			
R1426 (592h)	AIF3 Frame Ctrl 12	0	0	0	0	0	0	0	0	0	0		Α	IF3RX2_	SLOT [5	5:0]		0001h			
R1433 (599h)	AIF3 Tx Enables	0	0	0	0	0	0	0	0	0	0	0	0	0	0	AIF3T X2_EN A	AIF3T X1_EN A	0000h			
R1434 (59Ah)	AIF3 Rx Enables	0	0	0	0	0	0	0	0	0	0	0	0	0	0	AIF3R X2_EN A	AIF3R X1_EN A	0000h			
R1498 (05DAh)	SLIMbus RX Ports0	0	0												0100h						
R1499 (05DBh)	SLIMbus RX Ports1	0	0	SLIMRX4_PORT_ADDR [5:0] 0 0 SLIMRX3_PORT_ADDR [5:0]											0302h						
R1500 (05DCh)	SLIMbus RX Ports2	0	0		SLIMF	RX6_POF	RT_ADD	R [5:0]		0	0		SLIMI	RX5_POI	RT_ADD	OR [5:0]		0504h			
R1501 (05DDh)	SLIMbus RX Ports3	0	0												0706h						
R1502 (05DEh)	SLIMbus TX Ports0	0	0		SLIMT	TX2_POF	RT_ADD	R [5:0]		0	0		SLIM	TX1_POI	RT_ADD	OR [5:0]		0908h			
R1503 (05DFh)	SLIMbus TX Ports1	0	0	SLIMTX4_PORT_ADDR [5:0] 0 0 SLIMTX3_PORT_ADDR [5:0]											0B0Ah						



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R1504 (05E0h)	SLIMbus TX Ports2	0	0		SLIM	TX6_POF	RT_ADD	R [5:0]		0	0		SLIM	TX5_POF	RT_ADD	R [5:0]		0D0Ch
R1505 (05E1h)	SLIMbus TX Ports3	0	0		SLIM	TX8_POF	RT_ADD	R [5:0]	_	0	0		SLIM	TX7_POF	RT_ADD	R [5:0]		0F0Eh
R1507 (5E3h)	SLIMbus Framer Ref Gear	0	0	0	0	0	0	0	0	0	0	0	SLIMC LK_SR C		CLK_RE	F_GEAF	R [3:0]	0004h
R1509 (5E5h)	SLIMbus Rates 1	0	SL	IMRX2_	RATE [3	3:0]	0	0	0	0	SI	IMRX1_	_RATE [3	3:0]	0	0	0	0000h
R1510 (5E6h)	SLIMbus Rates 2	0	SL	IMRX4_	RATE [3	3:0]	0	0	0	0	SI	IMRX3_	_RATE [3	3:0]	0	0	0	0000h
R1511 (5E7h)	SLIMbus Rates 3	0	SL	.IMRX6_	RATE [3	3:0]	0	0	0	0	SI	IMRX5_	_RATE [3	3:0]	0	0	0	0000h
R1512 (5E8h)	SLIMbus Rates 4	0	SL	.IMRX8_	RATE [3	3:0]	0	0	0	0	SI	IMRX7_	_RATE [3	3:0]	0	0	0	0000h
R1513 (5E9h)	SLIMbus Rates 5	0	SL	.IMTX2_	RATE [3	3:0]	0	0	0	0	SI	_IMTX1_	RATE [3	3:0]	0	0	0	0000h
R1514 (5EAh)	SLIMbus Rates 6	0	SL	.IMTX4_	RATE [3	3:0]	0	0	0	0	SI	_IMTX3_	RATE [3	3:0]	0	0	0	0000h
R1515 (5EBh)	SLIMbus Rates 7	0	SL	.IMTX6_	RATE [3	3:0]	0	0	0	0	SI	_IMTX5_	RATE [3	3:0]	0	0	0	0000h
R1516 (5ECh)	SLIMbus Rates 8	0	SL	_8XTMI	RATE [3	3:0]	0	0	0	0	SI	_IMTX7_	RATE [3	3:0]	0	0	0	0000h
R1525 (5F5h)	SLIMbus RX Channel Enable	0	0	0	0	0	0	0	0	X8_EN	X7_EN	X6_EN	X5_EN	SLIMR X4_EN	X3_EN	X2_EN	_	0000h
R1526 (5F6h)	SLIMbus TX Channel Enable	0	0	0	0	0	0	0	0		A SLIMT X7_EN A		-	A SLIMT X4_EN A	SLIMT X3_EN A			0000h
R1527 (5F7h)	SLIMbus RX Port Status	0	0	0	0	0	0	0	0	SLIMR X8_PO	SLIMR X7_PO	SLIMR X6_PO	SLIMR X5_PO	SLIMR X4_PO RT_ST S	SLIMR X3_PO	SLIMR X2_PO	SLIMR X1_PO	0000h
R1528 (5F8h)	SLIMbus TX Port Status	0	0	0	0	0	0	0	0	SLIMT X8_PO	SLIMT X7_PO	SLIMT X6_PO	SLIMT X5_PO		SLIMT X3_PO	SLIMT X2_PO	SLIMT X1_PO	
R1600 (640h)	PWM1MIX Input 1 Source	PWM1 MIX_S TS1	0	0	0	0	0	0	0			PV	VM1MIX	_SRC1 [7	7:0]		ı	0000h
R1601 (641h)	PWM1MIX Input 1 Volume	0	0	0	0	0	0	0	0			PWM1	MIX_VO	DL1 [6:0]			0	0080h
R1602 (642h)	PWM1MIX Input 2 Source	PWM1 MIX_S TS2	0	0	0	0	0	0	0			PV	VM1MIX	_SRC2 [7	7:0]			0000h
R1603 (643h)	PWM1MIX Input 2 Volume	0	0	0	0	0	0	0	0			PWM1	MIX_VO	L2 [6:0]			0	0080h
R1604 (644h)	PWM1MIX Input 3 Source	PWM1 MIX_S TS3	0	0	0	0	0	0	0			PV	VM1MIX	_SRC3 [7	7:0]			0000h
R1605 (645h)	PWM1MIX Input 3 Volume	0	0	0	0	0	0	0	0			PWM1	MIX_VO	L3 [6:0]			0	0080h
R1606 (646h)	PWM1MIX Input 4 Source	PWM1 MIX_S TS4	0	0	0	0	0	0	0			PV	VM1MIX	_SRC4 [7	7:0]			0000h
R1607 (647h)	PWM1MIX Input 4 Volume	0	0	0	0	0	0	0	0			PWM1	MIX_VO	0L4 [6:0]			0	0080h
R1608 (648h)	PWM2MIX Input 1 Source	PWM2 MIX_S TS1	0	0	0	0	0	0	0			PV	VM2MIX	_SRC1 [7	7:0]			0000h
R1609 (649h)	PWM2MIX Input 1 Volume	0	0	0	0	0	0	0	0			PWM2	MIX_VO	DL1 [6:0]			0	0080h
R1610 (64Ah)	PWM2MIX Input 2 Source	PWM2 MIX_S TS2	0	0	0	0	0	0	0			PV	VM2MIX	_SRC2 [7	7:0]			0000h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2		1		0	DEFAULT
R1611 (64Bh)	PWM2MIX Input 2 Volume	0	0	0	0	0	0	0	0			PWM2	2MIX_V	OL2 [6:0]]				0	0080h
R1612 (64Ch)	PWM2MIX Input 3 Source	PWM2 MIX_S TS3	0	0	0	0	0	0	0			P\	WM2MI)	CSRC3	[7:0]					0000h
R1613 (64Dh)	PWM2MIX Input 3 Volume	0	0	0	0	0	0	0	0			PWM2	2MIX_V	OL3 [6:0]]				0	0080h
R1614 (64Eh)	PWM2MIX Input 4 Source	PWM2 MIX_S TS4	0	0	0	0	0	0	0			P\	WM2MI)	(_SRC4	[7:0]					0000h
R1615 (64Fh)	PWM2MIX Input 4 Volume	0	0	0	0	0	0	0	0			PWM2	2MIX_V	OL4 [6:0]]				0	0080h
R1632 (660h)	MICMIX Input 1 Source	MICMI X_STS 1	0	0	0	0	0	0	0			N	MICMIX_	_SRC1 [7:0]					0000h
R1633 (661h)	MICMIX Input 1 Volume	0	0	0	0	0	0	0	0			MIC	MIX_VO	L1 [6:0]					0	0080h
R1634 (662h)	MICMIX Input 2 Source	MICMI X_STS 2	0	0	0	0	0	0	0			N	MICMIX_	_SRC2 [7:0]					0000h
R1635 (663h)	MICMIX Input 2 Volume	0	0	0	0	0	0	0	0			MIC	MIX_VO	L2 [6:0]					0	0080h
R1636 (664h)	MICMIX Input 3 Source	MICMI X_STS 3	0	0	0	0	0	0	0			N	MICMIX_					0000h		
R1637 (665h)	MICMIX Input 3 Volume	0	0	0	0	0	0	0	0			MICN	MIX_VO	L3 [6:0]					0	0080h
R1638 (666h)	MICMIX Input 4 Source	MICMI X_STS 4	0	0	0	0	0	0	0		MICMIX_VOL3 [6:0] MICMIX_SRC4 [7:0]									0000h
R1639 (667h)	MICMIX Input 4 Volume	0	0	0	0	0	0	0	0			MIC	MIX_VO	L4 [6:0]					0	0080h
R1640 (668h)	NOISEMIX Input 1 Source	NOISE MIX_S TS1	0	0	0	0	0	0	0			N	DISEMIX	K_SRC1	[7:0]			_		0000h
R1641 (669h)	NOISEMIX Input 1 Volume	0	0	0	0	0	0	0	0			NOISE	EMIX_V	OL1 [6:0]]				0	0080h
R1642 (66Ah)	NOISEMIX Input 2 Source	NOISE MIX_S TS2	0	0	0	0	0	0	0			N	OISEMI	K_SRC2	[7:0]					0000h
R1643 (66Bh)	NOISEMIX Input 2 Volume	0	0	0	0	0	0	0	0			NOISE	EMIX_V	OL2 [6:0]]				0	0080h
R1644 (66Ch)	NOISEMIX Input 3 Source	NOISE MIX_S TS3	0	0	0	0	0	0	0			N	DISEMIX	K_SRC3	[7:0]					0000h
R1645 (66Dh)	NOISEMIX Input 3 Volume	0	0	0	0	0	0	0	0			NOISE	MIX_V	OL3 [6:0]]				0	0080h
R1646 (66Eh)	NOISEMIX Input 4 Source	NOISE MIX_S TS4	0	0	0	0	0	0	0	NOISEMIX_SRC4 [7:0]										0000h
R1647 (66Fh)	NOISEMIX Input 4 Volume	0	0	0	0	0	0	0	0	NOISEMIX_VOL4 [6:0]									0	0080h
R1664 (680h)	OUT1LMIX Input 1 Source	OUT1L MIX_S TS1	0	0	0	0	0	0	0			Ol	[7:0]					0000h		
R1665 (681h)	OUT1LMIX Input 1 Volume	0	0	0	0	0	0	0	0			OUT1I	_MIX_V	OL1 [6:0				0	0080h	



REG	NAME	15	14	13	12	11	10	9	8	7 6 5 4 3 2 1	0	DEFAULT
R1666 (682h)	OUT1LMIX Input 2 Source	OUT1L MIX_S TS2	0	0	0	0	0	0	0	OUT1LMIX_SRC2 [7:0]		0000h
R1667 (683h)	OUT1LMIX Input 2 Volume	0	0	0	0	0	0	0	0	OUT1LMIX_VOL2 [6:0]	0	0080h
R1668 (684h)	OUT1LMIX Input 3 Source	OUT1L MIX_S TS3	0	0	0	0	0	0	0	OUT1LMIX_SRC3 [7:0]		0000h
R1669 (685h)	OUT1LMIX Input 3 Volume	0	0	0	0	0	0	0	0	OUT1LMIX_VOL3 [6:0]	0	0080h
R1670 (686h)	OUT1LMIX Input 4 Source	OUT1L MIX_S TS4	0	0	0	0	0	0	0	OUT1LMIX_SRC4 [7:0]		0000h
R1671 (687h)	OUT1LMIX Input 4 Volume	0	0	0	0	0	0	0	0	OUT1LMIX_VOL4 [6:0]	0	0080h
R1672 (688h)	OUT1RMIX Input 1 Source	OUT1 RMIX_ STS1	0	0	0	0	0	0	0	OUT1RMIX_SRC1 [7:0]		0000h
R1673 (689h)	OUT1RMIX Input 1 Volume	0	0	0	0	0	0	0	0	OUT1RMIX_VOL1 [6:0]	0	0080h
R1674 (68Ah)	OUT1RMIX Input 2 Source	OUT1 RMIX_ STS2	0	0	0	0	0	0	0	OUT1RMIX_SRC2 [7:0]		0000h
R1675 (68Bh)	OUT1RMIX Input 2 Volume	0	0	0	0	0	0	0	0	OUT1RMIX_VOL2 [6:0]	0	0080h
R1676 (68Ch)	OUT1RMIX Input 3 Source	OUT1 RMIX_ STS3	0	0	0	0	0	0	0	OUT1RMIX_SRC3 [7:0]		0000h
R1677 (68Dh)	OUT1RMIX Input 3 Volume	0	0	0	0	0	0	0	0	OUT1RMIX_VOL3 [6:0]	0	0080h
R1678 (68Eh)	OUT1RMIX Input 4 Source	OUT1 RMIX_ STS4	0	0	0	0	0	0	0	OUT1RMIX_SRC4 [7:0]		0000h
R1679 (68Fh)	OUT1RMIX Input 4 Volume	0	0	0	0	0	0	0	0	OUT1RMIX_VOL4 [6:0]	0	0080h
R1680 (690h)	OUT2LMIX Input 1 Source	OUT2L MIX_S TS1	0	0	0	0	0	0	0	OUT2LMIX_SRC1 [7:0]		0000h
R1681 (691h)	OUT2LMIX Input 1 Volume	0	0	0	0	0	0	0	0	OUT2LMIX_VOL1 [6:0]	0	0080h
R1682 (692h)	OUT2LMIX Input 2 Source	OUT2L MIX_S TS2	0	0	0	0	0	0	0	OUT2LMIX_SRC2 [7:0]		0000h
R1683 (693h)	OUT2LMIX Input 2 Volume	0	0	0	0	0	0	0	0	OUT2LMIX_VOL2 [6:0]	0	0080h
R1684 (694h)	OUT2LMIX Input 3 Source	OUT2L MIX_S TS3	0	0	0	0	0	0	0	OUT2LMIX_SRC3 [7:0]		0000h
R1685 (695h)	OUT2LMIX Input 3 Volume	0	0	0	0	0	0	0	0	OUT2LMIX_VOL3 [6:0]	0	0080h
R1686 (696h)	OUT2LMIX Input 4 Source	OUT2L MIX_S TS4	0	0	0	0	0	0	0	OUT2LMIX_SRC4 [7:0]		0000h
R1687 (697h)	OUT2LMIX Input 4 Volume	0	0	0	0	0	0	0	0	OUT2LMIX_VOL4 [6:0]	0	0080h
R1688 (698h)	OUT2RMIX Input 1 Source	OUT2 RMIX_ STS1	0	0	0	0	0	0	0	OUT2RMIX_SRC1 [7:0]		0000h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4		3	2	1	1	0	DEFAULT
R1689 (699h)	OUT2RMIX Input 1 Volume	0	0	0	0	0	0	0	0			OUT2	RMIX_\	/OL1 [6:0]				0	0080h
R1690 (69Ah)	OUT2RMIX Input 2 Source	OUT2 RMIX_ STS2	0	0	0	0	0	0	0			0	UT2RM	IX_SR	IC2 [7:	:0]				0000h
R1691 (69Bh)	OUT2RMIX Input 2 Volume	0	0	0	0	0	0	0	0			OUT2	RMIX_\	/OL2 [6:0]				0	0080h
R1692 (69Ch)	OUT2RMIX Input 3 Source	OUT2 RMIX_ STS3	0	0	0	0	0	0	0			0	UT2RM	IX_SR	C3 [7:	:0]				0000h
R1693 (69Dh)	OUT2RMIX Input 3 Volume	0	0	0	0	0	0	0	0			OUT2	RMIX_\	/OL3 [6:0]				0	0080h
R1694 (69Eh)	OUT2RMIX Input 4 Source	OUT2 RMIX_ STS4	0	0	0	0	0	0	0			0	UT2RM	IX_SR	C4 [7:	:0]				0000h
R1695 (69Fh)	OUT2RMIX Input 4 Volume	0	0	0	0	0	0	0	0			OUT2	RMIX_\	/OL4 [6:0]				0	0080h
R1696 (6A0h)	OUT3LMIX Input 1 Source	OUT3 MIX_S TS1	0	0	0	0	0	0	0			C	OUT3MI	X_SR(C1 [7:0	0]				0000h
R1697 (6A1h)	OUT3LMIX Input 1 Volume	0	0	0	0	0	0	0	0			OUT	BMIX_V	OL1 [6	6:0]				0	0080h
R1698 (6A2h)	OUT3LMIX Input 2 Source	OUT3 MIX_S TS2	0	0	0	0	0	0	0			C	OUT3MI	X_SR(C2 [7:0				0000h	
R1699 (6A3h)	OUT3LMIX Input 2 Volume	0	0	0	0	0	0	0	0			OUT	BMIX_V	OL2 [6	6:0]				0	0080h
R1700 (6A4h)	OUT3LMIX Input 3 Source	OUT3 MIX_S TS3	0	0	0	0	0	0	0			C	OUT3MI.	X_SR(C3 [7:0	0]				0000h
R1701 (6A5h)	OUT3LMIX Input 3 Volume	0	0	0	0	0	0	0	0			OUT	BMIX_V	OL3 [6	6:0]				0	0080h
R1702 (6A6h)	OUT3LMIX Input 4 Source	OUT3 MIX_S TS4	0	0	0	0	0	0	0			C	OUT3MI.	X_SR(C4 [7:0	0]				0000h
R1703 (6A7h)	OUT3LMIX Input 4 Volume	0	0	0	0	0	0	0	0			OUT	BMIX_V	OL4 [6	6:0]				0	0080h
R1712 (6B0h)	OUT4LMIX Input 1 Source	OUT4L MIX_S TS1	0	0	0	0	0	0	0			0	UT4LM	IX_SR	C1 [7:	0]				0000h
R1713 (6B1h)	OUT4LMIX Input 1 Volume	0	0	0	0	0	0	0	0			OUT4	LMIX_\	/OL1 [6:0]				0	0080h
R1714 (6B2h)	OUT4LMIX Input 2 Source	OUT4L MIX_S TS2	0	0	0	0	0	0	0			0	UT4LM	IX_SR	C2 [7:	0]				0000h
R1715 (6B3h)	OUT4LMIX Input 2 Volume	0	0	0	0	0	0	0	0			OUT4	LMIX_\	/OL2 [6:0]				0	0080h
R1716 (6B4h)	OUT4LMIX Input 3 Source	OUT4L MIX_S TS3	0	0	0	0	0	0	0	OUT4LMIX_SRC3 [7:0]										0000h
R1717 (6B5h)	OUT4LMIX Input 3 Volume	0	0	0	0	0	0	0	0	OUT4LMIX_VOL3 [6:0]									0	0080h
R1718 (6B6h)	OUT4LMIX Input 4 Source	OUT4L MIX_S TS4	0	0	0	0	0	0	0			0	UT4LM	IX_SR	C4 [7:	0]				0000h
R1719 (6B7h)	OUT4LMIX Input 4 Volume	0	0	0	0	0	0	0	0			OUT4	LMIX_\	/OL4 [T	0	0080h	



REG	NAME	15	14	13	12	11	10	9	8	7 6 5 4 3 2 1	0	DEFAULT
R1720 (6B8h)	OUT4RMIX Input 1	OUT4	0	0	0	0	0	0	0	OUT4RMIX_SRC1 [7:0]		0000h
, ,	Source	RMIX_ STS1										
R1721 (6B9h)	OUT4RMIX Input 1 Volume	0	0	0	0	0	0	0	0	OUT4RMIX_VOL1 [6:0]	0	0080h
R1722 (6BAh)	OUT4RMIX Input 2 Source	OUT4 RMIX_ STS2	0	0	0	0	0	0	0	OUT4RMIX_SRC2 [7:0]		0000h
R1723 (6BBh)	OUT4RMIX Input 2 Volume	0	0	0	0	0	0	0	0	OUT4RMIX_VOL2 [6:0]	0	0080h
R1724 (6BCh)	OUT4RMIX Input 3 Source	OUT4 RMIX_ STS3	0	0	0	0	0	0	0	OUT4RMIX_SRC3 [7:0]		0000h
R1725 (6BDh)	OUT4RMIX Input 3 Volume	0	0	0	0	0	0	0	0	OUT4RMIX_VOL3 [6:0]	0	0080h
R1726 (6BEh)	OUT4RMIX Input 4 Source	OUT4 RMIX_ STS4	0	0	0	0	0	0	0	OUT4RMIX_SRC4 [7:0]		0000h
R1727 (6BFh)	OUT4RMIX Input 4 Volume	0	0	0	0	0	0	0	0	OUT4RMIX_VOL4 [6:0]	0	0080h
R1728 (6C0h)	OUT5LMIX Input 1 Source	OUT5L MIX_S TS1	0	0	0	0	0	0	0	OUT5LMIX_SRC1 [7:0]		0000h
R1729 (6C1h)	OUT5LMIX Input 1 Volume	0	0	0	0	0	0	0	0	OUT5LMIX_VOL1 [6:0]	0	0080h
R1730 (6C2h)	OUT5LMIX Input 2 Source	OUT5L MIX_S TS2	0	0	0	0	0	0	0	OUT5LMIX_SRC2 [7:0]		0000h
R1731 (6C3h)	OUT5LMIX Input 2 Volume	0	0	0	0	0	0	0	0	OUT5LMIX_VOL2 [6:0]	0	0080h
R1732 (6C4h)	OUT5LMIX Input 3 Source	OUT5L MIX_S TS3	0	0	0	0	0	0	0	OUT5LMIX_SRC3 [7:0]		0000h
R1733 (6C5h)	OUT5LMIX Input 3 Volume	0	0	0	0	0	0	0	0	OUT5LMIX_VOL3 [6:0]	0	0080h
R1734 (6C6h)	OUT5LMIX Input 4 Source	OUT5L MIX_S TS4	0	0	0	0	0	0	0	OUT5LMIX_SRC4 [7:0]		0000h
R1735 (6C7h)	OUT5LMIX Input 4 Volume	0	0	0	0	0	0	0	0	OUT5LMIX_VOL4 [6:0]	0	0080h
R1736 (6C8h)	OUT5RMIX Input 1 Source	OUT5 RMIX_ STS1	0	0	0	0	0	0	0	OUT5RMIX_SRC1 [7:0]		0000h
R1737 (6C9h)	OUT5RMIX Input 1 Volume	0	0	0	0	0	0	0	0	OUT5RMIX_VOL1 [6:0]	0	0080h
R1738 (6CAh)	OUT5RMIX Input 2 Source	OUT5 RMIX_ STS2	0	0	0	0	0	0	0	OUT5RMIX_SRC2 [7:0]		0000h
R1739 (6CBh)	OUT5RMIX Input 2 Volume	0	0	0	0	0	0	0	0	OUT5RMIX_VOL2 [6:0]	0	0080h
R1740 (6CCh)	OUT5RMIX Input 3 Source	OUT5 RMIX_ STS3	0	0	0	0	0	0	0	OUT5RMIX_SRC3 [7:0]		0000h
R1741 (6CDh)	OUT5RMIX Input 3 Volume	0	0	0	0	0	0	0	0	OUT5RMIX_VOL3 [6:0]	0	0080h
R1742 (6CEh)	OUT5RMIX Input 4 Source	OUT5 RMIX_ STS4	0	0	0	0	0	0	0	OUT5RMIX_SRC4 [7:0]		0000h



REG	NAME	15	14	13	12	11	10	9	8	7 6 5	5 4	3	2	1	0	DEFAULT
R1743 (6CFh)	OUT5RMIX Input 4 Volume	0	0	0	0	0	0	0	0	OUT	T5RMIX_VC	DL4 [6:0]			0	0080h
R1792 (700h)	AIF1TX1MIX Input 1 Source	AIF1T X1MIX _STS1	0	0	0	0	0	0	0	A	AIF1TX1MI)	X_SRC1	[7:0]			0000h
R1793 (701h)	AIF1TX1MIX Input 1 Volume	0	0	0	0	0	0	0	0	AIF1	TX1MIX_V	OL1 [6:0]		0	0080h
R1794 (702h)	AIF1TX1MIX Input 2 Source	AIF1T X1MIX _STS2	0	0	0	0	0	0	0	Α	AIF1TX1MI)	X_SRC2	[7:0]	•		0000h
R1795 (703h)	AIF1TX1MIX Input 2 Volume	0	0	0	0	0	0	0	0	AIF1	TX1MIX_V	OL2 [6:0]		0	0080h
R1796 (704h)	AIF1TX1MIX Input 3 Source	AIF1T X1MIX _STS3	0	0	0	0	0	0	0	Α	AIF1TX1MI)	X_SRC3	[7:0]	•		0000h
R1797 (705h)	AIF1TX1MIX Input 3 Volume	0	0	0	0	0	0	0	0	AIF1	TX1MIX_V	OL3 [6:0]		0	0080h
R1798 (706h)	AIF1TX1MIX Input 4 Source	AIF1T X1MIX _STS4	0	0	0	0	0	0	0	А	AIF1TX1MI)	X_SRC4	[7:0]			0000h
R1799 (707h)	AIF1TX1MIX Input 4 Volume	0	0	0	0	0	0	0	0	AIF1	TX1MIX_V		0	0080h		
R1800 (708h)	AIF1TX2MIX Input 1 Source	AIF1T X2MIX _STS1	0	0	0	0	0	0	0	Α	•		0000h			
R1801 (709h)	AIF1TX2MIX Input 1 Volume	0	0	0	0	0	0	0	0	AIF1	TX2MIX_V	OL1 [6:0]		0	0080h
R1802 (70Ah)	AIF1TX2MIX Input 2 Source	AIF1T X2MIX _STS2	0	0	0	0	0	0	0	А			0000h			
R1803 (70Bh)	AIF1TX2MIX Input 2 Volume	0	0	0	0	0	0	0	0	AIF1	TX2MIX_V	OL2 [6:0]		0	0080h
R1804 (70Ch)	AIF1TX2MIX Input 3 Source	AIF1T X2MIX _STS3	0	0	0	0	0	0	0	Α	AIF1TX2MI)	K_SRC3	[7:0]			0000h
R1805 (70Dh)	AIF1TX2MIX Input 3 Volume	0	0	0	0	0	0	0	0	AIF1	TX2MIX_V	OL3 [6:0]		0	0080h
R1806 (70Eh)	AIF1TX2MIX Input 4 Source	AIF1T X2MIX _STS4	0	0	0	0	0	0	0	Α	AIF1TX2MI)	X_SRC4	[7:0]			0000h
R1807 (70Fh)	AIF1TX2MIX Input 4 Volume	0	0	0	0	0	0	0	0	AIF1	TX2MIX_V	OL4 [6:0]		0	0080h
R1808 (710h)	AIF1TX3MIX Input 1 Source	AIF1T X3MIX _STS1	0	0	0	0	0	0	0	Α	AIF1TX3MI)	K_SRC1	[7:0]			0000h
R1809 (711h)	AIF1TX3MIX Input 1 Volume	0	0	0	0	0	0	0	0	AIF1	TX3MIX_V	OL1 [6:0]		0	0080h
R1810 (712h)	AIF1TX3MIX Input 2 Source	AIF1T X3MIX _STS2	0	0	0	0	0	0	0	Α			0000h			
R1811 (713h)	AIF1TX3MIX Input 2 Volume	0	0	0	0	0	0	0	0	AIF1		0	0080h			
R1812 (714h)	AIF1TX3MIX Input 3 Source	AIF1T X3MIX _STS3	0	0	0	0	0	0	0	Α			0000h			
R1813 (715h)	AIF1TX3MIX Input 3 Volume	0	0	0	0	0	0	0	0	AIF1	TX3MIX_V	OL3 [6:0	1		0	0080h



REG	NAME	15	14	13	12	11	10	9	8	7 6 5 4 3 2 1	0	DEFAULT
R1814 (716h)	AIF1TX3MIX Input 4 Source	AIF1T X3MIX _STS4	0	0	0	0	0	0	0	AIF1TX3MIX_SRC4 [7:0]		0000h
R1815 (717h)	AIF1TX3MIX Input 4 Volume	0	0	0	0	0	0	0	0	AIF1TX3MIX_VOL4 [6:0]	0	0080h
R1816 (718h)	AIF1TX4MIX Input 1 Source	AIF1T X4MIX _STS1	0	0	0	0	0	0	0	AIF1TX4MIX_SRC1 [7:0]		0000h
R1817 (719h)	AIF1TX4MIX Input 1 Volume	0	0	0	0	0	0	0	0	AIF1TX4MIX_VOL1 [6:0]	0	0080h
R1818 (71Ah)	AIF1TX4MIX Input 2 Source	AIF1T X4MIX _STS2	0	0	0	0	0	0	0	AIF1TX4MIX_SRC2 [7:0]		0000h
R1819 (71Bh)	AIF1TX4MIX Input 2 Volume	0	0	0	0	0	0	0	0	AIF1TX4MIX_VOL2 [6:0]	0	0080h
R1820 (71Ch)	AIF1TX4MIX Input 3 Source	AIF1T X4MIX _STS3	0	0	0	0	0	0	0	AIF1TX4MIX_SRC3 [7:0]		0000h
R1821 (71Dh)	AIF1TX4MIX Input 3 Volume	0	0	0	0	0	0	0	0	AIF1TX4MIX_VOL3 [6:0]	0	0080h
R1822 (71Eh)	AIF1TX4MIX Input 4 Source	AIF1T X4MIX _STS4	0	0	0	0	0	0	0	AIF1TX4MIX_SRC4 [7:0]		0000h
R1823 (71Fh)	AIF1TX4MIX Input 4 Volume	0	0	0	0	0	0	0	0	AIF1TX4MIX_VOL4 [6:0]	0	0080h
R1824 (720h)	AIF1TX5MIX Input 1 Source	AIF1T X5MIX _STS1	0	0	0	0	0	0	0	AIF1TX5MIX_SRC1 [7:0]		0000h
R1825 (721h)	AIF1TX5MIX Input 1 Volume	0	0	0	0	0	0	0	0	AIF1TX5MIX_VOL1 [6:0]	0	0080h
R1826 (722h)	AIF1TX5MIX Input 2 Source	AIF1T X5MIX _STS2	0	0	0	0	0	0	0	AIF1TX5MIX_SRC2 [7:0]		0000h
R1827 (723h)	AIF1TX5MIX Input 2 Volume	0	0	0	0	0	0	0	0	AIF1TX5MIX_VOL2 [6:0]	0	0080h
R1828 (724h)	AIF1TX5MIX Input 3 Source	AIF1T X5MIX _STS3	0	0	0	0	0	0	0	AIF1TX5MIX_SRC3 [7:0]		0000h
R1829 (725h)	AIF1TX5MIX Input 3 Volume	0	0	0	0	0	0	0	0	AIF1TX5MIX_VOL3 [6:0]	0	0080h
R1830 (726h)	AIF1TX5MIX Input 4 Source	AIF1T X5MIX _STS4	0	0	0	0	0	0	0	AIF1TX5MIX_SRC4 [7:0]		0000h
R1831 (727h)	AIF1TX5MIX Input 4 Volume	0	0	0	0	0	0	0	0	AIF1TX5MIX_VOL4 [6:0]	0	0080h
R1832 (728h)	AIF1TX6MIX Input 1 Source	AIF1T X6MIX _STS1	0	0	0	0	0	0	0	AIF1TX6MIX_SRC1 [7:0]		0000h
R1833 (729h)	AIF1TX6MIX Input 1 Volume	0	0	0	0	0	0	0	0	AIF1TX6MIX_VOL1 [6:0]	0	0080h
R1834 (72Ah)	AIF1TX6MIX Input 2 Source	AIF1T X6MIX _STS2	0	0	0	0	0	0	0	AIF1TX6MIX_SRC2 [7:0]		0000h
R1835 (72Bh)	AIF1TX6MIX Input 2 Volume	0	0	0	0	0	0	0	0	AIF1TX6MIX_VOL2 [6:0]	0	0080h
R1836 (72Ch)	AIF1TX6MIX Input 3 Source	AIF1T X6MIX _STS3	0	0	0	0	0	0	0	AIF1TX6MIX_SRC3 [7:0]		0000h



REG	NAME	15	14	13	12	11	10	9	8	7 6 5 4 3 2 1	0	DEFAULT
R1837 (72Dh)	AIF1TX6MIX Input 3 Volume	0	0	0	0	0	0	0	0	AIF1TX6MIX_VOL3 [6:0]	0	0080h
R1838 (72Eh)	AIF1TX6MIX Input 4 Source	AIF1T X6MIX _STS4	0	0	0	0	0	0	0	AIF1TX6MIX_SRC4 [7:0]		0000h
R1839 (72Fh)	AIF1TX6MIX Input 4 Volume	0	0	0	0	0	0	0	0	AIF1TX6MIX_VOL4 [6:0]	0	0080h
R1840 (730h)	AIF1TX7MIX Input 1 Source	AIF1T X7MIX _STS1	0	0	0	0	0	0	0	AIF1TX7MIX_SRC1 [7:0]		0000h
R1841 (731h)	AIF1TX7MIX Input 1 Volume	0	0	0	0	0	0	0	0	AIF1TX7MIX_VOL1 [6:0]	0	0080h
R1842 (732h)	AIF1TX7MIX Input 2 Source	AIF1T X7MIX _STS2	0	0	0	0	0	0	0	AIF1TX7MIX_SRC2 [7:0]		0000h
R1843 (733h)	AIF1TX7MIX Input 2 Volume	0	0	0	0	0	0	0	0	AIF1TX7MIX_VOL2 [6:0]	0	0080h
R1844 (734h)	AIF1TX7MIX Input 3 Source	AIF1T X7MIX _STS3	0	0	0	0	0	0	0	AIF1TX7MIX_SRC3 [7:0]		0000h
R1845 (735h)	AIF1TX7MIX Input 3 Volume	0	0	0	0	0	0	0	0	AIF1TX7MIX_VOL3 [6:0]	0	0080h
R1846 (736h)	AIF1TX7MIX Input 4 Source	AIF1T X7MIX _STS4	0	0	0	0	0	0	0	AIF1TX7MIX_SRC4 [7:0]		0000h
R1847 (737h)	AIF1TX7MIX Input 4 Volume	0	0	0	0	0	0	0	0	AIF1TX7MIX_VOL4 [6:0]	0	0080h
R1848 (738h)	AIF1TX8MIX Input 1 Source	AIF1T X8MIX _STS1	0	0	0	0	0	0	0	AIF1TX8MIX_SRC1 [7:0]		0000h
R1849 (739h)	AIF1TX8MIX Input 1 Volume	0	0	0	0	0	0	0	0	AIF1TX8MIX_VOL1 [6:0]	0	0080h
R1850 (73Ah)	AIF1TX8MIX Input 2 Source	AIF1T X8MIX _STS2	0	0	0	0	0	0	0	AIF1TX8MIX_SRC2 [7:0]		0000h
R1851 (73Bh)	AIF1TX8MIX Input 2 Volume	0	0	0	0	0	0	0	0	AIF1TX8MIX_VOL2 [6:0]	0	0080h
R1852 (73Ch)	AIF1TX8MIX Input 3 Source	AIF1T X8MIX _STS3	0	0	0	0	0	0	0	AIF1TX8MIX_SRC3 [7:0]		0000h
R1853 (73Dh)	AIF1TX8MIX Input 3 Volume	0	0	0	0	0	0	0	0	AIF1TX8MIX_VOL3 [6:0]	0	0080h
R1854 (73Eh)	AIF1TX8MIX Input 4 Source	AIF1T X8MIX _STS4	0	0	0	0	0	0	0	AIF1TX8MIX_SRC4 [7:0]		0000h
R1855 (73Fh)	AIF1TX8MIX Input 4 Volume	0	0	0	0	0	0	0	0	AIF1TX8MIX_VOL4 [6:0]	0	0080h
R1856 (740h)	AIF2TX1MIX Input 1 Source	AIF2T X1MIX _STS1	0	0	0	0	0	0	0	AIF2TX1MIX_SRC1 [7:0]		0000h
R1857 (741h)	AIF2TX1MIX Input 1 Volume	0	0	0	0	0	0	0	0	AIF2TX1MIX_VOL1 [6:0]	0	0080h
R1858 (742h)	AIF2TX1MIX Input 2 Source	AIF2T X1MIX _STS2	0	0	0	0	0	0	0	AIF2TX1MIX_SRC2 [7:0]		0000h
R1859 (743h)	AIF2TX1MIX Input 2 Volume	0	0	0	0	0	0	0	0	AIF2TX1MIX_VOL2 [6:0]	0	0080h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2		1	0	DEFAULT
R1860 (744h)	AIF2TX1MIX Input 3 Source	AIF2T X1MIX	0	0	0	0	0	0	0			AIF	2TX1M	IX_SRC3	3 [7:0]				0000h
R1861 (745h)	AIF2TX1MIX Input	_STS3	0	0	0	0	0	0	0		,	AIF2TX	1MIX_\	/OL3 [6:0)]			0	0080h
R1862 (746h)	3 Volume AIF2TX1MIX Input 4 Source	AIF2T X1MIX	0	0	0	0	0	0	0			AIF	2TX1M	IX_SRC4	1 [7:0]				0000h
R1863 (747h)	AIF2TX1MIX Input 4 Volume	_STS4 0	0	0	0	0	0	0	0		,	AIF2TX	1MIX_\	/OL4 [6:0)]		П	0	0080h
R1864 (748h)	AIF2TX2MIX Input 1 Source	AIF2T X2MIX _STS1	0	0	0	0	0	0	0			AIF	2TX2M	IX_SRC1	I [7:0]				0000h
R1865 (749h)	AIF2TX2MIX Input 1 Volume	0	0	0	0	0	0	0	0		,	AIF2TX	2MIX_\	/OL1 [6:0)]			0	0080h
R1866 (74Ah)		AIF2T X2MIX _STS2	0	0	0	0	0	0	0			AIF	2TX2M	IX_SRC2	2 [7:0]				0000h
R1867 (74Bh)	AIF2TX2MIX Input 2 Volume	0	0	0	0	0	0	0	0		,	AIF2TX	2MIX_\	/OL2 [6:0)]			0	0080h
R1868 (74Ch)	AIF2TX2MIX Input 3 Source	AIF2T X2MIX _STS3	0	0	0	0	0	0	0			AIF	2TX2M	IX_SRC3	3 [7:0]				0000h
R1869 (74Dh)	AIF2TX2MIX Input 3 Volume	0	0	0	0	0	0	0	0		ı	AIF2TX	2MIX_\	/OL3 [6:0)]			0	0080h
R1870 (74Eh)	AIF2TX2MIX Input 4 Source	AIF2T X2MIX _STS4	0	0	0	0	0	0	0			AIF	2TX2M	IX_SRC4	1 [7:0]				0000h
R1871 (74Fh)	AIF2TX2MIX Input 4 Volume	0	0	0	0	0	0	0	0		,	AIF2TX	2MIX_\	/OL4 [6:0)]			0	0080h
R1920 (780h)	AIF3TX1MIX Input 1 Source	AIF3T X1MIX _STS1	0	0	0	0	0	0	0			AIF	3TX1M	IX_SRC1	l [7:0]				0000h
R1921 (781h)	AIF3TX1MIX Input 1 Volume	0	0	0	0	0	0	0	0		,	AIF3TX	1MIX_\	/OL1 [6:0)]			0	0080h
R1922 (782h)	AIF3TX1MIX Input 2 Source	AIF3T X1MIX _STS2	0	0	0	0	0	0	0			AIF	3TX1M	IX_SRC2	2 [7:0]				0000h
R1923 (783h)	AIF3TX1MIX Input 2 Volume	0	0	0	0	0	0	0	0		ı	AIF3TX	1MIX_\	/OL2 [6:0)]			0	0080h
R1924 (784h)	AIF3TX1MIX Input 3 Source	AIF3T X1MIX _STS3	0	0	0	0	0	0	0			AIF	3TX1M	IX_SRC3	3 [7:0]				0000h
R1925 (785h)	AIF3TX1MIX Input 3 Volume	0	0	0	0	0	0	0	0		ļ	AIF3TX	1MIX_\	/OL3 [6:0)]			0	0080h
R1926 (786h)	AIF3TX1MIX Input 4 Source	AIF3T X1MIX _STS4	0	0	0	0	0	0	0			AIF	3TX1M	IX_SRC4	1 [7:0]				0000h
R1927 (787h)	AIF3TX1MIX Input 4 Volume	0	0	0	0	0	0	0	0	AIF3TX1MIX_VOL4 [6:0]								0	0080h
R1928 (788h)	AIF3TX2MIX Input 1 Source	AIF3T X2MIX _STS1	0	0	0	0	0	0	0										0000h
R1929 (789h)	AIF3TX2MIX Input 1 Volume	0	0	0	0	0	0	0	0		/	AIF3TX	2MIX_\	/OL1 [6:0)]			0	0080h
R1930 (78Ah)	AIF3TX2MIX Input 2 Source	AIF3T X2MIX _STS2	0	0	0	0	0	0	0			AIF	3TX2M	IX_SRC2	[7:0]				0000h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	;	3	2	1	ı	0	DEFAULT
R1931 (78Bh)	AIF3TX2MIX Input 2 Volume	0	0	0	0	0	0	0	0			AIF3T	(2MIX_	VOL2 [[6:0]				0	0080h
R1932 (78Ch)	AIF3TX2MIX Input 3 Source	AIF3T X2MIX _STS3	0	0	0	0	0	0	0			All	-3TX2N	1IX_SR	RC3 [7	:0]				0000h
R1933 (78Dh)	AIF3TX2MIX Input 3 Volume	0	0	0	0	0	0	0	0			AIF3T	(2MIX_	VOL3 [[6:0]				0	0080h
R1934 (78Eh)	AIF3TX2MIX Input 4 Source	AIF3T X2MIX _STS4	0	0	0	0	0	0	0			All	3TX2N	1IX_SR	RC4 [7	:0]				0000h
R1935 (78Fh)	AIF3TX2MIX Input 4 Volume	0	0	0	0	0	0	0	0			AIF3T	(2MIX_	VOL4 [[6:0]				0	0080h
R1984 (7C0h)	SLIMTX1MIX Input 1 Source	SLIMT X1MIX _STS1	0	0	0	0	0	0	0			SL	MTX1N	/IIX_SF	RC1 [7	':0]				0000h
R1985 (7C1h)	SLIMTX1MIX Input 1 Volume	0	0	0	0	0	0	0	0			SLIMT	K1MIX_	VOL1	[6:0]				0	0080h
R1986 (7C2h)	SLIMTX1MIX Input 2 Source	SLIMT X1MIX _STS2	0	0	0	0	0	0	0			SL	MTX1N	/IIX_SF	RC2 [7	':0]				0000h
R1987 (7C3h)	SLIMTX1MIX Input 2 Volume	0	0	0	0	0	0	0	0			SLIMT	K1MIX_	VOL2	[6:0]				0	0080h
R1988 (7C4h)	SLIMTX1MIX Input 3 Source	SLIMT X1MIX _STS3	0	0	0	0	0	0	0			SL	MTX1N	MIX_SF				0000h		
R1989 (7C5h)	SLIMTX1MIX Input 3 Volume	0	0	0	0	0	0	0	0			SLIMT	K1MIX_	VOL3	[6:0]				0	0080h
R1990 (7C6h)	SLIMTX1MIX Input 4 Source	SLIMT X1MIX _STS4	0	0	0	0	0	0	0			SL	MTX1N	/IIX_SF	RC4 [7	':0]				0000h
R1991 (7C7h)	SLIMTX1MIX Input 4 Volume	0	0	0	0	0	0	0	0			SLIMT	K1MIX_	VOL4	[6:0]				0	0080h
R1992 (7C8h)	SLIMTX2MIX Input 1 Source	SLIMT X2MIX _STS1	0	0	0	0	0	0	0			SL	MTX2N	/IIX_SF	RC1 [7	':0]				0000h
R1993 (7C9h)	SLIMTX2MIX Input 1 Volume	0	0	0	0	0	0	0	0			SLIMT	K2MIX_	VOL1	[6:0]				0	0080h
R1994 (7CAh)	SLIMTX2MIX Input 2 Source	SLIMT X2MIX _STS2	0	0	0	0	0	0	0			SL	MTX2N	/IIX_SF	RC2 [7	':0]				0000h
R1995 (7CBh)	SLIMTX2MIX Input 2 Volume	0	0	0	0	0	0	0	0			SLIMT	K2MIX_	VOL2	[6:0]				0	0080h
R1996 (7CCh)	SLIMTX2MIX Input 3 Source	SLIMT X2MIX _STS3	0	0	0	0	0	0	0			SL	MTX2N	/IIX_SF	RC3 [7	':0]				0000h
R1997 (7CDh)	SLIMTX2MIX Input 3 Volume	0	0	0	0	0	0	0	0			SLIMT	K2MIX_	VOL3	[6:0]				0	0080h
R1998 (7CEh)	SLIMTX2MIX Input 4 Source	SLIMT X2MIX _STS4	0	0	0	0	0	0	0	SLIMTX2MIX_SRC4 [7:0]										0000h
R1999 (7CFh)	SLIMTX2MIX Input 4 Volume	0	0	0	0	0	0	0	0	SLIMTX2MIX_VOL4 [6:0]									0	0080h
R2000 (7D0h)	SLIMTX3MIX Input 1 Source	SLIMT X3MIX _STS1	0	0	0	0	0	0	0			SL	MTX3N	MIX_SF	RC1 [7	7:0]				0000h
R2001 (7D1h)	SLIMTX3MIX Input 1 Volume	0	0	0	0	0	0	0	0			SLIMT	K3MIX_	VOL1	[6:0]				0	0080h



REG	NAME	15	14	13	12	11	10	9	8	7 6 5 4 3 2 1 0	DEFAUL
R2002 (7D2h)	SLIMTX3MIX Input	SLIMT	0	0	0	0	0	0	0	SLIMTX3MIX_SRC2 [7:0]	0000h
	2 Source	X3MIX _STS2									
R2003 (7D3h)	SLIMTX3MIX Input 2 Volume	0	0	0	0	0	0	0	0	SLIMTX3MIX_VOL2 [6:0] 0	0080h
R2004 (7D4h)	SLIMTX3MIX Input 3 Source	SLIMT X3MIX _STS3	0	0	0	0	0	0	0	SLIMTX3MIX_SRC3 [7:0]	0000h
R2005 (7D5h)	SLIMTX3MIX Input 3 Volume	0	0	0	0	0	0	0	0	SLIMTX3MIX_VOL3 [6:0] 0	0080h
R2006 (7D6h)	SLIMTX3MIX Input 4 Source	SLIMT X3MIX _STS4	0	0	0	0	0	0	0	SLIMTX3MIX_SRC4 [7:0]	0000h
R2007 (7D7h)	SLIMTX3MIX Input 4 Volume	0	0	0	0	0	0	0	0	SLIMTX3MIX_VOL4 [6:0] 0	0080h
R2008 (7D8h)	SLIMTX4MIX Input 1 Source	SLIMT X4MIX _STS1	0	0	0	0	0	0	0	SLIMTX4MIX_SRC1 [7:0]	0000h
R2009 (7D9h)	SLIMTX4MIX Input 1 Volume	0	0	0	0	0	0	0	0	SLIMTX4MIX_VOL1 [6:0] 0	0080h
R2010 (7DAh)	SLIMTX4MIX Input 2 Source	SLIMT X4MIX _STS2	0	0	0	0	0	0	0	SLIMTX4MIX_SRC2 [7:0]	0000h
R2011 (7DBh)	SLIMTX4MIX Input 2 Volume	0	0	0	0	0	0	0	0	SLIMTX4MIX_VOL2 [6:0] 0	0080h
R2012 (7DCh)	SLIMTX4MIX Input 3 Source	SLIMT X4MIX _STS3	0	0	0	0	0	0	0	SLIMTX4MIX_SRC3 [7:0]	0000h
R2013 (7DDh)	SLIMTX4MIX Input 3 Volume	0	0	0	0	0	0	0	0	SLIMTX4MIX_VOL3 [6:0] 0	0080h
R2014 (7DEh)	SLIMTX4MIX Input 4 Source	SLIMT X4MIX _STS4	0	0	0	0	0	0	0	SLIMTX4MIX_SRC4 [7:0]	0000h
R2015 (7DFh)	SLIMTX4MIX Input 4 Volume	0	0	0	0	0	0	0	0	SLIMTX4MIX_VOL4 [6:0] 0	0080h
R2016 (7E0h)	SLIMTX5MIX Input 1 Source	SLIMT X5MIX _STS1	0	0	0	0	0	0	0	SLIMTX5MIX_SRC1 [7:0]	0000h
R2017 (7E1h)	SLIMTX5MIX Input 1 Volume	0	0	0	0	0	0	0	0	SLIMTX5MIX_VOL1 [6:0] 0	0080h
R2018 (7E2h)	SLIMTX5MIX Input 2 Source	SLIMT X5MIX _STS2	0	0	0	0	0	0	0	SLIMTX5MIX_SRC2 [7:0]	0000h
R2019 (7E3h)	SLIMTX5MIX Input 2 Volume	0	0	0	0	0	0	0	0	SLIMTX5MIX_VOL2 [6:0] 0	0080h
R2020 (7E4h)	SLIMTX5MIX Input 3 Source	SLIMT X5MIX _STS3	0	0	0	0	0	0	0	SLIMTX5MIX_SRC3 [7:0]	0000h
R2021 (7E5h)	SLIMTX5MIX Input 3 Volume	0	0	0	0	0	0	0	0	SLIMTX5MIX_VOL3 [6:0] 0	0080h
R2022 (7E6h)	SLIMTX5MIX Input 4 Source	SLIMT X5MIX _STS4	0	0	0	0	0	0	0	SLIMTX5MIX_SRC4 [7:0]	0000h
R2023 (7E7h)	SLIMTX5MIX Input 4 Volume	0	0	0	0	0	0	0	0	SLIMTX5MIX_VOL4 [6:0] 0	0080h
R2024 (7E8h)	SLIMTX6MIX Input 1 Source	SLIMT X6MIX _STS1	0	0	0	0	0	0	0	SLIMTX6MIX_SRC1 [7:0]	0000h



REG	NAME	15	14	13	12	11	10	9	8	7 (6 5	5	4	3		2	1		0	DEFAULT
R2025 (7E9h)	SLIMTX6MIX Input 1 Volume	0	0	0	0	0	0	0	0		SLIM	ЛТХ6	MIX_\	/OL1 [6:0]				0	0080h
R2026 (7EAh)	SLIMTX6MIX Input 2 Source	SLIMT X6MIX _STS2	0	0	0	0	0	0	0		;	SLIM [*]	TX6M	IX_SR	C2 [7	:0]				0000h
R2027 (7EBh)	SLIMTX6MIX Input 2 Volume	0	0	0	0	0	0	0	0		SLIM	/ITX6	MIX_\	/OL2 [6:0]				0	0080h
R2028 (7ECh)	SLIMTX6MIX Input 3 Source	SLIMT X6MIX _STS3	0	0	0	0	0	0	0		;	SLIM	TX6M	IX_SR	C3 [7	:0]				0000h
R2029 (7EDh)	SLIMTX6MIX Input 3 Volume	0	0	0	0	0	0	0	0		SLIM	/TX6	MIX_\	/OL3 [6:0]				0	0080h
R2030 (7EEh)	SLIMTX6MIX Input 4 Source	SLIMT X6MIX _STS4	0	0	0	0	0	0	0		;	SLIM	TX6M	IX_SR	C4 [7	:0]				0000h
R2031 (7EFh)	SLIMTX6MIX Input 4 Volume	0	0	0	0	0	0	0	0		SLIM	ЛТХ6	MIX_\	/OL4 [6:0]				0	0080h
R2032 (7F0h)	SLIMTX7MIX Input 1 Source	SLIMT X7MIX _STS1	0	0	0	0	0	0	0		;	SLIM [*]	TX7M	IX_SR	C1 [7	:0]				0000h
R2033 (7F1h)	SLIMTX7MIX Input 1 Volume	0	0	0	0	0	0	0	0		SLIM	SLIMTX7MIX_VOL1 [6:0]							0	0080h
R2034 (7F2h)	SLIMTX7MIX Input 2 Source	SLIMT X7MIX _STS2	0	0	0	0	0	0	0		SLIMTX7MIX_VOL1 [6:0] SLIMTX7MIX_SRC2 [7:0] SLIMTX7MIX_VOL2 [6:0]									0000h
R2035 (7F3h)	SLIMTX7MIX Input 2 Volume	0	0	0	0	0	0	0	0		SLIM	/ITX7	MIX_\	/OL2 [6:0]				0	0080h
R2036 (7F4h)	SLIMTX7MIX Input 3 Source	SLIMT X7MIX _STS3	0	0	0	0	0	0	0		;	SLIM [*]	TX7M	IX_SR	C3 [7	:0]				0000h
R2037 (7F5h)	SLIMTX7MIX Input 3 Volume	0	0	0	0	0	0	0	0		SLIM	/ITX7	MIX_\	/OL3 [6:0]				0	0080h
R2038 (7F6h)	SLIMTX7MIX Input 4 Source	SLIMT X7MIX _STS4	0	0	0	0	0	0	0		;	SLIM [*]	TX7M	IX_SR	C4 [7	:0]				0000h
R2039 (7F7h)	SLIMTX7MIX Input 4 Volume	0	0	0	0	0	0	0	0		SLIM	/ITX7	MIX_\	/OL4 [6:0]				0	0080h
R2040 (7F8h)	SLIMTX8MIX Input 1 Source	SLIMT X8MIX _STS1	0	0	0	0	0	0	0		;	SLIM	TX8M	IX_SR	C1 [7	:0]				0000h
R2041 (7F9h)	SLIMTX8MIX Input 1 Volume	0	0	0	0	0	0	0	0		SLIN	/ITX8	MIX_\	/OL1 [6:0]				0	0080h
R2042 (7FAh)	SLIMTX8MIX Input 2 Source	SLIMT X8MIX _STS2	0	0	0	0	0	0	0		;	SLIM	TX8M	IX_SR	C2 [7	:0]				0000h
R2043 (7FBh)	SLIMTX8MIX Input 2 Volume	0	0	0	0	0	0	0	0		SLIM	/ITX8	MIX_\	/OL2 [6:0]				0	0080h
R2044 (7FCh)	SLIMTX8MIX Input 3 Source	SLIMT X8MIX _STS3	0	0	0	0	0	0	0		:0]				0000h					
R2045 (7FDh)	SLIMTX8MIX Input 3 Volume	0	0	0	0	0	0	0	0	SLIMTX8MIX_VOL3 [6:0]									0	0080h
R2046 (7FEh)	SLIMTX8MIX Input 4 Source	SLIMT X8MIX _STS4	0	0	0	0	0	0	0			SLIM	TX8M	IX_SR	C4 [7	:0]				0000h
R2047 (7FFh)	SLIMTX8MIX Input 4 Volume	0	0	0	0	0	0	0	0		SLIM	/ITX8	MIX_\				0	0080h		



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3		2	1	Т	0	DEFAULT
R2176 (880h)	EQ1MIX Input 1 Source	EQ1MI X_STS	0	0	0	0	0	0	0		<u>· </u>		Q1MIX	_SRC1	_					0000h
R2177 (881h)	EQ1MIX Input 1 Volume	0	0	0	0	0	0	0	0		E	EQ1M	IX_VO	L1 [6:0]			T	0	0080h
R2178 (882h)	EQ1MIX Input 2 Source	EQ1MI X_STS 2	0	0	0	0	0	0	0			EC	Q1MIX	_SRC2	[7:0]					0000h
R2179 (883h)	EQ1MIX Input 2 Volume	0	0	0	0	0	0	0	0		E	EQ1M	IX_VO	L2 [6:0]				0	0080h
R2180 (884h)	EQ1MIX Input 3 Source	EQ1MI X_STS 3	0	0	0	0	0	0	0			EC	Q1MIX	_SRC3	[7:0]					0000h
R2181 (885h)	EQ1MIX Input 3 Volume	0	0	0	0	0	0	0	0		E	EQ1M	IX_VO	L3 [6:0]			T	0	0080h
R2182 (886h)	EQ1MIX Input 4 Source	EQ1MI X_STS 4	0	0	0	0	0	0	0			EC	Q1MIX	_SRC4	[7:0]					0000h
R2183 (887h)	EQ1MIX Input 4 Volume	0	0	0	0	0	0	0	0		E	EQ1M	IX_VO	L4 [6:0]]			T	0	0080h
R2184 (888h)	EQ2MIX Input 1 Source	EQ2MI X_STS 1	0	0	0	0	0	0	0			EC	Q2MIX	_SRC1	[7:0]					0000h
R2185 (889h)	EQ2MIX Input 1 Volume	0	0	0	0	0	0	0	0		E	EQ2M	IX_VO	L1 [6:0]				0	0080h
R2186 (88Ah)	EQ2MIX Input 2 Source	EQ2MI X_STS 2	0	0	0	0	0	0	0			EC	Q2MIX	_SRC2	[7:0]					0000h
R2187 (88Bh)	EQ2MIX Input 2 Volume	0	0	0	0	0	0	0	0		E	EQ2M	IX_VO	L2 [6:0]				0	0080h
R2188 (88Ch)	EQ2MIX Input 3 Source	EQ2MI X_STS 3	0	0	0	0	0	0	0			EC	Q2MIX	_SRC3	[7:0]					0000h
R2189 (88Dh)	EQ2MIX Input 3 Volume	0	0	0	0	0	0	0	0		E	EQ2M	IX_VO	L3 [6:0]]				0	0080h
R2190 (88Eh)	EQ2MIX Input 4 Source	EQ2MI X_STS 4	0	0	0	0	0	0	0			EC	Q2MIX	_SRC4	[7:0]					0000h
R2191 (88Fh)	EQ2MIX Input 4 Volume	0	0	0	0	0	0	0	0		E	EQ2M	IX_VO	L4 [6:0]]				0	0080h
R2192 (890h)	EQ3MIX Input 1 Source	EQ3MI X_STS 1	0	0	0	0	0	0	0			EC	Q3MIX	_SRC1	[7:0]					0000h
R2193 (891h)	EQ3MIX Input 1 Volume	0	0	0	0	0	0	0	0		E	EQ3M	IX_VO	L1 [6:0]				0	0080h
R2194 (892h)	EQ3MIX Input 2 Source	EQ3MI X_STS 2	0	0	0	0	0	0	0			EC	Q3MIX	_SRC2	[7:0]					0000h
R2195 (893h)	EQ3MIX Input 2 Volume	0	0	0	0	0	0	0	0	EQ3MIX_VOL2 [6:0]									0	0080h
R2196 (894h)	EQ3MIX Input 3 Source	EQ3MI X_STS 3	0	0	0	0	0	0	0	EQ3MIX_SRC3 [7:0]										0000h
R2197 (895h)	EQ3MIX Input 3 Volume	0	0	0	0	0	0	0	0		E	EQ3M	IX_VO	L3 [6:0]				0	0080h
R2198 (896h)	EQ3MIX Input 4 Source	EQ3MI X_STS 4	0	0	0	0	0	0	0			EC	Q3MIX	_SRC4	[7:0]					0000h



REG	NAME	15	14	13	12	11	10	9	8	7 6 5 4	3 2	1	0	DEFAULT
R2199 (897h)	EQ3MIX Input 4 Volume	0	0	0	0	0	0	0	0	EQ3MIX_VOL4	[6:0]		0	0080h
R2200 (898h)	EQ4MIX Input 1 Source	EQ4MI X_STS 1	0	0	0	0	0	0	0	EQ4MIX_SF	RC1 [7:0]			0000h
R2201 (899h)	EQ4MIX Input 1 Volume	0	0	0	0	0	0	0	0	EQ4MIX_VOL1	[6:0]		0	0080h
R2202 (89Ah)	EQ4MIX Input 2 Source	EQ4MI X_STS 2	0	0	0	0	0	0	0	EQ4MIX_SF	RC2 [7:0]			0000h
R2203 (89Bh)	EQ4MIX Input 2 Volume	0	0	0	0	0	0	0	0	EQ4MIX_VOL2	[6:0]		0	0080h
R2204 (89Ch)	EQ4MIX Input 3 Source	EQ4MI X_STS 3	0	0	0	0	0	0	0	EQ4MIX_SF	RC3 [7:0]			0000h
R2205 (89Dh)	EQ4MIX Input 3 Volume	0	0	0	0	0	0	0	0	EQ4MIX_VOL3	[6:0]		0	0080h
R2206 (89Eh)	EQ4MIX Input 4 Source	EQ4MI X_STS 4	0	0	0	0	0	0	0	EQ4MIX_SF	RC4 [7:0]			0000h
R2207 (89Fh)	EQ4MIX Input 4 Volume	0	0	0	0	0	0	0	0	EQ4MIX_VOL4	[6:0]		0	0080h
R2240 (8C0h)	DRC1LMIX Input 1 Source	DRC1 LMIX_ STS1	0	0	0	0	0	0	0	DRC1LMIX_S	SRC1 [7:0]			0000h
R2241 (8C1h)	DRC1LMIX Input 1 Volume	0	0	0	0	0	0	0	0	DRC1LMIX_VOL	1 [6:0]		0	0080h
R2242 (8C2h)	DRC1LMIX Input 2 Source	DRC1 LMIX_ STS2	0	0	0	0	0	0	0	DRC1LMIX_S	SRC2 [7:0]			0000h
R2243 (8C3h)	DRC1LMIX Input 2 Volume	0	0	0	0	0	0	0	0	DRC1LMIX_VOL	2 [6:0]		0	0080h
R2244 (8C4h)	DRC1LMIX Input 3 Source	DRC1 LMIX_ STS3	0	0	0	0	0	0	0	DRC1LMIX_S	SRC3 [7:0]			0000h
R2245 (8C5h)	DRC1LMIX Input 3 Volume	0	0	0	0	0	0	0	0	DRC1LMIX_VOL	3 [6:0]		0	0080h
R2246 (8C6h)	DRC1LMIX Input 4 Source	DRC1 LMIX_ STS4	0	0	0	0	0	0	0	DRC1LMIX_S	SRC4 [7:0]			0000h
R2247 (8C7h)	DRC1LMIX Input 4 Volume	0	0	0	0	0	0	0	0	DRC1LMIX_VOL4	4 [6:0]		0	0080h
R2248 (8C8h)	DRC1RMIX Input 1 Source	DRC1 RMIX_ STS1	0	0	0	0	0	0	0	DRC1RMIX_S	SRC1 [7:0]			0000h
R2249 (8C9h)	DRC1RMIX Input 1 Volume	0	0	0	0	0	0	0	0	DRC1RMIX_VOL	1 [6:0]		0	0080h
R2250 (8CAh)	DRC1RMIX Input 2 Source	DRC1 RMIX_ STS2	0	0	0	0	0	0	0	DRC1RMIX_S	SRC2 [7:0]			0000h
R2251 (8CBh)	DRC1RMIX Input 2 Volume	0	0	0	0	0	0	0	0	DRC1RMIX_VOL	2 [6:0]		0	0080h
R2252 (8CCh)	DRC1RMIX Input 3 Source	DRC1 RMIX_ STS3	0	0	0	0	0	0	0	DRC1RMIX_S	SRC3 [7:0]			0000h
R2253 (8CDh)	DRC1RMIX Input 3 Volume	0	0	0	0	0	0	0	0	DRC1RMIX_VOL	3 [6:0]		0	0080h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4		3	2	1	0	DEFAULT
R2254 (8CEh)	DRC1RMIX Input 4 Source	DRC1 RMIX_ STS4	0	0	0	0	0	0	0			D	RC1RM	IX_SR	RC4 [7	[0]			0000h
R2255 (8CFh)	DRC1RMIX Input 4 Volume	0	0	0	0	0	0	0	0			DRC1	RMIX_\	/OL4 [[6:0]			0	0080h
R2304 (900h)	HPLP1MIX Input 1 Source	LHPF1 MIX_S TS1	0	0	0	0	0	0	0			L	HPF1MI	IX_SR	C1 [7	:0]			0000h
R2305 (901h)	HPLP1MIX Input 1 Volume	0	0	0	0	0	0	0	0			LHPF	1MIX_V	/OL1 [6:0]			0	0080h
R2306 (902h)	HPLP1MIX Input 2 Source	LHPF1 MIX_S TS2	0	0	0	0	0	0	0			L	HPF1MI	IX_SR	C2 [7	:0]			0000h
R2307 (903h)	HPLP1MIX Input 2 Volume	0	0	0	0	0	0	0	0			LHPF	1MIX_V	/OL2 [6:0]			0	0080h
R2308 (904h)	HPLP1MIX Input 3 Source	LHPF1 MIX_S TS3	0	0	0	0	0	0	0			L	HPF1MI	IX_SR	C3 [7	:0]			0000h
R2309 (905h)	HPLP1MIX Input 3 Volume	0	0	0	0	0	0	0	0			LHPF	1MIX_V	/OL3 [6:0]			0	0080h
R2310 (906h)	HPLP1MIX Input 4 Source	LHPF1 MIX_S TS4	0	0	0	0	0	0	0			L	HPF1MI	IX_SR	C4 [7	:0]			0000h
R2311 (907h)	HPLP1MIX Input 4 Volume	0	0	0	0	0	0	0	0			LHPF	1MIX_V	/OL4 [6:0]			0	0080h
R2312 (908h)	HPLP2MIX Input 1 Source	LHPF2 MIX_S TS1	0	0	0	0	0	0	0			L	HPF2MI	IX_SR	C1 [7	:0]			0000h
R2313 (909h)	HPLP2MIX Input 1 Volume	0	0	0	0	0	0	0	0			LHPF	2MIX_V	/OL1 [6:0]			0	0080h
R2314 (90Ah)	HPLP2MIX Input 2 Source	LHPF2 MIX_S TS2	0	0	0	0	0	0	0			L	HPF2MI	IX_SR	C2 [7	:0]			0000h
R2315 (90Bh)	HPLP2MIX Input 2 Volume	0	0	0	0	0	0	0	0			LHPF	2MIX_V	/OL2 [6:0]			0	0080h
R2316 (90Ch)	HPLP2MIX Input 3 Source	LHPF2 MIX_S TS3	0	0	0	0	0	0	0			L	HPF2MI	IX_SR	C3 [7	:0]			0000h
R2317 (90Dh)	HPLP2MIX Input 3 Volume	0	0	0	0	0	0	0	0			LHPF	2MIX_V	/OL3 [6:0]			0	0080h
R2318 (90Eh)	HPLP2MIX Input 4 Source	LHPF2 MIX_S TS4	0	0	0	0	0	0	0			L	HPF2MI	IX_SR	C4 [7	:0]			0000h
R2319 (90Fh)	HPLP2MIX Input 4 Volume	0	0	0	0	0	0	0	0			LHPF	2MIX_V	/OL4 [6:0]			0	0080h
R2320 (910h)	HPLP3MIX Input 1 Source	LHPF3 MIX_S TS1	0	0	0	0	0	0	0			L	HPF3MI	IX_SR	C1 [7	:0]			0000h
R2321 (911h)	HPLP3MIX Input 1 Volume	0	0	0	0	0	0	0	0			LHPF	3MIX_V	/OL1 [6:0]			0	0080h
R2322 (912h)	HPLP3MIX Input 2 Source	LHPF3 MIX_S TS2	0	0	0	0	0	0	0			L	HPF3MI	IX_SR	C2 [7	:0]			0000h
R2323 (913h)	HPLP3MIX Input 2 Volume	0	0	0	0	0	0	0	0			LHPF	3MIX_V	/OL2 [6:0]			0	0080h
R2324 (914h)	HPLP3MIX Input 3 Source	LHPF3 MIX_S TS3	0	0	0	0	0	0	0			L	HPF3MI	IX_SR	C3 [7	:0]			0000h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2		1	0	DEFAULT
R2325 (915h)	HPLP3MIX Input 3 Volume	0	0	0	0	0	0	0	0			LHPF	BMIX_V	OL3 [6:0]	ı		0	0080h
R2326 (916h)	HPLP3MIX Input 4 Source	LHPF3 MIX_S TS4	0	0	0	0	0	0	0			LH	IPF3MI	X_SRC4	[7:0]				0000h
R2327 (917h)	HPLP3MIX Input 4 Volume	0	0	0	0	0	0	0	0			LHPF	BMIX_V	OL4 [6:0]			0	0080h
R2328 (918h)	HPLP4MIX Input 1 Source	LHPF4 MIX_S TS1	0	0	0	0	0	0	0			LH	IPF4MI	X_SRC1	[7:0]				0000h
R2329 (919h)	HPLP4MIX Input 1 Volume	0	0	0	0	0	0	0	0			LHPF	IMIX_V	OL1 [6:0]			0	0080h
R2330 (91Ah)	HPLP4MIX Input 2 Source	LHPF4 MIX_S TS2	0	0	0	0	0	0	0			LH	IPF4MI	X_SRC2	[7:0]				0000h
R2331 (91Bh)	HPLP4MIX Input 2 Volume	0	0	0	0	0	0	0	0			LHPF	IMIX_V	OL2 [6:0]			0	0080h
R2332 (91Ch)	HPLP4MIX Input 3 Source	LHPF4 MIX_S TS3	0	0	0	0	0	0	0			LH	IPF4MI	X_SRC3	[7:0]				0000h
R2333 (91Dh)	HPLP4MIX Input 3 Volume	0	0	0	0	0	0	0	0			LHPF	IMIX_V	OL3 [6:0]			0	0080h
R2334 (91Eh)	HPLP4MIX Input 4 Source	LHPF4 MIX_S TS4	0	0	0	0	0	0	0			LH	IPF4MI	X_SRC4	[7:0]				0000h
R2335 (91Fh)	HPLP4MIX Input 4 Volume	0	0	0	0	0	0	0	0			LHPF4	IMIX_V	OL4 [6:0]			0	0080h
R2368 (940h)	DSP1LMIX Input 1 Source	DSP1L MIX_S TS1	0	0	0	0	0	0	0			DS	SP1LMI	X_SRC1	[7:0]				0000h
R2369 (941h)	DSP1LMIX Input 1 Volume	0	0	0	0	0	0	0	0			DSP1I	_MIX_V	OL1 [6:0]			0	0080h
R2370 (942h)	DSP1LMIX Input 2 Source	DSP1L MIX_S TS2	0	0	0	0	0	0	0			DS	SP1LMI	X_SRC2	[7:0]				0000h
R2371 (943h)	DSP1LMIX Input 2 Volume	0	0	0	0	0	0	0	0			DSP1I	_MIX_V	OL2 [6:0]			0	0080h
R2372 (944h)	DSP1LMIX Input 3 Source	DSP1L MIX_S TS3	0	0	0	0	0	0	0			DS	SP1LMI	X_SRC3	[7:0]				0000h
R2373 (945h)	DSP1LMIX Input 3 Volume	0	0	0	0	0	0	0	0			DSP1I	_MIX_V	OL3 [6:0]			0	0080h
R2374 (946h)	DSP1LMIX Input 4 Source	DSP1L MIX_S TS4	0	0	0	0	0	0	0			DS	SP1LMI	X_SRC4	[7:0]				0000h
R2375 (947h)	DSP1LMIX Input 4 Volume	0	0	0	0	0	0	0	0			DSP1I	_MIX_V	OL4 [6:0]			0	0080h
R2376 (948h)	DSP1RMIX Input 1 Source	DSP1 RMIX_ STS1	0	0	0	0	0	0	0			DS	SP1RMI	X_SRC1	[7:0]				0000h
R2377 (949h)	DSP1RMIX Input 1 Volume	0	0	0	0	0	0	0	0			DSP1F	RMIX_V	OL1 [6:0)]			0	0080h
R2378 (94Ah)	DSP1RMIX Input 2 Source	DSP1 RMIX_ STS2	0	0	0	0	0	0	0			DS	SP1RMI	X_SRC2	[7:0]				0000h
R2379 (94Bh)	DSP1RMIX Input 2 Volume	0	0	0	0	0	0	0	0			DSP1F	RMIX_V	OL2 [6:0)]			0	0080h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4		3		2	1	0	DEFAULT
R2380 (94Ch)	DSP1RMIX Input 3 Source	DSP1 RMIX_ STS3	0	0	0	0	0	0	0			DS	SP1RM	MIX_	SRC	3 [7:0	0]	•		0000h
R2381 (94Dh)	DSP1RMIX Input 3 Volume	0	0	0	0	0	0	0	0			DSP1I	RMIX_	VOL	3 [6:0	0]			0	0080h
R2382 (94Eh)	DSP1RMIX Input 4 Source	DSP1 RMIX_ STS4	0	0	0	0	0	0	0			DS	SP1RM	AIX_	SRC4	4 [7:0	0]			0000h
R2383 (94Fh)	DSP1RMIX Input 4 Volume	0	0	0	0	0	0	0	0			DSP1I	RMIX_	VOL	4 [6:0	0]			0	0080h
R2384 (950h)	DSP1AUX1MIX Input 1 Source	DSP1 AUX1 MIX_S TS	0	0	0	0	0	0	0			D	SP1Al	JX1_	SRC	7:0]			0000h
R2392 (958h)	DSP1AUX2MIX Input 1 Source	DSP1 AUX2 MIX_S TS	0	0	0	0	0	0	0			D	SP1Al	JX2_	SRC	7:0]			0000h
R2400 (960h)	DSP1AUX3MIX Input 1 Source	DSP1 AUX3 MIX_S TS	0	0	0	0	0	0	0			D	SP1Al	JX3_	SRC	7:0]			0000h
R2408 (968h)	DSP1AUX4MIX Input 1 Source	DSP1 AUX4 MIX_S TS	0	0	0	0	0	0	0			D	SP1Al	JX4_	SRC	7:0]			0000h
R2416 (970h)	DSP1AUX5MIX Input 1 Source	DSP1 AUX5 MIX_S TS	0	0	0	0	0	0	0			D	SP1Al	JX5_	SRC	7:0]			0000h
R2424 (978h)	DSP1AUX6MIX Input 1 Source	DSP1 AUX6 MIX_S TS	0	0	0	0	0	0	0			D	SP1AL	JX6_	SRC	7:0]			0000h
R2688 (A80h)	ASRC1LMIX Input 1 Source	ASRC 1LMIX _STS	0	0	0	0	0	0	0				ASRC ²	1L_9	RC [[7:0]				0000h
R2696 (A88h)	ASRC1RMIX Input 1 Source	ASRC 1RMIX _STS	0	0	0	0	0	0	0			,	ASRC1	1R_9	SRC [[7:0]				0000h
R2704 (A90h)	ASRC2LMIX Input 1 Source	ASRC 2LMIX _STS	0	0	0	0	0	0	0				ASRC	2L_S	RC [[7:0]				0000h
R2712 (A98h)	ASRC2RMIX Input 1 Source	ASRC 2RMIX _STS	0	0	0	0	0	0	0			ı	ASRC2	2R_9	SRC [[7:0]				0000h
R2816 (B00h)	ISRC1DEC1MIX Input 1 Source	ISRC1 DEC1 MIX_S TS	0	0	0	0	0	0	0			IS	RC1DI	EC1	_SRC	C [7:0)]			0000h
R2824 (B08h)	ISRC1DEC2MIX Input 1 Source	ISRC1 DEC2 MIX_S TS	0	0	0	0	0	0	0			IS	RC1DI	EC2	_SRC	C [7:0)]			0000h
R2848 (B20h)	ISRC1INT1MIX Input 1 Source	ISRC1I NT1MI X_STS	0	0	0	0	0	0	0			IS	SRC1IN	NT1_	SRC	7:0]			0000h
R2856 (B28h)	ISRC1INT2MIX Input 1 Source	ISRC1I NT2MI X_STS	0	0	0	0	0	0	0			IS	SRC1IN	NT2_	SRC	7:0]			0000h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R2880 (B40h)	ISRC2DEC1MIX Input 1 Source	ISRC2 DEC1 MIX_S TS	0	0	0	0	0	0	0			ISF	RC2DEC	1_SRC [7:0]			0000h
R2888 (B48h)	ISRC2DEC2MIX Input 1 Source	ISRC2 DEC2 MIX_S TS	0	0	0	0	0	0	0			ISF	RC2DEC	2_SRC [7:0]			0000h
R2912 (B60h)	ISRC2INT1MIX Input 1 Source	ISRC2I NT1MI X_STS	0	0	0	0	0	0	0			IS	RC2INT1	_SRC [7	7:0]			0000h
R2920 (B68h)	ISRC2INT2MIX Input 1 Source	ISRC2I NT2MI X_STS		0	0	0	0	0	0			IS	RC2INT2	2_SRC [7	7:0]			0000h
R3072 (C00h)	GPIO1 CTRL	GP1_ DIR	GP1_P U	GP1_P D	0	GP1_L VL	GP1_P OL	GP1_ OP_C FG	GP1_ DB	0			Gl	P1_FN [6	i:0]			A101h
R3073 (C01h)	GPIO2 CTRL	GP2_ DIR	GP2_P U	GP2_P D	0	GP2_L VL	GP2_P OL	GP2_ OP_C FG	GP2_ DB	0			GF	P2_FN [6	i:0]			A101h
R3074 (C02h)	GPIO3 CTRL	GP3_ DIR	GP3_P U	GP3_P D	0	GP3_L VL	GP3_P OL	GP3_ OP_C FG	GP3_ DB	0			GI	P3_FN [6	i:0]			A101h
R3075 (C03h)	GPIO4 CTRL	GP4_ DIR	GP4_P U	GP4_P D	0	GP4_L VL	GP4_P OL	GP4_ OP_C FG	GP4_ DB	0			GF	P4_FN [6	i:0]			A101h
R3076 (C04h)	GPIO5 CTRL	GP5_ DIR	GP5_P U	GP5_P D	0	GP5_L VL	GP5_P OL	GP5_ OP_C FG	GP5_ DB	0			GI	P5_FN [6	i:0]			A101h
R3087 (C0Fh)	IRQ CTRL 1	0	0	0	0	0	IRQ_P OL	IRQ_O P_CF G	0	0	0	0	0	0	0	0	0	0400h
R3088 (C10h)	GPIO Debounce Config		GP_DBT	IME [3:0]	0	0	0	0	0	0	0	0	0	0	0	0	1000h
R3104 (C20h)	Misc Pad Ctrl 1	LDO1 ENA_ PD	0	MCLK 2_PD	0	0	0	0	0	0	0	0	0	0	0	RESE T_PU	0	8002h
R3105 (C21h)	Misc Pad Ctrl 2	0	0	0	MCLK 1_PD	0	0	0	0	0	0	0	0	0	0	0	ADDR _PD	0001h
R3106 (C22h)	Misc Pad Ctrl 3	0	0	0	0	0	0	0	0	0	0	0	0	0	DMIC DAT3_ PD	DMIC DAT2_ PD	DMIC DAT1_ PD	0000h
R3107 (C23h)	Misc Pad Ctrl 4	0	0	0	0	0	0	0	0	0	0	AIF1L RCLK_ PU	AIF1L RCLK_ PD	AIF1B CLK_P U	AIF1B CLK_P D	AIF1R XDAT_ PU	AIF1R XDAT_ PD	0000h
R3108 (C24h)	Misc Pad Ctrl 5	0	0	0	0	0	0	0	0	0	0	AIF2L RCLK_ PU	AIF2L RCLK_ PD	AIF2B CLK_P U	AIF2B CLK_P D	AIF2R XDAT_ PU		0000h
R3109 (C25h)	Misc Pad Ctrl 6	0	0	0	0	0	0	0	0	0	0	AIF3L RCLK_ PU	AIF3L RCLK_ PD	AIF3B CLK_P U	AIF3B CLK_P D	AIF3R XDAT_ PU	AIF3R XDAT_ PD	0000h
R3328 (D00h)	Interrupt Status 1	0	0	0	0	0	0	0	0	0	0	0	0	GP4_E INT1	GP3_E INT1	GP2_E INT1	GP1_E INT1	0000h
R3329 (D01h)	Interrupt Status 2	0	0	0	0	0	0	0	DSP1_ RAM_ RDY_ EINT1	0	0	0	0	0	0	DSP_I RQ2_ EINT1	DSP_I RQ1_ EINT1	0000h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R3330 (D02h)	Interrupt Status 3	SPK_S HUTD OWN_ WARN _EINT 1	SPK_S HUTD OWN_ EINT1	HPDE T_EIN T1	MICDE T_EIN T1	WSEQ _DON E_EIN T1	0	DRC1_ SIG_D ET_EI NT1	ASRC 2_LOC K_EIN T1	_	UNDE RCLO CKED _EINT 1	OVER CLOC KED_ EINT1	0	FLL2_ LOCK _EINT 1	FLL1_ LOCK _EINT 1	CLKG EN_E RR_EI NT1	CLKG EN_E RR_A SYNC _EINT 1	0000h
R3331 (D03h)	Interrupt Status 4	ASRC _CFG_ ERR_ EINT1	AIF3_ ERR_ EINT1	AIF2_ ERR_ EINT1	AIF1_ ERR_ EINT1	CTRLI F_ER R_EIN T1	MIXER _DRO PPED _SAM PLE_E INT1	ASYN C_CLK _ENA_ LOW_ EINT1	SYSC LK_EN A_LO W_EIN T1	ISRC1 _CFG_ ERR_ EINT1	ISRC2 _CFG_ ERR_ EINT1	0	0	0	0	0	0	0000h
R3332 (D04h)	Interrupt Status 5	0	0	0	0	0	0	0	BOOT _DON E_EIN T1	DCS_ DAC_ DONE _EINT 1	DCS_ HP_D ONE_ EINT1	0	0	0	0	FLL2_ CLOC K_OK_ EINT1		0000h
R3336 (D08h)	Interrupt Status 1 Mask	0	0	0	0	0	0	0	0	0	0	0	0	IM_GP 4_EIN T1	IM_GP 3_EIN T1	IM_GP 2_EIN T1		000Fh
R3337 (D09h)	Interrupt Status 2 Mask	0	0	0	0	0	0	0	IM_DS P1_RA M_RD Y_EIN T1	0	0	0	0	0	0	IM_DS P_IRQ 2_EIN T1	P_IRQ	0103h
R3338 (D0Ah)	Interrupt Status 3 Mask	K_SH UTDO	IM_SP K_SH UTDO WN_EI NT1	IM_HP DET_E INT1	IM_MI CDET _EINT 1	IM_W SEQ_ DONE _EINT 1	0	IM_DR C1_SI G_DE T_EIN T1	IM_AS RC2_L OCK_ EINT1		IM_UN DERC LOCK ED_EI NT1	IM_OV ERCL OCKE D_EIN T1	0	IM_FL L2_LO CK_EI NT1	IM_FL L1_LO CK_EI NT1	IM_CL KGEN _ERR_ EINT1		FBEFh
R3339 (D0Bh)	Interrupt Status 4 Mask	_	IM_AIF 3_ERR _EINT 1	_	_	_	IM_MI XER_ DROP PED_ SAMP LE_EI NT1	YNC_	IM_SY SCLK_ ENA_L OW_EI NT1	FG_E	IM_IS RC2_C FG_E RR_EI NT1	0	0	0	0	0	0	FFC0h
	Interrupt Status 5 Mask	1	1	1	1	1	1	1		_	IM_DC S_HP_ DONE _EINT 1	0	0	0	0	IM_FL L2_CL OCK_ OK_EI NT1	L1_CL	FEC3h
R3343 (D0Fh)	Interrupt Control	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	IM_IR Q1	0000h
R3344 (D10h)	IRQ2 Status 1	0	0	0	0	0	0	0	0	0	0	0	0	GP4_E INT2	GP3_E INT2	GP2_E INT2	GP1_E INT2	0000h
R3345 (D11h)	IRQ2 Status 2	0	0	0	0	0	0	0	DSP1_ RAM_ RDY_ EINT2	0	0	0	0	0	0	DSP_I RQ2_ EINT2	DSP_I RQ1_ EINT2	0000h
R3346 (D12h)	IRQ2 Status 3	HUTD OWN_	SPK_S HUTD OWN_ EINT2		MICDE T_EIN T2	WSEQ _DON E_EIN T2	0		ASRC 2_LOC K_EIN T2		UNDE RCLO CKED _EINT 2	OVER CLOC KED_ EINT2	0	FLL2_ LOCK _EINT 2		CLKG EN_E RR_EI NT2	EN_E	0000h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R3347 (D13h)	IRQ2 Status 4	ASRC _CFG_ ERR_ EINT2	AIF3_ ERR_ EINT2	AIF2_ ERR_ EINT2	AIF1_ ERR_ EINT2	CTRLI F_ER R_EIN T2	MIXER _DRO PPED _SAM PLE_E INT2	ASYN C_CLK _ENA_ LOW_ EINT2	SYSC LK_EN A_LO W_EIN T2	ISRC1 _CFG_ ERR_ EINT2	ISRC2 _CFG_ ERR_ EINT2	0	0	0	0	0	0	0000h
R3348 (D14h)	IRQ2 Status 5	0	0	0	0	0	0	0	BOOT _DON E_EIN T2	DCS_ DAC_ DONE _EINT 2	DCS_ HP_D ONE_ EINT2	0	0	0	0	K_OK_	FLL1_ CLOC K_OK_ EINT2	0000h
R3352 (D18h)	IRQ2 Status 1 Mask	0	0	0	0	0	0	0	0	0	0	0	0	IM_GP 4_EIN T2	IM_GP 3_EIN T2	IM_GP 2_EIN T2	_	000Fh
R3353 (D19h)	IRQ2 Status 2 Mask	0	0	0	0	0	0	0	IM_DS P1_RA M_RD Y_EIN T2	0	0	0	0	0	0	IM_DS P_IRQ 2_EIN T2	_	0103h
R3354 (D1Ah)	IRQ2 Status 3 Mask	-	_	IM_HP DET_E INT2	IM_MI CDET _EINT 2	IM_W SEQ_ DONE _EINT 2	0	_	IM_AS RC2_L OCK_ EINT2	IM_AS RC1_L OCK_ EINT2	IM_UN DERC LOCK ED_EI NT2	IM_OV ERCL OCKE D_EIN T2	0	_	IM_FL L1_LO CK_EI NT2	IM_CL KGEN _ERR_ EINT2		FFEFh
R3355 (D1Bh)	IRQ2 Status 4 Mask	_	IM_AIF 3_ERR _EINT 2	_	_	_	IM_MI XER_ DROP PED_ SAMP LE_EI NT2	_	OW_EI	FG_E	IM_IS RC2_C FG_E RR_EI NT2	0	0	0	0	0	0	FFC0h
R3356 (D1Ch)	IRQ2 Status 5 Mask	1	1	1	1	1	1	1	IM_BO OT_D ONE_ EINT2	S_DA	IM_DC S_HP_ DONE _EINT 2	0	0	0	0	IM_FL L2_CL OCK_ OK_EI NT2	L1_CL OCK_	FEC3h
R3359 (D1Fh)	IRQ2 Control	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	IM_IR Q2	0000h
R3360 (D20h)	Interrupt Raw Status 2	0	0	0	0	0	0	0	DSP1_ RAM_ RDY_ STS	0	0	0	0	0	0	DSP_I RQ2_ STS	DSP_I RQ1_ STS	0000h
R3361 (D21h)	Interrupt Raw Status 3		SPK_S HUTD OWN_ STS	0	0	WSEQ _DON E_STS	0		ASRC 2_LOC K_STS	1_LOC		OVER CLOC KED_ STS	0	FLL2_ LOCK _STS	FLL1_ LOCK _STS	CLKG EN_E RR_S TS	EN_E	0000h
R3362 (D22h)	Interrupt Raw Status 4	ASRC _CFG_ ERR_ STS	_	AIF2_ ERR_ STS	AIF1_ ERR_ STS	CTRLI F_ER R_STS	MIXER _DRO PPED _SAM PLE_S TS	ASYN C_CLK _ENA_ LOW_ STS	SYSC LK_EN A_LO W_ST S	ISRC1 _CFG_ ERR_ STS	ISRC2 _CFG_ ERR_ STS	0	0	0	0	0	0	0000h
R3363 (D23h)	Interrupt Raw Status 5	0	0	0	0	0	0	0	BOOT _DON E_STS	DCS_ DAC_ DONE _STS	DCS_ HP_D ONE_ STS	0	0	0	0	FLL2_ CLOC K_OK_ STS	CLOC	0000h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R3364 (D24h)	Interrupt Raw	0	0	PWM_	FX_C	0	DAC_	DAC_	ADC_	MIXER	AIF3_	AIF2_	AIF1_	AIF3_	AIF2_	AIF1_	PAD_	0000h
	Status 6			OVER	ORE_		SYS_	WARP	OVER	_OVE	ASYN	ASYN	ASYN	SYNC	SYNC	SYNC	CTRL_	
				CLOC KED	OVER CLOC		OVER CLOC	_OVE RCLO	CLOC KED_	RCLO CKED	C_OV ERCL	C_OV ERCL	C_OV ERCL	_OVE RCLO	_OVE RCLO	_OVE RCLO	OVER CLOC	
				STS	KED_		KED_	CKED	STS	_STS	OCKE		OCKE	CKED	CKED	CKED	KED_	
					STS		STS	_STS			D_STS	D_STS	D_STS	_STS	_STS	_STS	STS	
R3365 (D25h)	Interrupt Raw	SLIMB		SLIMB	ASRC		ASRC	ASRC	0	0	0	0	0	DSP1_	0	ISRC2	ISRC1	0000h
	Status 7	US_S UBSY	US_A SYNC	US_S YNC_	_ASY NC_S	_ASY	_SYN C_SY	_SYN C_WA						OVER CLOC		_OVE RCLO	_OVE RCLO	
		S_OV	_OVE	OVER	YS_O	ARP	S_0V	RP_O						KED_		CKED	CKED	
		ERCL	RCLO	CLOC	VERC	OVER	ERCL	VERC						STS		_STS	_STS	
		OCKE		KED_	LOCK		OCKE	LOCK										
		D_STS	_STS	STS	ED_ST S	KED_ STS	ט_515	ED_ST S										
R3366 (D26h)	Interrupt Raw	0	0	0	0	0	AIF3_	AIF2_	AIF1_	0	ISRC2	ISRC1	FX_U	ASRC	DAC_	ADC_	MIXER	0000h
	Status 8						UNDE	UNDE	UNDE		_UND	_UND	NDER	_UND	UNDE	UNDE	_UND	
							RCLO CKED	RCLO CKED	RCLO CKED		ERCL OCKE	ERCL OCKE	CLOC KED_	ERCL OCKE	RCLO CKED	RCLO CKED	ERCL OCKE	
							_STS	_STS	_STS			D_STS	_	D_STS	_STS		D_STS	
R3392 (D40h)	IRQ Pin Status	0	0	0	0	0	0	0	0	0	0	0	0	0	0	IRQ2_ STS	IRQ1_ STS	0000h
R3393 (D41h)	ADSP2 IRQ0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	DSP_I RQ2	DSP_I RQ1	0000h
R3408 (D50h)	AOD wkup and trig	0	0	0	0	0	0	0	0	MICD_	MICD_	GP5_F	GP5_	JD1_F	JD1_R	0	0	0000h
										CLAM P_FAL	CLAM P_RIS	_	RISE_ TRIG_	ALL_T RIG_S	ISE_T RIG_S			
										L_TRI	E_TRI	TS	STS	TS	TS			
										G_ST	G_ST							
										S	S							
R3409 (D51h)	AOD IRQ1	0	0	0	0	0	0	0	0	MICD_	MICD_	GP5_F	GP5_	JD1_F	JD1_R	0	0	0000h
										CLAM P_FAL	CLAM P_RIS	ALL_E INT1	RISE_ EINT1	ALL_E INT1	ISE_EI NT1			
										L_EIN	E_EIN							
R3410 (D52h)	AOD IRQ2	0	0	0	0	0	0	0	0	T1 MICD	T1 MICD	GP5 F	GP5_	JD1_F	JD1_R	0	0	0000h
. 10 . 10 (2021)										CLAM	CLAM	_	RISE_	ALL_E	ISE_EI		ľ	0000.1
										P_FAL	P_RIS	INT2	EINT2	INT2	NT2			
										L_EIN T2	E_EIN T2							
D3/11 (D53h)	AOD IRQ Mask	0	0	0	0	0	0	0	0	IM_MI		IM_GP	IM GP	IM ID	IM ID	0	0	003Ch
110411 (D3311)	IRQ1			U	U	0	0	U	0			5_FAL				U		003011
										AMP_	AMP_	L_EIN	E_EIN	L_EIN	E_EIN			
										FALL_ EINT1	RISE_ EINT1	T1	T1	T1	T1			
D3/12 (D5/h)	AOD IRQ Mask	0	0	0	0	0	0	0	0	IM_MI	IM_MI	IM CD	IM_GP	IM_JD	IM_JD	0	0	003Ch
K3412 (D34II)	IRQ2	U	U	U	U	U	U	U	U			5_FAL				U	0	003011
										AMP_	AMP_			L_EIN				
										FALL_ EINT2	RISE_ EINT2	T2	T2	T2	T2			
D2412 (DEEP)	AOD IRQ Raw	0	0	0	0	0	0	0	0	0	0	0	0	MICD_	GP5_S	0	JD1_S	0000h
K3413 (D3311)	Status	U	U	U	U	U	U	U	U	U	U	U	U	CLAM	TS	U	TS	000011
														P_STS				
R3414 (D56h)	Jack detect	0	0	0	0	0	0	0	0	0	0	0	0	MICD_	0	0	JD1_D	0000h
	debounce													CLAM P_DB			В	
R3584 (E00h)	FX_Ctrl1	0		FX_RA	TE [3:01		0	0	0	0	0	0	0	0	0	0	0	0000h
R3585 (E01h)			<u> </u>		_ [0.0]		FX_ST							0	0	0	0	0000h
R3600 (E10h)			EQ1	B1_GAII	N [4:01				B2_GAII	N [4:01		ĺ	EQ1	B3_GAII		-	EQ1_E	6318h
7					<u> </u>					- '							NA	
R3601 (E11h)	EQ1_2		EQ1_	B4_GAII	N [4:0]			EQ1_	B5_GAII	N [4:0]		0	0	0	0	0	EQ1_	6300h



REG	NAME	15	14	13	12	11	10	Т	9	8	I	7	6		5	4		3	2		1		0	DEFAULT
R3602 (E12h)	EQ1_3									EQ1_I	B1_/	A [15:0]											0FC8h
R3603 (E13h)	EQ1_4									EQ1_I	B1_I	3 [15:0]											03FEh
R3604 (E14h)	EQ1_5								Е	Q1_E	1_P	G [15	0]											00E0h
R3605 (E15h)	EQ1_6									EQ1_I	32_/	\ [15:0]											1EC4h
R3606 (E16h)	EQ1_7									EQ1_I	32_I	3 [15:0]											F136h
R3607 (E17h)										EQ1_I	32_0	(15:0)]											0409h
R3608 (E18h)									E	Q1_B	2_P	G [15:	0]											04CCh
R3609 (E19h)	EQ1_10									EQ1_I	33_/	\ [15:(]											1C9Bh
R3610 (E1Ah)	EQ1_11									EQ1_I	33_I	3 [15:0]											F337h
R3611 (E1Bh)	EQ1_12									EQ1_I	33_0	C [15:0)]											040Bh
R3612 (E1Ch)	EQ1_13								E	Q1_B	3_P	G [15:	0]											0CBBh
R3613 (E1Dh)										EQ1_I	B4_/	\ [15:0]											16F8h
R3614 (E1Eh)	EQ1_15									EQ1_I	B4_I	3 [15:0]											F7D9h
R3615 (E1Fh)	EQ1_16									EQ1_I	34_0	C [15:0)]											040Ah
R3616 (E20h)	EQ1_17								Е	Q1_B	4_P	G [15:	0]											1F14h
R3617 (E21h)	EQ1_18									EQ1_I	35_/	A [15:0]											058Ch
R3618 (E22h)										EQ1_I	35_I	3 [15:0]											0563h
R3619 (E23h)									Е	Q1_E	5_P	G [15:	0]											4000h
R3620 (E24h)										EQ1_I														0B75h
R3622 (E26h)	EQ2_1		EQ2_	B1_GAIN	N [4:0]			Е	Q2_	B2_G	AIN	[4:0]	-			EQ2	2_B3_	_GAI	N [4:0]			2_E NA	6318h
R3623 (E27h)	EQ2_2		EQ2_	B4_GAIN	N [4:0]			E	Q2_	B5_G	AIN	[4:0]			0	0		0	0		0		Q2_ DDE	6300h
R3624 (E28h)	EQ2_3									EQ2_I	31_/	A [15:0]									-		0FC8h
R3625 (E29h)										EQ2_														03FEh
R3626 (E2Ah)									Е	Q2_E	1_P	G [15:	0]											00E0h
R3627 (E2Bh)	EQ2_6									EQ2_I	32_/	\ [15:0]											1EC4h
R3628 (E2Ch)	EQ2_7									EQ2_I	32_I	3 [15:0]											F136h
R3629 (E2Dh)	EQ2_8									EQ2_I	32_0	C [15:0)]											0409h
R3630 (E2Eh)	EQ2_9								Е	Q2_E	2_P	G [15	0]											04CCh
R3631 (E2Fh)	EQ2_10									EQ2_I	33_/	A [15:0]											1C9Bh
R3632 (E30h)										EQ2_I														F337h
R3633 (E31h)	EQ2_12									EQ2_I	33_0	C [15:0)]											040Bh
R3634 (E32h)									Е	Q2_E	3_P	G [15	0]											0CBBh
R3635 (E33h)	EQ2_14									EQ2_I	B4_/	\ [15:0]											16F8h
R3636 (E34h)	EQ2_15									EQ2_I	B4_I	3 [15:0]											F7D9h
R3637 (E35h)	EQ2_16									EQ2_I	34_0	C [15:0)]											040Ah
R3638 (E36h)	EQ2_17								Е	Q2_E	4_P	G [15	0]											1F14h
R3639 (E37h)	EQ2_18									EQ2_I	35_/	A [15:0]											058Ch
R3640 (E38h)										EQ2_														0563h
R3641 (E39h)									Е	Q2_E	5_P	G [15:	0]											4000h
R3642 (E3Ah)	EQ2_21									EQ2_I														0B75h
R3644 (E3Ch)	EQ3_1		EQ3_	B1_GAIN	N [4:0]			Е		B2_G			-			EQ3	B_B3_	_GAI	N [4:0]			3_E NA	6318h
R3645 (E3Dh)	EQ3_2		EQ3_	B4_GAIN	N [4:0]			E	Q3_	B5_G	AIN	[4:0]		T	0	0		0	0		0	E	Q3_ DDE	6300h
R3646 (E3Eh)	EQ3_3									EQ3_I	B1_/	\ [15:0]						•					0FC8h
R3647 (E3Fh)										EQ3_														03FEh
R3648 (E40h)										Q3_E														00E0h
R3649 (E41h)										EQ3_I														1EC4h
	1	+										3 [15:0												F136h



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REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R3651 (E43h)									EQ3_B2	2_C [15:0)]							0409h
R3652 (E44h)	EQ3_9								Q3_B2_	_PG [15:	0]							04CCh
R3653 (E45h)	EQ3_10								EQ3_B3	3_A [15:0]							1C9Bh
R3654 (E46h)	EQ3_11								EQ3_B3	3_B [15:0]							F337h
R3655 (E47h)	EQ3_12								EQ3_B3	3_C [15:0)]							040Bh
R3656 (E48h)	EQ3_13							E	EQ3_B3_	_PG [15:	0]							0CBBh
R3657 (E49h)	EQ3_14								EQ3_B4	1_A [15:0]							16F8h
R3658 (E4Ah)	EQ3_15								EQ3_B4	1_B [15:0]							F7D9h
R3659 (E4Bh)	EQ3_16								EQ3_B4	1_C [15:0)]							040Ah
R3660 (E4Ch)	EQ3_17							E	Q3_B4_	_PG [15:	0]							1F14h
R3661 (E4Dh)	EQ3_18								EQ3_B5	5_A [15:0]							058Ch
R3662 (E4Eh)									EQ3_B5	5_B [15:0]							0563h
R3663 (E4Fh)										 _PG [15:								4000h
R3664 (E50h)										 I_C [15:0								0B75h
R3666 (E52h)			FO4	B1_GAII	N [4·0]		ĺ		B2_GAI				FO4	B3_GAI	N [4·0]		EQ4_E	6318h
110000 (2021)				D1_0/111	1[1.0]				_D2_O/ \\					_D0_0/11			NA	001011
R3667 (E53h)	EQ4_2		EQ4_	B4_GAII	N [4:0]			EQ4_	B5_GAI	N [4:0]		0	0	0	0	0	EQ4_ MODE	6300h
R3668 (E54h)	EQ4_3								EQ4_B1	1_A [15:0]							0FC8h
R3669 (E55h)	EQ4_4								EQ4_B1	1_B [15:0]							03FEh
R3670 (E56h)	EQ4_5							E	Q4_B1	_PG [15:	0]							00E0h
R3671 (E57h)	EQ4_6									2_A [15:0								1EC4h
R3672 (E58h)										 2_B [15:0								F136h
R3673 (E59h)										 2_C [15:0								0409h
R3674 (E5Ah)										PG [15:								04CCh
R3675 (E5Bh)										o [.o. B_A [15:0								1C9Bh
R3676 (E5Ch)										3_B [15:0								F337h
R3677 (E5Dh)										3_C [15:0								040Bh
R3678 (E5Eh)										_PG [15:								0CBBh
R3679 (E5Fh)										_ •								
, ,										1_A [15:0								16F8h
R3680 (E60h)										1_B [15:0	-							F7D9h
R3681 (E61h)										1_C [15:0								040Ah
R3682 (E62h)										_PG [15:								1F14h
R3683 (E63h)									EQ4_B5	5_A [15:0]							058Ch
_ '		<u> </u>							EQ4_B5	5_B [15:0]							0563h
R3685 (E65h)									Q4_B5_	_PG [15:	0]							4000h
R3686 (E66h)									T	I_C [15:0)]							0B75h
R3712 (E80h)	DRC1 ctrl1	D	RC1_SI	G_DET_	RMS [4:	0]		SIG_DE ([1:0]	DRC1_ NG_E NA		DRC1_ SIG_D ET	DRC1_ KNEE 2_OP_ ENA	DRC1_ QR		DRC1_ WSEQ _SIG_ DET_E NA	_ENA	DRC1 R_EN A	0018h
R3713 (E81h)	DRC1 ctrl2	0	0	0		DRC1_	ATK [3:0]		DRC1_E	OCY [3:0]		DRC1	_MINGA	IN [2:0]	DRC1_ IN [MAXGA [1:0]	0933h
R3714 (E82h)	DRC1 ctrl3	DRC	1_NG_N	IINGAIN	[3:0]		NG_EX [1:0]		_QR_TH [1:0]		QR_DC 1:0]	DRC1_	_HI_COI	MP [2:0]	DRC1_			0018h
R3715 (E83h)	DRC1 ctrl4	0	0	0	0	0		D	RC1_KN	IEE_IP [5	5:0]			DRC1	_KNEE_0	OP [4:0]		0000h
R3716 (E84h)	DRC1 ctrl5	0	0	0	0	0	0		DRC1_	KNEE2	_IP [4:0]			DRC1_	KNEE2_	OP [4:0]		0000h
R3776 (EC0h)		0	0	0	0	0	0	0	0	0	0	0	0	0	0	LHPF1 _MOD _E	LHPF1	0000h
R3777 (EC1h)	HPLPF1_2	<u> </u>	1					Lŀ	HPF1 C	OEFF [1	5:0]				1			0000h
, ,									_									



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	DEFAULT
R3780 (EC4h)		0	0	0	0	0	0	0	0	0	0	0	0	0	0		LHPF2	0000h
(==,	_															_MOD	_ENA	
																Е		
R3781 (EC5h)					1	1		I	IPF2_CC		I		1			1	1	0000h
R3784 (EC8h)	HPLPF3_1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	LHPF3 _MOD	LHPF3 _ENA	0000h
																_IVIOD	LINA	
R3785 (EC9h)	HPLPF3_2							LH	IPF3_CC	EFF [15	5:0]							0000h
R3788 (ECCh)	HPLPF4_1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	LHPF4	LHPF4	0000h
																_MOD	_ENA	
R3789 (ECDh)	HDI DE/L 2							116	IPF4_CC	NEEE [18	:-01					E		0000h
	ASRC_ENABLE	0	0	0	0	0	0	0	0	0	0	0	0	ASRC	ASRC	ASRC	ASDC	0000h
113000 (LLUII)	//ORO_EIV/BEE			0		0	ľ			U	ľ						1R_EN	
														Α	Α	Α	Α	
R3809 (EE1h)	ASRC_STATUS	0	0	0	0	0	0	0	0	0	0	0	0	ASRC		ASRC	ASRC	0000h
														_	_	_	1R_EN A_STS	
R3810 (EE2h)	ASRC_RATE1	0	А	SRC RA	ATE1 [3:	01	0	0	0	0	0	0	0	0	0	0	0	0000h
	ASRC_RATE2	0			ATE2 [3:		0	0	0	0	0	0	0	0	0	0	0	0400h
	ISRC 1 CTRL 1	0			SH [3:0]		0	0	0	0	0	0	0	0	0	0	0	0000h
R3825 (EF1h)	ISRC 1 CTRL 2	0		ISRC1_I	FSL [3:0]]	0	0	0	0	0	0	0	0	0	0	0	0000h
R3826 (EF2h)	ISRC 1 CTRL 3	ISRC1	ISRC1	0	0	0	0	ISRC1	ISRC1	0	0	0	0	0	0	0	ISRC1	0000h
		_INT1	_INT2					_DEC1	_DEC2								_NOT	
		_ENA	_ENA					_ENA	_ENA								CH_E NA	
R3827 (EF3h)	ISRC 2 CTRL 1	0		ISRC2 F	SH [3:0]	1	0	0	0	0	0	0	0	0	0	0	0	0000h
, ,	ISRC 2 CTRL 2	0			FSL [3:0]		0	0	0	0	0	0	0	0	0	0	0	0000h
	ISRC 2 CTRL 3	ISRC2	ISRC2	0	0	0	0	ISRC2	ISRC2	0	0	0	0	0	0	0	ISRC2	0000h
		_INT1	_INT2					_DEC1	_DEC2								_NOT	
		_ENA	_ENA					_ENA	_ENA								CH_E NA	
R4352	DSP1 Control 1	0		DSP1 R	ATE [3:0)]	0	0	0	0	0	0	DSP1	0	DSP1	DSP1	DSP1	0010h
(1100h)													MEM_		_	CORE	_	
				ı	ı	ı							ENA		NA	_ENA	T	
R4353 (1101h)	DSP1 Clocking 1	0	0	0	0	0	0	0	0	0	0	0	0	0	DSP1_	_CLK_SE	EL [2:0]	0000h
R4356	DSP1 Status 1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	DSP1_	0000h
(1104h)	Doi 1 otatus 1	0	0	0	U	U	0	0	0	U	U	U	0	U	0	U	RAM_	000011
																	RDY	
R4357	DSP1 Status 2	DSP1_	DSP1_	0	0	0	0	0	0		DSF	P1_WDM	1A_ACTI	VE_CHA	NNELS	[7:0]		0000h
(1105h)		FULL	PONG _FULL															
R4368	DSP1 WDMA	. 522	022				SP1 S1	ART AD	DRESS	WDMA	BUFFE	R 0 [15:	:01					0000h
(1110h)	Buffer 1											[-,					
R4369	DSP1 WDMA					D	SP1_S1	TART_AD	DRESS	_WDMA	_BUFFE	R_1 [15:	:0]					0000h
(1111h)	Buffer 2																	
R4370 (1112h)	DSP1 WDMA Buffer 3						SP1_S1	TART_AD	DRESS	_WDMA	_BUFFE	R_2 [15:	:0]					0000h
R4371	DSP1 WDMA	1				r	SP1 ST	ART AF	DRESS	WDMA	BLIFFF	R 3 [15	·01					0000h
(1113h)	Buffer 4	1				_						0 [10.	.~]					
R4372	DSP1 WDMA					D	SP1_S1	ART_AD	DRESS	_WDMA	BUFFE	R_4 [15:	:0]					0000h
(1114h)	Buffer 5	-																
R4373	DSP1 WDMA					D	SP1_S1	TART_AD	DRESS	_WDMA	_BUFFE	R_5 [15:	:0]					0000h
(1115h)	Buffer 6 DSP1 WDMA	1					יס ומסו	ΔDT ΛΓ	DRESS	WDM	Blicco	D C ME	·01					0000h
R4374									コルトつう		OUFFE		1/1					 (AAAAII)



REG	NAME	15	14	13	12	11	10	9	8	7	6	5 4 3 2 1 0	DEFAULT
R4375 (1117h)	DSP1 WDMA Buffer 8					D	SP1_ST	ART_A	DRESS	_WDMA	_BUFFE	ER_7 [15:0]	0000h
R4384 (1120h)	DSP1 RDMA Buffer 1					С	OSP1_S1	ART_AI	DDRESS	_RDMA	_BUFFE	R_0 [15:0]	0000h
R4385 (1121h)	DSP1 RDMA Buffer 2					Г	OSP1_S1	ART_AI	DDRESS	_RDMA	_BUFFE	R_1 [15:0]	0000h
R4386 (1122h)	DSP1 RDMA Buffer 3					Г	OSP1_ST	ART_AI	DDRESS	_RDMA	_BUFFE	R_2 [15:0]	0000h
R4387 (1123h)	DSP1 RDMA Buffer 4					С	OSP1_S1	ART_AI	DDRESS	_RDMA	_BUFFE	R_3 [15:0]	0000h
R4388 (1124h)	DSP1 RDMA Buffer 5					Г	OSP1_ST	ART_AI	DDRESS	_RDMA	_BUFFE	R_4 [15:0]	0000h
R4389 (1125h)	DSP1 RDMA Buffer 6					[OSP1_S1	ART_AI	DDRESS	_RDMA	_BUFFE	R_5 [15:0]	0000h
R4400 (1130h)	DSP1 WDMA Config 1	0	0			T		DS	P1_WDN	MA_BUF	FER_LE	NGTH [13:0]	0000h
R4401 (1131h)	DSP1 WDMA Config 2	0	0	0	0	0	0	0	0		DSI	P1_WDMA_CHANNEL_ENABLE [7:0]	0000h
R4404 (1134h)	DSP1 RDMA Config 1	0	0	0	0	0	0	0	0	0	0	DSP1_RDMA_CHANNEL_ENABLE [5:0]	0000h
R4416 (1140h)	DSP1 Scratch 0							DSP	1_SCRA	TCH_0	[15:0]		0000h
R4417 (1141h)	DSP1 Scratch 1								1_SCRA				0000h
R4418 (1142h)	DSP1 Scratch 2								1_SCRA				0000h
R4419 (1143h)	DSP1 Scratch 3							DSP	1_SCRA	TCH_3	15:0]		0000h
	_					Co	ntrol Wri	te Seque	ncer Me	mory			
R12288 (3000h)	WSEQ Sequence 1	WSEQ_	DATA_\ [2:0]	VIDTH0		T				WSEC	_ADDR(0 [12:0]	0225h
R12289 (3001h)	WSEQ Sequence 2	W	SEQ_DE	LAY0 [3	:0]	WSE	Q_DATA	_START	0 [3:0]			WSEQ_DATA0 [7:0]	0001h
R12290 (3002h)	WSEQ Sequence 3		[2:0]			ı				WSEC	_ADDR		0000h
R12291 (3003h)	WSEQ Sequence 4	W	SEQ_DE	LAY1 [3	:0]	WSE	Q_DATA	_START	1 [3:0]			WSEQ_DATA1 [7:0]	0003h
								(Similar	for WSE	Q Index	2 254	()	
R12798 (31FEh)	WSEQ Sequence 511		DATA_\ 55 [2:0]	VIDTH2		1				WSEQ_	ADDR2	55 [12:0]	0000h
R12799 (31FFh)	WSEQ Sequence 512	WS	EQ_DEL	.AY255 [3:0]	WSEQ	_DATA_	START2	55 [3:0]			WSEQ_DATA255 [7:0]	0000h
	ı					Г	DSP1 F	irmware	Memory	<u> </u>			_
R1048576 (10_0000h)	DSP1PM0	0	0	0	0	0	0	0	0			DSP1_PM_0 [39:32]	0000h
R1048577 (10_0001h)	DSP1PM1								SP1_PM				0000h
R1048578 (10_0002h)	DSP1PM2					ı —		ı	OSP1_PI	M_0 [15:	0]		0000h
R1048579 (10_0003h)	DSP1PM3	0	0	0	0	0	0	0	0			DSP1_PM_1 [39:32]	0000h
R1048580 (10_0004h)	DSP1PM4								SP1_PN				0000h
R1048581 (10_0005h)	DSP1PM5							[OSP1_PI	M_1 [15:)]		0000h



REG	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	:	2	1	0	DEFAULT
							(Simil	ar for DS	SP1 Prog	ram Men	nory 2	. 8190)							
R1073149 (10_5FFDh)	DSP1PM024573	0	0	0	0	0	0	0	0	DSP1_PM_8191 [39:32]				0000h					
R1073150 (10_5FFEh)	DSP1PM24574							DS	P1_PM_	8191 [31	:16]								0000h
R1073151 (10_5FFFh)	DSP1PM24575							DS	SP1_PM_	_8191 [1	5:0]								0000h
R1572864 (18_0000h)	DSP1ZM0	0	0	0	0	0	0	0	0	DSP1_ZM_0 [23:16]				0000h					
R1572865 (18_0001h)	DSP1ZM1		•	•		•		[OSP1_ZN	И_0 [15:0)]								0000h
R1572866 (18_0002h)	DSP1ZM2	0	0	0	0	0	0	0	0			[SP1_Z	M_1 [23	3:16]				0000h
R1572867 (18_0003h)	DSP1ZM3								OSP1_ZN	И_1 [15:0)]								0000h
			ſ	1		1	(Simila	r for DSI	P1 Coeffi	cient Me	mory 2 .	1022)							
R1574910 (18_07FEh)	DSP1ZM2046	0	0	0	0	0	0	0	0	DSP1_ZM_1023 [23:16]			0000h						
R1574911 (18_07FFh)	DSP1ZM2047		DSP1_ZM_1023 [15:0]				0000h												
R1638400 (19_0000h)	DSP1XM0	0	0	0	0	0	0	0	0	DSP1_XM_0 [23:16]			0000h						
R1638401 (19_0001h)	DSP1XM1		DSP1_XM_0 [15:0]			0000h													
R1638402 (19_0002h)	DSP1XM2	0	0	0	0	0	0	0	0	DSP1_XM_1 [23:16]			0000h						
R1638403 (19_0003h)	DSP1XM3		DSP1_XM_1 [15:0]					0000h											
		(Similar for DSP1 X Data Memory 2 9214)																	
R1656830 (19_47FEh)	DSP1XM18430	0	0	0	0	0	0	0	0			DS	P1_XM	_9215 [[23:16]				0000h
R1656831 (19_47FFh)	DSP1XM18431	DSP1_XM_9215 [15:0]			0000h														
R1736704 (1A_8000h)	DSP1YM0	0	0	0	0	0	0	0	0	DSP1_YM_0 [23:16]			0000h						
R1736705 (1A_8001h)	DSP1YM1		DSP1_YM_0 [15:0]				0000h												
R1736706 (1A_8002h)	DSP1YM2	0	0	0	0	0	0	0	0			Г	SP1_Y	M_1 [23	3:16]				0000h
R1736707 (1A_8003h)	DSP1YM3 DSP1_YM_1 [15:0]						0000h												
		(Similar for DSP1 Y Data Memory 2 3070)																	
R1742846 (1A_97FEh)	DSP1YM6142	0	0	0	0	0	0	0	0	DSP1_YM_3071 [23:16]			0000h						
R1742847 (1A_97FFh)	DSP1YM6143				_	_		DS	SP1_YM_	_3071 [1	5:0]		_	_	_				0000h



APPLICATIONS INFORMATION

RECOMMENDED EXTERNAL COMPONENTS

ANALOGUE INPUT PATHS

The WM5102 provides up to 6 analogue audio input paths. Each of these inputs is referenced to the internal DC reference, VMID. A DC blocking capacitor is required for each analogue input pin used in the target application. The choice of capacitor is determined by the filter that is formed between that capacitor and the impedance of the input pin. The circuit is illustrated in Figure 82.

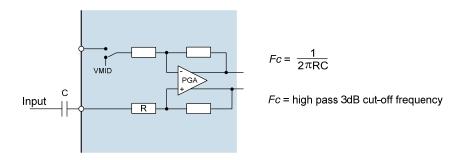


Figure 82 Audio Input Path DC Blocking Capacitor

In accordance with the WM5102 input pin resistance (see "Electrical Characteristics"), it is recommended that a $1\mu F$ capacitance for all input connections will give good results in most cases, with a 3dB cut-off frequency around 13Hz.

Ceramic capacitors are suitable, but care must be taken to ensure the desired capacitance is maintained at the AVDD operating voltage. Also, ceramic capacitors may show microphonic effects, where vibrations and mechanical conditions give rise to electrical signals. This is particularly problematic for microphone input paths where a large signal gain is required.

A single capacitor is required for a single-ended line or microphone input connection. For a differential input connection, a DC blocking capacitor is required on both input pins.

The external connections for single-ended and differential microphones, incorporating the WM5102 microphone bias circuit, are shown later in the "Microphone Bias Circuit" section - see Figure 83.

DIGITAL MICROPHONE INPUT PATHS

The WM5102 provides up to 6 digital microphone input paths; two channels of audio data can be multiplexed on each of the DMICDATn pins. Each of these stereo pairs is clocked using the respective DMICCLKn pin.

The external connections for digital microphones, incorporating the WM5102 microphone bias circuit, are shown later in the "Microphone Bias Circuit" section - see Figure 85.

Ceramic decoupling capacitors for the digital microphones may be required - refer to the specific recommendations for the application microphone(s).

When two microphones are connected to a single DMICDAT pin, the microphones must be configured to ensure that the Left mic transmits a data bit when DMICCLK is high, and the Right mic transmits a data bit when DMICCLK is low. The WM5102 samples the digital microphone data at the end of each DMICCLK phase. Each microphone must tri-state its data output when the other microphone is transmitting. Integrated pull-down resistors can be enabled on the DMICDAT pins if required.

The voltage reference for each digital microphone interface is selectable. It is important that the selected reference for the WM5102 interface is compatible with the applicable configuration of the external microphone.



MICROPHONE BIAS CIRCUIT

The WM5102 is designed to interface easily with up to 6 analogue or digital microphones.

Each microphone requires a bias current (electret condenser microphones) or voltage supply (silicon microphones); these can be provided by the MICBIAS1, MICBIAS2 or MICBIAS3 regulators on the WM5102.

Note that the MICVDD pin can also be used (instead of MICBIASn) as a reference or power supply for external microphones. The MICBIAS outputs are recommended, as these offer better noise performance and independent enable/disable control.

Analogue microphones may be connected in single-ended or differential configurations, as illustrated in Figure 83. The differential configuration provides better performance due to its rejection of common-mode noise; the single-ended method provides a reduction in external component count.

A current-limiting resistor is required when using an electret condenser microphone (ECM). The resistance should be chosen according to the minimum operating impedance of the microphone and MICBIAS voltage so that the maximum bias current of the WM5102 is not exceeded.

A $2.2k\Omega$ current-limiting resistor is recommended; this provides compatibility with a wide range of microphone components.

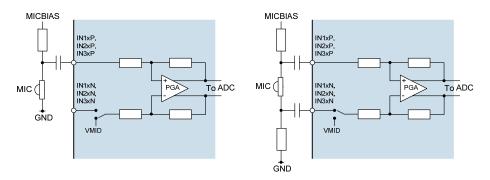


Figure 83 Single-Ended and Differential Analogue Microphone Connections

Analogue MEMS microphones can be connected to the WM5102 as illustrated in Figure 84. In this configuration, the MICBIAS generators provide a low-noise supply for the microphones; a current-limiting resistor is not required.

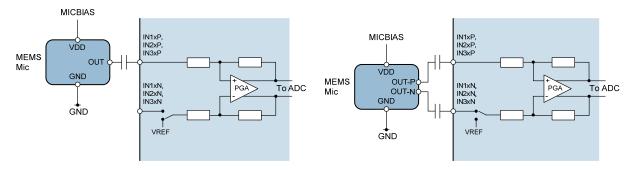


Figure 84 Single-Ended and Differential Analogue Microphone Connections

Digital microphone connection to the WM5102 is illustrated in Figure 85.

Ceramic decoupling capacitors for the digital microphones may be required - refer to the specific recommendations for the application microphone(s).

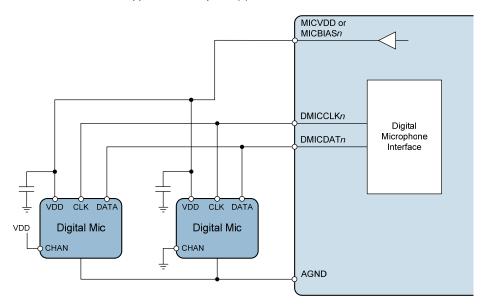


Figure 85 Digital Microphone Connection

The MICBIAS generators can each operate as a voltage regulator or in bypass mode. See "Charge Pumps, Regulators and Voltage Reference" for details of the MICBIAS generators.

In Regulator mode, the MICBIAS regulators are designed to operate without external decoupling capacitors. The regulators can be configured to support a capacitive load if required (eg. for digital microphone supply decoupling). The compatible load conditions are detailed in the "Electrical Characteristics" section.

If the capacitive load on MICBIAS1, MICBIAS2 or MICBIAS3 exceeds the specified conditions for Regulator mode (eg. due to a decoupling capacitor or long PCB trace), then the respective generator must be configured in Bypass mode.

The maximum output current for each MICBIAS n pin is noted in the "Electrical Characteristics". This limit must be observed on each MICBIAS output, especially if more than one microphone is connected to a single MICBIAS pin. Note that the maximum output current differs between Regulator mode and Bypass mode. The MICBIAS output voltage can be adjusted using register control in Regulator mode.

HEADPHONE/EARPIECE DRIVER OUTPUT PATH

The WM5102 provides 2 stereo headphone and 1 mono earpiece output drivers. These outputs are all ground-referenced, allowing direct connection to the external load(s). There is no requirement for DC blocking capacitors.

In single-ended (default) configuration, the headphone outputs comprise 4 independently controlled output channels, for up to 2 stereo headphone or line outputs. In mono (BTL) mode, the headphone drivers support up to 2 differential outputs, suitable for a mono earpiece or hearing coil load.

The headphone outputs incorporate a common mode, or ground loop, feedback path which provides rejection of system-related ground noise. The feedback pins must be connected to ground for normal operation of the headphone outputs. Two alternate feedback pins are configurable for the HPOUT1L and HPOUT1R drivers.

The feedback pins should be connected to GND close to the respective headphone jack, as illustrated in Figure 86. In mono (differential) mode, the feedback pin(s) should be connected to the ground plane that is physically closest to the earpiece output PCB tracks.

The mono earpiece output is supported on the EPOUTP and EPOUTN pins. The output configuration



is differential (BTL), suitable for direct connection to an external earpiece or hearing coil load.

Typical headphone and earpiece connections are illustrated in Figure 86.

It is recommended to ensure that the electrical characteristics of the PCB traces for each output pair are closely matched. This is particularly important to matching the two traces of a differential (BTL) output.

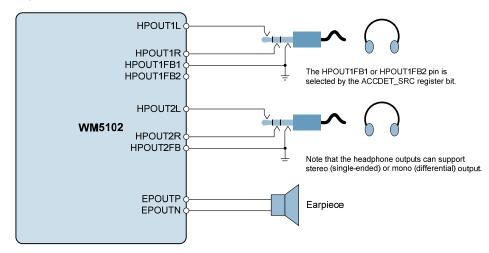


Figure 86 Headphone and Earpiece Connection

It is common for ESD diodes to be wired to pins that link to external connectors. This provides protection from potentially harmful ESD effects. In a typical application, ESD diodes would be recommended for both headphone paths (HPOUT1 and HPOUT2), when used as external headphone or line output.

The HPOUT1 and HPOUT2 outputs are ground-referenced, and the respective voltages may swing between +1.8V and -1.8V. The ESD diode configuration must be carefully chosen.

The recommended ESD diode configuration for these ground-referenced outputs is illustrated in Figure 87. The 'back-to-back' arrangement is necessary in order to prevent clipping and distortion of the output signal.

Note that similar care is required when connecting the WM5102 outputs to external circuits that provide input path ESD protection - the configuration on those input circuits must be correctly designed to accommodate ground-referenced signals.

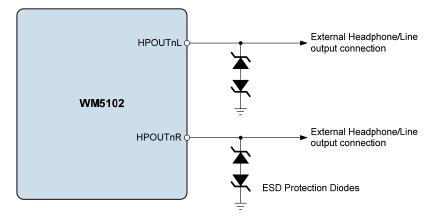


Figure 87 ESD Diode Configuration for External Output Connections

SPEAKER DRIVER OUTPUT PATH

The WM5102 incorporates two Class D speaker drivers, offering high amplifier efficiency at large signal levels. As the Class D output is a pulse width modulated signal, the choice of speakers and tracking of signals is critical for ensuring good performance and reducing EMI in this mode.

The efficiency of the speaker drivers is affected by the series resistance between the WM5102 and the speaker (e.g. PCB track loss and inductor ESR) as shown in Figure 88. This resistance should be as low as possible to maximise efficiency.

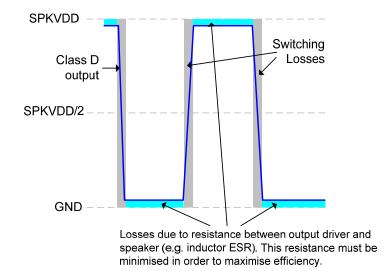


Figure 88 Speaker Connection Losses

The Class D output requires external filtering in order to recreate the audio signal. This may be implemented using a 2nd order LC or 1st order RC filter, or else may be achieved by using a loudspeaker whose internal inductance provides the required filter response. An LC or RC filter should be used if the loudspeaker characteristics are unknown or unsuitable, or if the length of the loudspeaker connection is likely to lead to EMI problems.

In applications where it is necessary to provide Class D filter components, a 2nd order LC filter is the recommended solution as it provides more attenuation at higher frequencies and minimises power dissipated in the filter when compared to a first order RC filter (lower ESR). This maximises both rejection of unwanted switching frequencies and overall speaker efficiency. A suitable implementation is illustrated in Figure 89.

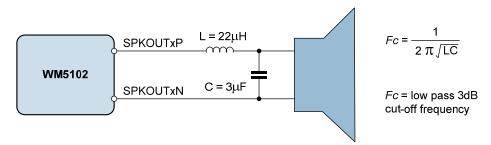
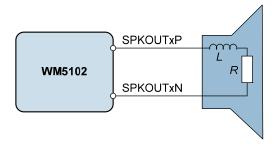


Figure 89 Class D Output Filter Components

A simple equivalent circuit of a loudspeaker consists of a serially connected resistor and inductor, as shown in Figure 90. This circuit provides a low pass filter for the speaker output. If the loudspeaker characteristics are suitable, then the loudspeaker itself can be used in place of the filter components described earlier. This is known as 'filterless' operation.





$$F_C = \frac{R}{2 \pi L}$$

Fc = low pass 3dB cut-off frequency

Figure 90 Speaker Equivalent Circuit for Filterless Operation

For filterless Class D operation, it is important to ensure that a speaker with suitable inductance is chosen. For example, if we know the speaker impedance is 8Ω and the desired cut-off frequency is 20kHz, then the optimum speaker inductance may be calculated as:

$$L = \frac{R}{2 \pi Fc} = \frac{8\Omega}{2 \pi * 20 \text{kHz}} = 64 \mu \text{H}$$

 8Ω loudspeakers typically have an inductance in the range $20\mu H$ to $100\mu H$, however, it should be noted that a loudspeaker inductance will not be constant across the relevant frequencies for Class D operation (up to and beyond the Class D switching frequency). Care should be taken to ensure that the cut-off frequency of the loudspeaker's filtering is low enough to suppress the high frequency energy of the Class D switching and, in so doing, to prevent speaker damage. The Class D outputs of the WM5102 operate at much higher frequencies than is recommended for most speakers and it must be ensured that the cut-off frequency is low enough to protect the speaker.

POWER SUPPLY / REFERENCE DECOUPLING

Electrical coupling exists particularly in digital logic systems where switching in one sub-system causes fluctuations on the power supply. This effect occurs because the inductance of the power supply acts in opposition to the changes in current flow that are caused by the logic switching. The resultant variations ('spikes') in the power supply voltage can cause malfunctions and unintentional behavior in other components. A decoupling ('bypass') capacitor can be used as an energy storage component which will provide power to the decoupled circuit for the duration of these power supply variations, protecting it from malfunctions that could otherwise arise.

Coupling also occurs in a lower frequency form when ripple is present on the power supply rail caused by changes in the load current or by limitations of the power supply regulation method. In audio components such as the WM5102, these variations can alter the performance of the signal path, leading to degradation in signal quality. A decoupling capacitor can be used to filter these effects, by presenting the ripple voltage with a low impedance path that does not affect the circuit to be decoupled.

These coupling effects are addressed by placing a capacitor between the supply rail and the corresponding ground reference. In the case of systems comprising multiple power supply rails, decoupling should be provided on each rail.

The recommended power supply and voltage reference decoupling capacitors for WM5102 are detailed below in Table 128.

POWER SUPPLY	DECOUPLING CAPACITOR
LDOVDD, DBVDD1, DBVDD2, DBVDD3, AVDD	0.1μF ceramic (see Note)
CPVDD	4.7μF ceramic
MICVDD	4.7μF ceramic
DCVDD	4.7μF ceramic
SPKVDDL, SPKVDDR	4.7μF ceramic
VREFC	1.0μF ceramic

Table 128 Power Supply Decoupling Capacitors

Note: $0.1\mu F$ is required with $4.7\mu F$ a guide to the total required power rail capacitance.

All decoupling capacitors should be placed as close as possible to the WM5102 device. The connection between AGND, the AVDD decoupling capacitor and the main system ground should be made at a single point as close as possible to the AGND balls of the WM5102.

Due to the wide tolerance of many types of ceramic capacitors, care must be taken to ensure that the selected components provide the required capacitance across the required temperature and voltage ranges in the intended application. For most application the use of ceramic capacitors with capacitor dielectric X5R is recommended.



CHARGE PUMP COMPONENTS

The WM5102 incorporates two Charge Pump circuits, identified as CP1 and CP2.

CP1 generates the CP1VOUTP and CP1VOUTN supply rails for the ground-referenced headphone drivers; CP2 generates the CP2VOUT supply rail for the microphone bias (MICBIAS) regulators.

Decoupling capacitors are required on each of the Charge Pump outputs. A fly-back capacitor is also required for each Charge Pump.

The recommended Charge Pump capacitors for WM5102 are detailed below in Table 129.

DESCRIPTION	CAPACITOR
CP1VOUTP decoupling	Required capacitance is 2.0μF at 2V. Suitable component typically 4.7μF.
CP1VOUTN decoupling	Required capacitance is 2.0μF at 2V. Suitable component typically 4.7μF.
CP1 fly-back (connect between CP1CA and CP1CB)	Required capacitance is 1.0μF at 2V. Suitable component typically 2.2μF.
CP2VOUT decoupling	Required capacitance is 1.0μF at 3.6V. Suitable component typically 4.7μF.
CP2 fly-back (connect between CP2CA and CP2CB)	Required capacitance is 220nF at 2V. Suitable component typically 470nF.

Table 129 Charge Pump External Capacitors

Ceramic capacitors are recommended for these Charge Pump requirements. Note that, due to the wide tolerance of many types of ceramic capacitors, care must be taken to ensure that the selected components provide the required capacitance across the required temperature and voltage ranges in the intended application. Ceramic capacitors with X5R dielectric are recommended.

The positioning of the Charge Pump capacitors is important, particularly the fly-back capacitors. These capacitors should be placed as close as possible to the WM5102. The component choice and positioning of the CP1 components are more critical than those of CP2, due to the higher output power requirements of CP1.

EXTERNAL ACCESSORY DETECTION COMPONENTS

The external accessory detection circuit measures jack insertion using the JACKDET pin. The insertion switch status is detected using an internal pull-up resistor circuit on the JACKDET pin.

Microphone detection and key-button press detection is supported using the MICDETn pins. The applicable pin should be connected to one of the MICBIASn outputs, via a $2.2k\Omega$ current-limiting resistor, as described in the "Microphone Bias Circuit" section. Note that, when using the External Accessory Detection function, the MICBIASn resistor must be $2.2k\Omega$ +/-2%.

A recommended circuit configuration, including headphone output on HPOUT1 and microphone connections, is shown in Figure 91. See "Analogue Input Paths" for details of the DC-blocking microphone input capacitor selection.

The recommended external components and connections for microphone / push-button detection are illustrated in Figure 92.

Note that, when using the Microphone Detect circuit, it is recommended to use one of the Right channel analogue microphone input paths, to ensure best immunity to electrical transients arising from the external accessory.



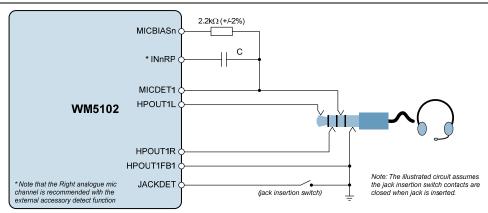


Figure 91 External Accessory Detection

The accessory detection circuit measures the impedance of an external load connected to one of the MICDET pins.

The microphone detection circuit uses MICVDD, MICBIAS1, MICBIAS2 or MICBIAS3 as a reference. The applicable source is configured using the MICD_BIAS_SRC register.

The WM5102 can detect the presence of a typical microphone and up to 6 push-buttons, using the components shown in Figure 92. When the microphone detection circuit is enabled, then each of the push-buttons shown will cause a different bit within the MICD_LVL register to be set.

The microphone detect function is specifically designed to detect a video accessory (typical 75 Ω) load if required. A measured external impedance of 75 Ω will cause the MICD_LVL [3] bit to be set.

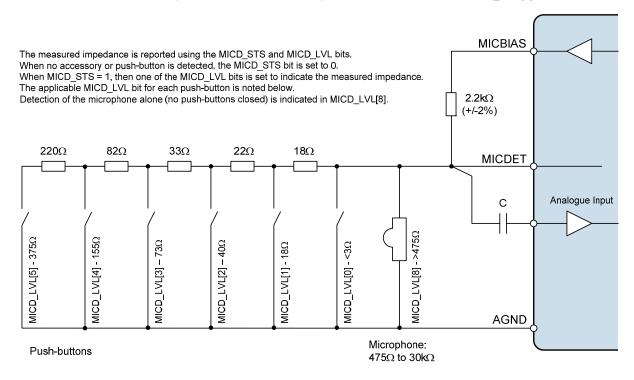
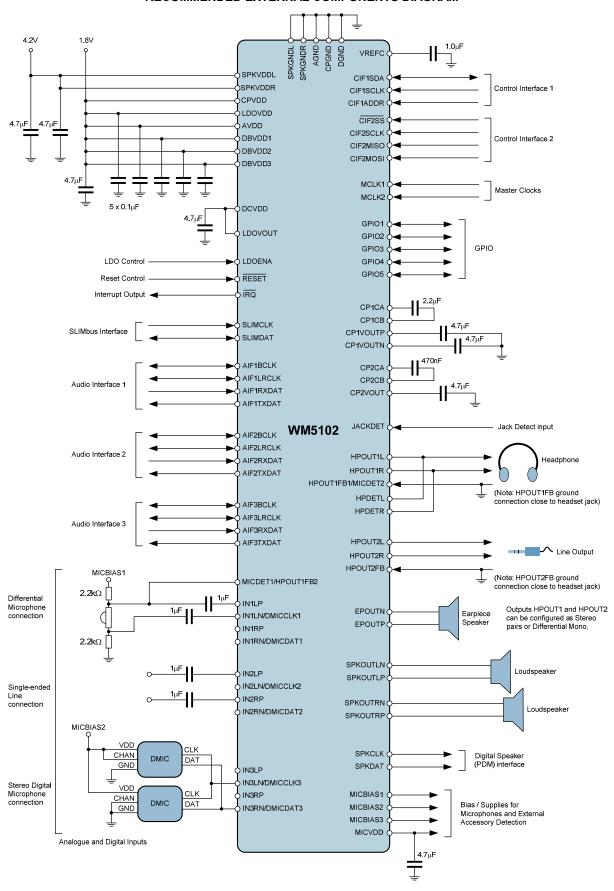


Figure 92 External Accessory Detect Connection

RECOMMENDED EXTERNAL COMPONENTS DIAGRAM



RESETS SUMMARY

The contents of Table 130 provide a summary of the WM5102 registers and other programmable memory under different reset conditions. The associated events and conditions are listed below.

- A Power-On Reset occurs when AVDD or DBVDD1 is below its respective reset threshold.
 (Note that DCVDD is also required for initial start-up; subsequent interruption to DCVDD should only be permitted as part of a control sequence for entering Sleep mode.)
- A Hardware Reset occurs when the RESET input is asserted (logic 0).
- A Software Reset occurs when register R0 is written to.
- Sleep Mode is selected when LDO1 is disabled. (LDO1 can be controlled using the LDO1_ENA register bit, or using the LDOENA pin; both of these controls must be deasserted to disable the LDO.) Note that the AVDD, DBVDD1 and LDOVDD supplies must be present, and the LDOENA pin held low. It is assumed that DCVDD is supplied by LDO1.

	ALWAYS-ON REGISTERS	OTHER REGISTERS	CONTROL SEQUENCER MEMORY	DSP FIRMWARE MEMORY
Power-On Reset (AVDD)	Reset	Reset	Retained	Retained
Power-On Reset (DBVDD1)	Reset	Reset	Retained	Retained
Power-On Reset (DCVDD)	Reset	Reset	Reset	Reset
Hardware Reset	Reset	Reset	Retained	Retained
			(see note)	(see note)
Software Reset	Reset	Reset	Retained	Retained
			(see note)	(see note)
Sleep Mode	Retained	Reset	Retained	Reset

Table 130 Memory Reset Summary

See "Low Power Sleep Configuration" for details of the 'Always-On' registers.

Note that, to retain the Control Write Sequencer memory and DSP firmware memory contents during Hardware Reset or Software Reset, it must be ensured that DCVDD is held above its reset threshold. If DCVDD is powered from internal LDO, then it is recommended to assert the LDOENA pin before the Reset, in order to maintain the DCVDD supply.



DIGITAL AUDIO INTERFACE CLOCKING CONFIGURATIONS

The digital audio interfaces (AIF1, AIF2, AIF3) can be configured in Master or Slave modes. In all applications, it is important that the system clocking configuration is correctly designed. Incorrect clock configurations will lead to audible clicks arising from dropped or repeated audio samples; this is caused by the inherent tolerances of multiple asynchronous system clocks.

To ensure reliable clocking of the audio interface functions, it is a requirement that the external interface clocks (eg. BCLK, LRCLK) are derived from the same clock source as SYSCLK (or ASYNCCLK, where applicable).

In AIF Master mode, the external BCLK and LRCLK signals are generated by the WM5102 and synchronisation of these signals with SYSCLK (or ASYNCCLK) is guaranteed. In this case, clocking of the AIF is typically derived from the MCLK1 or MCLK2 inputs, either directly or via one of the Frequency Locked Loop (FLL) circuits. It is also possible to use a different interface (AIFn or SLIMbus) to provide the reference clock to which the AIF Master can be synchronised.

In AIF Slave mode, the external BCLK and LRCLK signals are generated by another device, as inputs to the WM5102. In this case, it must be ensured that the applicable system clock (SYSCLK or ASYNCCLK) is generated from a source that is synchronised to the external BCLK and LRCLK inputs.

In a typical Slave mode application, the BCLK input is selected as the clock reference, using the FLL to perform frequency shifting. It is also possible to use the MCLK1 or MCLK2 inputs, but only if the selected clock is synchronised externally to the BCLK and LRCLK inputs. The SLIMbus interface can also provide the clock reference, via one of the FLLs, provided that the BCLK and LRCLK signals are externally synchronised with the SLIMCLK input.

The valid AIF clocking configurations are listed in Table 131 for AIF Master and AIF Slave modes.

The applicable system clock (SYSCLK or ASYNCCLK) depends on the AIFn_RATE setting for the relevant digital audio interface; if AIFn_RATE < 1000, then SYSCLK is applicable; if AIFn_RATE ≥ 1000, then ASYNCCLK is applicable.

AIF MODE	CLOCKING CONFIGURATION
AIF Master Mode	SYSCLK_SRC (ASYNCCLK_SRC) selects MCLK1 or MCLK2 as SYSCLK (ASYNCCLK) source.
	SYSCLK_SRC (ASYNCCLK_SRC) selects FLLn as SYSCLK (ASYNCCLK) source; FLLn_REFCLK_SRC selects MCLK1 or MCLK2 as FLLn source.
	SYSCLK_SRC (ASYNCCLK_SRC) selects FLLn as SYSCLK (ASYNCCLK) source; FLLn_REFCLK_SRC selects a different interface (BCLK, LRCLK, SLIMCLK) as FLLn source.
AIF Slave Mode	SYSCLK_SRC (ASYNCCLK_SRC) selects FLLn as SYSCLK (ASYNCCLK) source; FLLn_REFCLK_SRC selects BCLK as FLLn source.
	SYSCLK_SRC (ASYNCCLK_SRC) selects MCLK1 or MCLK2 as SYSCLK (ASYNCCLK) source, provided MCLK is externally synchronised to the BCLK input.
	SYSCLK_SRC (ASYNCCLK_SRC) selects FLLn as SYSCLK (ASYNCCLK) source; FLLn_REFCLK_SRC selects MCLK1 or MCLK2 as FLLn source, provided MCLK is externally synchronised to the BCLK input.
	SYSCLK_SRC (ASYNCCLK_SRC) selects FLLn as SYSCLK (ASYNCCLK) source; FLLn_REFCLK_SRC selects a different interface (eg. SLIMCLK) as FLLn source, provided the other interface is externally synchronised to the BCLK input.

Table 131 Audio Interface (AIF) Clocking Confgurations



In each case, the SYSCLK (ASYNCCLK) frequency must be a valid ratio to the LRCLK frequency; the supported clocking rates are defined by the SYSCLK_FREQ (ASYNC_CLK_FREQ) and SAMPLE_RATE_n (ASYNC_SAMPLE_RATE_n) registers.

The valid AIF clocking configurations are illustrated in Figure 93 to Figure 99 below. Note that, where MCLK1 is illustrated as the clock source, it is equally possible to select MCLK2 as the clock source. Similarly, in cases where FLL1 is illustrated, it is equally possible to select FLL2.

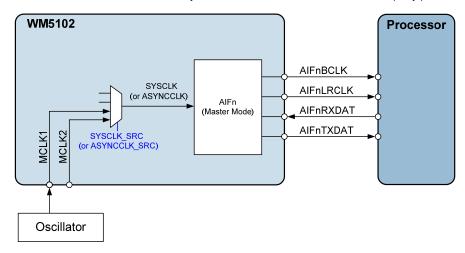


Figure 93 AIF Master Mode, using MCLK as Reference

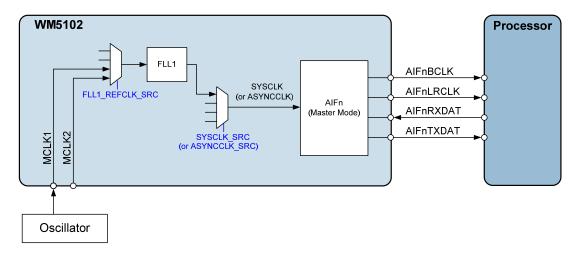


Figure 94 AIF Master Mode, using MCLK and FLL as Reference

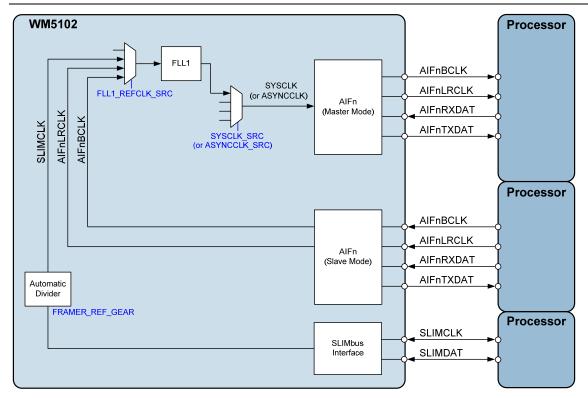


Figure 95 AIF Master Mode, using another Interface as Reference

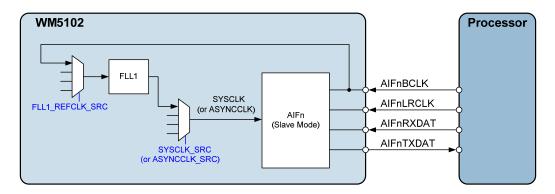


Figure 96 AIF Slave Mode, using BCLK and FLL as Reference

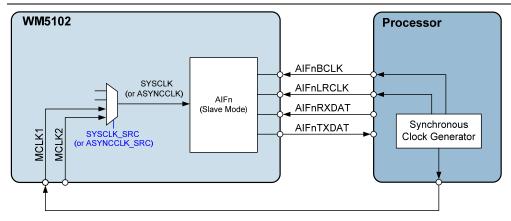


Figure 97 AIF Slave Mode, using MCLK as Reference

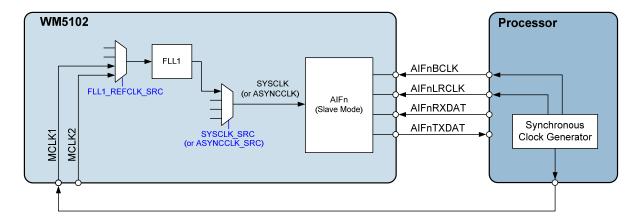


Figure 98 AIF Slave Mode, using MCLK and FLL as Reference

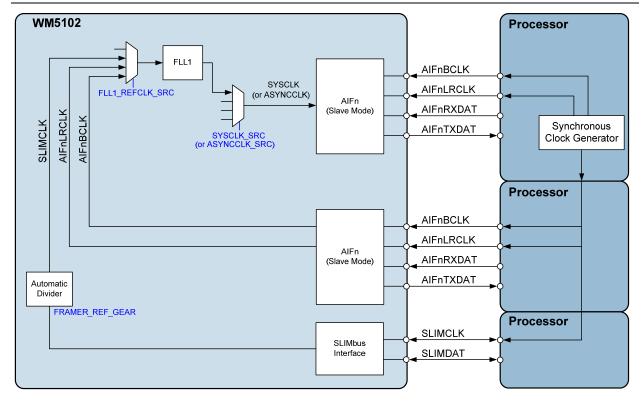
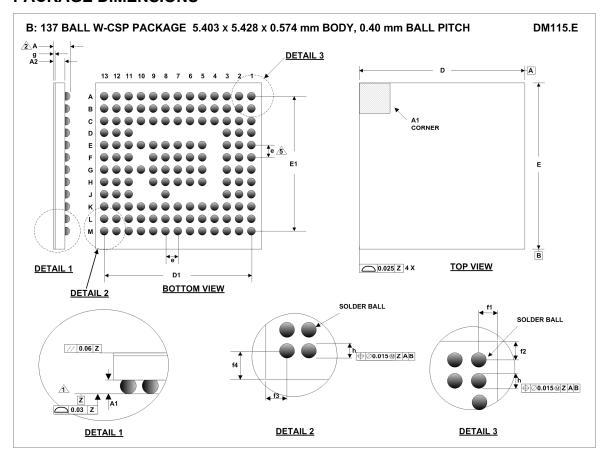


Figure 99 AIF Slave Mode, using another Interface as Reference

PCB LAYOUT CONSIDERATIONS

Poor PCB layout will degrade the performance and be a contributory factor in EMI, ground bounce and resistive voltage losses. All external components should be placed as close to the WM5102 device as possible, with current loop areas kept as small as possible.

PACKAGE DIMENSIONS



Symbols	Dimensions (mm)						
	MIN	NOM	MAX	NOTE			
Α	0.540	0.574	0.608				
A1	0.172	0.202	0.232				
A2	0.356	0.372	0.388				
D	5.378	5.403	5.428				
D1		4.80 BSC					
E	5.403	5.428	5.453				
E1		4.40 BSC					
е		0.400 BSC		5			
f1		0.300 BSC					
f2		0.427 BSC					
f3		0.303 BSC					
f4		0.601 BSC					
g		0.022					
h	0.222	0.262	0.302				

- NOTES:

 1. PRIMARY DATUM -Z- AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.

 2. THIS DIMENSION INCLUDES STAND-OFF HEIGHT 'A1'.

 3. A1 CORNER IS IDENTIFIED BY INK/LASER MARK ON TOP PACKAGE.

 4. BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

 5. 'e' REPRESENTS THE BASIC SOLDER BALL GRID PITCH.

 6. THIS DRAWING IS SUBJECT TO CHANGE WITHOUT NOTICE.

 7. FOLLOWS JEDEC DESIGN GUIDE MO-211-C.



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ADDRESS:

Wolfson Microelectronics plc 26 Westfield Road Edinburgh EH11 2QB

United Kingdom

Tel :: +44 (0)131 272 7000 Fax :: +44 (0)131 272 7001

Email :: sales@wolfsonmicro.com



REVISION HISTORY

DATE	REV	DESCRIPTION OF CHANGES	PAGE	CHANGED BY
05/04/12	1.0	Initial version		PH
18/04/12	2.0	HPDET_STS, MICDET_STS deleted		PH
	0	PWM_CLK_SEL description updated (50MHz option deleted).		
08/06/12	2.0	Sample rates greater than 192kHz deleted.		PH
		Power Domain information added.		
		DCVDD & Configuration requirements for 50MHz clocking added.		
		Electrical Characteristics updated (min/max limits deleted).		
		FLL Synchroniser timing requirements added.		
		DMICCLK, SPKCLK, BCLK timing requirements updated.		
		LRA_FREQ register description updated (Haptics).		
		Added details of the supported Sample Rates for different blocks.		
		Additional details of SLIMbus clocking & Framer functions.		
		Output Path noise gate function added.		
		ECI_JD_SRC register deleted.		
		ECI_BIAS_SRC register updated, noting permitted configurations of ECI digital/analogue bias sources.		
		LDO2_ENA and LDO2_BYPASS register deleted – these are slaved to the CP2 controls.		
		Clocking Configuration Applications Info updated to incorporate SLIMbus interface options.		
		Analogue connections updated on External Components figure.		
03/07/12	2.0	Update to GPIO FLL clock output: FLLn_GPCLK_DIV controls the frequency relative to Fvco, ie. independent of FLLn_OUTDIV.		PH
		Volume Ramp register descriptions updated.		
		Maximum LDO2 output voltage amended to 3.25V.		
30/07/12	2.0	DRC2 deleted		PH
		HP_CLK_DIV register deleted		
		GP_DBTIME register updated		
		DSP Firmware memory definitions updated		
		MICBIAS description moved to Charge Pump & Regulator section.		
05/10/12	2.0	Package Drawing updated.		PH
		Input Pin descriptions corrected.		
		SUBSYS_MAX_FREQ bit, and associated LDO requirements added, enabling 49.152MHz DSP clocking		
		Noted Left-Justified and DSP-B modes valid in Master mode only.		
		Maximum LDO2 output voltage reverted to 3.3V.		
		Electrical Characteristics updated.		
		Noted MICVDD required for analogue inputs.		
		Changed descriptions of Input PGA & Output PGA ramp control		
		registers.		
		Typical AIF system connections updated.		
		Noted AIF format is 2's complement.		
		Noted LRCLK rate registers only applicable in Slave mode.		
		Noted MICVDD required for accessory detection.		
		Deleted 64kHz & 128kHz audio sample rates.		
15/10/10	2.0	Noted 32kHz clock required for CP2.		DU
15/10/12	2.0	Rev B silicon updates added:		PH
		Support for second ASYNCCLK sample rate. Write Sequences trigger function from DBC Signal Detect added		
		Write Sequencer trigger function from DRC Signal Detect added.		
		Enhancement to Headphone Impedance measurement.		
		Added MICDET clamp and associated WKUP/WSEQ controls. Input pin maximum ratings updated; recommended to use Right		
		channel analogue mic paths when using accessory detect.		
		Granner analogue mic patris when using accessory detect.		



DATE	REV	DESCRIPTION OF CHANGES	PAGE	CHANGED BY
18/10/12	2.0	Package Drawing updated.		PH
		I2C timing diagram updated, with additional "SDA Valid" parameter.		
13/11/12	2.0	Electrical Characteristics updated.		PH
		OUT[1-4]_OSR register bits deleted.		
		OUTnx_PGA_VOL registers deleted.		
		Correction to Pin Numbering (SPKOUTLP, SPKOUTLN, SPKOUTRP, SPKOUTRN)		
14/12/12	3.0	Updates describing automatic gain in AEC Loopback path.		PH
		Package drawing updated.		
		Generic description added for digital core mixer control registers.		
		Typical power consumption data added		
19/02/13	3.0	Electrical Characteristics updated.		PH
		ESD diode configuration details added for external outputs.		
		OUT4_OSR register bit reinstated.		
20/03/13	4.0	FLL Gain and Bandwidth control registers added.		PH
		DSP Firmware memory reset conditions amended (including DSP1_MEM_ENA description).		
		DMA register control requirements added for disabling DSP.		
08/05/13	4.0	Deleted statements about automatic thermal shutdown - speaker		PH
		drivers must be disabled via software control.		
		IM_BOOT_DONE_EINT2 updated (default is 0 - unmasked)		
10/07/13	4.1	Power-up timing and Reset requirements updated.		PH
		SNR test conditions clarified.		
		Headphone impedance measurement control sequence updated; HP_IMPEDANCE_RANGE updated;		
		HP_DACVAL added, HP_LVL deleted.		
		MEMS microphone connection description added.		
		DSP_IRQn bits added.		
		DAC output path now supports sample rates up to192kHz.		
		SLIMbus description added, including supported messages.		
		SLIMbus port configuration registers added.		
		OUTn_OSR and DACn_FREQ_LIM registers added for optimising Headphone and Earpiece paths.		
		MICD_PD register deleted.		
		Clarifications to Sleep/Wake-Up control, including the LDOENA pin.		
		Noted that Control Sequence on Wake-Up is not supported.		
		User boot sequence is not supported.		
		FLLn_CTRL_UPD and associated descriptions updated.		
		Added details of register configuration sequence - required on POR, HW Reset, SW Reset & Wake-Up.		
06/12/13	4.1	Noted that MICVDD (output) can be used to power external mics.		PH
		Clarification to maximum input signal levels (analogue & digital). Thermal characteristics added.		
		Noted DRC function supports sample rates up to 96kHz only.		
		DSP firmware requirements clarified; DMA and JTAG added.		
		Noted GPIO5 functions are different to GPIO1,2,3,4.		
		GPIO WSEQ output description updated		
		FLL free-running mode description updated		
		Noted LDO1 cannot be used to power external circuits.		
		Added clarifications and summary of memory/register status following POR, HW Reset, SW Reset, and Sleep.		
29/01/14	4.1	MCLK2 sleep mode frequency limit added.		
		SLIMbus Interface Timing details added.		
		48kHz BCLK support deleted		
		Clarification of Sleep mode clocking requirements.		
		SPK1 FMT definition amended.		

